The Engineering Staff of TEXAS INSTRUMENTS INCORPORATED Semiconductor Group



# The Bipolar Microcomputer Components Data Book

**Design Engineers** 

for

**Second Edition** 





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# for Design Engineers

Second Edition



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#### **IMPORTANT NOTICES**

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Second Edition

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#### THE BIPOLAR MICROCOMPUTER COMPONENTS DATA BOOK

#### Second Edition

This data book describes a series of high-complexity bipolar digital building blocks designed specifically for implementing high-performance computer or controller systems. The series offers the system designer maximum flexibility for achieving cost-effective hardware designs from dedicated, highly specialized unique systems with tailored instructions to general-purpose computers capable of emulating existing machine instructions, or programs, without loss of software investment.

In addition to a choice between the high-performance Schottky-clamped<sup>†</sup> TTL 4-bit-slice processor element and a 16-bit computer central processing unit (CPU), the system designer can pick from a new expanded family of Schottky TTL memories (RAMs, PROMs and ROMs), and state-of-the art support functions needed to meet all control and interface requirements.

The SN54S481 and the SN74S481, with typical clock cycle times of 90 ns, are the industry's highest-complexity Schottky TTL processor elements and are the only bipolar micro/macroprogrammable elements featuring automatically sequenced iterative multiply, divide, and cyclical-redundancy algorithms. System control is simplified to a very low package count with the expandable SN54S482/SN74S482 4-bit-slice controller performing next-address generation functions.

The SBP 9900A microprocessor, a ruggedized, monolithic, 16-bit-parallel 1<sup>2</sup>L central processing unit (CPU), combines an advanced memory-to-memory architecture and a powerful minicomputer instruction set with the simplicity of a single power supply and static logic with a single-phase clock to thrust its capabilities beyond those of existing microprocessors.

The new SN74LS462/SN74LS463 fiber-optics interface functions provide a simplified, low-cost solution to interfacing requirements for optical source and detector components. This transmitter/receiver pair is designed to provide the appropriate encoding, synchronizing, and decoding logic necessary to control the transmission of digital data through a wide variety of fiber-optic data-link assemblies.

The family of high-performance Schottky TTL memories offers a wide variety of organizations providing efficient solutions for virtually any size microcontrol or program memory. A new expanded family of bipolar PROM (including standard, low-power, power-down and registered types) has dictated a new numbering system to encompass new device types. A number of advanced high-complexity I/O and interface circuits have been added to the peripheral product family. Most of these I/O and interface functions, as well as a number of the other processor support functions, are offered in space-saving 20-pin packages, which reduce package count and enhance system density.

The SBP 9708 8-bit by 8-bit parallel byte multiplier provides a 16-bit signed or unsigned 8-bit bytes. The SBP 9708 is designed to achieve the cost-effectiveness needed for microprocessor based systems.

Although this volume offers design and specification data only for bipolar computer components, complete technical data for any TI semiconductor-component product is available from your nearest TI field sales office, local authorized TI distributor, or by writing direct to: Marketing and Information Services, Texas Instruments Incorporated, P. O. Box 225012, MS 308, Dallas, Texas 75265.

We sincerely hope you will find *The Bipolar Microcomputer Components Data Book* a meaningful addition to your technical library.

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#### INTRODUCTION

This glossary consists of two parts: (1) general concepts for digital circuits including types of bipolar memories and (2) operating conditions and characteristics (including letter symbols). Some of the terms, symbols, abbreviations, and definitions used with memory integrated circuits have not, as yet, been standardized. These are currently under consideration by the EIA/JEDEC (Electronic Industries Association) and the IEC (International Electrotechnical Commission). The following are as consistent with the past and future work of these organizations as is possible to anticipate at this time.

#### PART I – GENERAL CONCEPTS INCLUDING TYPES OF BIPOLAR MEMORIES

#### **Chip-Enable Input**

A control input that when active permits operation of the integrated circuit for input, internal transfer, manipulation, refreshing, and/or output of data and when inactive causes the integrated circuit to be in a reduced-power standby mode.

NOTE: See "chip-select input".

#### Chip-Select Input

A gating input that when inactive prevents input or output of data to or from an integrated circuit. NOTE: See "chip-enable input".

#### Dynamic (Read/Write) Memory

A read/write memory in which the cells require the repetitive application of control signals in order to retain stored data.

NOTES: 1. The words "read/write" may be omitted from the term when no misunderstanding will result.

- 2. Such repetitive application of the control signals is normally called a refresh operation.
  - 3. A dynamic memory may use static addressing or sensing circuits.
  - 4. This definition applies whether the control signals are generated inside or outside the integrated circuit.

#### First-In First-Out (FIFO) Memory

A memory from which data bytes or words can be read in the same order, but not necessarily at the same rate, as that of the data entry.

#### Gate Equivalent Circuit

A basic unit-of-measure of relative digital-circuit complexity. The number of gate equivalent circuits is that number of individual logic gates that would have to be interconnected to perform the same function.

#### Large-Scale Integration, LSI

A concept whereby a complete major subsystem or system function is fabricated as a single microcircuit. In this context a major subsystem or system, whether digital or linear, is considered to be one that contains 100 or more equivalent gates or circuitry of similar complexity.

#### Mask-Programmed Read-Only Memory

A read-only memory in which the data content of each cell is determined during manufacture by the use of a mask, the data content thereafter being unalterable.

# GLOSSARY TTL TERMS AND DEFINITIONS

#### Medium-Scale Integration, MSI

A concept whereby a complete subsystem or system function is fabricated as a single microcircuit. The subsystem or system is smaller than for LSI, but whether digital or linear, is considered to be one that contains 12 or more equivalent gates or circuitry of similar complexity.

#### **Memory Cell**

The smallest subdivision of a memory into which a unit of data has been or can be entered, in which it is or can be stored, and from which it can be retrieved.

#### **Memory Integrated Circuit**

An integrated circuit consisting of memory cells and usually including associated circuits such as those for address selection, amplifiers, etc.

#### Output-Enable Input

A gating input that when active permits the integrated circuit to output data and when inactive causes the integrated circuit output(s) to be at a high impedance (off).

#### Programmable Read-Only Memory (PROM)

A read-only memory that after being manufactured can have the data content of each memory cell altered once only.

#### Random-Access Memory (RAM)

A memory that permits access to any of its address locations in any desired sequence with similar access time for each location.

NOTE: The term RAM, as commonly used, denotes a read/write memory.

#### Read-Only Memory (ROM)

A memory in which the contents are not intended to be altered during normal operation. NOTE: Unless otherwise qualified, the term "read-only memory" implies that the content is unalterable and defined by construction.

#### **Read/Write Memory**

A memory in which each cell may be selected by applying appropriate electronic input signals and the stored data may be either (a) sensed at appropriate output terminals, or (b) changed in response to other similar electronic input signals.

#### Small-Scale Integration, SSI

Integrated circuits of less complexity than medium-scale integration (MSI).

#### Very-Large-Scale Integration, VLSI

A concept whereby a complete system function is fabricated as a single microcircuit. In this context, a system, whether digital or linear, is considered to be one that contains 1000 or more gates or circuitry of similar complexity.

#### Volatile Memory

A memory the data content of which is lost when power is removed.

#### PART II – OPERATING CONDITIONS AND CHARACTERISTICS (INCLUDING LETTER SYMBOLS)

The symbols for quantities involving time use upper and lower case letters according to the following historically evolved principles:

- a. Time itself, is always represented by a lower case t.
- b. Subscripts are lower case when one or more letters represent single words, e.g., d for delay, su for setup, rd for read, wr for write.
- c. Multiple subscripts are upper case when each letter stands for a different word, e.g., SR for sense recovery and PLH for propagation delay from low to high.

#### Access Time (of a memory)

The time between the application of a specified input pulse during a read cycle and the availability of valid data signals at an output.

Example symbology:

| <sup>t</sup> a(ad) | Access time from address     |
|--------------------|------------------------------|
| ta(E)              | Access time from chip enable |
| t <sub>a</sub> (S) | Access time from chip select |

#### **Clock Frequency**

Maximum clock frequency, fmax

The highest rate at which the clock input of a bistable circuit can be driven through its required sequence while maintaining stable transistions of logic level at the output with input conditions established that should cause changes of output logic level in accordance with the specification.

#### Current

High-level input current, IIH

The current into\* an input when a high-level voltage is applied to that input.

#### High-level output current, IOH

The current into\* an output with input conditions applied that according to the product specification will establish a high level at the output.

#### Low-level input current, IIL

The current into\* an input when a low-level voltage is applied to that input.

#### Low-level output current, IOL

The current into\* an output with input conditions applied that according to the product specification will establish a low level at the output.

#### Off-state output current, IO(off)

The current flowing into<sup>\*</sup> an output with input conditions applied that according to the product specification will cause the output switching element to be in the off state.

Note: This parameter is usually specified for open-collector outputs intended to drive devices other than logic circuits.

\*Current out of a terminal is given as a negative value.

# GLOSSARY TTL TERMS AND DEFINITIONS

#### Off-state (high-impedance-state) output current (of a three-state output), IOZ

The current into<sup>\*</sup> an output having three-state capability with input conditions applied that according to the product specification will establish the high-impedance state at the output.

#### Short-circuit output current, IOS

The current into<sup>\*</sup> an output when that output is short-circuited to ground (or other specified potential) with input conditions applied to establish the output logic level farthest from ground potential (or other specified potential).

#### Supply current, ICC

The current into\* the V<sub>CC</sub> supply terminal of an integrated circuit.

#### Cycle Time

Read cycle time, t<sub>c(rd)</sub> (see note)

The time interval between the start and end of a read cycle.

#### Read-write cycle time, tc(rd,wr) (see note)

The time interval between the start of a cycle in which the memory is read and new data are entered, and the end of that cycle.

#### Write cycle time, tc(wr) (see note)

The time interval between the start and end of a write cycle.

NOTE: The read, read-write, or write cycle time is the actual interval between two impulses and may be insufficient for the completion of operations within the memory. A minimum value is specified that is the shortest time in which the memory will perform its read and/or write function correctly.

#### Hold Time

#### Hold time, th

The interval during which a signal is retained at a specified input terminal after an active transition occurs at another specified input terminal.

- NOTES: 1. The hold time is the actual time between two events and may be insufficient to accomplish the intended result. A minimum value is specified that is the shortest interval for which correct operation of the logic element is guaranteed.
  - 2. The hold time may have a negative value in which case the minimum limit defines the longest interval (between the release of data and the active transition) for which correct operation of the logic element is guaranteed.

#### **Output Enable and Disable Time**

Output enable time (of a three-state output) to high level, tPZH (or low level, tPZL)

The propagation delay time between the specified reference points on the input and output voltage waveforms with the three-state output changing from a high-impedance (off) state to the defined high (or low) level.

#### Output enable time (of a three-state output) to high or low level, tpzx

The propagation delay time between the specified reference points on the input and output voltage waveforms with the three-state output changing from a high-impedance (off) state to either of the defined active levels (high or low).

#### Output disable time (of a three-state output) from high level, tpHZ (or low level, tpLZ)

The propagation delay time between the specified reference points on the input and output voltage waveforms with the three-state output changing from the defined high (or low) level to a high-impedance (off) state.

\*Current out of a terminal is given as a negative value.

#### Output disable time (of a three-state output) from high or low level, tPXZ

The propagation delay time between the specified reference points on the input and output voltage waveforms with the three-state output changing from either of the defined active levels (high or low) to a high-impedance (off) state.

#### **Propagation Time**

#### Propagation delay time, tpD

The time between the specified reference points on the input and output voltage waveforms with the output changing from one defined level (high or low) to the other defined level.

#### Propagation delay time, low-to-high-level output, tpLH

The time between the specified reference points on the input and output voltage waveforms with the output changing from the defined low level to the defined high level.

#### Propagation delay time, high-to-low-level output, tPHL

The time between the specified reference points on the input and output voltage waveforms with the output changing from the defined high level to the defined low level.

#### Pulse Width

#### Pulse width, tw

The time interval between specified reference points on the leading and trailing edges of the pulse waveform.

Example symbology:

| <sup>t</sup> w(cl) | Clear pulse width |
|--------------------|-------------------|
| <sup>t</sup> w(wr) | Write pulse width |

#### **Recovery Time**

#### Sense Recovery time, tSR

The time interval needed to switch a memory from a write mode to a read mode and to obtain valid data signals at the output.

#### **Release Time**

#### Release time, trelease

The time interval between the release from a specified input terminal of data intended to be recognized and the occurrence of an active transition at another specified input terminal.

Note: When specified, the interval designated "release time" falls within the setup interval and constitutes, in effect, a negative hold time.

#### Setup Time

#### Setup time, t<sub>su</sub>

The time interval between the application of a signal that is maintained at a specified input terminal and a consecutive active transition at another specified input terminal.

- NOTES: 1. The setup time is the actual time between two events and may be insufficient to accomplish the setup. A minimum value is specified that is the shortest interval for which correct operation of the logic element is guaranteed.
  - The setup time may have a negative value in which case the minimum limit defines the longest interval (between the active transition and the application of the other signal) for which correct operation of the logic element is guaranteed.

# GLOSSARY TTL TERMS AND DEFINITIONS

#### **Transition Time**

Transition time, low-to-high-level, tTLH

The time between a specified low-level voltage and a specified high-level voltage on a waveform that is changing from the defined low level to the defined high level.

#### Transition time, high-to-low-level, tTHL

The time between a specified high-level voltage and a specified low-level voltage on a waveform that is changing from the defined high level to the defined low level.

#### Voltage

#### High-level input voltage, VIH

An input voltage within the more positive (less negative) of the two ranges of values used to represent the binary variables.

NOTE: A minimum is specified that is the least positive value of high-level input voltage for which operation of the logic element within specification limits is guaranteed.

#### High-level output voltage, VOH

The voltage at an output terminal with input conditions applied that according to the product specification will establish a high level at the output.

#### Input clamp voltage, VIK

An input voltage in a region of relatively low differential resistance that serves to limit the input voltage swing.

#### Low-level input voltage, VIL

An input voltage level within the less positive (more negative) of the two ranges of values used to represent the binary variables.

NOTE: A maximum is specified that is the most positive value of low-level input voltage for which operation of the logic element within specification limits is guaranteed.

#### Low-level output voltage, VOL

The voltage at an output terminal with input conditions applied that according to the product specification will establish a low level at the output.

#### Negative-going threshold voltage, VT-

The voltage level at a transition operated input that causes operation of the logic element according to specification as the input voltage falls from a level above the positive-going threshold voltage,  $V_{T+}$ .

#### Off-state output voltage, VO(off)

The voltage at an output terminal with input conditions applied that according to the product specification will cause the output switching element to be in the off state.

Note: This characteristic is usually specified only for outputs not having internal pull-up elements.

#### On-state output voltage, VO(on)

The voltage at an output terminal with input conditions applied that according to the product specification will cause the output switching element to be in the on state.

Note: This characteristic is usually specified only for outputs not having internal pull-up elements.

#### Positive-going threshold voltage, VT+

The voltage level at a transition-operated input that causes operation of the logic element according to specification as the input voltage rises from a level below the negative-going threshold voltage,  $V_{T-}$ .

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#### ACRONYMS AND MNEMONICS

| AG     | arithmetically greater than                          |
|--------|--|
| AI     | address input port                                   |
| ALU    | arithmetic logic unit                                |
| AO     | address output port                                  |
| BLWP   | branch and load workspace pointer                    |
| ссо    | counter-carry output                                 |
| С      | clock input (PROMs)                                  |
| CE     | chip enable  |
| CIN    | carry in   |
| CL     | clock  |
| CLK    | clock  |
| CLA    | carry look-ahead                                     |
| CLR    | clear  |
| COUT   | carry out  |
| CPU    | central processing unit                              |
| CRC    | cyclic redundancy check                              |
| CRU    | communications register unit                         |
| CRUIN  | data input to CPU for CRU input operations           |
| CRUOUT | data output from CPU for CRU output operations       |
| CRUCLK | CRU-enable signal from CPU for CRU output operations |
| DBIN   | data bus input                                       |
| DO     | data output port                                     |
| DMA    | direct memory access                                 |
| DP     | double precision                                     |
| E      | asynchronous chip enable                             |
| EQ     | equal to   |
| FPLA   | field-programmable logic array                       |
| G      | asynchronous output enable                           |
| INCMC  | increment memory counter                             |
| INCPC  | increment program counter                            |
| INT    | interrupt  |
| 1/0    | input or output                                      |
| IP     | intermediate position                                |
| INTREQ | interrupt request                                    |
| LG     | logically greater than                               |
| LCIR   | left circulate                                       |
| LD     | load   |
| LDCR   | load CRU   |
| LSA    | left-shift arithmetic                                |
| LSB    | least-significant bit                                |
| LSL    | left-shift logical                                   |
| LSP    | least-significant position                           |

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#### TEXAS INSTRUMENTS INCORPORATED POST OFFICE BOX 225012 • DALLAS, TEXAS 75265

| MC    | memory counter                              |
|-------|---|
| MEMEN | memory enable                               |
| MSB   | most-significant bit                        |
| MPX   | multiplex                                   |
| MSP   | most-significant position                   |
| MUX   | multiplexer                                 |
| NC    | not connected                               |
| OE    | output enable                               |
| OV    | overflow                                    |
| PC    | program counter                             |
| PLA   | programmable logic array                    |
| POS   | relative position control (MPS, IP, or LSP) |
| RCIR  | right circulate                             |
| RSA   | right-shift arithmetic                      |
| RSL   | right-shift logical                         |
| RTWP  | return workspace pointer instruction        |
| S     | asyncronous chip select                     |
| SBZ   | set bit to zero                             |
| SBO   | set bit to one                              |
| SP    | single precision                            |
| ST    | status register                             |
| STCR  | store CRU                                   |
| TB    | test bit                                    |
| WR    | working register                            |
| WE    | write enable                                |
| XOP   | extended operation instruction              |
| XWR   | extended working register                   |

Additional mnemonics or acronyms specifically relating to SBP 9900A instructions are found on pages 3-24 and 3-26.

The following symbols are used in function tables on TI data sheets:

| н              | = | high level (steady state)  |
|----------------|---|--|
| L              | = | low level (steady state)   |
| 1              | = | transition from low to high level  |
| ţ              | = | transition from high to low level  |
| <b>→</b>       | = | value/level or resulting value/level is routed to indicated destination  |
| r              | = | value/level is re-entered  |
| х              | = | irrelevant (any input, including transitions)  |
| Z              | = | off (high-impedance) state of a 3-state-output   |
| ah             | = | the level of steady-state inputs at inputs A through H respectively  |
| 0 <sub>0</sub> | = | level of Q before the indicated steady-state input conditions were established   |
| ō0             | = | complement of $\Omega_0$ or level of $\overline{\Omega}$ before the indicated steady-state input conditions were established   |
| Qn             | = | level of Q before the most recent active transition indicated by $\downarrow$ or $\uparrow$                                    |
| $\Box$         | = | one high-level pulse   |
|                | = | one low-level pulse  |
| TOGGLE         | = | each output changes to the complement of its previous level on each active transition indicated by $\downarrow$ or $\uparrow.$ |

If, in the input columns, a row contains only the symbols H, L, and/or X, this means the indicated output is valid whenever the input configuration is achieved and regardless of the sequence in which it is achieved. The output persists so long as the input configuration is maintained.

If, in the input columns, a row contains H, L, and/or X together with  $\uparrow$  and/or  $\downarrow$ , this means the output is valid whenever the input configuration is achieved but the transition(s) must occur following the achievement of the steady-state levels. If the output is shown as a level (H, L, Q<sub>0</sub>, or  $\overline{Q}_0$ ), it persists so long as the steady-state input levels and the levels that terminate indicated transitions are maintained. Unless otherwise indicated, input transitions in the opposite direction to those shown have no effect at the output. (If the output is shown as a pulse,  $\int \Box$  or  $\Box \Box \Gamma$ , the pulse follows the indicated input transition and persists for an interval dependent on the circuit.)

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### SERIES 54S/74S DEVICES



Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

D. In the examples above, the phase relationships between inputs and outputs have been chosen arbitrarily.

- E. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>out</sub>  $\approx$  50  $\Omega$ , t<sub>r</sub>  $\leq$  2.5 ns, t<sub>f</sub>  $\leq$  2.5 ns,
- F. When measuring propagation delay times of 3-state outputs, switches S1 and S2 are closed.



Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control. E. In the examples above, the phase relationships between inputs and outputs have been chosen arbitrarily.

F. All input pulses are supplied by generators having the following characteristics: PRR  $\leq$  1 MHz, Z<sub>out</sub>  $\approx$  50  $\Omega$ , t<sub>r</sub>  $\leq$  15 ns, t<sub>f</sub>  $\leq$  6 ns. G. When measuring propagation delay times of 3-state outputs, switches S1 and S2 are closed.

# 4-Bit-Slice Schottky Processor Components

# **4-BIT-SLICE PROCESSOR COMPONENTS**

SN54S481 SN74S481

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FUNCTIONAL BLOCK DIAGRAM FOR 'S481

#### 1 INTRODUCTION

These Schottky TTL 4-bit expandable parallel binary micro/macroprogrammable processor element building blocks are designed specifically for implementing high-performance digital computer/controllers. With the ability to efficiently emulate existing systems, they can be used to upgrade hardware performance with full compatibility to protect software investments.

The SN54S/74S481, Schottky TTL performs typically at a clock cycle time of 90 nanoseconds at 345 milliamperes of supply current.

#### 1.1 ARCHITECTURAL FEATURES

Designed with full parallel dual input/output ports, the memory-to-memory architecture provides a new dimension in interrupt processing or program context switching flexibilities. Static bipolar logic performs each microinstruction within a single clock cycle.

Primary among the architectural features are:

- Microprogrammable, bit-slice design is expandable in 4-bit multiples
- Full parallel dual input/output ports for use in advanced memory-to-memory architecture
- Full-function ALU with carry look-ahead, magnitude, and overflow decision capabilities
- Double-length accumulator with full shifting capability and sign-bit handling
- Dual memory address generators on-chip.

#### 1.2 OPERATIONAL FEATURES

The functional capabilities, characterized by the 24,780 unique operations, coupled with the macroprogrammable multiply and divide algorithms, make these processor elements particularly attractive for implementing advanced high performance computers and controllers.

In addition to the full parallel data bus structure, the 'S481 architecture also features asynchronous access to data routing and counter updating controls which, when combined with the most versatile instruction set available (see operational description) maximizes flexibility, efficiency, and performance. Simultaneous compound operations in the form of an ALU function with shift, plus destination selection with address/iteration updating, plus address and present data to memory can be accomplished in a single microcyle. Some other operational features are:

- Simultaneous one-clock compound operations, with status, can reduce microcycles and improve throughput
- Pre-programmed CRG and double-precision multiply/divide algorithms
- Double length accumulator with full bidirectional single/double precision arithmetic/logical/circulate shift capabilities include sign protection
- Full micro-operational control is provided for programming: address updating, data and address source selection, and direct transfer of data to working register or working memory
- Relative position control defines bit-slice rank and sign handling in N-bit applications.

#### 1.3 MECHANICAL FEATURES

These processor elements are supplied in either a high-density quad-in-line ceramic package or a plastic dual-in-line package. The high-density 48-pin ceramic package has quad pin rows formed on 600- and 800-mil centers. Within each of the four rows, the pin spacing is 100 mils, center-to-center. The plastic dual-in-line package has standard 100-mil spacing on 600-mil centers. Outline drawings are provided in Section 6 of this data book.

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#### TABLE 1 FUNCTIONAL DESCRIPTIONS

| PIN NUMBER                                  | PIN NAME   | PIN FUNCTION   | INPUT, OUTPUT, OR<br>INPUT/OUTPUT |
|---|--|--|-----------------------------------|
| 46, 47<br>1, 2                              | BI/O0, BI/O1<br>BI/O2, BI/O3                             | 4-bit parallel data input port to the B latch, or 4-bit parallel data output for the $\Sigma$ -bus when not being used as an input.  | Inputs/Outputs                    |
| 6, 5<br>4, 3                                | AI0, AI1<br>AI2, AI3                                     | 4-bit parallel data input port to the A latch and WR.  | Inputs                            |
| 7, 8<br>9, 10<br>17, 14<br>13, 11<br>15, 16 | OP0, OP1<br>OP2, OP3<br>OP4, OP5<br>OP6, OP7<br>OP8, OP9 | OP0 through OP9 serve as a 10-bit parallel operation-select input to<br>the micro-decode logic array. In the most-significant position, OP8<br>and OP9 additionally serve as open-collector outputs during multi-<br>ply and divide algorithms. In the least-significant position, OP9<br>serves as an open-collector output during the CRC algorithm.   | Inputs                            |
| 12  | Vcc  | Single 5-volt power-supply terminal.   | Supply Voltage Pin                |
| 18  | CTN  | Receives low-active ripple carry input data.   | Input                             |
| 19  | POS  | Directs internal and input/output end-conditions required to define<br>the relative position of each bit-slice when N-SN74S481's are<br>cascaded to implement Nx4-bit word lengths. When biased at 2.4<br>volts, the package operates as the least-significant (LSP) slice; when<br>grounded, it functions as an intermediate (IP) slice; and when high, 5<br>volts, it functions as the most-significant (MSP) slice.   | Input                             |
| 20  | Y/AG   | In least-significant and intermediate positions outputs arithmetic<br>carry generate (Y) for use with look-ahead. In most-significant<br>position outputs true arithmetically-greater-than signal.   | Output                            |
| 21  | X/LG   | In least-significant and intermediate positions outputs arithmetic<br>carry propagate (X) for use with look-ahead. In most-significant<br>position outputs true logically-greater-than signal.   | Output                            |
| 22  | COUT   | Outputs low-active ripple carry data.  | Output                            |
| 23  | EQ   | Outputs true (active-high) equality of $\Sigma'$ bus equals zero for each 4-bit slice. The open-collector output permits wire-AND to achieve Nx4-bit equality output.  | Open-Collector Output             |
| 24  | LDWR   | When low, data applied at the AI port coincident with the ↑ clock transition is loaded into the WR.  | Input                             |
| 26<br>25                                    | WRRT,<br>WRLFT   | Working register and $\Sigma$ -bus shift interconnectivity pins. WRRT receives left-shift and outputs right-shift (true) data. WRLFT receives right-shift and outputs left-shift (true) data. Shift can be single-precision, double-precision, signed or unsigned.   | Bidirectional I/O                 |
| 28<br>27                                    | XWRRT,<br>XWRLFT   | Extended working register shift interconnectivity pins. XWRRT<br>receives left-shift and outputs right-shift (true) data. XWRLFT<br>receives right-shift and outputs left-shift (true) data. Shift can be<br>single-precision, double-precision, signed or unsigned.   | Bidirectional I/O                 |
| 29<br>30                                    | D0<br>D1   | Selects one of three DOP sources (WR, XWR, or $\Sigma$ -bus) or places the DOP outputs in a high-impedance state.  | Inputs                            |
| 34<br>33<br>32<br>31                        | DOP0<br>DOP1<br>DOP2<br>DOP3                             | 4-bit parallel, data-out port. DOPO is LSB.  | 3-state outputs                   |
| 35  | INCMC  | When low, enables the MC to increment as directed by CCI on the next t clock transition. When high, inhibits MC to hold mode. As CCO is common to MC and PC, the MC should be inhibited when PC is enabled.  | Input                             |
| 36  | GND  | Common or ground terminal for the supply voltage.  |                                   |
| 37  | <u>CCO</u> /OV   | In least-significant and intermediate positions a low-level output<br>indicates that either the PC or MC is at maximum count. As CCO is<br>common for both PC and MC ambiguous carry can be avoided if one<br>or both counters is/are disabled by the INCPC and/or INCMC<br>inputs. In the most-significant position, a high-level output,<br>depending on the operation selected, indicates that the WR, XWR,<br>or ALU will overflow (OV) on the next clock. | Output                            |

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#### FIGURE 1-PIN ASSIGNMENTS

#### TABLE 1 (Continued)

| PIN NUMBER       | IER PIN NAME PIN FUNCTION   |  | INPUT, OUTPUT, OR<br>INPUT/OUTPUT |
|------------------|---|--|-----------------------------------|
| 38, 39<br>40, 41 | AOP0, AOP1<br>AOP2, AOP3  | 4-bit parallel address-out port.   | Outputs                           |
| 42               | A0  | Selects one of two AOP sources (PC or MC).   | Input                             |
| 43               | INCPC   | When low, enables the PC to increment as directed by $\overline{\text{CCI}}$ on the next $\uparrow$ clock transition. When high, inhibits PC to hold mode. As $\overline{\text{CCO}}$ is common to PC and MC, the PC should be inhibited when MC is enabled.                               | Input                             |
| 44               | CCI   | In least-significant position, a low input directs enabled PC or<br>enabled MC to increment by one on next 1 clock transition. In the<br>LSP, a high directs enabled PC or enabled MC to increment by 2. In<br>other positions, a low is a carry input and a high inhibits the<br>counter. | Input                             |
| 45               | 45 CK When high, enables the transparency of A and B input latches. When<br>low, latches A and B input data. Clocks synchronous registers and<br>counters on the positive transition. |  | Input                             |
| 48               | 48 BI/O SEL When low, enables BI/O to output と-bus data. When high, the BI/O output drivers are placed in a high-impedance state permitting BI/O to be used as data inputs.           |  | Input                             |

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#### 2. DETAILED FUNCTIONAL DESCRIPTIONS

#### 2.1 MICRO-DECODING LOGIC ARRAY

The micro-decoding logic array is a dedicated 11-input PLA decoding 73 product terms to generate 24 control lines needed to implement the 14 operation forms. The eleven inputs consist of the ten operation select lines (OP0 through OP9) and the ALU carry input. The carry input, utilized as an additional operation select line during operation forms not performing arithmetic functions, maximizes system pin efficiency and functional density.

In an expanded word length system (two or more 'S481's), operation select inputs 8 (OP8) and 9 (OP9) assume an input/output capability in the most-significant or least-significant package as a result of the position control and the type of operation being performed. During microprogrammable operation forms I through IX, OP8 and OP9 function simply as another input; but, during the macroprogrammable operations of forms X through XIV one or both become an output during iterations. Table 2 summarizes by operation form the control (output) package and the operation lines which are used as an output.

| 00.5004   |                   | CONTROL | OPERATION SELECT I/O |        |
|-----------|-------------------|---------|----------------------|--------|
| OP. FORM  | ALGORITHM         | PACKAGE | OP8                  | OP9    |
| I thru IX | All               | None    | INPUT                | INPUT  |
| x         | CRC ACCUMULATION  | LSP     | INPUT                | OUTPUT |
| XI        | SIGNED DIVIDE     | MSP     | OUTPUT               | ουτρυτ |
| XII       | UNSIGNED DIVIDE   | MSP     | INPUT                | OUTPUT |
| XIII      | UNSIGNED MULTIPLY | MSP     | INPUT                | ουτρυτ |
| XIV       | SIGNED MULTIPLY   | MSP     | ΟυΤΡυτ               | OUTPUT |

TABLE 2 MSP OP8 and OP9 ITERATIVE FUNCTION SUMMARY

If the macroinstructions are to be used in an expanded word length, OP8 and OP9 select lines of the MSP and the OP9 line of the LSP should be driven from either a 3-state output (which can be placed in high-impedance state) or an open-collector output (which can be wire-OR'ed with the OP select I/O lines). During an iterative function for which the OP line is designated as an open-collector output, the OP line driver should be placed in a high-impedance or off state permitting the output function to drive similar OP lines in the remaining packages.

The output state of OP8 or OP9 is a function of on-chip status decoder as enumerated in the flow diagrams illustrating the five algorithms.

#### 2.2 RELATIVE POSITION CONTROL (POS)

The single line position control, with the ability of decoding one of three input logic states, provides each 'S481 in an expanded word length system with the capability of identifying its relative position. The relative positions, with the corresponding input logic levels are enumerated in Table 3.

| POS INPUT<br>LOGIC LEVEL | RELATIVE POSITION                |
|--------------------------|----------------------------------|
| ≥ 3.6 V                  | MOST-SIGNIFICANT POSITION (MSP)  |
| 1.8 V to 3 V             | LEAST-SIGNIFICANT POSITION (LSP) |
| ≤ 0.8 V                  | INTERMEDIATE POSITION (IP)       |

TABLE 3 POSITION CONTROL FUNCTIONS

This relative position identification dictates how each 'S481 in the system handles the multi-purpose I/O accommodations and ALU sign and magnitude functions. See Table 4. Shift/Circulate interconnectivity bit transfers are explained in detail under shift/circulate transfer multiplexers.

| PIN    | MSP            | IP        | LSP              |
|--------|----------------|-----------|------------------|
| X/LG   | LG (OUT)       | X (IN)    | X (IN)           |
| Y/LG   | AG (OUT)       | Y (IN)    | Y (IN)           |
| CCO/OV | OVERFLOW (OUT) | CCO (OUT) | <u>CCO</u> (OUT) |

TABLE 4 DUAL-FUNCTION LOGIC I/O PINS

X AND Y ARE CARRY LOOK-AHEAD FUNCTIONS

#### 2.3 CLOCK

The clock synchronizes the entry or change of data in the 'S481 registers and counters, and it controls the status of the A and B input latches. A typical clock cycle is illustrated in Figure 2. The low-to-high transition of the clock input is the clocking edge for any combination of either the working register, extended working register, flag flip-flops, and the program counter or the memory counter activated by the resident operation. During the low-level portion of the clock input, both input latches are latched ensuring data stability at the positive clock transition. After the clock has gone to a high level, the input latches are placed in a transparent mode to accept the next set of input data.





#### 2.4 LATCHED DATA INPUT PORTS

The SN54S/74S481 features dual input ports combined with data flow paths which are designed specifically to reduce the number of system clock cycles needed to enter operands and/or data. Both the A and B input ports are latched, eliminating the need for external registers, to simplify interfacing directly with system data bus paths.

The A input port data is made available to both the input latch and the working register which allows A data to be loaded into the working register directly.

The B port is configured to serve as an input/output data path providing the capability to:

- a. Input data to the B latch
- b. Output sum-bus data.

This I/O port is designed specifically to simplify implementation of data transfers to the external working memory.

Both the A and B latches are transparent when the 'S481 clock input is high. Data applied at the A and B inputs should be stable anytime prior to or at least coincident with the falling edge of the clock input (see Figure 3). After the clock falling edge, the data inputs should be held steady for  $t_{hold}(data)$  or longer to facilitate the on-chip clock buffers to latch the data.



FIGURE 3 - INPUT LATCHES SETUP/HOLD TIMES

The A input port latch data is routed to the A input multiplexers, and the B input port latch data is sourced to both the A and B input multiplexers.

#### 2.5 A AND B OPERAND SOURCES

The A and B input multiplexers source the ALU A' and B' ports through true/complement conditional inverter circuits. Data routing for each, illustrated and listed in Figure 4, provides the ALU with access to the true or complement of:

#### ALU A' PORT

- 1. A input latch
- 2. B input latch
- 3. Working Register
- Low logic level inputs (force zeros)

#### ALU B' PORT

- 1. B input latch
- 2. Sum bus
- 3. Working register
- 4. Extended working register
- 5. Program counter
- Low logic level inputs (force zeros)

The A and B multiplexers and true complement circuits, under control of the resident operation code, are selectable at the microprogram level. The number of A or B multiplexer sources available depend upon the specific operation being performed by the 'S481. Operation form descriptions contain detailed microprogramming.

The A and B input multiplexers, with selectable true and complement operand sources, maximizes the processing power of the 'S481 by minimizing the active components needed to achieve both the simple but highly flexible data routing tasks and full ALU capabilities.
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FIGURE 4 - ALU OPERAND SOURCES

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### 2.6 ARITHMETIC/LOGIC UNIT (ALU)

The 4-bit, parallel, binary arithmetic/logic unit provides the arithmetic/Boolean operand combination/modification mechanism including magnitude and overflow status. The ALU performs, as directed by the resident operation form, one of four basic functions which, when combined with the operand selections at the A and B multiplexers, extends the arithmetic/logic capabilities to that of a full 16-function ALU.

When compared to other bit-slice processor elements, unique to the 'S481 arithmetic architecture are the parallel input ports and fully microprogrammable symmetry for all ALU functions within the selections of the A and B input multiplexers.

Logical and arithmetic operation forms for the 'S481 are shown in Table 5. The full functional power of the 'S481 can be visualized only if it is understood that although both ALU's have parallel A and B input ports, the 'S481 architecture not only provides access to multiple sources but has the capability to route true or complement of any source to the A and B ALU port. This means that for a subtract operation, the subtrahend may be either an A or B input. In addition to maximizing data routing capabilities of the 'S481 at minimum logic/gate levels, this architecture permits fully symmetrical operations to be performed on the A or B sources within the selections offered by these 'S481 arithmetic/logical operation forms.

| DATA   | INPUT         | TWO'S COMPLEMENT IN     | TEGER ARITHMETIC OP'S   | LOGIC        | AL OP'S (FO | RM VIII)<br>L |
|--------|---------------|-------------------------|-------------------------|--------------|-------------|---------------|
| A PORT | <b>B PORT</b> | CIN = L                 | CIN = H                 | OR           | NOR         | EX-NOR        |
|        |               |                         |                         |              |             |               |
| ZEROS  | ZEROS         | 1                       | 0                       | ZEROS        | ONES        | ONES          |
| ZEROS  | ONES          | 0                       | MINUS 1                 | ONES         | ZEROS       | ZEROS         |
| ONES   | ZEROS         | 0                       | MINUS 1                 | ONES         | ZEROS       | ZEROS         |
| ONES   | ONES          | MINUS 1                 | MINUS 2                 | ONES         | ZEROS       | ONES          |
| А      | ZEROS         | A PLUS 1                | А                       | А            | Ā           | Ā             |
| A      | ONES          | А                       | A MINUS 1               | ONES         | ZEROS       | A             |
| Ā      | ZEROS         | MINUS A                 | MINUS A MINUS 1         | Ā            | A           | A             |
| Ā      | ONES          | MINUS A MINUS 1         | MINUS A MINUS 2         | ONES         | ZEROS       | Ā             |
| ZEROS  | в             | B PLUS 1                | В                       | в            | Ē           | B             |
| ONES   | в             | В                       | B MINUS 1               | ONES         | ZEROS       | В             |
| ZEROS  | B             | MINUS B                 | MINUS B MINUS 1         | B            | в           | в             |
| ONES   | B             | MINUS B MINUS 1         | MINUS B MINUS 2         | ONES         | ZEROS       | B             |
| A      | в             | A PLUS B PLUS 1         | A PLUS B                | A + B        | Ā·B         | A⊕B           |
| A      | B             | A MINUS B               | A MINUS B MINUS 1       | A + 🖥        | Ä・в         | A⊕B           |
| Ā      | в             | B MINUS A               | B MINUS A MINUS 1       | <b>Ä</b> + В | A·B         | A⊕B           |
| Ā      | B             | MINUS A MINUS B MINUS 1 | MINUS A MINUS B MINUS 2 | Ā + B        | А•В         | A 🏵 B         |

### TABLE 5 'S481 ALU AND LOGIC FUNCTIONS

Some unique one-clock arithmetic/iterative capabilities of the 'S481 are listed in Table 6.

### TABLE 6 EXTENDED ALU FUNCTIONS OF 'S481

| FORM NO. | FUNCTION   |
|----------|--|
| 1        | A (ALU) B · WR   |
|          | A (ALU) B • XWR  |
|          | A (ALU) B · PC   |
| 11       | A (ALU) B DOUBLE-PRECISION SHIFTED LOGICAL LEFT OR RIGHT |
| 111      | A (ALU) B SINGLE-PRECISION SHIFTED LOGICAL OR ARITHMETIC |
|          | LEFT OR RIGHT  |
|          |  |

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Table 5 also indicates the 16 logical combinations of two Boolean variables which are selectable for the OR, NOR, and exclusive-NOR functions. Full symmetry of the ALU and the ability to select the complement of input data extends the logic functions for performance of:

- a. NAND
- b. AND
- c. Exclusive-OR
- d. Mixed combinations of each
- e. Transfer functions for true or inverted data
- f. All ones or all zeros.

### 2.7 ALU MAGNITUDE AND CARRY FUNCTIONS

The 'S481 ALU is fully decoded on chip to generate three magnitude outputs (status lines) and both ripple and look-ahead carry functions. The magnitude outputs and their status indications are as follows:

### 2.7.1 Equal (EQ, See Figure 5)

The results of the resident ALU operation are compared at the sum-bus for all bits high during subtract and left-shift arithmetic operations, or for all bits low during other operations.



#### FIGURE 5 -- EQUAL OUTPUT

### 2.7.2 Logically-Greater Than (LG, See Figure 6)

In the most-significant package (MSP) the X look-ahead function from the ALU is inhibited and the logically-greater-than (LG) output is enabled. See Figure 6. The MSP LG output is active during arithmetic and shift operation forms to provide a status indication that can be used when it is desirable to compare two unsigned integer numbers. The specific status for each operation form is listed in Table 7.

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# FIGURE 6 - MSP LOGICALLY-GREATER-THAN (LG) OUTPUT

TABLE 7 MSP LOGICALLY-GREATER-THAN (LG) OUTPUT

| OP FORM                | TYPE OF OP           | LG = H INDICATES                   |  |  |  |  |
|------------------------|----------------------|------------------------------------|--|--|--|--|
| l or II (ARITH)        | ALL                  | Σ-BUS ≠ ZERO (EQ = L)              |  |  |  |  |
| III (ARITH WITH SHIFT) | LSL, RSL             | $\Sigma$ -BUS $\neq$ ZERO (EQ = L) |  |  |  |  |
|                        | LSA or RSA           | ADDER C-OUT                        |  |  |  |  |
| IV, V, or VI (SHIFTS)  | ALL                  | AI ≠ ZERO (EQ = L)                 |  |  |  |  |
| VII (COMPARE)          | A : B                | A IS LG THAN B                     |  |  |  |  |
|                        | B : A                | B IS LG THAN A                     |  |  |  |  |
| VIII (LOGICAL)         | ALL                  | $\Sigma$ -BUS $\neq$ ZERO (EQ = L) |  |  |  |  |
| IX (NO OP)             | ZERO 2-BUS           | LG = L (EQ = H)                    |  |  |  |  |
| X THRU XIV             | HARDWIRED ALGORITHMS | SEE OPERATION FORM DESCRIPTION     |  |  |  |  |

### 2.7.3 Arithmetically-Greater Than (AG, See Figure 7)

In the most-significant package (MSP) the Y look-ahead function from the ALU is inhibited and the arithmetically-greater-than (AG) output is enabled. The MSP AG output is active during arithmetic and shift operation forms to provide a status indication that can be used when it is desirable to compare two signed integer numbers. The specific status for each operation form is listed in Table 8.



X AND Y ARE CARRY LOOK-AHEAD FUNCTIONS

#### FIGURE 7 - MSP ARITHMETICALLY-GREATER-THAN (AG) OUTPUT

| TABLE 8  |
|--|
| ALU CARRY AND MSP ARITHMETICALLY-GREATER-THAN (AG) OUTPUTS |

|                        | LSP AND IP |   |                   |       | MSP          |                   |            |       |  |
|------------------------|------------|---|-------------------|-------|--------------|-------------------|------------|-------|--|
| OPERATION FORM         | x          | Y | EQ                | C-OUT | LG           | AG                | EQ         | C-OUT |  |
| LOGICAL OPERATIONS     | L          | н | Σ-BUS = 0         | C-IN  | Σ-BUS ≠ 0.   | $\Sigma$ -BUS > 0 | Σ-BUS = 0  | C-IN  |  |
| ARITHMETIC OPERATIONS: |            |   |                   |       | A LG B       | A AG B            |            |       |  |
| COMPARE                | х          | Y | A=B               | C-OUT | or<br>B LG A | or<br>B AG A      | A = B      | C-OUT |  |
| ALL OTHER ARITHMETIC   | х          | Y | $\Sigma$ -BUS = 0 | C-OUT | Σ-BUS ≠ 0    | Σ-BUS AG 0        | Σ-BUS AG 0 | C-OUT |  |

X and Y are carry look-ahead functions.

# 2.8 OPERAND OVERFLOW

In the most-significant package (MSP) the counter-carry output ( $\overline{CCO}$ ) function from the program/memory counter is inhibited and the overflow (OV) output is enabled. The MSP OV output is active during arithmetic and shift operation forms to provide a status indication that the result of the operation cannot be correctly represented with the number of bit positions available. When the OV output goes high, it indicates that the next clock will:

- a. During arithmetic operations, cause the ALU to overflow.
- b. During left-shift arithmetic operations, cause the shifted register to overflow.

Table 9 enumerates the specific indicators generated.

|     | TABLE 9              |
|-----|----------------------|
| MSP | OVERFLOW (OV) OUTPUT |

| OP FORM                | TYPE OF OP           | OV = H INDICATES      |
|------------------------|----------------------|-----------------------|
| l or II (ARITH)        | ADD or SUB           | ALU OVERFLOW          |
| III (ARITH WITH SHIFT) | LSL, RSL             | ALU OVERFLOW          |
|                        | RSA                  | 0V = L                |
|                        | LSA                  | NEXT CLOCK WILL CAUSE |
|                        |                      | SHIFT OVERFLOW        |
| IV, V, or VI (SHIFTS)  | LSA                  | NEXT CLOCK WILL CAUSE |
|                        |                      | SHIFT OVERFLOW        |
|                        | ALL OTHERS           | $OV \equiv L$         |
| VII (COMPARE)          | A : B                | UNDEFINED             |
|                        | B : A                | UNDEFINED             |
| VIII (LOGICAL)         | ALL                  | OV ≡ L                |
| IX (NO OP)             | ZERO 2-BUS           | OV = L                |
| X THRU XIV             | HARDWIRED ALGORITHMS | SEE OPERATION FORM    |
|                        |                      | DESCRIPTIONS          |

H ≕ high level, L = low level

# 2.9 SUM' BUS MULTIPLEXER

The sum' bus multiplexer, sourced by the ALU, provides a means for accomplishing a shift operation on the ALU operand without affecting the contents of WR, XWR, PC or MC (See Figure 8). Functionally, this multiplexer can be used to:

- a. Shift the operand left or right (one bit position) arithmetic, logical, or circulate
- b. Pass the operand without shift to the  $\Sigma'$  bus.



TO: DO MUX, PC, MC, WR MUX, XWR MUX, 3-STATE BUS

### FIGURE 8 - SUM BUS MULTIPLEXER

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Full sign protection and fill-in is provided in the MSP and LSP under control of the relative position inputs.

Information on the  $\Sigma'$  bus can be accessed during some operations through the 3-state  $\Sigma'$  bus control buffer at the B input/output port.

The parallel data input ports and the I/O capability of the B port, combined with the  $\Sigma$ -bus access, provides considerable flexibility for performing simple shifts or combinations of operation-and-shift on data or operands resident in the external working memory locations.

### 2.10 B-INPUT/OUTPUT CONTROL

The B-input/output port is isolated from the sum' bus by a 3-state control buffer when the buffer outputs are at a high-impedance. Enabling the buffer routes the sum' bus data to the B-port. The low-current inputs of the B port latch minimizes loading effects, and the buffers can source 6.5 mA or sink 10 mA of drive current in the output mode. During the output mode, the 'bus data can be latched in the B input latch. Enabling or disabling is accomplished by the I/O control input. See Table 10 and Figure 9.

| I/O CONTROL | I/O BUFFER OUTPUT |
|-------------|-------------------|
| L           | SUM' BUS DATA     |
| Н           | HIGH-IMPEDANCE    |

TABLE 10 B-INPUT/OUTPUT CONTROL



FIGURE 9 - B-INPUT/OUTPUT CONTROL

### 2.11 WORKING REGISTER

The working register (WR) is a 4-bit D-type register which functions as an accumulator during iterative arithmetic operations or as a temporary holding register for intermediate operands (see Figure 10). It is sourced by the WR multiplexer. Storage of setup data, under control of the resident operation forms which permit the WR to be a destination, occurs on the positive transition of the clock. WR shifting capabilities are implemented in the WR multiplexer. The working register can be selected to source the data-out port multiplexer (DO MUX), A-input multiplexer (A MUX), or B-input multiplexer (B MUX). The MSB of the WR is sourced to the WRLFT MUX, and the LSB of the WR is sourced to the WRRT MUX to facilitate expansion.



### FIGURE 10 - WORKING REGISTER (WR) AND WR MULTIPLEXER

An asynchronous control line, LDWR, is available to facilitate loading the working register directly from the A input port in combination with the resident micro-operation.

# 2.12 WORKING REGISTER MULTIPLEXER (WR MUX)

The working register multiplexer provides source selection, including the bidirectional shifting capability, for the working register. See Figure 10. Under direction of the resident operation, the WR MUX asynchronously selects either:

- a. A input port for direct loading
- b.  $\Sigma'$  bus for ALU operand results

- c. Hold mode for no change
- d. Shift left
- e. Shift right

End conditions for both shift left and shift right operations are routed to or from WR MSB (WR3) or WRLSB (WR0) to the WRLFT/WRLFT' multiplexers or to the WRRT/WRRT' multiplexers respectively.

### 2.13 EXTENDED WORKING REGISTER

The extended working register (XWR) is a 4-bit D-type register which functions primarily as an extension of the working register to provide the double-precision operation capabilities needed for iterative multiply and divide routines (see Figure 11). Additionally, the storage capabilities of the XWR are available for use as another temporary holding register for intermediate operands during a number of the single-precision operation forms. It is sourced by the XWR multiplexer. Storage of setup data, under control of resident operation forms which permit the XWR to be a destination, occurs on the positive transition of the clock. XWR shifting capabilities are implemented in the XWR multiplexer. The XWR can be selected to source the data-out port multiplexer (DO MUX), B-input multiplexer (B MUX), or the XWR multiplexer (XWR MUX). The MSB of the XWR is sourced to the XWRLFT' MUX, and the LSB of the XWR is sourced to the XWRRT' MUX to facilitate expansion.





#### 2.14 EXTENDED WORKING REGISTER MULTIPLEXER (XWR MUX)

The extended working register multiplexer provides source selection, including the bidirectional shifting capability, for the extended working register (see Figure 11). Under direction of the resident operation, the XWR MUX asynchronously selects either:

- a.  $\Sigma'$  bus for ALU operand results
- b. Hold mode for no change

- c. Shift left
- d. Shift right.

End conditions for both shift left and shift right operations are routed to or from XWR MSB (XWR3) or XWR LSB (XWR0) to the XWRLFT/XWRLFT' multiplexers or to the XWRRT/XWRRT' multiplexers respectively.

### 2.14.1 Σ-Bus, WR, XWR MSB Shift Transfer Multiplexers

The MSB shift transfers are accomplished by the WRLFT, XWRLFT input/output multiplexers and the WRLFT', XWRLFT' sum-bus/register MSB input multiplexers. All four multiplexers, and the impedance of the 3-state I/O lines of the WRLFT and XWRLFT multiplexer outputs are under control of the resident operation code and the relative position control (POS). Data paths of the multiplexers are illustrated in Figure 12, and bit transfers with respect to each of the shift operations are enumerated in Tables 11 through 14.

### 2.14.2 WRLFT, XWRLFT Multiplexers

The WRLFT, XWRLFT input/output multiplexers facilitate routing of the working register, extended working register, or sum bus MSB out the WRLFT, XWRLFT I/O's during output modes. In an input mode, the three-state output is at a high impedance permitting the WRLFT and/or the XWRLFT pins to be used as inputs.

### 2.14.3 WRLFT', XWRLFT' Multiplexers

The WRLFT' multiplexer selects the source for either the sum bus or working register MSB. Sign bit protection and right-shift bit-fill functions are all handled on-chip by these multiplexers under control of the operation code and relative position. The WRLFT' sources are:

- a. WRLFT (input)
- b. ALU carry out (for sign-fill)
- c. Low level (for zero-fill)
- d. XWRLFT input
- e. XWR MSB
- f. WR MSB (sign-fill in for RSA)
- g. Sign fill in for RSA (see Figure 12)

The XWRLFT multiplexer selects the source for XWR MSB and provides sign-bit protection and right-shift-fill functions for the XWR. The XWRLFT sources are:

- a. XWRLFT (input)
- b. WRLFT
- c. XWR MSB (sign-fill in for RSA)

### 2.14.4 WR, XWR LSB Shift Transfer Multiplexers

The LSB shift transfers are accomplished by the WRRT, XWRRT input/output multiplexers and the WRRT', XWRRT' sum-bus/register LSB input multiplexers. All four multiplexers, and the impedance of the 3-state I/O lines of the WRRT and XWRRT multiplexer outputs, are under control of the resident operation code and the relative position control (POS). Data paths of the multiplexers are illustrated in Figure 13.

The WRRT input/output multiplexer facilitates routing of sum-bus or working register LSB out the WRRT I/O during output modes. The XWRRT I/O buffer can access and source the XWR LSB. In an input mode, the three-state output is at a high impedance permitting the WRRT and/or XWRRT pins to be used as inputs.

### 2.14.6 WRRT', XWRRT' Multiplexers

The WRRT' multiplexer selects either the WRRT input or a low logic level (fill) input as the LSB source for either the working register or the sum-bus. The XWRRT' multiplexer selects between the XWRRT input and low logic level (fill) input as the XWR LSB source.



FIGURE 12 - SUM-BUS, WR, XWR MSB SHIFT TRANSFER MULTIPLEXERS

| SHIFT     | моз   | T-SIGNIFIC | ANT POSIT | ION  | IN    | TERMEDIAT | E POSITIO | N    | LEAST | SIGNIFICAN | T POSITIC | N    |
|-----------|-------|------------|-----------|------|-------|-----------|-----------|------|-------|------------|-----------|------|
| MODE      | WRLFT | WRLFT      | WRRT'     | WRRT | WRLFT | WRLFT     | WRRT'     | WRRT | WRLFT | WRLFT'     | WRRT'     | WRRT |
| LSL (SP)  | z     | x          | WRRT      | z    | WR3   | x         | WRRT      | z    | WR3   | x          | WRRT      | z    |
| LSL (DP)  | XWR3  | х          | WRRT      | z    | WR3   | ×         | WRRT      | z    | WR3   | ×          | WRRT      | z    |
| LSA (SP)  | WR3   | х          | WRRT      | z    | WR3   | x         | WRRT      | z    | WR3   | ×          | L         | z    |
| LSA (DP)  | XWR3  | x          | WRRT      | z    | WR3   | х         | WRRT      | z    | WR3   | х          | WRRT      | z    |
| LCIR (SP) | WR3   | ×          | WRRT      | z    | WR3   | ×         | WRRT      | Z    | WR3   | X          | WRRT      | Z    |
| LCIR (DP) | XWR3  | х          | WRRT      | z    | WR3   | x         | WRRT      | z    | WR3   | ×          | WRRT      | z    |
| RSL (SP)  | Z     | WRLFT      | x         | WRO  | Z     | WRLFT     | x         | WRO  | Z     | WRLFT      | x         | z    |
| RSL (DP)  | z     | L          | x         | WRO  | z     | WRLFT     | x         | WR0  | z     | WRLFT      | x         | WR0  |
| RSA (SP)  | z     | WR3        | x         | WR0  | z     | WRLFT     | ×         | WR0  | z     | WRLFT      | х         | WR0  |
| RSA (DP)  | z     | WR3        | х         | WR0  | z     | WRLFT     | x         | WR0  | z     | WRLFT      | х         | WRO  |
| RCIR (SP) | Z     | WRLFT      | x         | WRO  | z     | WRLFT     | x         | WRO  | Z     | WRLFT      | x         | WR0  |
| RCIR (DP) | z     | WRLFT      | x         | WRO  | z     | WRLFT     | х         | WRO  | z     | WRLFT      | х         | WRO  |

TABLE 11 WORKING REGISTER BIT TRANSFERS TO WRLFT/WRRT

TABLE 12 SUM-BUS BIT TRANSFERS TO WRLFT/WRRT

| SHIFT     | MOS   | T-SIGNIFICA | ANT POSIT |      | IN    | TERMEDIAT | E POSITIO | N    | LEAST      | SIGNIFICAN | IT POSITIC | DN NC      |
|-----------|-------|-------------|-----------|------|-------|-----------|-----------|------|------------|------------|------------|------------|
| MODE      | WRLFT | WRLFT       | WRRT      | WRRT | WRLFT | WRLFT'    | WRRT'     | WRRT | WRLFT      | WRLFT'     | WRRT'      | WRRT       |
| LSL (SP)  | z     | x           | WRRT      | z    | Σ3    | x         | WRRT      | z    | Σ3         | ×          | WRRT       | z          |
| LSL (DP)  | XWR3  | х           | WRRT      | z    | Σ3    | ×         | WRRT      | z    | Σ3         | ×          | WRRT       | z          |
| LSA (SP)  | Σ3    | x           | WRRT      | z    | Σ3    | x         | WRRT      | z    | <u>۲</u> 3 | ×          | L          | z          |
| LSA (DP)  | XWR3  | х           | WRRT      | z    | Σ3    | ×         | WRRT      | z    | Σ3         | ×          | WRRT       | Z          |
| LCIR (SP) | Σ3    | x           | WRRT      |      | Σ3    | ×         | WRRT      | Z    | £3         | x          | WRRT       | Z          |
| LCIR (DP) | XWR3  | х           | WRRT      | z    | Σ3    | ×         | WRRT      | z    | Σ3         | ×          | WRRT       | z          |
| RSL (SP)  | z     | WRLFT       | х         | Σ0   | Z     | WRLFT     | x         | Σ0   | Z          | WRLFT      | x          | Σ0         |
| RSL (DP)  | z     | C-OUT       | x         | Σ0   | z     | WRLFT     | х         | Σ0   | z          | WRLFT      | x          | 20         |
| RSA (SP)  | z     | *           | x         | 20   | Z     | WRLFT     | X         | Σ0   | Z          | WRLFT      | x          | 20         |
| RSA (DP)  | z     | • 1         | ×         | Σ0   | z     | WRLFT     | x         | ΣO   | z          | WRLFT      | x          | Σ0         |
| RCIR (SP) | z     | WRLFT       | x         | ΣΟ   | z     | WRLFT     | x         | Σ0   | z          | WRLFT      | x          | Σ0         |
| RCIR (DP) | z     | XWRLFT      | х         | Σ0 · | z     | WRLFT     | х         | Σ0   | z          | WRLFT      | x          | <u>۲</u> 0 |

\*VARIABLE = (23 · ALU OVERFLOW) + (COUT · ALU OVERFLOW)

# TABLE 13

### EXTENDED WORKING REGISTER BIT TRANSFERS TO XWRLFT/XWRRT

| SHIFT     | M      |         | CANT POSIT | ION   |        | INTERMEDIA | TE POSITIO | N     | LE     | AST-SIGNIF | CANT POSI | TION  |
|-----------|--------|---------|------------|-------|--------|------------|------------|-------|--------|------------|-----------|-------|
| MODE      | XWRLFT | XWRLFT' | XWRRT'     | XWRRT | XWRLFT | XWRLFT'    | XWRRT'     | XWRRT | XWRLFT | XWRLFT'    | XWRRT'    | XWRRT |
| LSL (SP)  | z      | x       | XWRRT      | z     | XWR3   | x          | XWRRT      | z     | XWR3   | x          | XWRRT     | z     |
| LSL (DP)  | z      | ×       | XWRRT      | z     | XWR3   | ×          | XWRRT      | z     | XWR3   | x          | XWRRT     | z     |
| LSA (SP)  | XWR3   | x       | XWRRT      | z     | XWR3   | ×          | XWRRT      | Z     | XWR3   | ×          | L         | z     |
| LSA (DP)  | WR3    | x       | XWRRT      | z     | XWR3   | ×          | XWRRT      | z     | XWR3   | x          | L         | z     |
| LCIR (SP) | XWR3   | x       | XWRRT      | z     | XWR3   | ×          | XWRRT      | z     | XWR3   | x          | XWRRT     | z     |
| LCIR (DP) | WR3    | ×       | XWRRT      | _ Z   | XWR3   | X          | XWRRT      | Z     | _ XWR3 | x          | XWRRT     | z     |
| RSL (SP)  | z      | XWRLFT  | x          | XWR0  | z      | XWRLFT     | x          | XWR0  | z      | XWRLFT     | X         | z     |
| RSL (DP)  | z      | WRLFT   | х          | XWR0  | z      | XWRLFT     | х          | XWR0  | z      | XWRLFT     | x         | XWR0  |
| RSA (SP)  | z      | XWR3    | x          | XWR0  | z      | XWRLFT     | x          | XWR0  | z      | XWRLFT     | x         | XWR0  |
| RSA (DP)  | z      | WRLFT   | x          | XWR0  | z      | XWRLFT     | x          | XWR0  | z      | XWRLFT     | ×         | XWR0  |
| RCIR (SP) | z      | XWRLFT  | x          | XWR0  | z      | XWRLFT     | x          | XWR0  | z      | XWRLFT     | x         | XWR0  |
| RCIR (DP) | z      | WRLFT   | ×          | XWR0  | z      | XWRLFT     | x          | XWR0  | z      | XWRLFT     | x         | XWR0  |

| SHIFT     |        | MOST-SIGNIFIC | ANT POSITION |       |
|-----------|--------|---------------|--------------|-------|
| MODE      | XWRLFT | XWRLFT'       | XWRRT'       | XWRRT |
| LSL (SP)  | Z      | x             | XWRRT        | z     |
| LSL (DP)  | Z      | . X           | XWRRT        | Z     |
| LSA (SP)  | XWR3   | x             | XWRRT        | z     |
| LSA (DP)  | Σ3     | x             | XWRRT        | Z     |
| LCIR (SP) | XWR3   | X             | XWRRT        | Z     |
| LCIR (DP) | Σ3     | х             | XWRRT        | Z     |
| RSL (SP)  | Z      | XWRLFT        | x            | XWR0  |
| RSL (DP)  | Z      | WRLFT         | х            | XWR0  |
| RSA (SP)  | Z      | XWR3          | x            | XWR0  |
| RSA (DP)  | Z      | WRLFT         | x            | XWR0  |
| RCIR (SP) | z      | XWRLFT        | x            | XWR0  |
| RCIR (DP) | Z      | WRLFT         | x            | XWR0  |

TABLE 14 SUM-BUS BIT TRANSFERS TO XWRLFT (MSP)

NOTE: Intermediate and Least-Significant Positions are the same as shown in Table 13.



FIGURE 13 -- SUM-BUS, WR, XWR LSB SHIFT TRANSFER MULTIPLEXERS

### 2.15 SHIFT FUNCTIONS

The 'S481 contains the necessary controls and data paths to perform single or double length logical, arithmetic, or circulate bidirectional shift functions in a single clock cycle. Each of the six shift functions implemented are selectable by a single microinstruction; and, additionally two single clock operation forms are included which provide the capability of performing an add/subtract in conjunction with a shift. The six shift functions and the basic operation forms offering them are enumerated in Table 15.

|                              |                  | OPERATI          | ON FORMS         |                  |
|------------------------------|------------------|------------------|------------------|------------------|
| FUNCTION                     | SIMPL            | E SHIFT          | ADD/SU<br>WITH   | JBTRACT<br>SHIFT |
|                              | SINGLE<br>LENGTH | DOUBLE<br>LENGTH | SINGLE<br>LENGTH | DOUBLE<br>LENGTH |
| LEFT CIRCULATE (LCIR)        | IV, V            | VI               |                  |                  |
| LEFT SHIFT ARITHMETIC (LSA)  | IV, V            | VI               | 111              |                  |
| LEFT SHIFT LOGICAL (LSL)     | IV, V            | VI               | 111              | п                |
| RIGHT CIRCULATE (RCIR)       | IV, V            | VI               |                  |                  |
| RIGHT SHIFT ARITHMETIC (RSA) | IV, V            | VI               | ш                |                  |
| RIGHT SHIFT LOGICAL (RSL)    | IV, V            | VI               | н                |                  |

TABLE 15 MICROPROGRAMMABLE SHIFT FUNCTIONS

### 2.15.1 CIRCULATE (SHIFT) FUNCTIONS (MICROPROGRAMMABLE)

Operation forms IV and V provide the system designer with the capability of programming a single precision circulate (or rotate) of the  $\Sigma'$  bus, working register, or extended working register and operation form VI provides the capability of circulating or rotating a double-length word resident in the WR/XWR. A single-bit-position left or right circulate is accomplished on each clock without the loss of any bits as the shift transfer multiplexers, under control of the resident operation and position input, interconnect the bus or register as illustrated in Figure 14.

The remaining end conditions are handled on chip by the shift transfer multiplexers to interconnect the bit transfer mechanisms for MSB  $\rightarrow$  LSB for single precision circulates and for transfers to or from the  $\Sigma'$  bus or working register and the extended working register during double-precision circulates. Data flow between packages in an expanded word-length system is via the interconnected WRRT/WRLFT and XWRRT/XWRLFT terminals.

### 2.15.2 ARITHMETIC SHIFT FUNCTIONS (MICROPROGRAMMABLE)

Operation forms III, IV, V and VI provide the system designer with the capability of programming the following arithmetic shifts.

Form III - A single-precision arithmetic left or sign-protected right shift of the sum or difference of the A and B operands destined for either the WR or XWR.

Form IV – A single-precision arithmetic left or sign-protected right shift of the A operand destined for the  $\Sigma'$  bus.

Form V - A single-precision arithmetic left or sign-protected right shift of the WR or XWR contents.

Form VI – A double precision arithmetic left or sign-protected right shift of the WR and XWR contents.



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A single-bit-position shift is accomplished on each clock with right-shift sign-protection and left shift LSB zero-fill operations controlled by the shift transfer multiplexers under direction of the resident operation and the position input. See Figure 15.

The remaining end conditions are handled on chip by the shift transfer multiplexers to interconnect the bit transfer mechanisms for transfers to or from the  $\Sigma'$  bus or working register and the extended working register during double-precision arithmetic shifts. Data flow between packages in an expanded word-length system is via the interconnected WRRT/WRLFT and XWRRT/XWRLFT terminals.

#### 2.15.3 LOGICAL SHIFT FUNCTIONS (MICROPROGRAMMABLE)

Operation Forms II, III, IV, V and VI provide the system designer with the capability of programming the following logical shifts:

Form II - A double-precision left or right shift of the sum or difference of the A and B operands destined for the WR in conjunction with the XWR.

Form III - A single-precision left or right logical shift of the sum or difference of the A and B operands destined for the WR or the XWR.

Form IV – A single-precision left or right logical shift of the A operand destined for the  $\Sigma'$  bus.

Form V - A single-precision left or right logical shift of the WR or XWR contents.

Form VI – A double-precision left or right logical shift of the WR and XWR contents.

A single-bit-position shift is accomplished on each clock with MSB and LSB fill operations controlled by the shift transfer multiplexers under direction of the resident operation and the position input. See Figure 16.

The remaining end conditions are handled on chip by the shift transfer multiplexers to interconnect the bit transfer mechanisms for transfers to and from the  $\Sigma'$  bus or working register and the extended working register during double-precision logical shifts. Data flow between packages in an expanded word length system is via the interconnected WRRT/WRLFT and XWRRT/XWRLFT terminals.

### 2.16 DATA-OUT PORT MULTIPLEXER (DO MUX)

The data-out port multiplexer, Figure 17, provides selection for routing the contents of either the sum'-bus, working register, or extended working register to the parallel output port. Additionally, the multiplexer is equipped with 3-state outputs providing the capability to isolate the 'S481 from the system data bus. Source selections and high-impedance controls are detailed in Table 16.

Each data output is capable of sourcing 6.5 and sinking 10 milliamperes of drive current.

### 2.17 MEMORY AND PROGRAM COUNTERS.

Dual counters provide the system designer with a processor element containing both an iteration counter and the capability of generating and/or storing locations of operands/data.

Either counter can be loaded or preset to any value or result from the sum bus in operations forms as follows:

|         | SELECT | ABLE AS |
|---------|--------|---------|
| OP FORM | PC     | MC      |
| I       | Yes    | Yes     |
| 111     | No     | Yes     |
| VIII    | Yes    | No      |



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FIGURE 16 - LOGICAL SHIFT FUNCTIONS

7 6 5

XWR

'S481 IP

4

XWR

10 9

'S481 MSP

11

8

I

1

XWR

'S481 LSP

1 0

L

2

3



FIGURE 17 - DATA-OUT PORT MULTIPLEXER (DO MUX)

Under control of the position (POS) input and the resident operation code, the  $\overline{CCO}/OV$  output facilitates cascading the program and memory counters. In the least-significant and intermediate positions, the  $\overline{CCO}$  pins of lesser significant packages are connected to the  $\overline{CCI}$  pins of more significant packages to complete the counter interconnections to the bit-size of the processor element.

The functionally identical program and memory counters, sharing a

TABLE 16 DATA-OUT PORT CONTROL

| CON<br>INP | TROL<br>PUTS | SOURCE OR FUNCTION        |
|------------|--------------|---------------------------|
| D1         | D0           |                           |
| L          | L            | Σ'-BUS                    |
| L          | н            | EXTENDED WORKING REGISTER |
| н          | L            | WORKING REGISTER          |
| н          | н            | HIGH-IMPEDANCE            |

common counter carry input (CCI) control pin and a common counter carry output (CCO) pin, feature individual control lines (INC PC, INC MC) which can be used to instruct either (but normally not both) or neither counter to increment on the next clock transition in any of the 14 operation forms. Additionally, the counter in the LSP, under command of the POS input, has the capability of incrementing its value by one or by two to facilitate the generation of even or odd address locations in a single clock cycle. Contents of the counters can be read out from the address out port asynchronously under control of the address output multiplexer (AO MUX) select input.

Typical counter functions with respect to package relative positions are shown in Figure 18.

In the MSP, the CCO/OV output, as a result of the position (POS) control, becomes the ALU/shift overflow (OV) status output.

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|        | INPUTS |     | CK | COUNTER VALUE |        |            |            |  |  |
|--------|--------|-----|----|---------------|--------|------------|------------|--|--|
| INC PC | INC MC | ССІ | UN | LSP MC        | LSP PC | MSP, IP MC | MSP, IP PC |  |  |
| н      | н      | Х   | A  | NO CHG        | NO CHG | NO CHG     | NO CHG     |  |  |
| L      | н      | L   | 4  | NO CHG        | +1     | NO CHG     | +1         |  |  |
| L      | н      | н   |    | NO CHG        | +2     | NO CHG     | NO CHG     |  |  |
| н      | L      | L   |    | +1            | NO CHG | +1         | NO CHG     |  |  |
| н      | L      | н   |    | +2            | NO CHG | NO CHG     | NO CHG     |  |  |
| х      | x      | х   | L  | NOCHG         | NO CHG | NO CHG     | NO CHG     |  |  |
| ×      | x      | x   | н  | NO CHG        | NO CHG | NO CHG     | NO CHG     |  |  |

H=HIGH LEVEL, L=LOW LEVEL, X=IRRELEVANT , ↓ =LOW-TO-HIGH TRANSITION

### FIGURE 18 - PROGRAM AND MEMORY COUNTER FUNCTIONS

# 2.18 ADDRESS-OUT PORT MULTIPLEXER (AO MUX)

The address-out port multiplexer, Figure 19, provides for direct parallel access to the contents of either the program or memory counter contents. A single line controls selection as shown in Table 17.

| CONTROL<br>INPUT A0 | COUNTER SELECTED  |
|---------------------|-------------------|
| L<br>H              | MEMORY<br>PROGRAM |

| ТА          | BLE | 17 |       |     |
|-------------|-----|----|-------|-----|
| ADDRESS-OUT | PO  | RТ | CONTR | IOL |



FIGURE 19 - ADDRESS-OUT PORT MULTIPLEXER (AO MUX)

### 2.19 EXPANDING THE WORD LENGTH

The 'S481 processor element contains on-chip personality circuitry designed specifically to minimize the external discrete components required to cascade 4-bit slices to form larger word lengths. At the processor-element level, three external resistors are all that is required: one to pull-up the open-collector outputs and two to establish the position control input voltage at the LSP. Figure 20 shows a typical 16-bit processor element and illustrates the parallel bus arrangements for I/O and control with an SN74S182 performing ALU look-ahead across the 16-bit word. Interconnectivity for the shift, arithmetic, and counter functions is accomplished by hardwiring the functions as shown.

At the system level, standard techniques commonly employed for power-supply bypass, termination of unused pins, and system grounding of high-performance Schottky TTL systems are recommended.

# 3. OPERATIONAL DESCRIPTIONS

### 3.1 MICRO/MACRO-OPERATIONS

The micro/macro-operations resident in the micro-decode logic array can be accessed with an eleven-bit operation-select word. Operational flexibility is maximized by the fact that the op-select word format has been defined individually for each of the 14 different operation forms.

Operation Forms I, II, and III are primarily ALU functions. Forms II and III combine logical or arithmetic shifting functions with the ALU result. Form II can be used for double-precision shifting. Sources, specific ALU function, shift format, and destinations are detailed for each op-select word format.

Forms IV, V, and VI perform either logical or arithmetic, bidirectional shifting of the single- and doubleprecision buses and registers.

Form VII can be used to compare the magnitude of A source to B source, or B source to A source.

Form VIII provides the capability to logically combine the values of the A and B sources.

Form IX zeros the  $\Sigma'$  bus with the effect of providing no operation.

Forms X through XIV are macroprogrammable operations which provide:

- a. CRC partial sum update (normally  $\frac{N}{2}$  clocks)
- b. Signed Divide (N + 3 clocks)
- c. Unsigned Divide (N + 1 clocks)
- d. N-bit-by-N-bit double-precision unsigned multiply (N clocks)
- e. N-bit-by-N-bit double-precision signed multiply (N clocks)

The 14 operation forms, symbols, and number of unique operations are detailed in Table 18.



FIGURE 20-TYPICAL 16-BIT PROCESSOR

| NO.         OPE ATION         OP         CO         COULD         COULD <th< th=""><th>ASP           CCO           CCO</th></th<>  | ASP           CCO           CCO |
|--|---|
| NO.         OPERATION         OP:<br>(7) <sup>1</sup> OP:<br>(8)         OP:<br>(19)         OP:<br>(14)         OP:<br>(13)         OP:<br>(11)         OP:<br>(15)         CIN         LG         AG         EG         COUT         X         Y         (21)         (23)         (23)         (21)         (23)         (23)         (23)         (21)         (23)         (23)         (21)         (23)         (23)         (21)         (23)         (23)         (21)         (23)         (23)         (23)         (21)         (23)         (23)         (23)         (21)         (23)         (23)         (21)         (23)         (23)         (21)         (23)         (23)         (23)         (21)         (23)         (23)         (23)         (21)         (23)  | 033<br>(10)<br>035<br>035<br>035<br>035<br>035<br>035<br>035  |
| NO.OF EARTONU///U////U///U////U////U////U////U////U////U////U////U////U////U////   | (37)<br>000<br>000<br>000<br>000<br>000<br>000<br>000<br>0  |
| IA       (IA 4 B + CIN) - 2' BUS ONLY2       H       L       L       A SOURCE       B SOURCE       A' FNCT       B' FNCT       C-CARRY       D = 2ERO       D = 2ERO      D = 2ERO <thd 2ero<<="" =="" td=""><td>033<br/>035<br/>035<br/>035<br/>035</td></thd>   | 033<br>035<br>035<br>035<br>035   |
| $ \begin{array}{ c c c c c c c c c c c c c c c c c c c$  | 033<br>035<br>035<br>035<br>035   |
| $ \begin{array}{ c c c c c c c c c c c c c c c c c c c$  | 033<br>033<br>035<br>035<br>035   |
| $\begin{array}{ c c c c c c c c c c c c c c c c c c c$   | 050<br>050<br>050<br>050<br>050<br>050  |
| $\begin{array}{ c c c c c c c c c c c c c c c c c c c$   | 033<br>033<br>035<br>035<br>035<br>033  |
| $\begin{array}{c c c c c c c c c c c c c c c c c c c $   | 033<br>033<br>035<br>035<br>035<br>033  |
| HBIBIBAHHHLHLHHHHA 'SRCREGISTERBI -A 'H # WR +B' H * BI -AH = RTH = ADDCOUTXYOVIIII(A + B + CIN) $\Leftarrow$ REGISTERHHHLHA 'SRCREGISTERB'SOURCESHIFTTYPEL = CARRY $\Sigma' \neq ZERO$ $\Sigma' = ZERO$ $\Sigma' = ZERO$ $Z' = ZERO$ $Z$  | 033<br>033<br>033<br>033<br>033   |
| $\begin{array}{c c c c c c c c c c c c c c c c c c c $   | 033<br>035<br>035<br>035<br>035   |
| $ \begin{array}{ c c c c c c c c c c c c c c c c c c c$  | 033   |
| $\begin{array}{ c c c c c c c c c c c c c c c c c c c$   | 000   |
| $\begin{array}{c c c c c c c c c c c c c c c c c c c $   | 033   |
| $ \begin{array}{ c c c c c c c c c c c c c c c c c c c$  | 030   |
| $ \begin{array}{c c c c c c c c c c c c c c c c c c c $  | 073   |
| VI       WB, XWR + WR, XWR       H       L       L       GAME AS FORM 1 ABOVE)       CEAL       A'SRC       OPER       H       N1>N2       N1>N2       N1>N2       N1>N2       N1>N2       N1>N2       *LG       X       Y         VIIA A:B (N1:N2)       H       H       H       L       L       (SAME AS FORM 1 ABOVE) $= A + A' + B + B$ N1>N2       N1>N2       N1>N2       *LG       X       Y $= A' + A' + B' + B' + B' + B' + B' + B' +$  | 050   |
| VIIA     A: B (N1:N2)     H     H     H     L     L     B'SOURCE     A:SRC     OPER     H     N1>N2     N1>N2     N1-N2     *LG     X     Y       VIIB     B:A (N1:N2)     H     H     H     L     L     (SAME AS FORM 1 ABOVE) $I = 1 + A' = 1 - A' = A'$   | 050   |
| $\begin{array}{c c c c c c c c c c c c c c c c c c c $   |   |
| NOR/AND LOGICAL OPERATIONS     H     LHL=NOR     A: SRC     REG1     B SOURCE     A'FNCT     BEG1 $\Sigma \neq ZERO$ $\Sigma'ZERO$ $Z'ZERO$ $Z'Z'ZERO$ $Z'Z'ZERO$ $Z'Z'ZERO$ <t< td=""><td></td></t<>  |   |
| VIIIA NOR/AND LOGICAL OPERATIONS       H       LH = NOR       LL=AI+A       LL=BI+B       L=A -A'       L=B-B'       [SEE         VIIIB ORNAND LOGICAL OPERATIONS       H       LHH = OR       H+WR +A       LH = WR       LB       H= $\overline{A} - \overline{A}'$ H= $\overline{B} - \overline{B}'$ [SEE         VIIIB ORNAND LOGICAL OPERATIONS       H       LHH = VR       LH = WR       H       H = $\overline{A} - \overline{A}'$ H= $\overline{B} - \overline{B}'$ [SEE       [JIII]       [JIIII]       [JIIIII]       [JIIIII]       [JIIIIII]       [JIIIII]       [JIIIII]       [JIIIII]       [JIIIII]       [JIIIIIII]       [JIIIIII]       [JIIIIII]       [JIIIIII]       [JIIIIII]       [JIIIIIIIII]       [JIIIIIIIII]       [JIIIIIII]       [JIIIIII]       [JIIIIIIIII]       [JIIIIIIIIII]       [JIIIIIIII]       [JIIIIIIIIIIIIIIIIIIIII]       [JIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIIII   | CCO   |
| Intermediation         Interme   |   |
| OPERATIONS         H         H         H         H         PC = 0         COLUMN         I         H         I         I         H         H         I         H         I         H         I         H         I         H         I         I         I         I         H         I         H         I   | - <u> </u>  |
|  |   |
|  | 000   |
|  | -   |
| XI SIGNED B. ITERATE (N1CLKS) H H H H L H L H 0/15 0/15 H  | - 1   |
|  | -   |
|  | -   |
| XII UNSIGNED <mark>A. START H H H H L L L H H L – DIVOVFL – – – – –</mark>   | -   |
| DIVIDE (B. ITERATE (N-1 CLKS) H H H H H L L L H H O//6 L   | -   |
|  | +   |
| XIV SIGNED INTEGER MULTIPLY H H H H L H H H 0/16 0/16 H  | 1   |
| D0 1 SEL (29)  |   |
| AO SEL (42) DO2 SEL (30) BI/O SEL (29) LD WR (24) INC MC (35) INC PC (43) CCI (44) POS (19) DATA PORTS PIN ASS   | IMENTS  |
| L MC LL ∑'BUS L OUTPUT L AI→WR L INC L INC LSPL:×1 0V=MID AI BI/O DOP AOP BIT (2 <sup>n</sup> ) WRRT (26)  | CK (45)   |
| H PC LH WR H INPUT H NO LOAD H HOLD H HOLD LSP H: x 2 24 V LSP N (6) (46) (34) (38) (01.58) WRLET (25)   | V <sub>CC</sub> (12)  |
| H H-Z HLZ SW   | GND (36)  |
| H NO CARRY $\left  \begin{array}{c} k \\ \bar{k} \end{array} \right  \left  \begin{array}{c} (3) \\ (2) \\ (3) \end{array} \right  \left  \begin{array}{c} (41) \\ (41) \\ (41) \end{array} \right  \left  \begin{array}{c} (41) \\ (41) \end{array} \right  \left  \left  \begin{array}{c} (41) \\ (41) \end{array} \right  \left  \left  \left  \left  \left  \left  \left  \left  \begin{array}{c} (41) \\ (41) \end{array} \right  \left  \left $ |   |
| NOTES: 1. NUMERALS IN PARENTHESIS ARE PIN NUMBERS 5. O IS OUTPUT ON LSP, I IS INPUT ON LSP   |   |
| 2. → DESTINED FOR SHIFTED AND DESTINED FOR 6. O IS OUTPUT ON MSP. I IS INPUT ON MSP  |   |
| 3. HIF HIGH VOLTAGE LEVEL, LIF LOW VOLTAGE LEVEL 1. VOLTAGE VALUES ARE NOMINAL   |   |

### TABLE 18 - OPERATION FORM, COMMAND FORMAT, AND TEST OUTPUTS

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### 3.2 OPERATION FORM I - ADD/SUBTRACT → REGISTER

Operation Form I is designed specifically to perform the addition or symmetrial subtraction of two operands. The operation form shown in Figure 21, is composed of two distinct capabilities:



a. Form IA provides the capability of adding or subtracting two operands and routing the results to the  $\Sigma'$  bus. Symbolically, this operation can be expressed as:

$$A \left\{ \begin{array}{c} \mathsf{PLUS} \\ \mathsf{MINUS} \end{array} \right\} \quad \mathsf{B} \ \mathsf{PLUS} \ \mathsf{ALUCIN} \to \Sigma' \ \mathsf{BUS}$$

This form provides the capability of choosing from any one of the A and any one of the B sources listed in Figure 21 as the operands to accomplish the add/subtract. The example illustrated in Figure 22 utilizes the I/O capability of the B input/output port. Input data at the AI or B I/O is setup and then latched into the 'S481 A or B input latch on the negative transition of the 'S481 clock.

During Form IA operations, the contents of the extended working register are not changed and the working register may be saved or loaded directly. The program or memory counters under control of the asynchronous increment, inhibit, and LSP CCI can be saved or either may be incremented by one or two. Sources for the DOP and AOP are also selectable.





The overflow and magnitude status lines are active as enumerated in Figure 21.

b. Form IB provides the capability of adding or subtracting two operands and routing the results to one of the four 'S481 storage destinations: the working register (WR), the extended working register (XWR), the program counter (PC), or the memory counter (MC). Symbolically, this operation can be expressed as:

This form provides the capability of choosing from any one of the A and any one of the B sources listed in Figure 21 as the operands to accomplish the add/subtract.

# 3.3 OPERATION FORM II - ADD/SUBTRACT WITH DOUBLE-PRECISION SHIFT

Operation Form II is designed specifically to perform one of two classical iterations used frequently to implement microprogrammed multiply and divide algorithms. This form provides the system designer with the capability of selecting a single microinstruction which will complete both the add-and-shift or subtract-and-shift functions in a single clock cycle. Available microinstructions are illustrated in Figure 23. Symbolically, Form II operations can be represented as:

Hardwired algorithms for double-precision multiply and divide routines can be selected in operation forms XI, XII, XIII, or XIV.

During Form II operations the status, overflow, and asynchronous controls are the same as described for Form I.



FIGURE 23 - FORM II-ARITHMETIC WITH DOUBLE-PRECISION SHIFT

 $\begin{bmatrix} A \\ B \end{bmatrix} PLUS \begin{bmatrix} B \\ A \end{bmatrix} PLUS CARRY SHIFTED \rightarrow WR, XWR$ 

(MULTIPLY AND DIVIDE SHIFT OPERATIONS WITHOUT AUTOMATIC CONTROL)

### 3.4 OPERATION FORM III – ADD WITH SINGLE-PRECISION SHIFT

Operation Form III is a universal microinstruction providing the designers with the capability of performing an add-and-shift function in a single clock cycle. Sources and destinations are shown in Figure 24. Also enumerated are the shift functions which are selectable as part of the microinstruction.

Magnitude and overflow status indicators are active as enumerated in Figure 24. Form III can be represented symbolically as:

SHIFTED  $\rightarrow$  XWR, OR MC

During Form III operation the contents of the working register are not changed unless an asynchronous load is selected. If not selected as the destination, the extended working register will be saved. The memory counter can be the operand destination, or it and the program counter can be saved, or one can be incremented by one or two on selection. Sources for the DOP and AOP are also selectable.



# FIGURE 24 – FORM III-ARITHMETIC WITH SINGLE-PRECISION SHIFT (A PLUS B PLUS ALUCIN) SHIFTED $\rightarrow$ XWR OR MC

### 3.5 OPERATION FORM IV – AI SHIFTED $\rightarrow \Sigma'$ BUS

Operation Form IV is designed specifically for performing a single bit-position logical, arithmetic, or circular shift of the data applied at the A input port. This single clock operation can be used to shift information residing in any of the external working memory register locations simply by enabling the output capability of the BI/O port and writing the shifted word back into the same (or any other selected) memory location.

Asynchronous controls are the same as described for Operation Form IA, and the magnitude status lines are active and overflow is active during left-shift arithmetic (LSA) operation as enumerated in Figure 25.



- 1.  $\overline{\text{COUT}} = \overline{\text{CIN}}$
- OVFL (MSP = H) Indicates that LSA operation in process will cause shift overflow. For all other operations, OVFL = L.
- 3. MAGNITUDE: Al is compared to ZERO. Resultant outputs are:

AG = H (AI > ZERO)  $LG = H (AI \neq ZERO)$ EQ = H (AI = ZERO)

### FIGURE 25 – FORM IV–AI SHIFTED $\rightarrow \Sigma'$ BUS

### 3.6 OPERATION FORM V - SINGLE-LENGTH SHIFT

Operation Form V performs a single-bit position, logical, arithmetic, or circular shift of either the working register or extended working register. Magnitude status indicators are active and overflow is active during left-shift arithmetic (LSA) operations as enumerated in Figure 26. Asynchronous controls are the same as described for Operation Form IA.



# 3.7 OPERATION FORM VI - DOUBLE-PRECISION SHIFTS

Operation Form VI performs a double-precision logical, arithmetic, or circular shift of a double-length word residing in the working register and extended working register. Magnitude status indicators are active and overflow is active during left-shift arithmetic (LSA) operations as enumerated in Figure 27. Asynchronous controls are the same as described for operation form IA.



### FIGURE 27 - FORM VI-DOUBLE-PRECISION SHIFTS: (WR, XWR)SHIFTED →(WR, XWR)

# 3.8 OPERATION FORM VII - COMPARE (A:B OR B:A)

Operation Form VII is designed specifically to provide the system designer with the capability of symmetrically comparing either operands A-to-B or operands B-to-A. The operands selectable are enumerated in Figure 28 as the A source select or B source select. The carry output, overflow, and magnitude status lines decode and indicate the logical and arithmetic relationship of the operands being compared as shown in Figure 28. Asynchronous controls are the same as described for Operation Form IA.

### 3.9 OPERATION FORM VIII – LOGICAL FUNCTIONS

The ALU with its carry circuit functionally inactivated in Form VIII operations can be microprogrammed in conjunction with the source operands to perform any of the possible combinatorial Boolean functions on two binary variables. See Figure 29. Simple transfer functions are performed with the arithmetic operations in Form I, and combinatorial transfer and shift operations are available in Form III.

As with the arithmetic operations, a highly flexible source selection extends performance of single clock combinatorial logical operations between two (external) operands applied at the A and B input ports, or combinations of resident data in 'S481 registers or counters can be combined logically with another register or external source. The specific combinations selectable are enumerated in the following paragraphs.



### 3.9.1 NOR/AND Logical Operations

Operation Form VIIIA can be used to perform the NOR or AND logical combination of two selectable operands and route the results to one of four destinations. The operation microcode is:





As shown above, the A and B sources are selectable by the A1, B1, and B2 bits in their true or complementary form (bits A0, B0) to facilitate performing the NOR, mixed NOR/AND, and the AND functions. As implemented, see Figure 30, the NOR function is performed when the sources are both true, mixed NOR/AND functions are performed with one source complemented, and the AND function is performed when both sources are selected in their complement form. Both implementation and other/equal logic symbols are shown in Figure 30. Also provided are the function tables and Boolean equations.

|   | SELECTIONS AVAILABLE   |   |  |  |  |  |
|---|--|---|--|--|--|--|
|   | TRUE   | A = COMP  | B = COMP   | A and B = COMP   |  |  |
| IMPLEMENTATION  | Α<br>ΒΣ'   |   |  |  |  |  |
| FUNCTION TABLES<br>(H = HIGH LEVEL,<br>L = LOW LEVEL) | A         B         Σ'           L         L         H           H         L         L           L         H         L           L         L         H           U         L         L           U         H         L           H         H         L           OP8 = OP9 = L         C | A A B 2'<br>L H L L<br>H L L H<br>L H H L<br>H L H L<br>H L H L<br>OP8 = H, OP9 = L | B         B         A         2'           L         H         L         L           L         H         L         H           H         L         H         L           H         L         H         L           H         L         H         L           H         L         H         L           H         L         H         L | A         B         Ā         B         Σ'           L         L         H         H         L           H         L         L         H         L           L         H         L         L         L           H         L         L         H         L           H         H         L         L           H         H         L         L           H         H         L         L           H         H         L         L           OP8 = OP9 = H         OP8 = OP9 = H         OP8 = OP9 = H |  |  |
| OTHER OR<br>EQUAL SYMBOLS                             |  |   |  | $\begin{array}{c} A \\ B \\ \hline \\ AND \end{array} \\ \begin{array}{c} \Sigma' \\ \end{array}$  |  |  |
| BOOLEAN FUNCTIONS                                     | $\Sigma' = \overline{A + B}$   | Σ' = AB   | Σ' = ĀB  | Σ' = AB  |  |  |



### 3.9.2 OR/NAND Logical Operations

Operation Form VIIIB can be used to perform the OR or NAND logical combination of two selectable operands and route the results to one of four destinations. The operation microcode is:





As shown above, the A and B sources are selectable by the A1, B1, and B2 bits in their true or complementary form (bits A0, B0) to facilitate performing the OR, mixed OR/NAND, and the NAND functions. As implemented, see Figure 31, the OR function is performed when the sources are both true, mixed OR/NAND functions are performed with one source complemented, and the NAND function is performed when both sources are selected in their complement form. Both implementation and other/equal logic symbols are shown in Figure 31. Also provided are the function tables and Boolean equations.

|   | SELECTIONS AVAILABLE  |  |  |  |  |  |  |
|---|---|--|--|--|--|--|--|
|   | TRUE A = COMP B = COMP                                      |  | B = COMP   | A and B = COMP   |  |  |  |
| IMPLEMENTATION  |   | $B$ $\Sigma'$  |  | $\begin{array}{c} A - \underbrace{\bigcirc \overline{A}} \\ B - \underbrace{\bigcirc \overline{B}} \\ \end{array} \end{array} \xrightarrow{\Sigma'}$ |  |  |  |
| FUNCTION TABLES<br>(H = HIGH LEVEL,<br>L = LOW LEVEL) | A Β Σ'<br>L L L<br>H L H<br>L H H<br>H H H<br>OP8 = OP9 = L | A         Ā         B         Σ'           L         H         L         H           H         L         L         L           L         H         H         H           H         L         L         L           L         H         H         H           H         L         H         H           H         L         H         H           H         H         H         H | B B A ∑'<br>L H L H<br>L H H H<br>H L L L<br>H L H H<br>OP8 = L, OP9 = H | A B A B ∠'<br>L L H H H<br>H L L H H<br>L H H L H<br>H H L L L<br>OP8 = OP9 = H  |  |  |  |
| OTHER OR<br>EQUAL SYMBOLS                             |   |  |  |  |  |  |  |
| BOOLEAN FUNCTIONS                                     | Σ′≃ A + B   | Σ' = Ā + B   | Σ'= A + B  | Σ' = ĀB  |  |  |  |

### FIGURE 31 - FORM VIIIB OR/NAND LOGICAL OPERATIONS

### 3.9.3 Exclusive-OR/Exclusive-NOR Logical Operations

Operation Form VIIIC can be used to perform the exclusive-OR/exclusive-NOR logical combination of two selectable operands and route the results to one of four destinations. The operation microcode is:



H = HIGH LEVEL, L = LOW LEVEL

As shown above, the A and B sources are selectable by the A1, B1, and B2 bits in their true or complementary form (bits A0, B0) to facilitate both exclusive-OR and exclusive-NOR operations. As implemented, see Figure 32, the exclusive-NOR function is performed when the sources are both true or both complemented. When either the A or the B source (not both) are complemented, the exclusive-OR function is performed. Both implementation and other/equal logic symbols are shown in Figure 32. Also provided are the function tables and Boolean equations.

|   | ALL TRUE OR ALL<br>COMPLEMENT SOURCES  | ONE SOURCE CO  | DMPLEMENTED   |
|---|--|--|---|
| IMPLEMENTATION  | $\begin{array}{c} A \\ B \\ \hline \\ EX - OR \end{array} \Sigma'$   | $B \xrightarrow{\overline{A}} \Sigma'$   | $\begin{array}{c} A \\ B \\ \hline \end{array} \\ \hline \end{array} \\ \hline \end{array} \\ \hline \end{array} \\ \begin{array}{c} D \\ \hline \end{array} \\ \hline \end{array} \\ \begin{array}{c} D \\ \end{array} \\ \begin{array}{c} D \\ \end{array} \\ \hline \end{array} \\ \begin{array}{c} D \\ \end{array} \\ \end{array} \\ \begin{array}{c} D \\ \end{array} \\ \begin{array}{c} D \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} D \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} D \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} D \\ \end{array} \\ \end{array} \\ \end{array} \\ \end{array} \\ \begin{array}{c} D \\ \end{array} \\$ |
| FUNCTION TABLES<br>(H = HIGH LEVEL,<br>L = LOW LEVEL) | $\begin{array}{c ccc} A & B & \Sigma' \\ L & L & H \\ H & L & L \\ L & H & L \\ H & H & H \end{array}$ OP8 = OP9 = L | $\begin{array}{c cccc} A & \overline{A} & B & \overline{\Sigma'} \\ L & H & L & L \\ H & L & L & H \\ L & H & H & H \\ H & L & H & L \end{array}$ $OP8 = H, OP9 = L$ | $\begin{array}{c ccccccccccccccccccccccccccccccccccc$   |
| BOOLEAN FUNCTIONS                                     | $\Sigma' = A \oplus B$   | $\Sigma' = \overline{A} \oplus B$  | $\Sigma' = A \oplus \overline{B}$   |

### FIGURE 32-FORM VIIIC EXCLUSIVE-OR/EXCLUSIVE-NOR OPERATIONS

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### 3.10 OPERATION FORM IX - NO OP

Operation Form IX is designed specifically to clear the  $\Sigma'$  bus force AG and LG low, and force EQ high; and, during this operation form data in the 'S481 registers, counters and latches remain unchanged unless directed to do otherwise by the asynchronous control inputs as shown in Figure 33.

The memory or program counter can be incremented (by one or two) on each clock transition, or the working register can be loaded on each clock. Additionally, the B input/output can be specified, as well as sources for the address or data out ports. States of the carry and overflow outputs are not interrupted.

| 0P0<br>0P1<br>0P2<br>0P3<br>0P3 |       |        |      |      |        | OP6   | 0P7    | 0P8   | 640 | CIN |
|---------------------------------|-------|--------|------|------|--------|-------|--------|-------|-----|-----|
| н                               | н     | н      | н    | н    | ×      | х     | ×      | х     | ×   | ×   |
| H = HIGH LEVEL, L = LOW LEV     |       |        |      |      | /EL, X | = IRR | ELEV   | ANT   |     |     |
| ASYNCHRONOUS CONTROLS:          |       |        |      |      |        |       |        |       |     |     |
| SEL B INPUT/OUTPUT              |       |        |      |      |        |       |        |       |     |     |
| SEL DOB SOURCE                  |       |        |      |      |        |       | AG     | = ZER | 0   |     |
| SEL AOB SOURCE                  |       |        |      |      |        |       | LG     | = ZER | о   |     |
| INCREMENT PC OR MC              |       |        |      |      |        | FO    | = HIGI | 4     |     |     |
| 1                               | NHIBI | Т РС А | ND/O | R MC |        |       | 20     | mai   |     |     |
| LOAD WR                         |       |        |      |      |        |       |        |       |     |     |

FIGURE 33 – FORM IX-NO OPERATION: ZERO  $\rightarrow \Sigma'$  BUS

### 3.11 OPERATION FORM X - CYCLIC REDUNDANCY CHARACTER ACCUMULATION

Operation Form X is a macroinstruction which can be used to update a 16-bit cyclic redundancy character (CRC) partial sum in eight clock cycles, assuming 8-bit data characters. The updated CRC partial sum resides in the working register. The flow diagram of this algorithm is illustrated in Figure 34.



FIGURE 34 - CYCLIC REDUNDANCY CHARACTER ACCUMULATION

Setup conditions include the existence or placement of the previous CRC partial sum in the working register, the CRC polynomial at the A input port, and the data character in the eight least significant bits of the extended working register. All decisions after setup are decoded on chip for each of the eight iterations. Microcontrol open-collector output OP9 of the LSP assumes control during the iterations to generate one of two microinstructions requires to accomplish the CRC update.

### 3.12 OPERATION FORM XI - SIGNED INTEGER DIVIDE

Operation Form XI consists of the micro/macroinstructions needed to perform the signed division of a double length dividend by an N-bit divisor in N + 3 clock times. After the division routine the quotient will reside in the extended working register (XWR) and the remainder will be in the working register (WR). Negative results are in two's complement. The flow diagram of this algorithm is illustrated in Figure 35.

Setup conditions include the existence or placement of the double length dividend in the WR, XWR and application of the divisor at the A input port. To obtain a legitimate result, the divisor must not be arithmetically zero as indicated during the start command by the EQ output being low. The dividend must be of a nature that it could be generated by a signed multiply and add operation on the divisor. Status outputs LG, AG, C OUT and OV are undefined, as is EQ after the start command.

After setup, all decisions are decoded on chip for start, iterate, iteration finish, fix remainder, and adjust quotient. The iterate macroinstruction (Form XIB) internally decodes the status of the stored signs, carry out, and working register and the OP8 and OP9 microcontrol open-collector outputs of the MSP assume control generating one of four microinstructions required to accomplish the signed divide.

#### 3.13 OPERATION FORM XII – UNSIGNED DIVIDE

Operation Form XII consists of micro/macroinstructions needed to perform the unsigned division of a double length dividend by an N-bit divisor in N + 1 clock times. After the division routine the binary magnitude quotient will reside in the extended working register (XWR) and the binary magnitude remainder will be in the working register (WR). The flow diagram of this algorithm is illustrated in Figure 36.

Setup conditions include the existence or placement of the double length dividend in the WR, XWR; application of the divisor at the A input port and that the last operation was not a divide command. To obtain a legitimate result, the N-bit divisor must be logically greater than the most-significant N-bits resident in the working register. A-input data compared to working register (A1:WR) prior to the unsigned divide can be used to obtain validity to start by asserting LG true.

After setup, all decisions are decoded on chip for start, iterate and finish. The iterate macroinstruction (Form XIIB) internally decodes the status of C OUT or FORCE LOAD FLAG and the OP9 microcontrol open-collector output of the MSP assumes control generating one of two microinstructions required to accomplish the unsigned divide.

### 3.14 OPERATION FORM XIII - UNSIGNED MULTIPLY

Operation Form XIII consists of a macroinstruction which performs the unsigned multiplication of two N-bit words in N clock times. After the multiply routine the double length product is residing in the working register (most-significant N-bits) and the extended working register (least-significant N-bits). The flow diagram of this algorithm is illustrated in Figure 37.

Setup conditions include clearing the working register to all zeros, loading (not shifting) the multiplier into the extended working register, and applying the multiplicand at the A input port. Arithmetic shift commands must not occur between multiplier load and the first iteration. Status outputs (EQ, AG, LG, C OUT and OV) are undefined during this algorithm.



FIGURE 35 - FORM XI-SIGNED INTEGER DIVIDE (SHEET 1 OF 2)


FIGURE 35 - FORM XI-SIGNED INTEGER DIVIDE (SHEET 2 OF 2)



### FIGURE 36 - FORM XII-UNSIGNED DIVIDE (SHEET 1 OF 2)



FIGURE 36 - FORM XII-UNSIGNED DIVIDE (SHEET 2 OF 2)



FIGURE 37 - FORM XIII-UNSIGNED MULTIPLY

The iterate macroinstruction internally decodes the status of the XWR LSB and the OP9 microcontrol open-collector output of the MSP assumes control generating one of two microinstructions required to accomplish the unsigned multiply.

# 3.15 OPERATION FORM XIV - SIGNED INTEGER MULTIPLY

Operation Form XIV consists of a macroinstruction which performs the signed multiplication of two N-bit signed integers in N clock times. After the multiply routine, the double precision signed product resides in the working register (most-significant N-bits) and the extended working register (least-significant N-bits). Negative products are in two's complement. The flow diagram of this algorithm is illustrated in Figure 38.

Setup conditions include clearing the working register to all zeros, loading (not shifting) the multiplier into the extended working register, and applying the multiplicand at the A input port. Arithmetic shifts must not occur between multiplier load and the first iteration. Status outputs (EO, AG, LG, C-OUT, and OV) are undefined during this algorithm.

The iterate macroinstruction internally decodes the status of the multiplier (XWR) sign-bit flag, the multiplier LSB, and the multiplier LSB flag and the OP8 and OP9 microcontrol open-collector outputs of the MSP assume control generating one of four microinstructions required to accomplish the signed multiply.



FIGURE 38 - FORM XIV-SIGNED INTEGER MULTIPLY

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#### **SPECIFICATIONS** 4.

|                                 |   | <b>I</b> | SN54S481 |              | SN   | 745481 |             |  |
|---------------------------------|---|----------|----------|--------------|------|--------|-------------|--|
|                                 | PARAMETER   | MIN      | NOM      | MAX          | MIN  | NOM    | MAX         | UNIT                                     |
| Supply voltage, V <sub>CC</sub> |   | 4.5      | 5        | 5,5          | 4.75 | 5      | 5.25        | ν,                                       |
| High-level output volt          | age at EQ, OP8, OP9; VO                                 |          |          | 5,5          |      |        | 5.5         | V  |
|                                 | AOP, BI/O, DOP, CCO/OV, COUT                            |          |          | 10           |      |        | 10          |  |
| Low-level output                | EQ, OP8, OP9  |          |          | 8            |      |        | 8           |  |
| current, IOL                    | WRLFT, WRRT, XWRLFT, XWRRT                              |          |          | 6            |      |        | 6           | ] [] [] [] [] [] [] [] [] [] [] [] [] [] |
|                                 | X/LG, Y/AG  |          |          | 16           |      |        | 16          |  |
| High-level output               | BI/O, DOP   |          |          | 2            |      |        | 6.5         |  |
| current, IOH                    | All other outputs or I/O except EQ, OP8, OP9            |          |          | 1            |      |        | 1           |  |
| Width of clock                  | High logic level  | 35       |          |              | 35   |        |             |  |
| pulse, t <sub>w</sub>           | Low logic level   | 25       |          |              | 25   |        |             | ns                                       |
| Clock frequency                 |   |          |          | 9            |      |        | 10          | MHz                                      |
|                                 | AI, BI/O Latch  | 15↓      |          |              | 15↓  |        |             |  |
|                                 | AI → WR   | 15†      |          |              | 151  |        |             |  |
|                                 | AI, $BI/O \rightarrow ALU \rightarrow MC$ , PC, WR, XWR | 70†      |          |              | 601  |        |             |  |
| Setup time, t <sub>su</sub>     | CCI, INCMC, INCPC, LDWR                                 | 351      |          |              | 301  | -      |             | ns                                       |
|                                 | OP0 thru OP9  | 1201     | 90       |              | 1001 | 60     |             |  |
|                                 | CIN   | 551      |          |              | 401  |        |             | ]  |
|                                 | WRLFT, WRRT, XWRLFT, XWRRT                              | 301      |          |              | 25↑  |        |             |  |
|                                 | A1, BI/O → Latch  | 10↓      |          |              | 10↓  |        |             |  |
|                                 | AI → WR   | 101      |          |              | 101  |        |             | ]  |
|                                 | AI, $BI/O \rightarrow ALU \rightarrow MC, PC, WR, XWR$  |          |          | <b>-20</b> † |      |        | <b>20</b> † |  |
| Hold time, t <sub>h</sub>       | CCI, INCMC, INCPC, EDWR                                 | 10       |          |              | 101  |        |             | ns                                       |
|                                 | OP0 thru OP9  |          |          | 51           |      |        | 51          |  |
|                                 | CIN   | · 01     |          |              | 10   |        |             |  |
|                                 | WRLFT, WRRT, XWRLFT, XWRRT                              | 51       |          |              | 51   |        |             |  |
| Operating free-air terr         | perating free-air temperature range TA                  |          |          | 125          | 0    | 25     | 70          | 0°                                       |

TABLE 19 SN54S481 AND SN74S481 RECOMMENDED OPERATING CONDITIONS

↑↓The arrow indicates the transistion of the clock input used for reference; ↑for the low-to-high transition, ↓ for the high-to-low transistion.

# TABLE 20

## SN54S481 AND SN74S481 ELECTRICAL CHARACTERISTICS OVER RECOMMENDED OPERATING FREE-AIR TEMPERATURE RANGE (UNLESS OTHERWISE NOTED)

|      | PARAM                             | IETER                                    | TEST CONDITION                               | IS <sup>†</sup> | MIN | TYP <sup>‡</sup> | MAX  | UNIT |
|------|-----------------------------------|--|--|-----------------|-----|------------------|------|------|
| _VIH | High-level input voltage          | see Note 1                               |  |                 | 2   |                  |      | V    |
| VIL  | Low-level input voltage           | see Note 1                               |  |                 |     |                  | 0.8  | v    |
| VIK  | Input clamp voltage               |  | V <sub>CC</sub> =MIN, I <sub>I</sub> =-18 mA |                 |     |                  | -1.2 | v    |
| Vau  | High-level output voltage         | Any I/O or output                        | V <sub>CC</sub> =MIN, V <sub>IH</sub> =2 V,  | 54S'            | 2.5 |                  |      | V    |
| ∎∙он | rightevel output voltage          | except EQ, OP8, OP9                      | VIL=0.8 V, IOH=MAX 745'                      |                 | 2.7 | 3.4              |      | v    |
| VOL  | Low-level output voltage          |  | V <sub>CC</sub> =MIN, V <sub>IH</sub> =2 V,  |                 |     |                  | 0.5  | v    |
|      | High-level output current         | EQ OP8 OP9                               | $V_{CC} = MAX V_{CC} = 5.5 V$                |                 |     |                  | 100  | uА   |
|      | Input current at maximum          | POS                                      | Vcc=MAX, Vi=Vcc                              |                 |     |                  | 100  |      |
| 11   | Input voltage                     | Any other input                          | V <sub>CC</sub> =MAX, V <sub>I</sub> =5.5 V  |                 |     |                  | 1    | mA   |
|      |                                   | OP0, OP1, OP2, OP3, CIN                  | V  |                 |     |                  | 200  | μA   |
| ЧН   | High-level input current          | Any other (see Note 1)                   | VCC=MAX, VI=2.7 V                            | ľ               |     |                  | 100  | μA   |
|      |                                   | OP0 thru OP3, CIN, POS, CCI              |  |                 |     |                  | -8   |      |
| ЧL   | Low-level input current           | WRRT, WRLFT, XWRRT,<br>XWRLFT, CLOCK     | V <sub>CC</sub> =MAX, V <sub>I</sub> =0.5 V  |                 |     |                  | -6   | mA   |
|      |                                   | Any other input                          |  |                 |     |                  | -2   |      |
| los  | Short-circuit<br>output current § | Any output or I/O<br>except EQ, OP8, OP9 | V <sub>CC</sub> =MAX                         |                 | -30 |                  | -100 | mA   |
| 1cc  | Supply current                    | ·········                                | V <sub>CC</sub> =MAX                         |                 |     | 380              | 425  | mA   |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ . § Not more than one output should be shorted at a time.

NOTE 1. For POS input value see Table 3 on page 1-10

# DESIGN GOAL

This document provides tentative infor-mation on a product in the developmental 2-54 stage. Texas Instruments reserves the right to change or discontinue this product without notice.

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| TABLE 21   |          |
|--|----------|
| 154S481 AND SN74S481 SWITCHING CHARACTERISTICS (OVER OPERATING RANGE OF V <sub>CC</sub> AND T <sub>A</sub> ) | SN54S481 |

| DARAMETER        | EPOM (INPLIT)      |                            | OPERATION                    | SN54 | IS481 | SN7 | 4\$481 | UNIT |
|------------------|--------------------|----------------------------|------------------------------|------|-------|-----|--------|------|
| FANAMETER        |                    | 10 (00 1701)               | ROUTING                      | TYP  | MAX   | TYP | MAX    | UNIT |
|                  |                    | DOP                        | LATCH $\rightarrow$ ALU, DOP | 42   | 75    | 42  | 65     |      |
|                  |                    | Х, Ү                       | LATCH → ALU                  | 32   | 60    | 32  | 50     |      |
|                  |                    | COUT                       | LATCH → ALU                  | 30   | 50    | 30  | 45     |      |
| <sup>t</sup> PD  | AL, BI/O           | EQ                         | LATCH → ALU                  | 45   | 75    | 45  | 65     | ns   |
|                  |                    | ov                         | LATCH → ALU                  | 35   | 60    | 35  | 45     |      |
|                  |                    | AG, LG                     | LATCH → ALU                  | 60   | 100   | 60  | 80     |      |
|                  |                    | WRLFT, WRRT, XWRLFT, XWRRT | LATCH → ALU                  | 45   | 75    | 45  | 65     |      |
|                  |                    | WRLFT, WRRT, XWRLFT, XWRRT |                              | 65   | 115   |     | 95     |      |
|                  |                    | COUT                       |                              | 55   | 95    | 55  | 80     |      |
|                  |                    | X, Y                       |                              | 60   | 105   | 60  | 85     |      |
| <sup>t</sup> PD  | OP0 thru OP9       | EQ                         |                              | 55   | 105   | 55  | 75     | ns   |
|                  |                    | ov                         |                              | 60   | 105   | 60  | 90     |      |
|                  |                    | AG, LG                     |                              | 75   | 125   | 75  | 110    |      |
|                  |                    | DOP                        |                              | 70   | 115   | 70  | 95     |      |
| tPD              | AI, BI/O           | BI/O                       | LATCH → ALU                  | 35   | 65    | 50  | 55     | ns   |
| tPD              | CIN                | COUT                       |                              | 30   | 50    | 30  | 45     | ns   |
| tPD              | CCI                | CCO                        |                              | 37   | 75    | 37  | 60     | ns   |
| tPD              | A0                 | AOP                        |                              | 20   | 30    | 15  | 30     | ris  |
| tPD              | D0, D1             | DOP                        |                              | 15   | 35    | 15  | 30     | ns   |
| <sup>t</sup> PXZ | BI/O SEL or D0, D1 | BI/O or DOP                |                              | 15   | 35    | 15  | 30     | ns   |
| tPXZ             | OP0 thru OP9       | WRLFT, WRRT, XWRLFT, XWRRT |                              | 45   | 90    | 45  | 80     | ns   |
| <sup>t</sup> PZX | BI/O SEL or D0, D1 | BI/O or DOP                |                              | 15   | 35    | 15  | 30     | ns   |
| tPZX             | OP0 thru OP9       | WRLFT, WRRT, XWRLFT, XWRRT |                              | 45   | 90    | 45  | 80     | ns   |
|                  |                    | AOP, DOP                   | NO SHIFT                     | 26   | 50    | 26  | 40     |      |
|                  |                    | WRLFT, WRRT, XWRLFT, XWRRT | [WR, XWR, <b>SBUS</b> ]      | 40   | 75    | 40  | 60     |      |
|                  |                    | AOP, DOP                   | → SHIFTED                    | 30   | 50    | 35  | 40     |      |
|                  |                    | ov                         |                              | 50   | 90    | 50  | 70     |      |
| ۲PD              | ULUUK              | CCO                        |                              | 25   | 45    | 25  | 40     | ns   |
|                  |                    | COUT                       |                              | 47   | 85    | 47  | 65     |      |
|                  |                    | OP8, OP9                   |                              | 45   | 90    |     |        |      |
|                  |                    | Х, Ү                       |                              | 48   | 85    | 48  | 75     |      |
| tPD              | CIN                | DOP                        |                              | 42   | 80    | 42  | 60     | ns   |

t<sub>PD</sub> ≡ Propogation delay

 $t_{PXZ} \equiv Disable time to Hi-Z$ 

 $t_{PZX} \equiv Enable time (Hi-Z-To-Enable)$ 

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 $t_r \leq 5 \text{ ns}, t_P \leq 5 \text{ ns}, PRR \geq 1 \text{ MHz}, ZOUT \approx 50 \Omega$ 

A0001385

FIGURE 39 - SWITCHING-TIME VOLTAGE WAVEFORMS

# TYPES SN54S482, SN74S482 4-BIT-SLICE EXPANDABLE CONTROL ELEMENTS

BULLETIN NO. DL-S 7612384, MARCH 1976

- 4-Bit Slice is Cascadable to N-Bits
- Designed Specifically for Microcontroller/ Next-Address Generator Functions
- Increment/Decrement by One (Immediate or Direct Symbolic Addressing Modes)
- Offset, Vector, or Branch (Indexed or Relative Addressing Modes)
- Store Up to Four Returns or Links (Program Return Address from Subroutine)
- Program Start or Initialize (Return to Zero or Clear Mode)
- On-Chip Edge-Triggered Output Register (Provides Steady-State Micro-Address/ Instruction)
- High-Density 20-Pin Dual-in-Line Package with 300-Mil Row Pin Spacing



# description

The 'S482 is a high-performance Schottky TTL 4-bit-slice control element for use in any computer/control application requiring the coupling of high-performance bipolar speeds with the flexibility of microprogram control and bit-slice expandability. When used as a next-address generator, two 'S482 elements can address up to 256 words of microprogram; three elements can address up to 4096 words of microprogram; or a number of 'S482 elements can generate N words in multiples of four lines.

Comprised of an output register, push-pop stack, and a full adder, the 'S482 provides the capability to implement multiway testing needed to generate or to determine and select the source of the next function of microprogram address.

# functional block diagram



#### TENTATIVE DATA SHEET

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This document provides tentative information on a new product. Texas Instruments reserves the right to change specifications for this product in any manner without notice.

TEXAS INSTRUMENTS INCORPORATED

# TYPES SN54S482, SN74S482 4-BIT-SLICE EXPANDABLE CONTROL ELEMENTS

# output register and source functions

The 4-bit edge-triggered register provides a steady-state output throughout each system clock cycle. An asynchronous clear extends the multiway testing to directly implement system initialization at ROM address zero.

Two source-select lines (S5, S6) provide the output register with access to either the current instruction (no change), an operand or address stored in the push-pop stack, the output of a four-function full adder, or a direct data-in address port. The sources and functions are summarized in Tables I and II.

| SEL | ECT | RECISTER INDUIT SOURCE           |
|-----|-----|----------------------------------|
| S5  | S6  | REGISTER INFOT SOURCE            |
| L   | L   | DATA-IN PORT (Di)                |
| L   | н   | FULL ADDER OUTPUTS ( $\Sigma$ i) |
| н   | L   | PUSH-POP STACK OUTPUTS (Qi)      |
| н н |     | REGISTER OUTPUTS (HOLD)          |

TABLE I. REGISTER-SOURCE FUNCTIONS

 $H \equiv high level, L \equiv low level$ 

#### INPUTS INTERNAL OUTPUTS S3 **S4** S5 S6 CLOCK CLEAR QiA Fi HOLD х х Х х н QiA0 Fi0 L х OiA0 CLEAR х х х × I. L L L L 1 Н QiA0\* Di L PUSH-POP ↑ н QiA0\* Σi L ГН L L STACK L L н L 1 н QiA0\* QiA0 "HOLD" QiA0\* L Ĺ Ĥ н н Fi0 t н Σi\* Ði L L L 1 н PUSH-POP L н L н t н Σi\* Σi STACK н L 1 н Σi\* QiA0 L н "LOAD" Σi\* Fi0 L н | н н 1 H QiB0<sup>†</sup> Di н L L L 1 н PUSH-POP н н Ť н QiB0<sup>†</sup> Σi L L STACK н LH L t н QiB0<sup>†</sup> QiA0 "POP" н LH н ↑ н QiB0<sup>†</sup> Fi0 н н L L 1 н Σi‡ Di PUSH-POP н н L н t н Σi‡ Σi STACK Σi‡ н н н L t н QiA0 "PUSH" Σi‡ н н н н t н Fi0

#### TABLE II. PUSH-POP STACK CONTROL AND REGISTER-SOURCE FUNCTIONS

MSB LSB i ≡ 3, 2, 1, 0

Ai ≡ Data inputs

 $QiA \equiv Push-pop stack word A output (internal)$  $QiA0 \equiv the level of Qi before the indicated inputs conditions were established.$  Fi ≅ Device outputs

 ${\rm Fi0} \equiv {\rm the}$  level of  ${\rm Fi}$  before the indicated input

conditions were established.

 $\Sigma i \equiv \text{Adder outputs (internal)}$ 

\*QiB, QiC, QiD do not change

# push-pop stack control

The 4-word push-pop stack can be used for nesting up to four levels of program or return (link) addresses. In the load mode, the first (top) word is filled with new data from the output of the full adder, and no push occurs meaning that previous data at that location is lost. However, all other word locations in the push-pop stack remain unchanged. In the push mode, the new word is again entered in the first (top) location; however, previous data residing in the top three words are pushed down one word location and retained at their new locations. The bottom word is written over and lost.

In the pop mode, words in the push-pop stack move up one location on each clock transition. A unique function is provided by the bottom (fourth) register as its content is retained during the pop mode, and after 3 clock transitions, all words in the stack are filled with the operand/address that occupied the bottom register.

The operand/address will remain available indefinitely if stack functions are limited to the pop or hold modes.

The push-pop stack functions are shown in Tables II and III.

|       | FUNCTION | SE | L. | REG.         | REG.      | REG.      | REG.      | INPUT/  |
|-------|----------|----|----|--------------|-----------|-----------|-----------|---------|
|       | FUNCTION | S3 | S4 | D            | С         | в         | А         | OUTPUT  |
| ВІТ О | LOAD     | L  | н  | QiD0         | QiC0      | QiB0      | ←<br>Σi   | Σί ΙΝ   |
| BIT 1 | PUSH     | н  | н  | ←<br>QiC0    | ←<br>QiB0 | ←<br>QiA0 | ←<br>Σi   | Σi IN   |
| BIT 2 | РОР      | н  | L  | v∩ →<br>QiD0 | →<br>QiD0 | →<br>QiC0 | →<br>QiB0 | QiA OUT |
| віт з | HOLD     | L  | L  | QiD0         | QiC0      | QiB0      | QiA0      | QiA OUT |

#### TABLE III. PUSH-POP STACK FUNCTIONS

µlink operations show previous data location after clock transition.

# full adder

The four-function full adder is controllable from select inputs S1 and S2 to perform:

A or B incrementation, or decrementation of B

Unconditional jumps or relative offsets

No change

Return to zero or one

Incrementation can be implemented by forcing a carry (high) into the ALU. In this mode either of the following options are possible:

- 1. Increment (A plus zero plus carry)
- 2. Increment B (zero plus B plus carry), or decrement B (all highs at A then A plus B with carry input low and disregard, don't use, carry out)
- 3. Increment the jump or offset (A plus B plus carry)

# full adder (continued)

- 4. Start at zero or one and increment on each clock (select zero plus zero plus carry, then select zero plus B plus carry), or set register to N and decrement B (see 2 above).
- 5. No change (carry input is always active and removal of carry combined with either the ALU or register hold mode will retain the current address).

Unconditional jumps can be implemented by applying and selecting the jump directly from the data inputs to the output register. Offset can be accomplished by summing the output register with the offset magnitude (A plus B) with carry low.

The ALU functions are shown in Table IV.

| INP | UTS | INTERNAL             |
|-----|-----|----------------------|
| S1  | S2  | Σi                   |
| н   | н   | 0 PLUS 0 PLUS C-in   |
| н   | L   | 0 PLUS Bi PLUS C-in  |
| L   | н   | Ai PLUS 0 PLUS C-in  |
| L   | L   | Ai PLUS Bi PLUS C-in |

#### TABLE IV. ADDRESS CONTROL FUNCTIONS

# compound generator functions

As the function-select lines of the register sources, push-pop stack, and adder are independent, compound functions can be selected to occur on the next clock transition.

Subroutine branches and returns can be simplified by saving the return or link addresses in the push-pop stack. This branch-and-save function can be accomplished on the same clock time as follows:

| DATA-IN        | ADDER                | PUSH-POP STACK | REGISTER SOURCE |
|----------------|----------------------|----------------|-----------------|
| Branch address | Zero plus B plus one | Push           | Data-in         |
|                | (S1 = H, S2 = L)     | (S3 = S4 = H)  | (S5 = S6 = L)   |

Up to four branches can be made with the return stored in the 4-word push-pop stack.

# absolute maximum ratings over operating free-air temperature (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1) . |          |   |   |   | • |  |   |   |     |   |   | • |   |   | • | • |    |     |      | . 7 V  |
|--|----------|---|---|---|---|--|---|---|-----|---|---|---|---|---|---|---|----|-----|------|--------|
| Input voltage                                  |          |   |   | • |   |  |   |   |     |   | • |   |   |   |   |   |    |     |      | 5.5 V  |
| Off-state output voltage                       |          |   |   |   | • |  |   |   |     |   |   |   |   |   |   |   |    |     |      | 5.5 V  |
| Operating free-air temperature range:          | SN54S482 |   |   |   |   |  |   |   |     |   |   |   |   |   |   |   | 5! | 5°C | to   | 125°C  |
|  | SN74S482 |   |   |   |   |  |   |   |     |   |   |   |   |   |   |   |    | 0°  | C to | 5 70°C |
| Storage temperature range                      |          | • | • | • | • |  | • | · | • • | • | • | • | • | · | • | · | 6  | 5°C | to   | 150°C  |

NOTE 1. All voltage values are with respect to network ground terminal.

# recommended operating conditions

|                                    |                      |     | SN54S482 SN74S482 |     |      |        |      |      |
|------------------------------------|----------------------|-----|-------------------|-----|------|--------|------|------|
|                                    |                      | MIN | NOM               | MAX | MIN  | NOM    | MAX  | UNIT |
| Supply voltage, V <sub>CC</sub>    |                      | 4.5 | 5                 | 5.5 | 4.75 | 5      | 5.25 | V    |
| High lovel entropy and the second  | Carry output         |     |                   | -1  |      |        | 1    |      |
| High-level output current, IOH     | Any F output         |     |                   | 2   |      |        | -2   | ] ma |
|                                    | Carry output         |     |                   | 10  |      |        | 10   |      |
| Low-level output current, IOL      | Any F output         |     |                   | 16  |      |        | 16   |      |
|                                    | Data-in, S5, S6      | 0   | 1                 |     | 01   |        |      |      |
|                                    | Data-in via adder    | 20  | 1                 |     | 15   |        |      |      |
| Setup time, t <sub>su</sub>        | \$1, \$2             | 40  | 1                 |     | 301  |        |      | ns   |
|                                    | \$3, \$4             | 20  | <b>†</b>          |     | 151  |        |      | ]    |
|                                    | Clear-inactive state | 0   | ↑                 |     | 01   |        |      |      |
| Bulan usidah a                     | Clock (high or low)  | 50  |                   |     | 30   |        |      |      |
| Fulse width, t <sub>W</sub>        | Clear (low)          | 15  |                   |     | 15   |        |      | ] ns |
| Clock input rise time, tr          |                      | 20  |                   |     | 25   |        |      | ns   |
|                                    | Data-in, S5, S6      | 30  | 1                 |     | 251  |        |      |      |
|                                    | Data-in via adder    | 15  | 1                 |     | 101  |        |      | 1    |
| Hold time, th                      | S1, S2               | 15  | 1                 |     | 101  |        |      | ] ns |
|                                    | \$3, \$4             | 25  | †                 |     | 201  | 、<br>、 |      |      |
| Operating free-air temperature, TA |                      | -55 |                   | 125 | 0    | 25     | 70   | °C   |

 $\uparrow_{\mathsf{The}}$  arrow indicates that the rising edge of the clock pulse is used for reference.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|         | DADAMET         |                          | 7507.001   | DUTIONOT  | 5   | SN54S48 | 32   | S   | SN74S48 | 32   |        |
|---------|-----------------|--------------------------|--|---|-----|---------|------|-----|---------|------|--------|
|         | PARAMEI         | CK                       | TESTCON  | DITIONS   | MIN | түрŧ    | MAX  | MIN | TYPŦ    | MAX  |        |
| VIH     | High-level inpu | it voltage               |  |   | 2   |         |      | 2   |         |      | V      |
| VIL     | Low-level inpu  | t voltage                |  |   |     |         | 0.8  |     |         | 0.8  | V      |
| VIK     | Input clamp vo  | oltage                   | V <sub>CC</sub> = MIN,                             | l <sub>l</sub> = –18 mA                         |     |         | -1.2 |     |         | -1.2 | V      |
| ∨он     | High-level outp | put voltage              | V <sub>CC</sub> = MIN,<br>V <sub>1L</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>I <sub>OH</sub> = MAX | 2.5 | 3.4     |      | 2.7 | 3.4     |      | v      |
| VOL     | Low-level outp  | ow-level output voltage  |  | V <sub>IH</sub> = 2 V,<br>I <sub>OL</sub> = MAX |     |         | 0.5  |     |         | 0.5  | v      |
| Ц       | Input current a | at maximum input voltage | V <sub>CC</sub> = MAX,                             | V <sub>1</sub> = 5.5 V                          |     |         | 1    |     |         | 1    | mA     |
|         |                 | S1, S2, Cin              |  |   |     |         | 50   |     |         | 50   |        |
| 1       | High-level      | S3, S4, S5, S6, clock    |  | 1 271   |     |         | 100  |     |         | 100  |        |
| 'IH<br> | input current   | Clear                    |  | v   - 2.7 v                                     |     |         | 250  |     |         | 250  |        |
|         |                 | Any A                    |  |   |     |         | 150  |     |         | 150  |        |
|         |                 | S1, S2                   |  |   |     |         | -1   |     | _       | _1   |        |
|         |                 | C-in                     |  |   |     |         | -0.8 |     |         | 0.8  |        |
| 1       | Low-level       | S3, S4                   |  | V 0 5 V   |     |         | -1.2 |     |         | -1.2 |        |
| 146     | input current   | Any A, S5, S6, CK        |  | v] - 0.5 v                                      |     |         | 2    |     |         | 2    | ] [[[] |
|         |                 | Clear                    |  |   |     |         | -4   |     |         | -4   | ]      |
|         |                 | Clock                    |  |   |     |         | -2.8 |     |         | -2.8 | ]      |
| los     | Short-circuit o | utput current§           | V <sub>CC</sub> = MAX                              |   | -40 |         | -110 | -40 |         | -110 | mA     |
| Icc     | Supply current  |                          | V <sub>CC</sub> = MAX                              |   |     | 90      | 130  |     | 90      | 140  | mA     |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>†</sup>All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C.

\$Not more than one output should be shorted at a time.



# TYPES SN54S482, SN74S482 4-BIT-SLICE EXPANDABLE CONTROL ELEMENTS

switching characteristics over recommended operating ranges of T<sub>A</sub> and V<sub>CC</sub> (unless otherwise noted)

| PADAMETED        | EROM   | то         | TEST CONDITIONS          | 5   | SN54S48 | 32  | SM  | 745482 | 2   |      |
|------------------|--------|------------|--------------------------|-----|---------|-----|-----|--------|-----|------|
| FARAMETER        | FROM   | 10         | TEST CONDITIONS          | MIN | TYPŦ    | MAX | MIN | TYPŦ   | MAX | UNIT |
| <sup>t</sup> PLH |        |            |                          |     | 12      | 30  |     | 12     | 25  |      |
| <sup>t</sup> PHL | OLOCIX | BAIA 001   |                          |     | 15      | 30  |     | 15     | 25  | ns   |
| <sup>t</sup> PHL | CLEAR  | DATA OUT   | $C_{1} = 15 \text{ pc}$  |     | 12      | 25  |     | 12     | 20  | ns   |
| <sup>t</sup> PLH |        |            | $C_{L} = 15 \text{ pm},$ |     | 12      | 22  |     | 12     | 18  |      |
| <sup>t</sup> PHL | CARTIN | CANITI OUT | NL - 200 82              |     | 10      | 22  |     | 10     | 18  | 115  |
| <sup>t</sup> PLH |        |            |                          |     | 17      | 30  |     | 17     | 25  |      |
| <sup>t</sup> PHL |        | CANIT OUT  |                          |     | 12      | 30  |     | 12     | 25  | 115  |

<sup>‡</sup>All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> =  $25^{\circ}$ C.



# I<sup>2</sup> L Microcomputer Components



I<sup>2</sup>L MICROPROCESSOR SYSTEM

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\* References to SBP 9900A apply equally to the SBP 9900A-1 throughout this document except in 6.3 Switching Characteristics. SBP 9900A-1 complies with JAN specification MIL-M-38510/46001 and MIL-STD-883 processing.

FIGURE 1 - SBP 9900A AND SBP 9900A-1\* ARCHITECTURE

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# 1. INTRODUCTION

# 1.1 DESCRIPTION

The SBP 9900A microprocessor is a ruggedized monolithic Central Processing Unit (CPU) fabricated with Integrated Injection Logic (I<sup>2</sup>L) technology. The SBP 9900A combines the properties of I<sup>2</sup>L technology with a 16-bit word length, an advanced memory-to-memory architecture, and a full minicomputer instruction set to extend the end application reach of Texas Instruments 9900 microprocessor family into those applications requiring efficient, stable, reliable performance in severe operating environments. I<sup>2</sup>L technology enables the SBP 9900A to operate over a very wide ambient temperature range from a dc power source. Static Logic is used throughout with directly TTL compatible I/O permitting use with standard logic and memory devices and thereby eliminating the need for special clock and interface functions. The SBP 9900A is software compatible with other 9900 microprocessor family members and shares a common body of hardware/software with Texas Instruments 990 minicomputer family. The SBP 9900A-1 continues all the advantages of the SBP 9900A with MIL-M-38512/46001 JAN qualification and MIL-STD-883 processing. In the following discussion all references to the SBP 9900A apply equally to the SBP 9900A-1 except in 6.3 Switching Characteristics.

# 1.2 KEY FEATURES

- Parallel 16-Bit Word Length
- Full Minicomputer Instruction Set Includes Multiply and Divide
- Directly Addresses Up to 65,536 Bytes/32,768 Words of Memory
- Advanced Memory-To-Memory Architecture
- Multiple 16-Word Register Files (Work Spaces) Reside in Memory
- Separate I/O, Memory and Interrupt Bus Structures
- 16 Prioritized Hardware Interrupts
- 16 Software Interrupts (XOPS)
- Programmed and DMA I/O Capability
- Serial I/O Via Communications-Register-Unit (CRU)
- 64-Pin Package
- Software Compatible with TI 9900 Microprocessor/9900 Minicomputer Family
- I<sup>2</sup>L Technology:
  - 2.6 MHz Nominal Clock at 500 mW
  - Single dc Power Supply
  - Fully Static Operation
  - Single Phase Clock
  - Directly TTL Compatible I/O (Including Clock)
  - Operates Over Wide Temperature Range:
    - -55°C to 125°C for SBP 9900AM, SBP 9900AN (883 B)
    - 40°C to 85°C for SBP 9900AE
- SBP 9900A-1 Provided With MIL-M-38510 Qualification and MIL-STD-883 Processing



#### FIGURE 2 - 9900 CPU FLOW CHART

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The SBP 9900A is a 16-bit processor with 69 instructions including byte and bit addressing. The 16-bit word is used to address 32K words or 65K bytes of memory. Processing power comes not only from the 16-bit word length, but also from eight powerful addressing modes and the use of memory as working registers. It is, in fact, this concept called the "Workspace Register" concept that is the most outstanding architectural feature of the SBP 9900A. In contrast to the pushdown stack found in many minicomputers and microprocessors, the workspace register file is a contiguous block of 16 words in memory used as working registers. Storage of intermediate results and subroutine return addresses, as well as index register functions, is accomplished in the workspace.

Most important of all is that each small routine, program or subroutine may have its own 16-word workspace. A workspace pointer (a 16-bit register within the arithmetic unit) points to the first word of the appropriate workspace for any given program. This is especially significant in systems where interrupt processing is used, or where multifunction applications require frequent changes of program context. When an interrupt occurs, for example, there is no need to save register contents and a return address in a stack or other block of memory, because they are all in the workspace. The Program Counter, Status Register, and Workspace Pointer (PC, ST, WP) are saved in three words of the workspace, the WP is set to a new value, pointing to the appropriate service routine, and processing resumes around a new set of workspace registers.

The primary impact of the workspace is to give the program designer 16 "working registers" for *every routine and subroutine;* and because the "registers" are actually memory words, there is no need to save and restore register contents when jumping from one routine to another.

Other important features of the SBP 9900A are vectored interrupts (16 levels), an asynchronous I/O bus, and a Communications Register Unit (CRU) to accommodate I/O circuit cards for a wide variety of peripherals and general interface requirements.

# 2. ARCHITECTURE

The memory word of the 9900 is 16 bits long. Each word is also defined as 2 bytes of 8 bits. The instruction set of the 9900 allows both word and byte operands. Thus, all memory locations are on even address boundaries and byte instructions can address either the even or odd byte. The memory space is 65,536 bytes or 32,768 words. The word and byte formats are shown in Figure 3.



#### FIGURE 3 - WORD AND BYTE FORMATS



3-10

# 2.1 REGISTERS AND MEMORY

The 9900 employs an advanced memory-to-memory architecture. The 9900 memory map is shown in Figure 4.

The first 32 words are used for interrupt trap vectors. The next contiguous block of 32 memory words is used by the extended operation (XOP) instruction for trap vectors. The last two memory words, FFFC<sub>16</sub> and FFFE<sub>16</sub>, are used for the trap vector of the LOAD signal. The remaining memory is then available for programs, data, and workspace registers. If desired, any of the special areas may also be used as general memory.

Three internal registers are accessible to the user. The program counter (PC) contains the address of the instruction following the current instruction being executed. This address is referenced by the processor to fetch the next instruction from memory and is then automatically incremented. The status register (ST) contains the present state of the processor and will be further defined in Section 3.4. The workspace pointer (WP) contains the address of the first word in the currently active set of workspace registers.

A workspace-register file occupies 16 contiguous memory words in the general memory area (see Figure 4). Each workspace register may hold data or addresses and function as operand registers, accumulators, address registers, or index registers. During instruction execution, the processor addresses any register in the workspace by adding the register number to the contents of the workspace pointer and initiating a memory request for the word. The relationship between the workspace pointer and its corresponding workspace is shown in Figure 4.

The workspace concept is particularly valuable during operations that require a context switch which is a change from one program environment to another (as in the case of an interrupt) or to a subroutine. Such an operation, using a conventional multi-register arrangement, requires that at least part of the contents of the register file be stored and reloaded. A memory cycle is required to store or fetch each word. By exchanging the program counter, status register, and workspace pointer in the 9900 concept accomplishes a complete context switch withonly three store cycles and three fetch cycles. See Figure 4. After the switch the workspace pointer contains the starting address of a new 16-word workspace in memory for use in the new routine. A corresponding time saving occurs when the original context is restored. Instructions in the 9900 that result in a context switch include:

- 1. Branch and Load Workspace Pointer (BLWP)
- 2. Return from Subroutine (RTWP)
- 3. Extended Operation (XOP).

Device interrupts, RESET, and LOAD also cause a context switch by forcing the processor to trap to a service subroutine.

# 2.2 INTERRUPTS

The 9900 employs 16 interrupt levels with the highest priority level 0 and lowest level 15. Level 0 is reserved for the RESET function and all other levels may be used for external devices. The external levels may also be shared by several device interrupts, depending upon system requirements.

The 9900 continuously compares the interrupt code (ICO through IC3) with the interrupt mask contained in status-register bits 12 through 15. When the level of the pending interrupt is less than or equal to the enabling mask level (higher or equal priority interrupt), the processor recognizes the interrupt and initiates a context switch following completion of the currently executing instruction. The processor fetches the new context WP and PC from the interrupt vector locations. Then, the previous context WP, PC, and ST are stored in workspace registers 13, 14, and 15, respectively, of the new workspace. The 9900 then forces the interrupt mask to a value that is one less than

the level of the interrupt being serviced. This allows only interrupts of higher priority to interrupt a service routine. The processor also inhibits interrupts until the first instruction of the service routine has been executed. All interrupt requests should remain active until recognized by the processor in the device-service routine. The individual service routines must reset the interrupt requests before the routine is complete.

If a higher priority interrupt occurs, a second context switch occurs to service the higher priority interrupt. When that routine is complete, a return instruction (RTWP) restores the first service routine parameters to the processor to complete processing of the lower-priority interrupt. All interrupt subroutines should terminate with the return instruction to restore original program parameters. The interrupt-vector locations, device assignment, enabling-mask value, and the interrupt code are shown in Table 1.

|                      | Vector Location |                   | Interrupt Mask Values To     | Interrupt    |
|----------------------|-----------------|-------------------|------------------------------|--------------|
| Interrupt Level      | (Memory Address | Device Assignment | Enable Respective Interrupts | Codes        |
|                      | in Hex)         |                   | (ST12 thru ST15)             | IC0 thru IC3 |
| (Highest priority) 0 | 00              | Reset             | 0 through F*                 | 0000         |
| 1                    | 04              | External device   | 1 through F                  | 0001         |
| 2                    | 08              |                   | 2 through F                  | 0010         |
| . 3                  | 0C              |                   | 3 through F                  | 0011         |
| 4                    | 10              |                   | 4 through F                  | 0100         |
| 5                    | 14              |                   | 5 through F                  | 0101         |
| 6                    | 18              |                   | 6 through F                  | 0110         |
| 7                    | 1C              |                   | 7 through F                  | 0111         |
| 8                    | 20              |                   | 8 through F                  | 1000         |
| 9                    | 24              |                   | 9 through F                  | 1001         |
| 10                   | 28              |                   | A through F                  | 1010         |
| 11                   | 2C              |                   | B through F                  | 1011         |
| 12                   | 30              |                   | C through F                  | 1100         |
| 13                   | 34              |                   | D through F                  | 1101         |
| 14                   | 38              | ♥                 | E and F                      | 1110         |
| (Lowest priority) 15 | 3C              | External device   | Fonly                        | 1111         |

TABLE 1 INTERRUPT LEVEL DATA

Level 0 can not be disabled.

The 9900 interrupt interface utilizes standard TTL components as shown in Figure 5. Note that for eight or less external interrupts a single SN54/74148 is required and for one external interrupt INTREQ is used as the interrupt signal with a hard-wired code IC0 through IC3.

# 2.3 I/O INTERFACE COMMUNICATIONS-REGISTER-UNIT (CRU)

The SBP 9900A communications-register-unit (CRU) is a versatile, direct command-driven serial I/O interface. The CRU may directly address, in bit-fields of one to sixteen, up to 4096 peripheral input bits and up to 4096 peripheral output bits. The SBP 9900A executes three single-bit and two multiple-bit CRU instructions. The single-bit instructions include TEST BIT (TB), SET BIT TO ONE (SBO), and SET BIT TO ZERO (SBZ); the multiple-bit instructions include LOAD CRU (LDCR) and STORE CRU (STCR).

The SBP 9900A employs three dedicated I/O signals CRUIN, CRUOUT, CRUCLK, and the least significant twelve bits of the address but to support the CRU interface. CRU interface timing is shown in Section 2.9.



#### FIGURE 5 - SBP 9900A INTERRUPT INTERFACE

### 2.4 SINGLE-BIT CRU OPERATIONS

The 9900 performs three single-bit CRU functions: test bit (TB), set bit to one (SBO), and set bit to zero (SBZ). To identify the bit to be operated upon, the 9900 develops a CRU-bit address and places it on the address bus, A3 to A14.

For the two output operations (SBO and SBZ), the processor also generates a CRUCLK pulse, indicating an output operation to the CRU device, and places bit 7 of the instruction word on the CRUOUT line to accomplish the specified operation (bit 7 is a one for SBO and a zero for SBZ). A test-bit instruction transfers the addressed CRU bit from the CRUIN input line to bit 2 of the status register (EQUAL).

The 9900 develops a CRU-bit address for the single-bit operations from the CRU-base address contained in workspace register 12 and the signed displacement count contained in bits 8 through 15 of the instruction. The displacement allows two's complement addressing from base minus 128 bits through base plus 127 bits. The base address from W12 is added to the signed displacement specified in the instruction and the result is loaded onto the address bus. Figure 6 illustrates the development of a single-bit CRU address.

## 2.5 MULTIPLE-BIT CRU OPERATIONS

The 9900 performs two multiple-bit CRU operations: store communications register (STCR) and load communications register (LDCR). Both operations perform a data transfer from the CRU-to-memory or from memory-to-CRU as illustrated in Figure 8. Although the figure illustrates a full 16-bit transfer operation, any number of bits from 1 through 16 may be involved. The LDCR instruction fetches a word from memory and right-shifts it to serially transfer it to CRU output bits. If the LDCR involves eight or fewer bits, those bits come from the right-justified field within the addressed byte of the memory word. If the LDCR involves nine or more bits, those bits come from the right-justified field within the whole memory word. When transferred to the CRU interface, each successive bit receives an address that is sequentially greater than the address for the previous bit. This addressing mechanism results





#### FIGURE 7 - 9900 LDCR/STCR DATA TRANSFERS

in an order reversal of the bits; that is, bit 15 of the memory word (or bit 7) becomes the lowest addressed bit in the CRU and bit 0 becomes the highest addressed bit in the CRU field.

An STCR instruction transfers data from the CRU to memory. If the operation involves a byte or less transfer, the transferred data will be stored right-justified in the memory byte with leading bits set to zero. If the operation involves from nine to 16 bits, the transferred data is stored right-justified in the memory word with leading bits set to

zero. When the input from the CRU device is complete, the first bit from the CRU is the least-significant-bit position in the memory word or byte.

Figure 8 illustrates how to implement a 16-bit input and a 16-bit output register in the CRU interface. CRU addresses are decoded as needed to implement up to 256 such 16-bit interface registers. In system application, however, only the exact number of interface bits needed to interface specific peripheral devices are implemented. It is not necessary to have a 16-bit interface register to interface an 8-bit device.



FIGURE 8 - 9900 16-BIT INPUT/OUTPUT INTERFACE

# 2.6 EXTERNAL INSTRUCTIONS

The 9900 has five external instructions that allow user-defined external functions to be initiated under program control. These instructions are CKON, CKOF, RSET, IDLE, and LREX. These mnemonics, except for IDLE, relate to functions implemented in the 990 minicomputer and do not restrict use of the instructions to initiate various user-defined functions. IDLE also causes the 9900 to enter the idle state and remain until an interrupt, RESET, or LOAD occurs. When any of these five instructions are executed by the 9900, a unique 3-bit code appears on the most-significant 3 bits of the address bus (A0 through A2) along with a CRUCLK pulse. When the 9900 is in an idle state, the 3-bit code and CRUCLK pulses occur repeatedly until the idle state is terminated. The codes are shown in Table 2.

Figure 9 illustrates typical external decode logic to implement these instructions. Note that a signal is generated to inhibit CRU decodes during external instructions.

|   | EXTERN               | AL INSTRUCT | TIONS |    |  |
|---|----------------------|-------------|-------|----|--|
| ſ | EXTERNAL INSTRUCTION | A0          | A1    | A2 |  |
| I | LREX                 | н           | н     | н  |  |
| l | CKOF                 | н           | н     | L  |  |
|   | CKON                 | н           | L     | н  |  |
|   | RSET                 | L           | H H   | н  |  |
|   | IDLE                 | L.          | н     | L  |  |







# 2.7 LOAD FUNCTION

The LOAD signal allows cold-start ROM loaders and front panels to be implemented for the 9900. When active, LOAD causes the 9900 to initiate an interrupt sequence immediately following the instruction being executed. Memory location FFFC is used to obtain the vector (WP and PC). The old PC, WP and ST are loaded into the new workspace and the interrupt mask is set to 0000. Then, program execution resumes using the new PC and WP.

# 2.8 SBP 9900A PIN DESCRIPTION

| SIGNATURE | PIN | 1/0 | DESCRIPTION  |  |                           |   |                  |
|-----------|-----|-----|--|--|---------------------------|---|------------------|
| A0 (MSB)  | 24  | OUT | ADDRESS BUS<br>A0 (MSB) through A14 (LSB) comprise the<br>address bus. This open-collector bus pro-<br>vides the memory-address vector to the<br>external-memory system when MEMEN is        | GND 1 K<br>GND 2 K<br>WAIT 3 K<br>LOAD 4 K   |                           | 64 HO<br>63 ME<br>62 RE<br>61 WE                                | MEN<br>ADY       |
|           |     |     | active, and I/O-bit addresses to the I/O<br>system when MEMEN is inactive. When<br>HOLDA is active, the address bus is pulled<br>to the logic level HIGH state by the individ-               | HOLDA 5 K<br>RESET 6 K<br>IAQ 7 K            |                           | 1 60 СR<br>59 СУ<br>1 58 NC                                     | UCLK<br>CEND     |
| A14 (LSB) | 10  | ουτ | ual pull-up resistors tied to each respective<br>open-collector output.  | INJ 9 K<br>A14 10 K                          |                           | 157 IN  | ,<br>5<br>4      |
| D0 (MSB)  | 41  | 1/0 | DATA BUS<br>D0 (MSB) through D15 (LSB) comprise the<br>bidirectional open-collector data bus. This<br>bus transfers memory data to (when writ-<br>ing) and from (when reading) the external- | A13 11 K<br>A12 12 K<br>A11 13 K<br>A10 14 K |                           | C 3 54 D13<br>C 3 53 D13<br>C 3 52 D1<br>C 3 52 D1<br>C 3 51 D1 | 3<br>2<br>1<br>0 |
|           | 50  | 1/0 | memory system when MEMEN is active.<br>When HOLDA is active, the data bus is<br>pulled to the logic level HIGH state by the<br>individual pull-up resistors tied to each                     | A9 15 K<br>A8 16 K<br>A7 17 K<br>A6 18 K     |                           | C 1 50 D9<br>C 1 49 D8<br>C 1 48 D7<br>C 1 47 D6                |                  |
| D15 (LSB) | 56  | 1/0 | POWER SUPPLY   | A5 19 P                                      |                           | 46 D5   |                  |
| INJ       | 9   |     | Injector-Supply-Current  |  |                           | Han   |                  |
| INJ       | 26  | ļ   | Injector-Supply-Current  | A3 21 L                                      |                           |   |                  |
| INJ       | 40  |     | Injector-Supply-Current  | A2 22 🛱                                      |                           | <b>                   </b>                                      |                  |
| INJ       | 57  |     | Injector-Supply-Current  | A1 23 🛱                                      |                           | [☐] 42 D1   |                  |
|           |     |     |  | A0 24 🛱                                      |                           | [ <b>□</b> ] 41 D0  |                  |
| GND       | 1   |     | Ground Reference   | NC 25 🕰                                      |                           | ⊏⊐‡40 INJ   | J                |
| GND       | 2   |     | Ground Reference   | IN.I 26 🕊                                    |                           | 133 NC  |                  |
| GND       | 27  |     | Ground Reference   | CND 27 P                                     | 5                         | 1 28 NC   |                  |
| GND       | 28  |     | Ground Reference   |  |                           |   |                  |
|           | 1   |     |  |  |                           | Har in  |                  |
| CLOCK     | 8   | IN  | CLOCK  |  |                           |   | )                |
| OLOOK     | l u |     |  | CR0001 30 6                                  |                           |   |                  |
|           | }   |     | BUS CONTROL  | CRUIN 31                                     | сl                        | H 34 IC2  | :                |
| DBIN      | 29  | ουτ | DATA BUS IN. When active (pulled to logic<br>level HIGH), DBIN indicates that the SBP<br>9900 has disabled its output buffers to<br>allow the memory to place memory-read                    | INTREQ 32 K                                  | <u></u>                   | 33 IC3 لميار  |                  |
|           |     |     | data on the data bus during MEMEN, DBIN<br>remains at logic level LOW in all other cases<br>except when HOLDA is active (pulled to<br>logic level HIGH).                                     | NC-NO Internal                               | connection                |   |                  |
| MEMEN     | 63  | ουτ | MEMORY ENABLE. When active (logic level address.   | LOW), MEMEN ind                              | icates that the address b | us contains a n   | nemory           |
| WE        | 61  | оυт | WRITE ENABLE. When active (logic level LO to be written into memory.   | W), WE indicates th                          | aat the SBP 9900A data    | bus is outputt  | ing data         |

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# TABLE 3 9900 PIN ASSIGNMENTS AND FUNCTIONS

# TABLE 3 (CONTINUED)

| SIGNATURE              | PIN      | 1/0 | DESCRIPTION  |
|------------------------|----------|-----|--|
| CRUCLK                 | 60       | OUT | COMMUNICATIONS-REGISTER-UNIT (CRU) CLOCK. When active (pulled to logic level HIGH),<br>CRUCLK indicates to the external interface logic the presence of output data on CRUOUT, or the<br>presence of an encoded external instruction on A0 through A2.   |
| CRUIN                  | 31       | IN  | CRU DATA IN. CRUIN, normally driven by 3-state or open-collector devices, receives input data from the external interface logic. When the SBP 9900A executes a STCR or TB instruction, it samples CRUIN for the level of the CRU input bit specified by the address bus (A3 through A14).  |
| CRUOUT                 | 30       | OUT | CRU DATA OUT. CRUOUT ouputs serial data when the SBP 9900A executes a LDCR, SBZ, SBO instruction. The data on CRUOUT should be sampled by the external interface logic when CRUCLK goes active (pulled to logic level HIGH).   |
| INTREQ                 | 32       | IN  | INTERRUPT CONTROL<br>INTERRUPT REQUEST. When active (logic level LOW), INTREQ indicates that an external interrupt is<br>requesting service. If INTREQ is active, the SBP 9900A loads the data on the interrupt-code input lines<br>ICO through IC3 into the internal interrupt-code storage register. The code is then compared to the<br>interrupt mask bits of the status register. If equal or higher priority than the enabled interrupt level<br>(interrupt code equal or less than status register bits 12 through 15), the SBP 9900A initiates the interrupt<br>sequence. If the comparison fails, the SBP 9900A ignores the interrupt request. In that case, INTREQ<br>should be held active. The SBP 9900A will continue to sample ICO through IC3 until the program enables<br>a sufficiently low interrupt level to accept the requesting interrupt. |
| ICO (MSB)<br>IC3 (LSB) | 36<br>33 | IN  | INTERRUPT CODES. ICO (MSB) through IC3 (LSB), receiving an interrupt identity code, are sampled by the SBP 9900A when INTREQ is active (logic level LOW). When ICO through IC3 are LLLH, the highest priority <i>external</i> interrupt is requesting service; when HHHH, the lowest priority external interrupt is requesting service.  |
|                        |          |     |  |
| HOLD                   | 64       | IN  | MEMORY CONTROL<br>When active (logic level LOW), HOLD indicates to the SBP 9900A that an external controller (e.g., DMA<br>device) desires to use both the address bus and data bus to transfer data to or from memory. In response,<br>the SBP 9900A enters the hold state after completion of its present memory cycle. The SBP 9900A then<br>allows its address bus, data bus, WE, MEMEN, DBIN, and HOLDA facilities to be pulled to the logic level<br>HIGH state. When HOLD is deactivated, the SBP 9900A returns to normal operation from the point at<br>which it was stopped.  |
| HOLDA                  | 5        | OUT | HOLD ACKNOWLEDGE. When active (pulled to logic level HIGH), HOLDA indicates that the SBP 9900A is in the hold state and that its address bus, data bus, WE, MEMEN, and DBIN facilities are pulled to the logic level HIGH state.   |
| READY                  | 62       | IN  | When active (logic level HIGH), READY indicates that the memory will be ready to read or write during<br>the next clock cycle. When not-ready is indicated during a memory operation, the SBP 9900A enters a<br>wait state and suspends internal operation until the memory systems activate READY.  |
| WAIT                   | 3        | ουτ | When active (pulled to logic level HIGH), WAIT indicates that the SBP 9900A has entered a wait state in response to a not-ready condition from memory.   |
| IAQ                    | 7        | OUT | TIMING AND CONTROL<br>INSTRUCTION ACQUISITION. IAQ is active (pulled to logic level HIGH) during any SBP 9900A initiated<br>instruction acquisition memory cycle. Consequently, IAQ may be used to facilitate detection of illegal op<br>codes.  |
| CYCEND                 | 59       | ΟυΤ | CYCLE END. When active (logic level LOW), CYCEND indicates that the SBP 9900A will initiate a new machine cycle on the low-to-high transition of the next CLOCK.   |
| LOAD                   | 4        | IN  | When active (logic level LOW), LOAD causes the SBP 9900A to execute a nonmaskable interrupt with memory addresses FFFC <sub>16</sub> and FFFE <sub>16</sub> containing the associated trap vectors (WP and PC). The load sequence is initiated after the instruction being executed is completed. LOAD will also terminate an idle state. If LOAD is active during the time RESET is active, the LOAD trap will occur after the RESET  |

function is completed. LOAD should remain active for one instruction execution period (IAQ may be

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#### TABLE 3 (CONCLUDED)

| SIGNATURE    | PIN | 1/0 | DESCRIPTION   |
|--------------|-----|-----|---|
| LOAD (Cont.) |     |     | used to monitor instruction boundaries). LOAD may be used to implement cold-start ROM loaders.<br>Additionally, front-panel routines may be implemented using CRU bits as front-panel-interface signals,<br>and software-control routines to direct the panel operations.   |
| RESET        | 6   | IN  | When active (logic level LOW), $\overline{\text{RESET}}$ causes the SBP 9900A to reset itself and inhibit $\overline{\text{WE}}$ and CRUCLK.<br>When $\overline{\text{RESET}}$ is released, the SBP 9900A initiates a level-zero interrupt sequence acquiring the WP and PC trap vectors from memory locations 0000 <sub>16</sub> and 0002 <sub>16</sub> , sets all status register bits to logic level LOW, and then fetches the first instruction of the reset program environment. $\overline{\text{RESET}}$ must be held active for a |

#### 2.9 SBP 9900A TIMING

# 2.9.1 SBP 9900A MEMORY

The SBP 9900A basic memory timing for a memory-read cycle with no wait states and for a memory-write cycle with one wait state is as shown in Figure 10. During each memory-read or memory-write, MEMEN becomes active (logic level LOW) along with valid memory-address data appearing on the address bus (A0 through A14).



# FIGURE 10 - SBP 9900A MEMORY BUS TIMING

In the case of a memory-read cycle, DBIN becomes active (pulled to logic level HIGH) at the same time memory-address data becomes valid; the memory write strobe WE remains inactive (pulled to logic level HIGH). If the memory-read cycle is initiated for acquisition of an instruction, IAQ becomes active (pulled to logic level HIGH) at the same time MEMEN becomes active. At the end of a memory-read cycle, MEMEN and DBIN together become inactive. At that time, though the address may change, the data bus remains in the input mode until terminated by the next high-to-low transition of the clock.

In the case of a memory-write cycle, WE becomes active (logic level LOW) with the first high-to-low transition of the clock after MEMEN becomes active; DBIN remains inactive. At the end of a memory-write cycle, WE and MEMEN together become inactive.

During either a memory-read or a memory-write operation, READY may be used to extend the duration of the associated memory cycle such that the speed of the memory system may be coordinated with the speed of the SBP 9900. If READY is inactive (logic level LOW) during the first low-to-high transition of the clock after MEMEN becomes active, the SBP 9900A will enter a wait state suspending further progress of the memory cycle. The first low-to-high transistion of the clock after READY becomes active terminates the wait state and allows normal completion of the memory cycle.

# 2.9.2 SBP 9900A HOLD

The hold facilities allow both the SBP 9900A and external devices to share a common memory. To gain memory-bus control, an external device requiring direct memory access (DMA) sends a hold request (HOLD) to the SBP 9900A. When the next available non-memory cycle occurs, the SBP 9900A enters a hold state and signals its surrender of the memory-bus to the external device via a hold acknowledge (HOLDA). Receiving the hold acknowledgement, the external device proceeds to utilize the common memory. After its memory requirements have been satisfied, the external device returns memory-bus control to the SBP 9900A by releasing HOLD.

When HOLD becomes active (logic level LOW), the SBP 9900A enters a hold state at the beginning of the next available non-memory cycle as shown below. Upon entering a hold state, HOLDA becomes active (pulled to logic level HIGH) with the following signals pulled to a HIGH logic level by the individual pull-up resistors tied to each respective open-collector output: DBIN, MEMEN, WE, A0 through A14, and D0 through D15. When HOLD becomes inactive, the SBP 9900A exits the hold state and regains memory-bus control. If HOLD becomes active during a CRU operation, the SBP 9900A uses an extra clock cycle after the deactivation of HOLD to reassert the CRU address thereby providing the normal setup time for the CRU-bit transfer.

#### 2.9.3 SBP 9900A CRU

The transfer of two data-bits from memory to a peripheral CRU device and the transfer of one data-bit from a peripheral CRU device memory are shown in Figure 12. To transfer a data-bit to a peripheral CRU device, the SBP 9900A outputs the corresponding CRU-bit-address on address bus bits A3 through A14 and the respective data-bit on CRUOUT. During the second clock cycle of the operation, the SBP 9900A outputs a pulse, on CRUCLK, indicating to the peripheral CRU device the presence of a data-bit. This process is repeated until transfer of the entire field of data-bits specified by the CRU instruction has been accomplished. To transfer a data-bit from a peripheral CRU device, the SBP 9900A outputs the corresponding CRU-bit-address on address bus bits A3 through A14 and receives the respective data-bit on CRUCLK pulses occur during a CRU input operation.



FIGURE 11 - SBP 9900A HOLD TIMING





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# 3. 9900 INSTRUCTION SET

# 3.1 DEFINITION

Each 9900 instruction performs one of the following operations:

- Arithmetic, logical, comparison, or manipulation operations on data
- Loading or storage of internal registers (program counter, workspace pointer, or status)
- Data transfer between memory and external devices via the CRU
- Control functions.

#### 3.2 ADDRESSING MODES

The 9900 instructions contain a variety of available modes for addressing random-memory data (e.g., program parameters and flags), or formatted memory data (character strings, data lists, etc.). The following figures graphically describe the derivation of the effective address for each addressing mode. The applicability of addressing modes to particular instructions is described in Section 3.5 along with the description of the operations performed by the instruction. The symbols following the names of the addressing modes [R, \*R, \*R+, @ LABEL, or @ TABLE (R)] are the general forms used by 9900 assemblers to select the addressing mode for register R.

## 3.2.1 WORKSPACE REGISTER ADDRESSING R

Workspace Register R contains the operand.



# 3.2.2 WORKSPACE REGISTER INDIRECT ADDRESSING \*R

Workspace Register R contains the address of the operand.



# 3.2.3 WORKSPACE REGISTER INDIRECT AUTO INCREMENT ADDRESSING \*R+

Workspace Register R contains the address of the operand. After acquiring the operand, the contents of workspace register R are incremented.


# 3.2.4 SYMBOLIC (DIRECT) ADDRESSING @ LABEL

The word following the instruction contains the address of the operand.



# 3.2.5 INDEXED ADDRESSING @ TABLE (R)

The word following the instruction contains the base address. Workspace register R contains the index value. The sum of the base address and the index value results in the effective address of the operand.



#### 3.2.6 IMMEDIATE ADDRESSING

The word following the instruction contains the operand.



## 3.2.7 PROGRAM COUNTER RELATIVE ADDRESSING

The 8-bit signed displacement in the right byte (bits 8 through 15) of the instruction is multiplied by 2 and added to the updated contents of the program counter. The result is placed in the PC.



#### 3.2.8 CRU RELATIVE ADDRESSING

The 8-bit signed displacement in the right byte of the instruction is added to the CRU base address (bits 3 through 14 of the workspace register 12). The result is the CRU address of the selected CRU bit.



# 3.3 TERMS AND DEFINITIONS

The terms used in describing the instructions of the 9900 are defined in Table 4.

| TERM           | DEFINITION                                   |
|----------------|--|
| В              | Byte indicator (1=byte, 0 = word)            |
| с              | Bit count                                    |
| D              | Destination address register                 |
| DA             | Destination address                          |
| IOP            | Immediate operand                            |
| LSB(n)         | Least significant (right most) bit of (n)    |
| MSB(n)         | Most significant (left most) bit of (n)      |
| N              | Don't care                                   |
| PC             | Program counter                              |
| Result         | Result of operation performed by instruction |
| S              | Source address register                      |
| SA             | Source address                               |
| ST             | Status register                              |
| STn            | Bit n of status register                     |
| т <sub>D</sub> | Destination address modifier                 |
| т <sub>s</sub> | Source address modifier                      |
| WR             | Workspace register (working register)        |
| WBn            | Workspace register n                         |
| (n)            | Contents of n                                |
| a→b            | a is transferred to b                        |
| Inl            | Absolute value of n                          |
| +              | Arithmetic addition                          |
|                | Arithmetic subtraction                       |
| AND            | Logical AND                                  |
| OR             | Logical OR                                   |
| $\oplus$       | Logical exclusive OR                         |
| n              | Logical complement of n                      |

TABLE 4 TERM DEFINITIONS

# 3.4 STATUS REGISTER

The status register contains the interrupt mask level and information pertaining to the instruction operation. Table 5 explains the bit indications.

| 0   | 1   | 2   | 3   | 4   | 5   | 6   | 7             | 8 | 9 | 10 | 11 | 12 | 13     | 14      | 15    |
|-----|-----|-----|-----|-----|-----|-----|---------------|---|---|----|----|----|--------|---------|-------|
| ST0 | ST1 | ST2 | ST3 | ST4 | ST5 | ST6 | not used (=0) |   |   |    |    |    | ST13   | ST14    | ST 15 |
| L>  | A>  | =   | с   | ο   | Р   | x   |               |   |   |    |    | 1  | nterru | ot Mask | ۲. I  |

| BIT              | NAME       | INSTRUCTION          | CONDITION TO SET BIT TO 1   |
|------------------|------------|----------------------|---|
| ST0              | LOGICAL    | С,СВ                 | If MSB(SA) = 1 and MSB(DA) = 0, or if MSB(SA) = MSB(DA)                               |
|                  | GREATER    |                      | and MSB of $[(DA)-(SA)] = 1$  |
|                  | THAN       | СІ                   | If MSB(WR) = 1 and MSB of IOP = 0, or if MSB(WR) = MSB of                             |
| ]                |            |                      | IOP and MSB of $[IOP-\{WR\}] = 1$   |
|                  |            | ABS                  | If (SA) ≠ 0   |
|                  |            | All Others           | If result $\neq 0$  |
| ST1              | ARITHMETIC | С,СВ                 | If MSB(SA) = 0 and MSB(DA) = 1, or if MSB(SA) = MSB(DA)                               |
| j                | GREATER    |                      | and MSB of $[(DA)-(SA)] = 1$  |
|                  | THAN       | CI                   | If MSB(WR) = 0 and MSB of IOP = 1, or if MSB(WR) = MSB of                             |
|                  |            |                      | IOP and MSB of [IOP-(WR)] = 1   |
|                  |            | ABS                  | If MSB(SA) = 0 and (SA) $\neq$ 0  |
|                  |            | All Others           | If MSB of result = 0 and result $\neq$ 0  |
| ST2              | EQUAL      | C, CB                | If (SA) = (DA)  |
|                  | 1          | C1                   | If (WR) = IOP   |
|                  |            |                      | If (SA) and $(\overline{DA}) = 0$   |
|                  |            | czc                  | If $(SA)$ and $(DA) = 0$  |
|                  | [          | тв                   | If CRUIN = 1  |
|                  |            | ABS                  | If (SA) = 0   |
|                  |            | All Others           | If result = 0   |
| ST3              | CARRY      | A, AB, ABS, AI, DEC, |   |
|                  | 1          | DECT, INC, INCT,     | If CARRY OUT = 1  |
|                  |            | NEG, S, SB           |   |
|                  |            | SLA, SRA, SRC, SRL   | If last bit shifted out = 1   |
| ST4              | OVERFLOW   | A, AB                | If MSB(SA) = MSB(DA) and MSB of result $\neq$ MSB(DA)                                 |
|                  | 1          | AI                   | If MSB(WR) = MSB of IOP and MSB of result $\neq$ MSB(WR)                              |
|                  |            | S, SB                | If MSB(SA) $\neq$ MSB(DA) and MSB of result $\neq$ MSB(DA)                            |
|                  |            | DEC, DECT            | If MSB(SA) = 1 and MSB of result = 0  |
|                  |            | INC, INCT            | If MSB(SA) = 0 and MSB of result = 1  |
|                  |            | SLA                  | If MSB changes during shift   |
|                  |            | עוס                  | If MSB(SA) = 0 and MSB(DA) = 1, or if MSB(SA) = MSB(DA)<br>and MSB of $(DA)$ (SA) = 0 |
|                  |            | ARE NEC              | and wish of [(DA)-(SA)] = 0   |
| OTE              | BADITY     | ABS, NEG             | $\frac{11}{3} (3A) \sim 300016$   |
| 515              |            | LDCD STCD            | If $(SA)$ has been humber of 1's  |
|                  |            |                      | If result has odd number of 1's   |
| STE              | XOP.       | X0P                  | If YOP instruction is executed  |
| 510<br>CT12 CT15 |            |                      | If corresponding bit of IOP is 1  |
| 3112-3115        | MASK       |                      | If corresponding bit of WR15 is 1   |
|                  | INAON      | L DIME               | in corresponding bit of Withole i   |

TABLE 5 STATUS REGISTER BIT DEFINITIONS

# 3.5 INSTRUCTIONS

# 3.5.1 Dual Operand Instructions with Multiple Addressing Modes for Source and Destination Operand



If B = 1 the operands are bytes and the operand addresses are byte addresses. If B = 0 the operands are words and the operand addresses are word addresses.

The addressing mode for each operand is determined by the T field of that operand.

| T <sub>S</sub> OR T <sub>D</sub> | S OR D   | ADDRESSING MODE                            | NOTES |
|----------------------------------|----------|--|-------|
| 00                               | 0, 1, 15 | Workspace register                         | . 1   |
| 01                               | 0, 1, 15 | Workspace register indirect                |       |
| 10                               | 0        | Symbolic                                   | 4     |
| 10                               | 1, 2, 15 | Indexed                                    | 2,4   |
| 11                               | 0, 1, 15 | Workspace register indirect auto-increment | 3     |

NOTES: 1, When a workspace register is the operand of a byte instruction (bit 3 = 1), the left byte (bits 0 through 7) is the operand and the right byte (bits 8 through 15) is unchanged,

2. Workspace register 0 may not be used for indexing.

3. The workspace register is incremented by 1 for byte instructions (bit 3 = 1) and is incremented by 2 for word instructions (bit 3 = 0). 4. When  $T_S = T_D = 10$ , two words are required in addition to the instruction word. The first word is the source operand base

address and the second word is the destination operand base address.

|          | OF | cc | DE | в |                                | RESULT   | STATUS   |                              |
|----------|----|----|----|---|--------------------------------|----------|----------|------------------------------|
| MNEMONIC | 0  | 1  | 2  | 3 | MEANING                        | COMPARED | BITS     | DESCRIPTION                  |
|          |    | -  | _  | - |                                | TO 0     | AFFECTED |                              |
| A        | 1  | 0  | 1  | 0 | Add                            | Yes      | 0-4      | (SA)+(DA) → (DA)             |
| AB       | 1  | 0  | 1  | 1 | Add byte <del>s</del>          | Yes      | 0-5      | (SA)+(DA) → (DA)             |
| с        | 1  | 0  | 0  | 0 | Compare                        | No       | 0-2      | Compare (SA) to (DA) and set |
|          |    |    |    |   |                                |          |          | appropriate status bits      |
| СВ       | 1  | 0  | 0  | 1 | Compare bytes                  | No       | 0-2,5    | Compare (SA) to (DA) and set |
|          |    |    |    |   |                                | ļ        |          | appropriate status bits      |
| s        | 0  | 1  | 1  | 0 | Subtract                       | Yes      | 0-4      | (DA) (SA) -→ (DA)            |
| SB       | 0  | 1  | 1  | 1 | Subtract bytes                 | Yes      | 0-5      | (DA) – (SA) → (DA)           |
| soc      | 1  | 1  | 1  | 0 | Set ones corresponding         | Yes      | 0-2      | (DA) OR (SA) → (DA)          |
| SOCB     | 1  | 1  | 1  | 1 | Set ones corresponding bytes   | Yes      | 0-2,5    | (DA) OR (SA) → (DA)          |
| szc      | 0  | 1  | 0  | 0 | Set zeroes corresponding       | Yes      | 0-2      | (DA) AND (SA) → (DA)         |
| SZCB     | 0  | 1  | 0  | 1 | Set zeroes corresponding bytes | Yes      | 0-2,5    | (DA) AND (SA) → (DA)         |
| MOV      | 1  | 1  | 0  | 0 | Move                           | Yes      | 0-2      | $(SA) \rightarrow (DA)$      |
| MOVB     | 1  | 1  | 0  | 1 | Move bytes                     | Yes      | 0-2,5    | $(SA) \rightarrow (DA)$      |

# 3.5.2 Dual Operand Instructions with Multiple Addressing Modes for the Source Operand and Workspace Register Addressing for the Destination

|                 | 0 | 1 | 2     | 3   | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----------------|---|---|-------|-----|---|---|---|---|---|---|----|----|----|----|----|----|
| General format: |   |   | OP CC | DDE |   |   |   | D |   |   | Т  | s  |    | 5  | 3  |    |

The addressing mode for the source operand is determined by the  $T_S$  field.

| т <sub>s</sub> | S        | ADDRESSING MODE                            | NOTES |
|----------------|----------|--|-------|
| 00             | 0, 1, 15 | Workspace register                         |       |
| 01             | 0, 1, 15 | Workspace register indirect                |       |
| 10             | 0        | Symbolic                                   |       |
| 10             | 1, 2, 15 | Indexed                                    | 1     |
| 11             | 0, 1, 15 | Workspace register indirect auto increment | 2     |

NOTES: 1. Workspace register 0 may not be used for indexing.

2. The workspace register is incremented by 2.

| MNEMONIC | OP CODE<br>0 1 2 3 4 5 | MEANING                        | RESULT<br>COMPARED<br>TO 0 | STATUS<br>BITS<br>AFFECTED | DESCRIPTION   |
|----------|------------------------|--------------------------------|----------------------------|----------------------------|---|
| coc      | 001000                 | Compare ones                   | No                         | 2                          | Test (D) to determine if 1's are in each bit<br>position where 1's are in (SA). If so, set ST2.   |
| czc      | 001001                 | Compare zeros<br>corresponding | No                         | 2                          | Test (D) to determine if 0's are in each bit position where 1's are in (SA). If so, set ST2.  |
| XOR      | 001010                 | Exclusive OR                   | Yes                        | 0-2                        | $(D) \bigoplus (SA) \rightarrow (D)$  |
| MPY      | 001110                 | Multiply                       | No                         |                            | Multiply unsigned (D) by unsigned (SA) and  |
|          |                        |                                |                            |                            | place unsigned 32-bit product in D (most<br>significant) and D+1 (least significant). If WR15<br>is D, the next word in memory after WR15 will<br>be used for the least significant half of the<br>product.   |
| DIV      | 001111                 | Divide                         | No                         | 4                          | If unsigned (SA) is less than or equal to unsigned<br>(D), perform no operation and set ST4. Otherwise,<br>divide unsigned (D) and (D+1) by unsigned<br>(SA). Quotient $\rightarrow$ (D), remainder $\rightarrow$ (D+1). If<br>D = 15, the next word in memory after WR 15<br>will be used for the remainder. |

### 3.5.3 Extended Operation (XOP) Instruction

|                 | 0 | 1 | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----------------|---|---|---|---|---|---|---|---|---|---|----|----|----|----|----|----|
| General format: | 0 | 0 | 1 | 0 | 1 | 1 |   | D |   |   | т  | s  |    | 5  | 3  |    |

The T<sub>S</sub> and S fields provide multiple mode addressing capability for the source operand. When the XOP is executed, ST6 is set and the following transfers occur:  $(40_{16} + 4D) \rightarrow (WP)$ 

 $(4216 + 4D) \rightarrow (PC)$ SA  $\rightarrow$  (new WR11) (old WP)  $\rightarrow$  (new WR13) (old PC)  $\rightarrow$  (new WR14) (old ST)  $\rightarrow$  (new WR15)

The 9900 does not test interrupt requests (INTREQ) upon completion of the XOP instruction.

# 3.5.4 Single Operand Instructions

|                 | 0 | 1 | 2 | 3 | 4    | 5   | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----------------|---|---|---|---|------|-----|---|---|---|---|----|----|----|----|----|----|
| General format: |   |   |   |   | OP C | ODE |   | _ |   |   | т  | s  |    | 5  | 3  |    |

,

The T<sub>S</sub> and S fields provide multiple mode addressing capability for the source operand.

| MNEMONIC                              | OP CODE<br>0 1 2 3 4 5 6 7 8 9 | MEANING           | RESULT<br>COMPARED | STATUS<br>BITS | DESCRIPTION                                       |
|---------------------------------------|--------------------------------|-------------------|--------------------|----------------|---|
|                                       |                                | <u> </u>          |                    | AFFECTED       |   |
| В                                     | 0000010001                     | Branch            | No                 | -              | $SA \rightarrow (PC)$                             |
| BL                                    | 0000011010                     | Branch and link   | No                 | -              | $(PC) \rightarrow (WR11); SA \rightarrow (PC)$    |
| BLWP                                  | 0000010000                     | Branch and load   | No                 | -              | $(SA) \rightarrow (WP); (SA+2) \rightarrow (PC);$ |
|                                       |                                | workspace pointer |                    |                | (old WP) $\rightarrow$ (new WR 13);               |
|                                       |                                |                   |                    |                | (old PC) $\rightarrow$ (new WR14);                |
|                                       |                                |                   |                    |                | (old ST) → (new WR15);                            |
|                                       |                                |                   |                    |                | the interrupt input (INTREQ) is not               |
| · · · · · · · · · · · · · · · · · · · |                                |                   |                    |                | tested upon completion of the                     |
|                                       |                                |                   |                    |                | BLWP instruction.                                 |
| CLR                                   | 0000010011                     | Clear operand     | No                 | _              | 0→ (SA)   |
| SETO                                  | 0000011100                     | Set to ones       | No                 | -              | FFFF16→(SA)                                       |
| INV                                   | 0000010101                     | Invert            | Yes                | 0-2            | $(\overline{SA}) \rightarrow (SA)$                |
| NEG                                   | 0000010100                     | Negate            | Yes                | 0-4            | –(SA) → (SA)                                      |
| ABS                                   | 0000011101                     | Absolute value*   | No                 | 0-4            | (SA)  → (SA)                                      |
| SWPB                                  | 0000011011                     | Swap bytes        | No                 | -              | (SA), bits 0 thru 7 → (SA), bits                  |
|                                       |                                | 1                 |                    |                | 8 thru 15; (SA), bits 8 thru 15 →                 |
|                                       |                                |                   |                    |                | (SA), bits 0 thru 7.                              |
| INC                                   | 0000010110                     | Increment         | Yes                | 0-4            | (SA) + 1 → (SA)                                   |
| INCT                                  | 0000010111                     | Increment by two  | Yes                | 0-4            | (SA) + 2→(SA)                                     |
| DEC                                   | 0000011000                     | Decrement         | Yes                | 0-4            | (SA) – 1 → (SA)                                   |
| DECT                                  | 0000011001                     | Decrement by two  | Yes                | 0-4            | (SA) – 2 → (SA)                                   |
| X†                                    | 0000010010                     | Execute           | No                 | -              | Execute the instruction at SA.                    |
|                                       |                                |                   |                    |                |   |

\* Operand is compared to zero for status bit.

<sup>†</sup> If additional memory words for the execute instruction are required to define the operands of the instruction located at SA, these words will be accessed from PC and the PC will be updated accordingly. The instruction acquisition signal (IAQ) will not be true when the accesses the instruction at SA. Status bits are affected in the normal manner for the instruction executed.

#### 3.5.5 CRU Multiple-Bit Instructions

|                 | 0 | 1 | 2    | 3   | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----------------|---|---|------|-----|---|---|---|---|---|---|----|----|----|----|----|----|
| General format: |   |   | OP C | ODE |   |   |   | с |   |   | т  | s  |    | 5  | 3  |    |

The C field specifies the number of bits to be transferred. If C = 0, 16 bits will be transferred. The CRU base register (WR12, bits 3 through 14) defines the starting CRU bit address. The bits are transferred serially and the CRU address is incremented with each bit transfer, although the contents of WR12 is not affected. T<sub>S</sub> and S provide multiple mode addressing capability for the source operand. If 8 or fewer bits are transferred (C = 1 through 8), the source address is a byte address. If 9 or more bits are transferred (C = 0, 9 through 15), the source address is a word address. If the source is addressed in the workspace register indirect auto increment mode, the workspace register is incremented by 1 if C = 1 through 8, and is incremented by 2 otherwise.

| MNEMONUC  | OP CODE | MEANUNG                     | RESULT | STATUS   | DECORIDATION  |
|-----------|---------|-----------------------------|--------|----------|---|
| MINEMONIC | 012345  | MEANING                     | TO 0   | AFFECTED | DESCRIPTION   |
| LDCR      | 001100  | Load communcation register  | Yes    | 0-2,5†   | Beginning with LSB of (SA), transfer the<br>specified number of bits from (SA) to<br>the CRU.                                     |
| STCR      | 001101  | Store communcation register | Yes    | 0-2,5†   | Beginning with LSB of (SA), transfer the<br>specified number of bits from the CRU to<br>(SA). Load unfilled bit positions with 0. |

<sup>†</sup>ST5 is affected only if  $1 \le C \le 8$ .

#### 3.5.6 CRU Single-Bit Instructions

|                 | 0 | 1 | 2 | 3     | 4  | 5 | 6 | 7 | 8 | 9 | 10    | 11    | 12    | 13   | 14 | 15 |
|-----------------|---|---|---|-------|----|---|---|---|---|---|-------|-------|-------|------|----|----|
| General format: |   |   |   | OP CC | DE |   |   |   |   |   | SIGNE | D DIS | PLACE | MENT |    |    |

CRU relative addressing is used to address the selected CRU bit.

| MNEMONIC | OP CODE<br>0 1 2 3 4 5 6 7 | MEANING         | STATUS<br>BITS<br>AFFECTED | DESCRIPTION                                 |
|----------|----------------------------|-----------------|----------------------------|---|
| SBO      | 00011101                   | Set bit to one  | _                          | Set the selected CRU output bit to 1.       |
| SBZ      | 00011110                   | Set bit to zero |                            | Set the selected CRU output bit to 0.       |
| тв       | 00011111                   | Test bit        | 2                          | If the selected CRU input bit = 1, set ST2. |

# 3.5.7 Jump Instructions

|                 | 0 | 1       | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11    | 12    | 13 | 14 | 15 |
|-----------------|---|---------|---|---|---|---|---|---|---|---|----|-------|-------|----|----|----|
| General format: |   | OP CODE |   |   |   |   |   |   |   |   | D  | ISPLA | CEMEN | IT |    |    |

Jump instructions cause the PC to be loaded with the value selected by PC relative addressing if the bits of ST are at specified values. Otherwise, no operation occurs and the next instruction is executed since PC points to the next instruction. The displacement field is a word count to be added to PC. Thus, the jump instruction has a range of -128 to 127 words from memory-word address following the jump instruction. No ST bits are affected by jump instruction.

|           | OP CODE         | MEANING            | ST CONDITION TO LOAD BC |
|-----------|-----------------|--------------------|-------------------------|
| MINEMONIC | 0 1 2 3 4 5 6 7 | MEANING            |                         |
| JEQ       | 0 0 0 1 0 0 1 1 | Jump equal         | ST2 = 1                 |
| JGT       | 0 0 1 0 1 0 1   | Jump greater than  | ST1 = 1                 |
| JH        | 0 0 0 1 1 0 1 1 | Jump high          | ST0 = 1 and ST2 = 0     |
| JHE       | 0 0 0 1 0 1 0 0 | Jump high or equal | ST0 = 1 or ST2 = 1      |
| JL .      | 0 0 0 1 1 0 1 0 | Jump low           | ST0 = 0 and ST2 = 0     |
| JLE       | 0 0 0 1 0 0 1 0 | Jump low or equal  | ST0 ≈ 0 or ST2 = 1      |
| JLT       | 0 0 0 1 0 0 0 1 | Jump less than     | ST1 = 0 and ST2 = 0     |
| JMP       | 0 0 0 1 0 0 0 0 | Jump unconditional | unconditional           |
| ЛИС       | 0 0 0 1 0 1 1 1 | Jump no carry      | ST3 = 0                 |
| JNE       | 0 0 0 1 0 1 1 0 | Jump not equal     | ST2 = 0                 |
| JNO       | 0 0 0 1 1 0 0 1 | Jump no overflow   | ST4 = 0                 |
| JOC       | 0 0 0 1 1 0 0 0 | Jump on carry      | ST3 = 1                 |
| JOP       | 0 0 0 1 1 1 0 0 | Jump odd parity    | ST5 = 1                 |

#### 3.5.8 Shift Instructions

|                 | 0 | 1       | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----------------|---|---------|---|---|---|---|---|---|---|---|----|----|----|----|----|----|
| General format: |   | OP CODE |   |   |   |   |   |   |   | ( | C  |    |    | v  | v  |    |

If C = 0, bits 12 through 15 of WR0 contain the shift count. If C = 0 and bits 12 through 15 of WR0 = 0, the shift count is 16.

|          |   |   | o | P C | :00 | DE |   |   |                        | RESULT   | STATUS   |                                      |
|----------|---|---|---|-----|-----|----|---|---|------------------------|----------|----------|--------------------------------------|
| MNEMONIC | 0 | 1 | 2 | 3   | 4   | 5  | 6 | 7 | MEANING                | COMPARED | BITS     | DESCRIPTION                          |
| L        |   |   |   |     |     |    |   |   |                        | <u> </u> | AFFECTED |                                      |
| SLA      | 0 | 0 | 0 | 0   | 1   | 0  | 1 | 0 | Shift left arithmetic  | Yes      | 0-4      | Shift (WR) left, Fill vacated bit    |
|          |   |   |   |     |     |    |   |   |                        |          |          | positions with 0.                    |
| SRA      | 0 | 0 | 0 | 0   | 1   | 0  | 0 | 0 | Shift right arithmetic | Yes      | 0-3      | Shift (WR) right. Fill vacated bit   |
|          |   |   |   |     |     |    |   |   |                        |          |          | positions with original MSB of (WR). |
| SRC      | 0 | 0 | 0 | 0   | 1   | 0  | 1 | 1 | Shift right circular   | Yes      | 0-3      | Shift (WR) right. Shift previous LSB |
|          |   |   |   |     |     |    |   |   |                        |          |          | into MSB.                            |
| SRL      | 0 | 0 | 0 | 0   | 1   | 0  | 0 | 1 | Shift right logical    | Yes      | 0-3      | Shift (WR) right. Fill vacated bit   |
|          |   |   |   |     |     |    |   |   |                        |          |          | positions with O's.                  |

# 3.5.9 Immediate Register Instructions

|                 | 0 | 1 | 2 | 3 | 4 | 5     | 6 | 7 | 8   | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----------------|---|---|---|---|---|-------|---|---|-----|---|----|----|----|----|----|----|
| General format: |   |   |   |   | 0 | P COD | E |   |     |   |    | N  |    | ١  | N  |    |
|                 |   |   |   |   |   |       |   |   | IOP |   |    |    |    |    |    |    |

|           | OP CODE      | MEANING        | RESULT | STATUS   | DESODIDION                 |
|-----------|--------------|----------------|--------|----------|----------------------------|
| MINEMONIC | 012345678910 | MEANING        | TO 0   | AFFECTED | DESCRIPTION                |
| AI        | 00000010001  | Add immediate  | Yes    | 0-4      | (WR) + IOP → (WR)          |
| ANDI      | 00000010010  | AND immediate  | Yes    | 0-2      | (WR) AND IOP → (WR)        |
| СІ        | 00000010100  | Compare        | Yes    | 0-2      | Compare (W) to IOP and set |
|           |              | immediate      |        |          | appropriate status bits    |
| LI        | 00000010000  | Load immediate | Yes    | 0-2      | IOP → (WR)                 |
| ORI       | 00000010011  | OR immediate   | Yes    | 0-2      | (WR) OR IOP → (WR)         |

# 3.5.10 Internal Register Load Immediate Instructions

|                 | 0 | 1 | 2 | 3 | 4 | 5     | 6   | 7   | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----------------|---|---|---|---|---|-------|-----|-----|---|---|----|----|----|----|----|----|
| General format: |   |   |   |   |   | OP CC | DDE |     |   |   |    |    |    | N  |    |    |
|                 |   |   |   |   |   |       |     | IOP |   |   |    |    |    |    |    |    |

|          |   |   |   | C | )P ( | col | DE |   |   |   |    |                                  |   |
|----------|---|---|---|---|------|-----|----|---|---|---|----|----------------------------------|---|
| MNEMONIC | 0 | 1 | 2 | 3 | 4    | .5  | 6  | 7 | 8 | 9 | 10 | MEANING                          | DESCRIPTION                                 |
| LWPI     | 0 | 0 | 0 | 0 | 0    | 0   | 1  | 0 | 1 | 1 | 1  | Load workspace pointer immediate | IOP $\rightarrow$ (WP), no ST bits affected |
| LIMI     | 0 | 0 | 0 | 0 | 0    | 0   | 1  | 1 | 0 | 0 | 0  | Load interrupt mask              | IOP, bits 12 thru 15 → ST12                 |
|          |   |   |   |   |      |     |    |   |   |   |    |                                  | thru ST15                                   |

#### 3.5.11 Internal Register Store Instructions

|                 | 0 | 1 | 2 | 3 | 4 | 5     | 6   | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----------------|---|---|---|---|---|-------|-----|---|---|---|----|----|----|----|----|----|
| General format: |   |   |   |   |   | OP CC | DDE |   |   |   |    | N  |    | ١  | N  |    |

No ST bits are affected.

| MNEMONIC |   |   |   | С | PC | :00 | DE |   |   |   |    | MEANING                 | DESCRIPTION |  |
|----------|---|---|---|---|----|-----|----|---|---|---|----|-------------------------|-------------|--|
|          | 0 | 1 | 2 | 3 | 4  | 5   | 6  | 7 | 8 | 9 | 10 | MEANING                 |             |  |
| STST     | 0 | 0 | 0 | 0 | 0  | 0   | 1  | 0 | 1 | 1 | 0  | Store status register   | (ST) → (WR) |  |
| STWP     | 0 | 0 | 0 | 0 | 0  | 0   | 1  | 0 | 1 | 0 | 1  | Store workspace pointer | (WP) → (WR) |  |

# 3.5.12 Return Workspace Pointer (RTWP) Instruction



#### 3.5.13 External Instructions

|                 | 0 | 1 | 2 | 3 | 4 | 5     | 6   | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
|-----------------|---|---|---|---|---|-------|-----|---|---|---|----|----|----|----|----|----|
| General format: | 1 |   |   |   |   | OP CC | DDE |   |   |   |    |    |    | N  |    |    |

External instructions cause the three most-significant address lines (A0 through A2) to be set to the below-described levels and the CRUCLK line to be pulsed, allowing external control functions to be initiated.

| MNEMONIC | OP CODE                | MEANING      | STATUS   | DESCRIPTION  | ADDRESS |    |    |  |
|----------|------------------------|--------------|----------|--|---------|----|----|--|
|          | 0 1 2 3 4 5 6 7 8 9 10 |              | AFFECTED | D  |         | A1 | A2 |  |
| IDLE     | 0 0 0 0 0 0 1 1 0 1 0  | Idle         | -        | Suspend SBP 9900A<br>instruction execution until<br>an interrupt, LOAD, or<br>RESET occurs | L       | н  | L  |  |
| RSET     | 00000011011            | Reset        | 1215     | 0 → ST12 thru ST15   | L       | н  | н  |  |
| CKOF     | 00000011110            | User defined |          |  | н       | н  | L  |  |
| CKON     | 00000011101            | User defined |          |  | н       | Ł  | н  |  |
| LREX     | 00000011111            | User defined |          |  | н       | н  | Н  |  |

#### 3.6 MICROINSTRUCTION CYCLE

The SBP 9900A includes circuitry which will indicate the completion of a microinstruction cycle. Designated as the CYCEND function, it provides CPU status that can simplify system design. The CYCEND output will go to a low logic level as a result of the low-to-high transistion of each clock pulse which initiates the last clock of a microinstruction.

#### 3.7 SBP 9900A INSTRUCTION EXECUTION TIMES

Instruction execution times for the SBP 9900A are a function of:

- 1) Clock cycle time, t<sub>c</sub>
- 2) Addressing mode used where operands have multiple addressing mode capability
- 3) Number of wait states required per memory access.

The following Table 6 lists the number of clock cycles and memory accesses required to execute each SBP 9900A instruction. For instructions with multiple addressing modes for either or both operands, the table lists the number of clock cycles and memory accesses with all operands addressed in the workspace-register mode. To determine the additional number of clock cycles and memory accesses required for modified addressing, add the appropriate values from the referenced tables. The total instruction-execution time for an instruction is:

$$T = t_c (C + W \cdot M)$$

where:

T = total instruction execution time;

- t<sub>c</sub> = clock cycle time;
- C = number of clock cycles for instruction execution plus address modification;
- W = number of required wait states per memory access for instruction execution plus address modification:
- M = number of memory accesses.

As an example, the instruction MOVB is used in a system with  $t_c = 0.5 \ \mu s$  and no wait states are required to access memory. Both operands are addressed in the workspace register mode:

 $T = t_{C} (C + W \cdot M) = 0.5 (14 + 0 \cdot 4) \mu s = 7 \mu s.$ 

If two wait states per memory access were required, the execution time is:

 $T = 0.5 (14 + 2 \cdot 4) \mu s = 11 \mu s.$ 

If the source operand was addressed in the symbolic mode and two wait states were required:

 $T = t_{C} (C + W \cdot M)$  C = 14 + 8 = 22 M = 4 + 1 = 5 $T = 0.5 (22 + 2 \cdot 5) \mu s = 16 \mu s.$ 

# TABLE 6 INSTRUCTION EXECUTION TIMES

|  | CLOCK  | MEMORY | ADDR     | ESS               |   | CLOCK  | MEMORY | ADDR    | ESS      |
|--|--------|--------|----------|-------------------|---|--------|--------|---------|----------|
| INSTRUCTION  | CYCLES | ACCESS | MODIFICA | TION <sup>†</sup> | INSTRUCTION   | CYCLES | ACCESS | MODIFIC | ATIONT   |
|  | С      | м      | SOURCE   | DEST              |   | С      | м      | SOURCE  | DEST     |
| Α  | 14     | 4      | Α        | A                 | LWPI  | 10     | 2      | -       | -        |
| AB   | 14     | 4      | В        | В                 | MOV   | 14     | 4      | A       | A        |
| ABS (MSB = 0)  | 12     | 2      | A        | -                 | MOVB  | 14     | 4      | В       | 8        |
| (MSB = 1)  | 14     | 3      | А        | -                 | MPY   | 52     | 5      | А       | -        |
| AI   | 14     | 4      | -        | -                 | NEG   | 12     | 3      | A       | -        |
| ANDI   | 14     | 4      | -        | -                 | ORI   | 14     | 4      | -       | -        |
| В  | 8      | 2      | А        | -                 | RSET  | 12     | 1      | -       | -        |
| BL   | 12     | 3      | А        | -                 | RTWP  | 14     | 4      |         | -        |
| BLWP   | 26     | 6      | A        | -                 | S   | 14     | 4      | А       | A        |
| с  | 14     | 3      | А        | А                 | SB  | 14     | 4      | в       | 8        |
| СВ   | 14     | 3      | В        | в                 | SBO   | 12     | 2      | ·       |          |
| CI   | 14     | 3      | -        | -                 | SBZ   | 12     |        | -       | -        |
| CKOF   | 12     | 1      | -        |                   | SETO  | 10     | 3      | А       |          |
| CKON   | 12     | 1      | -        | -                 | Shift (C≠0)   | 12+2C  | 3      |         | -        |
| CLR  | 10     | 3      | А        | -                 | (C = 0, Bits 12-15  |        |        |         |          |
| coc  | 14     | 3      | А        | -                 | of WRO = 0)   | 52     | 4      | -       | -        |
| CZC  | 14     | 3      | А        | -                 | (C = 0, Bits 12-15)   |        |        |         |          |
| DEC  | 10     | 3      | А        | -                 | of WRP = N ≠ 0)   | 20+2N  | 4      | -       | _        |
| DECT   | 10     | 3      | А        | -                 | SOC   | 14     | 4      | А       | A        |
| DIV (ST4 is set)   | 16     | 3      | А        | _                 | SOCB  | 14     | 4      | в       | В        |
| DIV (ST4 is reset)*  | 92-124 | 6      | А        | -                 | STCR (C = $0$ )   | 60     | 4      | A       | -        |
| IDLE   | 12     | 1      | -        |                   | (1 <c<7)< td=""><td>42</td><td>4</td><td>В</td><td>-</td></c<7)<>   | 42     | 4      | В       | -        |
| INC  | 10     | 3      | А        | -                 | (C = 8)   | 44     | 4      | в       | -        |
| INCT   | 10     | 3      | А        | -                 | (9 <c<15)< td=""><td>58</td><td>4</td><td>А</td><td>-</td></c<15)<> | 58     | 4      | А       | -        |
| INV  | 10     | 3      | А        |                   | STST  | 8      | 2      | -       | -        |
| Jump (PC is changed)   | 10     | 1      | -        | -                 | STWP  | 8      | 2      | -       | -        |
| (PC is not changed)  | 8      | 1      | -        | -                 | SWPB  | 10     | 3      | А       |          |
| LDCR (C = 0)   | 52     | 3      | А        | _ ·               | szc   | 14     | 4      | А       | A        |
| (1 <c<8)< td=""><td>20+2C</td><td>3</td><td>В</td><td>-</td><td>SZCB</td><td>14</td><td>4</td><td>в</td><td>в</td></c<8)<> | 20+2C  | 3      | В        | -                 | SZCB  | 14     | 4      | в       | в        |
| (9 <c<15)< td=""><td>20+2C</td><td>3</td><td>А</td><td>-</td><td>тв</td><td>12</td><td>2</td><td></td><td>-</td></c<15)<>  | 20+2C  | 3      | А        | -                 | тв  | 12     | 2      |         | -        |
| LI   | 12     | 3      | -        | -                 | X**   | 8      | 2      | А       | -        |
| LIMI   | 14     | 2      | -        | -                 | XOP   | 36     | 8      | А       | -        |
| LREX   | 12     | 1      | -        | -                 | XOR   | 14     | 4      | A       | <u> </u> |
| RESET function   | 26     | 5      | _        |                   | Undefined op codes:   |        |        |         |          |
| LOAD function  | 22     | 5      | -        | _                 | 0000-01FF,0320-033F,0C00-0FFF,                                      | 6      | 1      | -       | -        |
| Interrupt context switch   | 22     | 5      |          | -                 | 0780-07FF   |        |        |         |          |

\*Execution time is dependent upon the partial quotient after each clock cycle during execution.

• \* Execution time is added to the execution time of the instruction located at the source address minus 4 clock cycles and 1 memory access time.

<sup>†</sup>The letters A and B refer to the respective columns in the Address Modification Table.

## ADDRESS MODIFICATION

|  | COLU   | JMN A    | COLUMN B |          |  |
|--|--------|----------|----------|----------|--|
|  | CLOCK  | MEMORY   | CLOCK    | MEMORY   |  |
| ADDRESSING MODE  | CYCLES | ACCESSES | CYCLES   | ACCESSES |  |
|  | С      | м        | C        | м        |  |
| WR ( $T_S \text{ or } T_D = 00$ )                                | 0      | 0        | 0        | 0        |  |
| WR indirect (T <sub>S</sub> or T <sub>D</sub> = 01)              | 4      | 1        | 4        | 1        |  |
| WR indirect auto-increment (T <sub>S</sub> or $T_D = 11$ )       | 8      | 2        | 6        | 2        |  |
| Symbolic ( $T_S$ or $T_D$ = 10, S or D = 0)                      | 8      | 1        | 8        | 1        |  |
| Indexed (T <sub>S</sub> or T <sub>D</sub> = 10, S or D $\neq$ 0) | 8      | 2        | 8        | 2        |  |

# 4. INTERFACING

The input/output (I/O) accommodations have been designed for TTL compatibility. Direct interfacing, supportable by the entire families of catalog devices, is shown in Figure 13.



FIGURE 13 - MINIMUM SBP 9900A SYSTEM

# 4.1 INPUT CIRCUIT

The input circuit used on the SBP 9900A is basically an RTL configuration which has been modified for TTL compatibility as shown in Figure 14. An input-clamping diode is incorporated to limit negative excursions (ringing) when the SBP 9900A is on the receiving end of a transmission line; and input switching threshold of nominally +1.5 volts has been specified for improved noise immunity. This threshold is achieved via two resistors which function as a voltage divider to increase the one VBE threshold of the I<sup>2</sup>L input transistor to +1.5 volts.





The input circuit characteristics for input current versus input voltage are shown in Figure 15. The 10-k $\Omega$  and 20-k $\Omega$  load lines and threshold knee at +1.5 volts provide a high-impedance characteristic to reduce input loading and improve the low-logic-level input noise immunity over some standard TTL inputs. Full compatibility is maintained with virtually all 5-volt-logic families even when the SBP 9900A is powered down (injector current reduced).

#### 4.1.1 Sourcing Inputs

The inputs may be driven directly by most 5-volt-logic families. Functions that feature internal pull-up resistors at their outputs usually require no external interface components. Functions that feature opencollector outputs generally require external pull-up resistors.



# 4.1.2 Terminating Unused Inputs

Inputs that are selected to be hardwired to a logic-level low may be connected directly to

FIGURE 15 - TYPICAL INPUT CHARACTERISTICS

ground. Inputs that are selected to be hardwired to a logic-level high must be tied, via a current limiting (pull-up) resistor, to a logic-level-high low-impedance voltage source such as  $V_{CC}$ . A single resistor common to all (N) inputs may be used for transient protection.

3



FIGURE 16 - SCHEMATICS OF OUTPUTS AND INPUT/OUTPUTS

# 4.2 OUTPUT CIRCUIT

The output circuit selected for the SBP 9900A is a current-injected, open-collector transistor shown in Figure 16. Since this transistor is current-injected, output sourcing capability is directly related to injector current. In other words, the number of loads that may be driven by an SBP 9900A output is directly reduced as injector current is reduced.

The output circuit characteristic for low-level output voltage (VOL) versus low-level output current (IOL) is shown in Figure 17. At rated injector current, the SBP 9900A output circuit offers a low-level output voltage of typically 220 mV.

The output circuit characteristics for 1) high-level output voltage (VOH) and current (IOH), 2) rise times, and 3) next stage input noise immunity, are a function of the load circuit being driven. The load circuit may be either:

 A) the direct input of a five-volt-logic family if no source current is required

or, for greater noise immunity and improved rise times,

B) the direct input of a five-volt-logic family in conjunction with a discrete pull-up resistor.



#### **4.2.1 OUTPUT LOAD RESISTOR**

When a discrete pull-up resistor  $R_L$  is utilized, the fanout requirements will restrict both its maximum and minimum values. The maximum load resistor value  $R_L(max)$  will maintain the high-level output voltage minimum (2.4 V) while conducting IOH + N · I\_IH(Ioad).  $R_L(max)$  may be calculated as shown in Figure 18.

The minimum load resistor  $R_{L(min)}$  should insure that the arithmetic sum of the current through  $R_{L}$  and the sink currents of the loads is less than IOL.  $R_{L(min)}$  may be calculated as shown in Figure 18.

Table 7 shows, for convenience, RL(Min) and RL(Max) values for several fanout values.

### HIGH-LEVEL (OFF-STATE) CIRCUIT CALCULATIONS

The allowable voltage drop across the load resistor (V\_RL) is the difference between the pull-up source and the V\_OH level required at the load:

$$V_{RL} = V_{source} - V_{OH min}$$

The total current through the load resistor (I\_RL) is the sum of the load current and the high-level output current (I\_OH):

 $I_{RL}$  = Load Current (into the load inputs) +  $I_{OH}$ where:  $I_{OH}$  = 400  $\mu$ A max

Therefore, calculations for the maximum value of RL would be:

 $R_{L(max)} \text{ in ohms} = \frac{V_{source} - V_{OH min}}{Load Current + 400 \, \mu A}$ 

#### LOW-LEVEL (ON-STATE) CIRCUIT CALCULATIONS

The maximum current through the load resistor when the output is on, plus the amount of current from the low-level input load, must be limited to the  $I_{OL}$  capability of the output. Therefore, the equation is:

$$R_{L(min)} = \frac{V_{source} - V_{OL max}}{I_{OL} - I_{load}}$$





Assume: 
$$V_{source} = 5 V, V_{OH(min)} = 2.4 V,$$
  
N = 5, I<sub>IH</sub> = 50  $\mu$ A

$$R_{L(max)} = \frac{V_{source} - V_{OH}}{I_{load} + I_{OH}}$$

$$R_{L(max)} = \frac{5 V - 2.4 V}{250 \mu A + 400 \mu A} = \frac{2.6}{0.00065} \Omega = 4000 \Omega$$

Assume:  $V_{source} = 5 V$ ,  $V_{OL} = 0.4 V$ ,  $I_{IL} = 2 mA$ , N = 5,  $I_{OL}$  capability = 20 mA

$$R_{L(min)} = \frac{V_{source} - V_{OL}}{I_{OL} - I_{load}}$$

$$R_{L(min)} = \frac{5 V - 0.4 V}{20 m A - 10 m A} = \frac{4.6}{0.01} \Omega = 460 \Omega$$

B. RL MINIMUM CALCULATIONS

#### FIGURE 18 - OUTPUT LOAD RESISTOR CALCULATIONS

| TYPE OF   | DRI<br>1 L                    | VING<br>OAD          | DI<br>5      | RIVING              | DRIVING<br>10 LOADS |               |  |
|-----------|-------------------------------|----------------------|--------------|---------------------|---------------------|---------------|--|
| LUGIC     | RL(min)                       | RL(max)              | RL(min)      | R <sub>L(max)</sub> | RL(min)             | RL(max)       |  |
| 54LS/74LS | 234 Ω                         | 6190 Ω               | 252 Ω        | 5200 Ω              | <b>280 Ω</b>        | 4333 Ω        |  |
| 54/74     | 250 Ω                         | 5909 Ω               | 383 Ω        | 4333 Ω              | 1150 Ω              | 3250 Ω        |  |
| 54S/74S   | 256 Ω                         | 5777 Ω               | <b>460 Ω</b> | <b>4160</b> Ω       | 2300 Ω              | <b>2888</b> Ω |  |
| MOS       | 230 Ω                         | 6341 Ω               | 230 ົ        | 5777 Ω              | 231 Ω               | 5200 Ω        |  |
| C-MOS     | 230 Ω                         | 6500 Ω               | 230 Ω        | 6500 Ω              | <b>231</b> Ω        | 6498 Ω        |  |
| С         | ONDITIONS:                    |                      |              | And unit loads of:  | <br>IIL             |               |  |
| ÷         | V <sub>source</sub> = 5 V,    |                      |              | 54LS/74LS           | 0.36 mA             | 10 µA         |  |
|           | V <sub>OH</sub> = 2.4 V (Sati | sfies most 5-V logic | :},          | 54/74               | 1.6 mA              | 40 µA         |  |
|           | V <sub>OL</sub> ≈ 0.4 V,      |                      |              | 54S/74S             | 2 mA                | 50 µA         |  |
|           | l <sub>OH</sub> = 400 μA (Ma  | aximum leakage),     |              | N-MOS               | 10 µA               | 10 µA         |  |
|           | I <sub>OL</sub> = 20 mA       |                      |              | C-MOS               | 10 pA               | 10 pA         |  |

TABLE 7 OUTPUT LOAD RESISTOR VALUES (RL)

# 5. POWER SOURCE

 $1^{2}$ L is a current-injected logic. When the injector and ground pins are placed across a curve tracer, the processor V-I characteristic will resemble that of a silicon switching diode. Any voltage or current source capable of supplying the desired current at the injector node voltage required will suffice. A dry-cell battery, a 5-volt TTL power supply, a programmable current supply (See Figure 19) – literally whatever power source is convenient can be used for most cases. For example, if a 5-volt TTL power supply is to be used, a series dropping resistor should be connected between the 5-volt supply and the injector pins of the  $1^{2}$ L device, as illustrated in Figure 20, to select the desired operating current.



FIGURE 19 - INJECTOR CURRENT SOURCE



EXAMPLE FOR VSUPPLY = 5V, AND ICC = 500 mA:

 $R_{DROP} = \frac{5 - 1.05}{0.5} = \frac{3.95}{0.5} = 7.9 \text{ OHMS}$ 



Figures 21 and 22 show the typical injector node voltages that occur across the temperature and injector current ranges.





FIGURE 22 – INJECTOR-NODE VOLTAGE vs INJECTOR CURRENT · 3

# 6. ELECTRICAL AND MECHANICAL SPECIFICATIONS

# 6.1 SBP 9900A AND SBP 9900A-1\* RECOMMENDED OPERATING CONDITIONS AT I<sub>CC</sub> = MAX<sup>+</sup> (UNLESS OTHERWISE NOTED)

| PARAMETER                                      |                          | MIN  | NOM | MAX | UNIT |
|--|--------------------------|------|-----|-----|------|
|  | SBP 9900A MJ/NJ/EJ       | 450  | 500 | 550 |      |
| Supply current, ICC                            | SBP 9900ACJ              |      |     |     |      |
| High-level output voltage, VOH                 |                          |      |     | 5.5 | V    |
| Low-level output current, IOL                  |                          |      |     | 20  | mA   |
| Clock frequency, fclock                        |                          | 0    |     | 3   | MHz  |
|  | High (67%)               | 222  |     |     |      |
| Width of clock pulse, tw                       | Low (33%)                | 111  |     |     | ns   |
| Clock rise time, tr                            |                          |      |     | 20  | ns   |
| Clock fall time, tf                            |                          |      |     | 20  | ns   |
| . –  | HOLD                     | 110† |     |     |      |
|  | READY                    | 70†  |     |     |      |
|  | D0 thru D15              | 651  |     |     | 1    |
| Setup time, t <sub>su</sub> (see Figure 23)    | CRUIN                    | 501  |     |     | ns   |
|  | INTREQ                   | 251  |     |     | 1    |
|  | IC0 thru IC3             | 25†  |     |     |      |
|  | HOLD                     | 251  |     |     |      |
|  | READY                    | 501  |     |     |      |
| Held time (and Figure 22)                      | D0 thru D15              | 401  |     |     |      |
|  | CRUIN                    | 401  |     |     | ns   |
|  | INTREQ                   | 551  |     |     |      |
|  | ICO thru IC3             | 551  |     |     | ]    |
|  | SBP 9900AMJ, SBP 9900ANJ | -55  |     | 125 |      |
| Operating free-air temperature, T <sub>A</sub> | SBP 9900AEJ              | -40  |     | 85  | °c   |
| [  | SBP 9900ACJ              | 0    |     | 70  | ]    |

References to SBP 9900A apply equally to the SBP 9900A-1 throughout this document except in 6.3 Switching Characteristics, SBP 9900A-1 complies with JAN specification MIL-M-38510/46001 and MIL-STD-883 processing.

<sup>†</sup> For conditions shown as MIN, NOM, MAX, use the appropriate value specified under recommended operating conditions.

#### DESIGN GOAL

# 6.2 SBP 9900A AND SBP 9900A-1\* CHARACTERISTICS OVER RECOMMENDED OPERATING FREE-AIR TEMPERATURE RANGE (UNLESS OTHERWISE NOTED)

|                  | PARAMETER                      |                  | TEST COM                 |                         | MIN | TYP <sup>‡</sup> | MAX  | UNIT |
|------------------|--------------------------------|------------------|--------------------------|-------------------------|-----|------------------|------|------|
| VIH              | High-level input voltage       |                  |                          |                         | 2   |                  |      | V    |
| VIL              | Low-level input voltage        |                  |                          |                         | Γ   |                  | 0.8  | V    |
| VIK              | Input clamp voltage            |                  | ICC = MIN,               | l <sub>l</sub> = –12 mA |     |                  | -1.5 | V    |
| [                |                                | I/O Pins         | I <sub>CC</sub> = NOM,   | V <sub>IH</sub> = 2 V,  |     |                  | 350  | μA   |
| 1                | Litely lovel evidence evidence | Other outputs    | V <sub>1L</sub> = 0.8 V, | V <sub>OH</sub> = 2.4 V |     |                  | 50   | μA   |
| Гон              | High-level output current      | I/O Pins         | I <sub>CC</sub> = NOM,   | V <sub>IH</sub> = 2 V   |     |                  | 1    | mA   |
|                  |                                | Other outputs    | V <sub>IL</sub> = 0.8 V, | V <sub>OH</sub> = 5.5 V |     |                  | 250  | μA   |
|                  |                                |                  | I <sub>CC</sub> = NOM,   | V <sub>IH</sub> = 2 V   | T   |                  |      |      |
|                  |                                |                  | VIL = 0.8 V,             | I <sub>OL</sub> = 20 mA |     |                  | 0.4  | v    |
| 1.               | Input ourront                  | Clock            |                          | V. = 2 4 V              |     | 0.6              | 1    | mA   |
| II Input current |                                | All other inputs |                          | v   - 2.4 V             |     | 200              | 300  | μA   |

# 6.3 SBP 9900A AND SBP 9900A-1\* SWITCHING CHARACTERISTICS OVER RECOMMENDED OPERATING FREE-AIR TEMPERATURE RANGE (UNLESS OTHERWISE NOTED), I<sub>CC</sub> = MAX, SEE FIGURES 23 AND 24

| DADAMETED    | FROM  |                               | TEET CONDITIONST | SE  | 3P 990 | 0A  | SB  | A-1* | UNIT |      |
|--------------|-------|-------------------------------|------------------|-----|--------|-----|-----|------|------|------|
| PANAMEICA    | FROM  | 10                            | TEST CONDITIONS. | MIN | түр    | MAX | MIN | ТҮР  | MAX  | UNIT |
| TPLH OF TPHL | CLOCK | ADDRESS BUS (A0 - A14)        |                  |     | 90     | 130 |     | 90   | 140  | ns   |
| tPLH OF TPHL | CLOCK | DATA BUS (D0 - D15)           |                  |     | 105    | 145 |     | 105  | 155  | ns   |
| TPLH OF TPHL | CLOCK | WRITE ENABLE (WE)             |                  |     | 100    | 155 |     | 100  | 185  | ns   |
| tPLH or tPHL | CLOCK | CYCLE END (CYCEND)            |                  |     | 90     | 135 |     | 90   | 145  | ns   |
| tPLH or tPHL | CLOCK | DATA BUS IN (DBIN)            | 0 150 - 5        |     | 115    | 160 |     | 115  | 160  | ns   |
| TPLH OF TPHL | CLOCK | MEMORY ENABLE (MEMEN)         |                  |     | 90     | 130 |     | 90   | 140  | ns   |
| tPLH or tPHL | CLOCK | CRU CLOCK (CRUCK)             |                  |     | 95     | 145 |     | 95   | 155  | ns   |
| TPLH OF TPHL | CLOCK | CRU DATA OUT (CRUOUT)         | ]                |     | 110    | 175 |     | 110  | 185  | ns   |
| TPLH OF TPHL | CLOCK | HOLD ACKNOWLEDGE (HLDA)       | ]                |     | 190    | 290 |     | 190  | 290  | ns   |
| tPLH or tPHL | CLOCK | WAIT                          |                  |     | 90     | 130 |     | 90   | 130  | ns   |
| tPLH or tPHL | CLOCK | INSTRUCTION ACQUISITION (IAQ) |                  |     | 90     | 130 |     | 90   | 130  | ns   |

<sup>†</sup> For conditions shown MIN, NOM, or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup> All typical values are at  $I_{CC} = NOM$ ,  $T_A = 25^{\circ}C$ .

References to SBP 9900A apply equally to the SBP 9900A-1 throughout this document except in 6.3 Switching Characteristics. SBP 9900A-1 complies with JAN specification MIL-M-38510/46001 and MIL-STD-883 processing.

#### DESIGN GOAL

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# 6.4 CLOCK FREQUENCY VS. TEMPERATURE

Stability of the operational frequency over the full temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C is illustrated in Figure 25. The effects of temperature on clock frequency are nil above 0°C. Below 0°C the effects are typically less than -5% with respect to the typical performance.







# 7. MECHANICAL DATA

NOTES: A. Each pin centerline is located within 0.010 (2,54) of its true longitudinal position. B. All linear dimensions are in inches and parenthetically in millimeters. Inch dimensions govern. 3



# SBP 9960 Programmable CRU I/O Expander

# SBP 9960 PROGRAMMABLE CRU I/O EXPANDER

# **1.0 INTRODUCTION**

# **1.1 GENERAL DESCRIPTION**

The SBP 9960 Programmable CRU I/O Expander is a ruggedized monolithic software-configurable input/output device fabricated with oxide separated Integrated Injection Logic (I<sup>2</sup>L) technology. The SBP 9960 provides a flexible and efficient Communications Register Unit (CRU) based interface between the SBP/TMS 9900 series Family of microprocessors and auxiliary systems functions ranging from bit-oriented sensors and actuators to byte/word/n-bit-field oriented peripherals.

Under software control, each of the SBP 9960's sixteen single-bit I/O ports may be individually configured to either the input or output mode. I<sup>2</sup>L technology enables the SBP 9960's static logic, and TTL compatible I/O, to operate over a very wide ambient temperature range from a single d-c power source with output current sink capability up to 40 mA. When the SBP 9960 is used in conjunction with the SBP 9961 I<sup>2</sup>L Interrupt-Controller/Timer, the SBP 9960/SBP 9961 pair form an I<sup>2</sup>L systems alternate to the N-channel MOS TMS 9901 Programmable Systems Interface device while maintaining strict compatibility with existing software handlers developed in support of the TMS 9901.

# **1.2 KEY FEATURES**

- SBP/TMS 9900 Series Microprocessor Family Peripheral
- 16 Individual, Single Bit, Software Configurable I/O Ports
- 20/40 mA current Sinking Outputs
- Software Compatibility with TMS 9901 when used in Conjunction with SBP 9961
- TTL Compatible I/O
- Wide Ambient Temperature Operation

  - SBP 9960EJ: -40°C to +85°C

  - --- SBP 9960NJ: -55°C to +125°C (with high-reliability processing)
- I<sup>2</sup>L Technology
  - Constant Current Power Source
  - ---- Fully Static Operation
  - -Single Phase Edge-Triggering Clock
  - --- Wide Temperature Stability

DESIGN GOAL



# 2.0 FUNCTIONAL DESCRIPTION

# 2.1 SBP 9960/CPU INTERFACE

The SBP 9960 communicates with the CPU through the communications Register Unit (CRU) interface as shown in Figures 1 and 3. The SBP 9960's CRU interface consists of: a) five CRU address select lines (S0-S4), B) a single chip enable (CE), c) a 9960 to CPU serial data-bit line (CRUIN), d) a CPU to 9960 serial data-bit line (CRUOUT), and e) a CPU to 9960 serial data-bit clock (CRUCLK). When CE is activated (logic-level low), S0-S4 select a specific single-bit I/O port as indicated in Table 1. In the case of an SBP 9960 write operation, the datum is transferred from the CPU to the SBP 9960 via the CRUOUT line. The CRUOUT datum is strobed into the selected single-bit port by CRUCLK. In the case of a SBP 9960 read operation, the selected single-bit port is sampled by the CPU via the CRUIN line.



FIGURE 1. SBP9960 FUNCTIONAL BLOCK DIAGRAM

# 2.2 CRU BIT ASSIGNMENTS

Table 1 describes the SBP 9960's CRU bit assignments. Note that CRU bits 1-14 have been reserved for the SBP 9961 thereby insuring software compatibility between the SBP 9960/SBP9961 pair and the TMS 9901.

# 2.3 INPUT/OUTPUT

One of sixteen SBP 9960, single-bit, combination open-collector-output/resistor-divider-input I/O ports is conversationally represented in figure 2. As a direct result of the open-collector output structure, the data flow direction through the port is determined by the stored logic-level of the associated output-register bit in combination with the data flow direction of the external device serviced by the port. When

# SBP 9960

the output-register bit (Q) is at logic-level high, the corresponding package pin (P) is essentially floating and therefore free to be externally pulled to either the high or low logic-level. In other words, when Q is at logic-level high, the ports data flow direction can be either inward, where an external device pulls P to the high or low logic-level; or the data flow direction can be outward, where an external resistor (R) both pulls P to logic-level high and sources current drive into the inputs of external devices. When Q is at logic-level low, the ports unconditional data flow direction is outward, where P has the capacity to sink 20/40<sup>\*</sup>mA of current from external devices. Q can be reset to logic-level low through CPU execution of a SET BIT TO ZERO (SBZ) instruction; Q can be set to logic-level high through: 1) a hardware initiated reset (RESET), 2) a software initiated reset (RST : CRU BIT 15) preceded by setting the control bit (CRU BIT 0) to logic-level high, or 3) CPU execution of a SET BIT TO ONE (SBO) instruction. Note that both RESET and RST affect all sixteen single-bit I/O ports while CPU execution of either an SBO or SBZ instruction can be targeted at an individual single-bit port independent of uninvolved ports. Once the data flow direction has been established for each single-bit port, CPU communication with the external devices driven or sensed by each individual port is effected through execution of the CRU instructions: LDCR, STCR, SBO, SBZ, and TB.



FIGURE 2. 1 OF 16 SINGLE-BIT I/O PORTS

\*Outputs P0, P1, P2, and P3 have extended current sink capability to 40 mA.

| CRU BIT | S0 | S1 | <b>Š</b> 2 | S3 | <b>S</b> 4 | CRU READ DATA            | CRU WRITE DATA               |  |  |  |
|---------|----|----|------------|----|------------|--------------------------|------------------------------|--|--|--|
| 0       | 0  | 0  | 0          | 0  | 0          | Control Bit              | Control Bit                  |  |  |  |
| 1-14    |    |    |            |    |            | Note 1                   | Note 1                       |  |  |  |
| 15      | 0  | 1  | 1          | 1  | 1          | "1" No Operatio          |                              |  |  |  |
| 16      | 1  | 0  | 0          | 0  | 0          | PO Input <sup>(3)</sup>  | P0 Output <sup>(4)</sup> (5) |  |  |  |
| 17      | 1  | 0  | 0          | 0  | 1          | P1 🖡                     | P1 🔺 (5)                     |  |  |  |
| 18      | 1  | 0  | 0          | 1  | 0          | P2                       | P2 (5)                       |  |  |  |
| 19      | 1  | 0  | 0          | 1  | 1          | P3                       | P3 (5)                       |  |  |  |
| 20      | 1  | 0  | 1          | 0  | 0          | P4                       | P4                           |  |  |  |
| 21      | 1  | 0  | 1          | 0  | 1          | P5                       | P5                           |  |  |  |
| 22      | 1  | 0  | 1          | 1  | 0          | P6                       | P6                           |  |  |  |
| 23      | 1  | 0  | 1          | 1  | 1          | P7                       | P7                           |  |  |  |
| 24      | 1  | 1  | 0          | 0  | 0          | P8                       | P8                           |  |  |  |
| 25      | 1  | 1  | 0          | 0  | 1          | P9                       | P9                           |  |  |  |
| 26      | 1  | 1  | 0          | 1  | 0          | P10                      | P10                          |  |  |  |
| 27      | 1  | 1  | 0          | 1  | 1          | P11                      | P11                          |  |  |  |
| 28      | 1  | 1  | 1          | 0  | 0          | P12                      | P12                          |  |  |  |
| 29      | 1  | 1  | 1          | 0  | 1          | P13                      | P13                          |  |  |  |
| 30      | 1  | 1  | 1          | 1  | 0          | P14 🔻                    | P14 ¥                        |  |  |  |
| 31      | 1  | 1  | 1          | 1  | 1          | P15 Input <sup>(3)</sup> | P15 Output <sup>(4)</sup>    |  |  |  |

#### TABLE 1 - SBP 9960 CRU BIT ASSIGNMENTS

NOTES: (1) Bits 1-14 reserved for SBP 9961 Interval Timer/Interrupt Controller (2) Writing a zero to bit 15 while CONTROL = 1 executes a software reset of the I/O ports.

(3) Data present on the port will be read without affecting the data.

(4) Writing data to the port will both program the port to the output mode and output the data.

(5) These outputs are provided with extended sink-current capability to 40 mA.

# 2.4 SYSTEM OPERATION

During a typical power-up sequence of a SBP 9960-based system, RESET should be activated (logic-level low) to force the SBP 9960 to the state where each of the sixteen individual single-bit I/O ports is in the input mode. System software should then configure each single-bit port as required. If a given port must be reconfigured from the input to output mode after power-up, the associated output-register bit must be set to logic-level high through CPU execution of an SBO instruction.

#### 2.5 SBP 9960/SBP 9961 EMULATION OF THE TMS 9901

Figure 3 shows the system configuration of a SBP 9960 functioning in conjunction with a SBP 9961 in emulation of a TMS 9901. Note the common connection of: a) the individual chip enables, and b) the CRU interface lines. For a complete description of the SBP 9961 and the TMS 9901 refer respectively to the SBP 9961 Interrupt-Controller/Timer Data Manual and the TMS 9901 Programmable Systems Interface Data Manual.

#### DESIGN GOAL

SBP 9960



#### FIGURE 3 - SYSTEM CONFIGURATION USING SBP 9960 AND SBP 9961

#### DESIGN GOAL

# 2.6 SBP 9960 PIN ASSIGNMENTS AND FUNCTIONS

| SIGNATURE                  | PIN                    | I/O                  | DESCRIPTIO   | N   |
|----------------------------|------------------------|----------------------|--|---|
| S0<br>S1<br>S2<br>S3<br>S4 | 6<br>7<br>8<br>9<br>10 | IN<br>IN<br>IN<br>IN | ADDRESS SELECT LINES. The data bit interface is specified by the 5-bit code ap                             | being accessed by the CRU opearing on S0-S4.                  |
| CRUIN                      | 4                      | OUT                  | CRU DATA IN (to CPU). Data specified the CPU by CRUIN. When CE is not active, high.                        | by S0-S4 is transmitted to the CRUIN is pulled to logic-leve  |
| CRUOUT                     | 2                      | IN                   | CRU DATA OUT (from CPU). When $\overline{CE}$ CRUOUT input will be strobed by CRUC bit specified by S0-S4. | is active data present on the<br>CLK and written into the CRU |
| CRUCLK                     | 3                      | IN                   | CRU CLOCK (from CPU). CRUCLK speci<br>on the CRUOUT line.  | fies that valid data is present                               |
| RESET                      | 1                      | IN                   | POWER-UP RESET. When active (lot (P0-P15) to input mode.   | w), RESET forces all I/O's                                    |
| CE                         | 5                      | IN                   | CHIP ENABLE. When active (low), data ferred between the SBP 9960 and the CP                                | may be bidirectionally trans-                                 |
| INJ                        | 28                     |                      | Supply Current RESET 1   | О]28 [иј  |
| GND                        | 14                     |                      | Ground Reference CRUOUT 2  | 27 P0   |
| P0                         | 27                     | 1/0                  | I/O pins CRUCLK 3  | 0 <sub>26 P1</sub>  |
| · P1                       | 26                     | I/O                  |  |   |
| P2                         | 25                     | I/O                  | CRUIN 4  | _]25 P2   |
| P3                         | 24                     | 1/0                  | —d   | h   |
| P4                         | 23                     | 1/0                  | CE 5 L   | J24 P3  |
| P5                         | 22                     | Ï/O                  | a na   |   |
| P6                         | 21                     | 1/0                  | 30 V L   |   |
| P7                         | 20                     | 1/0                  | S1 7   | 22 P5   |
| P8                         | 19                     | 1/0                  | -  |   |
| P9                         | 18                     | 1/0                  | S2 8   | 21 P6   |
| P10                        | 17                     | 1/0                  | сэ о <b>Г</b>  |   |
| P11                        | 16                     | 1/0                  | 53 9 L   |   |
| P12                        | 16                     | 1/0                  | S4 10  | П19 Р8  |
| P13                        | 10                     | 1/0                  | 4  | E   |
| P14                        | 12                     | 1/0                  | P15 11   | <b>18 P9</b>  |
| P15                        | 11                     | 1/0                  | D14 12 0   | D17 010   |
| 115                        | ''                     | "0                   | P14 12   |   |
|                            |                        |                      | P13 13 [   | ]16 P11   |
|                            |                        |                      | GND 14   | 15 P12  |

# DESIGN GOAL

# 3.0 ELECTRICAL SPECIFICATIONS

# 3.1 RECOMMENDED OPERATING CONDITIONS UNLESS OTHERWISE NOTED, ICC = 70 mA

| PARAMETER                                      |                        | MIN | NOM | MAX | UNIT |  |
|--|------------------------|-----|-----|-----|------|--|
| Supply current, ICC                            | 63                     | 70  | 77  | mA  |      |  |
| High-level output voltage, VOH                 |                        |     | 5.5 | V   |      |  |
| Low-level output current, IOL                  |                        |     | 20† | mA  |      |  |
| · · · · · · · · · · · · · · · · · · ·          | SBP 9960MJ, SBP 9960NJ | -55 |     | 125 |      |  |
| Operating free-air temperature, T <sub>A</sub> | SBP 9960EJ             | -40 |     | 85  | °c   |  |
|  | SBP 9960CJ             |     |     | 70  | 1    |  |

<sup>†</sup>40 mA on extended drive outputs P0, P1, P2, and P3

# 3.2 ELECTRICAL CHARACTERISTICS (OVER RECOMMENDED OPERATING FREE-AIR TEMPERATURE RANGE, UNLESS OTHERWISE NOTED)

| PARAMETER |                           | TEST CONDITIONS <sup>†</sup> |                                   | MIN | TYPŦ | MAX  | UNIT |
|-----------|---------------------------|------------------------------|-----------------------------------|-----|------|------|------|
| VIH       | High-level input voltage  |                              |                                   | 2   |      | ,    | V    |
| VIL       | Low-level input voltage   |                              |                                   |     |      | 0.8  | V    |
| VIK       | Input clamp voltage       | ICC = MIN,                   | lj = -12 mA                       |     |      | -1.5 | V    |
| юн        | High-level output current | I <sub>CC</sub> = 70 mA,     | V <sub>IH</sub> = 2 V,            |     |      | 400  | μA   |
|           |                           | V <sub>IL</sub> = 0.8 V,     | V <sub>OH</sub> = 5.5 V           |     |      |      |      |
| VOL       | Low-level output voltage  | I <sub>CC</sub> = 70 mA,     | V <sub>IH</sub> = 2 V,            |     |      | 0.5  | v    |
|           |                           | V <sub>IL</sub> = 0.8 V,     | I <sub>OL</sub> = 20 mA (40 mA §) |     |      | 0.5  |      |
| 4         | Input current             | I <sub>CC</sub> = 70 mA,     | V <sub>1</sub> = 2.4 V            |     | 225  |      | μA   |

<sup>†</sup>For conditions shown as MAX, use the appropriate value specified under recommended operating conditions.

<sup>†</sup>All typical values are at  $I_{CC} = 70 \text{ mA}$ ,  $T_A = 25^{\circ}C$ .

§ Extended drive outputs only.

# 3.3 TIMING REQUIREMENTS OVER FULL RANGE OF OPERATING CONDITIONS

| PARAMETER       |   | MIN | NOM | MAX | UNIT |
|-----------------|---|-----|-----|-----|------|
| t <sub>su</sub> | Setup time for S0-S4, CE, or CRUOUT before CRUCLK |     | 200 |     | ns   |
| t <sub>su</sub> | Setup time, input before valid CRUIN              |     | 200 |     | ns   |
| tw(CRUCLK)      | CRU clock pulse width                             |     | 100 |     | ns   |
| t <sub>h</sub>  | Hold time for Address or Data                     |     | 0   |     | ns   |

# 3.4 SWITCHING CHARACTERISTICS OVER FULL RANGE OF RECOMMENDED OPERATING CONDITIONS

| PARAMETER       |  | TEST CONDITIONS                                 | MIN | ТҮР | MAX | UNIT |
|-----------------|--|---|-----|-----|-----|------|
| <sup>t</sup> PD | Propagation delay, S0-S4 or $\overline{CE}$ to valid CRUIN | C <sub>L</sub> = 100 pF, R <sub>L</sub> = 300 Ω |     | 300 |     | ns   |

# SBP 9960



NOTE 1: ALL TIMING MEASUREMENTS ARE FROM 10% and 90% POINTS

SWITCHING CHARACTERISTICS





# DESIGN GOAL





B. ALL LINEAR DIMENSIONS ARE IN INCHES (AND PARENTHETICALLY IN MILLIMETERS FOR REFERENCE ONLY). INCH DIMENSIONS GOVERN.





# SBP 9961 Interrupt Controller and Timer

# DESIGN GOAL
# 1.0 INTRODUCTION

## 1.1 GENERAL DESCRIPTION

The SBP 9961 Interrupt Controller and Timer is a ruggedized, monolithic, Communications Register Unit (CRU) programmable, multifunction systems support device fabricated with oxide separated Integrated Injection Logic ( $l^2L$ ) technology. The SBP 9961 provides the SBP/TMS 9900 series Family of Microprocessors with a flexible independently clocked interval/event timer plus maskable prioritized interrupt encoding capability.  $l^2L$  technology enables the SBP 9961s static logic, and TTL compatible I/O, to operate over a very wide ambient temperature range from a single d-c power source. When the SBP 9961 is used in conjunction with the  $l^2L$  SBP 9960 CRU I/O Expander, the SBP 9961/SBP 9960 pair form an  $l^2L$  systems alternate to the N-channel MOS TMS 9901 Programmable Systems Interface device while maintaining strict compatibility with existing software handlers developed in support of the TMS 9901.

# **1.2 KEY FEATURES**

- SBP/TMS 9900 Series Microprocessor Family Peripheral
- 15 Dedicated, Maskable, Prioritized, Encoded Interrupts
- 20 mA Current Sinking Outputs
- e 40-Pin Package
- Independently Clocked 14-Bit Interval/Event Timer
- Software Compatible with TMS 9901 when used in conjunction with SBP 9960
- TTL Compatible I/O
- Wide Ambient Temperature Operation
  - SBP 9961CJ: 0°C to +70°C
  - -- SBP 9961EJ: -40°C to +85°C
  - SBP 9961MJ: -55°C to +125°C
  - SBP 9961NJ: -55°C to +125°C (with high-reliability processing)
- I<sup>2</sup>L Technology
  - Constant Current Power Source
  - Fully Static Operation
  - Single Phase Edge-Triggering Clock
  - Wide Temperature Stability

#### 2.0 FUNCTIONAL DESCRIPTION

#### 2.1 SBP 9961/CPU INTERFACE

The SBP 9961 communicates with the CPU through the Communications Register Unit (CRU) interface as shown in Figures 1 and 4. The SBP 9961s CRU interface consists of: a) five CRU address select lines (SO-S4), b) a single chip enable ( $\overline{CE}$ ), c) a 9961 to CPU serial data-bit line (CRUIN), d) a CPU to 9961 serial data-bit line (CRUOUT), and e) a CPU to 9961 serial data-bit clock (CRUCLK). When  $\overline{CE}$  is activated (logic-level low), SO-S4 selects a specific CRU-bit function as indicated in Table 1. In the case of a SBP 9961 write operation, the datum is transferred from the CPU to the SBP 9961 via the CRUOUT line. The CRUOUT datum is strobed into the selected 9961 CRU-bit function by CRUCLK. In the case of a SBP 9961 read operation, the selected CRU-bit function is sampled by the CPU via the CRUIN line.

| CRU BIT | SO   | S1 | S2 | S3 | S4 | CRU READ DATA | CRU WRITE DATA             |
|---------|------|----|----|----|----|---------------|----------------------------|
|         |      |    |    |    |    |               |                            |
| 0       | 0(4) | 0  | 0  | 0  | 0  | Control Bit   | Control Bit <sup>(1)</sup> |
| 1       | 0    | 0  | 0  | 0  | 1  | INT1/TIM1(2)  | Mask1/TIM1(3)              |
| 2       | 0    | 0  | 0  | 1  | 0  | INT2/TIM2     | Mask2/TIM2                 |
| 3       | 0    | 0  | 0  | 1  | 1  | INT3/TIM3     | Mask3/TIM3                 |
| 4       | 0    | 0  | 1  | 0  | 0  | INT4/TIM4     | Mask4/TIM4                 |
| 5       | 0    | 0  | 1  | 0  | 1  | INT5/TIM5     | Mask5/TIM5                 |
| 6       | 0    | 0  | 1  | 1  | 0  | INT6/TIM6     | Mask6/TIM6                 |
| 7       | 0    | 0  | 1  | 1  | 1  | INT7/TIM7     | Mask7/TIM7                 |
| 8       | 0    | 1  | 0  | 0  | 0  | INT8/TIM8     | Mask8/TIM8                 |
| 9       | 0    | 1  | 0  | 0  | 1  | INT9/TIM9     | Mask9/TIM9                 |
| 10      | 0    | 1  | 0  | 1  | 0  | INT10/TIM10   | Mask10/TIM10               |
| 11      | 0    | 1  | 0  | 1  | 1  | INT11/TIM11   | Mask11/TIM11               |
| 12      | 0    | 1  | 1  | 0  | 0  | INT12/TIM12   | Mask12/TIM12               |
| 13      | 0    | 1  | 1  | 0  | 1  | INT13/TIM13   | Mask13/TIM13               |
| 14      | 0    | 1  | 1  | 1  | 1  | INT14/TIM14   | Mask14/TIM14               |
| 15      | 0    | 1  | 1  | 1  | 1  | INT15/INTREQ  | Mask 15                    |

#### TABLE 1 - CRU BIT ASSIGNMENTS

NOTES: (1)

(1) 0 = Interrupt Mode; 1 = TIMCK Mode.

(2) Data present on INT input (or timer value) will be read regardless of mask value.

(3) While in the Interrupt Mode (Control Bit = 0), writing a "1" into a mask will enable interrupt, "0" will disable.

(4) When the SBP 9961/SBP 9960 pair are used in emulation of the TMS 9901, S0 is used to distinguish between activation of the 9961 (S0 = 0) v.s. the 9960 (S0 = 1).

## 2.2 INTERRUPT CONTROL

A block diagram of the SBP 9961 interrupt control section is shown in Figure 2. The interrupt inputs are sampled on the positive-going edge of CLOCK and are ANDed with their respective mask bits. If an interrupt input is active (low) and enabled (MASK = 1), the signal is passed through the priority encoder where the highest priority signal is encoded into a 4-bit binary word as shown in Table 2. This word, along with an interrupt request, is then output to the CPU on the positive-going edge of the next CLOCK.

The output signals will remain valid until either the corresponding interrupt input is removed, the interrupt is disabled (MASK = 0), or a higher priority enabled interrupt becomes active. When the highest priority enabled interrupt is removed, the code corresponding to the next highest priority enabled interrupt is output. If no enabled interrupt is active, INTREQ will be pulled to logic-level high with ICO-IC3 retaining the last asserted interrupt code. RESET (power-up reset) will force the interrupt code ICO-IC3 to (0,0,0,0) with INTREQ pulled high, and will reset all mask bits low (interrupts disabled). Individual interrupts can be subsequently enabled (disabled) by programming the appropriate mask bits. Unused interrupt inputs may be used as data inputs by disabling the interrupt (MASK = 0).

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FIGURE 1 - SBP 9961 BLOCK DIAGRAM

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SBP 9961

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SBP 9961



FIGURE 2 - INTERRUPT CONTROL LOGIC

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|           | TABLE | 2      |      |
|-----------|-------|--------|------|
| INTERRUPT | CODE  | GENERA | TION |

| INTERRUPT/STATE | PRIORITY    | IC0    | 101    | I <sub>C2</sub> | I <sub>C3</sub> | INTREO |
|-----------------|-------------|--------|--------|-----------------|-----------------|--------|
| INT 1           | 1 (HIGHEST) | 0      | 0      | 0               | 1               | 0      |
| INT 2           | 2           | 0      | 0      | 1               | 0               | 0      |
| INT 3/TIMER     | 3           | 0      | 0      | 1               | 1               | 0      |
| INT 4           | 4           | 0      | 1      | 0               | 0               | 0      |
| INT 5           | 5           | 0      | 1      | ×0              | 1               | 0      |
| INT 6           | 6           | 0      | 1      | 1               | 0               | 0      |
| INT 7           | 7           | 0      | 1      | 1               | 1               | 0      |
| INT 8           | 8           | 1      | 0      | 0               | 0               | 0      |
| INT 9           | 9           | 1      | 0      | 0               | 1               | 0      |
| INT 10          | 10          | 1      | 0      | 1               | 0               | 0      |
| INT 11          | 11          | 1      | 0      | 1               | 1               | 0      |
| INT 12          | 12          | 1      | 1      | 0               | 0 .             | 0      |
| INT 13          | 13          | 1      | 1      | 0               | 1               | 0      |
| INT 14          | 14          | - 1    | 1      | 1 -             | 0               | 0      |
| INT 15          | 15 (LOWEST) | 1      | 1      | 1               | 1 1             | 0      |
| NO INTERRUPT    | -           | Note 1 | Note 1 | Note 1          | Note 1          | 1      |

(1) IC0-IC3 hold the level code of the previous interrupt.

### 2.3 INTERVAL TIMER

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The SBP 9961's interval/event timer, shown in Figure 3, has the following operational features:

- a) Independent clock input TIMCK
- b) Programmable 14-bit decrementer
- c) Timer-reaches-zero level-3 interrupt
- d) Timer reaches zero output pulse TDZ
- e) Able to read the current decremented value and therefore function as an event timer
- f) Able to determine the SBP 9961's operating mode and value of INTREQ.

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The SBP 9961 has an independent timer clock input, TIMCK, which allows the user to define an interval timer clock frequency other than that of the CPU. This, however, does not preclude the user option of connecting TIMCK to the CPU's CLOCK input and therefore running the interval timer at the CPU's clock frequency. The typical operating range of TIMCK is 0-5 MHz.

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The timer's CRU control bits are shown in Table 1. The SBP 9961 is placed into the timer-access mode by writing a logic-level high to the control bit located at CRU address zero. CRU bits 1-14 are then used to initiate the write-register with the desired start count. Writing a non-zero value to the write-register a) enables the decrementer, b) programs the third priority interrupt (INT3) as the timer interrupt, and c) disables the influence of external interrupts on the INT3 input pin. A single LDCR instruction can be used to accomplish the above initialization operation. After the write-register has been initialized with the desired start count, the timer begins decrementing toward zero. Upon reaching zero, the timer issues the level-3 interrupt, outputs the timer-zero pulse TDZ, and restarts itself with the write-register value. Since the timer interrupt is latched, clearing that interrupt is accomplished by writing either a logic-level low or high to the respective interrupt mask bit at CRU address three. The CRUCLK that accompanies that write operation is the stimulus which resets the timers interrupt latch. However, in order to retain the current mask value, the appropriate SBZ or SBO CRU-write instruction must be executed unless the mask value itself is to be changed. At any point in the timer's decrement sequence, a timer restart can be accomplished by either reinitiating the entire write-register with an LDCR instruction, or by writing to any individual write-register bit with an SBZ or SBO instruction.

If the control bit is at logic-level low, the timer's read-register is updated with the current decrementer value after each decrement operation (once every 64 TIMCK clocks); if the control bit is at logic-level high (timeraccess mode), the read-register retains its current value thereby ensuring that the read-register is not changed in the event a CRU read operation is executing during a decrement operation. Consequently, the current value of the timer's decrementer can be interrogated by 1) placing the SBP 9961 into the timeraccess mode, and 2) performing a CRU-read operation on the timer's read-register through execution of an STCR instruction. The timer, then, can function as an event timer by reading the elapsed time between software events as shown in Table 3. Note that when accessing the timer, all interrupts should be disabled. The timer is disabled by either RESET (power-up reset) or by writing all zeroes to the write-register.



FIGURE 3 - INTERVAL/EVENT TIMER

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# 2.4 SBP 9961 STATUS

The SBP 9961s status can be determined by reading the value of the control bit located at CRU address zero. If the control bit has a logic-level low value, then the interrupt masks may be changed and data on the interrupt inputs may be read. However, access to the interval timer is inhibited. If the control bit has a logic-level high value, then the timer may be initiated, restarted, or read. Also, reading CRU address fifteen gives the status of INTREQ where logic-level low indicates activation.

#### **TABLE 3 - SOFTWARE EXAMPLES**



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FIGURE 4 - SBP 9961 SYSTEM CONFIGURATION

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# 2.5 SYSTEM OPERATION

During power-up, RESET should be activated (low) to force the SBP 9961 into a known state. RESET will disable all interrupts, disable the timer, and force ICO-IC3 to (0,0,0,0) with INTREQ pulled high. System software should then enable the proper interrupts and program the timer (if used). See Table 3 for an example. After initial power up, the SBP 9961 is accessed only as needed to service the timer and enable or disable interrupts.

Figure 4 shows SBP 9961s system configuration. Figure 5 shows the use of a SBP 9961 with a SBP 9960 CRU I/O expander in emulation of the TMS 9901. (See *TMS 9901 Systems Interface Data Manual.*)



FIGURE 5 - SYSTEM CONFIGURATION USING SBP 9960 AND SBP 9961

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# SBP 9961

# 2.6 SBP 9961 PIN ASSIGNMENTS AND FUNCTIONS

| SIGNATURE  | PIN  | 1/0   | DESCRIPTION  |
|--|--|---|--|
| S0<br>S1<br>S2<br>S3<br>S4   | 33<br>35<br>31<br>34   | IN<br>IN<br>IN<br>IN<br><b>I</b> N  | ADDRESS SELECT LINES. The data bit being accessed by the CRU interface is speci-<br>fied by the 4-bit code appearing on S1–S4. S0 is used as the high order select line when<br>the SBP 9961 is used with the SBP 9960 in emulation of the TMS 9901. Otherwise,<br>tie S0 to logic-level low.  |
| CRUIN  | 28   | OUT   | CRU DATA IN (to CPU). Data specified by S0-S4 is transmitted to the CPU by CRUIN.<br>When CE is not active, CRUIN is logic-level high.   |
| CRUOUT   | 17   | IN  | CRU DATA OUT (from CPU). When $\overline{\text{CE}}$ is active, data present on the CRUOUT input will be sampled during CRUCLK and written into the CRU bit specified by S0-S4.  |
| CRUCLK   | 1  | IN  | CRU CLOCK (from CPU). CRUCLK specifies that valid data is present on the CRUOUT line.  |
| RESET  | 38   | IN  | POWER-UP RESET. When active (low), RESET forces all interrupt masks to "0", and disables the clock.  |
| CE   | 2  | IN  | CHIP ENABLE. When active (low), data transfers may occur between the CPU and the SBP 9961.   |
| TIMCK  | 11   | IN  | TIMER CLOCK IN. External clock used for the timer decrementer. May be externally tied to the CLOCK input pin.  |
| TDZ  | 30   | Ουτ   | TIMER DECREMENTER EQUALS ZERO. Low active pulse indicating that the timers decrementer contains a value of zero (all logic-level lows).  |
| IC0<br>IC1<br>IC2<br>IC3   | 3<br>4<br>5<br>6   | OUT<br>OUT<br>OUT<br>OUT  | INTERRUPT CODE LINES (to CPU). ICO (MSB) through IC3 output the binary code corresponding to the highest priority enabled interrupt most recently asserted.  |
| INTREQ   | 7  | ουτ   | INTERRUPT REQUEST (to CPU). When active (low) INTREQ indicates to the CPU that an enabled interrupt has been asserted, prioritized, and encoded.   |
| CLOCK<br>INJ<br>GND<br>VCC<br>INT1<br>INT2<br>INT3<br>INT4<br>INT5<br>INT6<br>INT7<br>INT8<br>INT9<br>INT10<br>INT11<br>INT12<br>INT12<br>INT13<br>INT14 | 9<br>40<br>19, 20<br>37<br>12<br>13<br>21<br>14<br>15<br>16<br>18<br>8<br>10<br>22<br>23<br>25<br>26<br>27 | IN<br>IN<br>IN<br>IN<br>IN<br>IN<br>IN<br>IN<br>IN<br>IN<br>IN<br>IN<br>IN<br>I | CPU SYSTEM CLOCK. Used by the SBP 9961 to synchronize the interrupt interface<br>(INTREQ, ICO-IC3) to the CPU.<br>Supply Current<br>Ground Reference<br>Common voltage return/reference for all I/O pull-up resistors.<br>INTERRUPT INPUTS. When active (Iow), the signal is ANDed with its corresponding<br>mask bit and if enabled sent to the interrupt control section. INT1 has highest priority. |
| INT9<br>INT10<br>INT11<br>INT12<br>INT13<br>INT13<br>INT14<br>INT15  | 8<br>10<br>22<br>23<br>25<br>26<br>27<br>29  | IN<br>IN<br>IN<br>IN<br>IN<br>IN  |  |

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# 3.0 ELECTRICAL SPECIFICATIONS

# 3.1 RECOMMENDED OPERATING CONDITIONS, UNLESS OTHERWISE NOTED ICC= 130 mA

| PARAMETER                          |                        | MIN | NOM | MAX | UNIT |
|------------------------------------|------------------------|-----|-----|-----|------|
| Supply current, ICC                |                        | 115 | 130 | 145 | mA   |
| High-level output voltage, VOH     |                        |     |     | 5.5 | V    |
| Low-level output current, IOL      |                        |     |     | 20  | mA   |
|                                    | SBP 9961MJ, SBP 9961NJ | -55 |     | 125 |      |
| Operating free-air temperature, TA | SBP 9961EJ             | -40 |     | 85  | ] °c |
|                                    | SBP 9961CJ             | 0   |     | 70  | 1    |

# **3.2 ELECTRICAL CHARACTERISTICS (OVER RECOMMENDED OPERATING FREE-AIR TEMPERATURE RANGE, UNLESS OTHERWISE NOTED)**

|     | PARAMETER                 | TEST C  | CONDITIONS <sup>†</sup>                           | MIN | түр† | MAX  | UNIT |
|-----|---------------------------|---|---|-----|------|------|------|
| VIH | High-level input voltage  |   |   | 2   |      |      | V    |
| VIL | Low-level input voltage   | · · · · ·   |   |     |      | 0.8  | V    |
| VIK | Input clamp voltage       | I <sub>CC</sub> = MIN,                                | I <sub>I</sub> = -12 mA                           |     |      | -1.5 | V    |
| юн  | High-level output current | I <sub>CC</sub> = 130 mA,<br>V <sub>1L</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>V <sub>OH</sub> = 5.5 V |     |      | -400 | μA   |
| Vol | Low-level output voltage  | I <sub>CC</sub> = 130 mA,<br>V <sub>1L</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>I <sub>OL</sub> = 20 mA |     |      | 0.5  | v    |
| Ξi  | Input current             | I <sub>CC</sub> = 130 mA,                             | V <sub>I</sub> = 2.4 V                            |     | 180  |      | μA   |

<sup>†</sup>For conditions shown as MAX, use the appropriate value specified under recommended operating conditions

 $^{\dagger}$ All typical values are at  $I_{CC} = 130 \text{ mA}$ ,  $T_A = 25^{\circ}$ C.

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# 3.3 TIMING REQUIREMENTS OVER FULL RANGE OF OPERATING CONDITIONS

| PAR             | AMETER  | MIN | NOM | MAX | UNIT |
|-----------------|---|-----|-----|-----|------|
| t <sub>c</sub>  | Clock cycle time                                  | 333 |     |     | ns   |
| tr              | Clock rise time                                   |     | 10  | 20  | ns   |
| tf              | Clock fall time                                   |     | 10  | 20  | ns   |
| twL             | Clock pulse low width                             | 111 |     |     | ns   |
| twH             | Clock pulse high width                            | 222 |     |     | ns   |
| t <sub>su</sub> | Setup time for S0-S4, CE, or CRUOUT before CRUCLK |     | 200 |     | ns   |
| t <sub>su</sub> | Setup time, input before valid CRUIN              |     | 200 |     | ns   |
| t <sub>su</sub> | Setup time, interrupt before clock high           |     | 60  |     | ns   |
| tw(CRUCLK)      | CRU clock pulse width                             |     | 100 |     | ns   |
| th              | Address hold time                                 |     | 80  |     | ns   |
| тс              | TIMCK cycle time                                  |     | 200 |     | ns   |

# ${\bf 3.4}$ SWITCHING CHARACTERISITICS OVER FULL RANGE OF RECOMMENDED OPERATING CONDITIONS

|     | PARAMETER  | TEST CONDITIONS                  | MIN | ТҮР | MAX | UNIT |
|-----|--|----------------------------------|-----|-----|-----|------|
| tPD | Propagation delay, 1 CLOCK to valid<br>INTREQ, ICO-IC3     | CL = 25 pF, RL = 5 kΩ            |     | 150 |     | ns   |
| tPD | Propagation delay, S0-S4 or $\overline{CE}$ to valid CRUIN | $C_L = 25  pF, R_L = 5  k\Omega$ |     | 330 |     | ns   |

# 4.0 INPUT, OUTPUT, AND INPUT/OUTPUT STRUCTURES



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#### SWITCHING CHARACTERISTICS

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# **5.0 MECHANICAL DATA**

# 5.1 40-PIN PLASTIC DUAL-IN-LINE PACKAGE



5.2 40-PIN CERAMIC DUAL-IN-LINE PACKAGE



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# Miscellaneous 9900 Family Products

# TIMING CONTROLLER FOR THE SBP 9900A

- 14-Bit Interval Timer-Event Counter
- RESET and LOAD Synchronization
- SBP 9900A Clock Generation
- 20-Pin Package
- TTL Compatible Open-Collector I/O

## DESCRIPTION

The SBP 9964 is a 14-bit interval timer-event counter, an SBP 9900A clock generator and an SBP 9900A RESET and LOAD signal synchronizer. The interval timer-event counter communicates with the SBP 9900A through the SBP 9900A's Communication Register Unit (CRU) I/O interface. The interval timer-event counter may be efficiently applied to a variety of applications in which the interval between external events, the number of external events, or the initiation of periodic events is desired. RESET and LOAD synchronizers provide for SBP 9900A compatible synchronization of these signals from asynchronously applied external signals.



FIGURE 1 - FUNCTION BLOCK DIAGRAM

#### PRODUCT PREVIEW

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## SBP 9965

# PERIPHERAL INTERFACE ADAPTER

- Microprocessor Memory-Mapped I/O Peripheral Interface
- Dual 8-Bit Input/Output Peripheral Ports
- Internal Mask Registers and Associated Compare Logic for Character/Data Recognition
- TTL Compatible Open-Collector I/O
- 40-Pin Package

#### DESCRIPTION

The SBP 9965 Peripheral Interface Adapter is a byte oriented, parallel memory-mapped, input/output interface which interfaces to microprocessor CPU's through the memory bus. Two 8-bit I/O ports with independent handshake lines are provided which allow a variety of byte oriented peripheral devices to be efficiently interfaced to the CPU. High data rates are effected through parallel transfers of data between the CPU and the peripheral device.

Two internal mask registers, one associated with each I/O port, may compare logic which flags the CPU whenever an equal condition exists between I/O and mask register data. This feature is useful for byte string searches or control character recognition.



FIGURE 1 - FUNCTIONAL BLOCK DIAGRAM

#### PRODUCT PREVIEW

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JUNE 1979

# I<sup>2</sup>L MASK-PROGRAMMABLE READ-ONLY MEMORIES

- TTL-Compatible Inputs and Outputs
- Industry Standard Pin Assignments in 24-Pin Plastic and Ceramic Dual-In-Line Packages
- Open-Collector Outputs

BIPOLAR MEMORIES

#### description

These mask-programmed read-only memories offer the designer a wide range of options such as activehigh or active-low memory-enable pins and strobe control for latched or transparent output flip flops (see Programmable Options Table). These flexible, high-density ROMs can provide the basis for costeffective solutions to many design problems including, those in large, fixed program memories with capability for code converters, constants, character generators, and look-up tables.

The SBP 9818M is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to 125°C. The SBP 9818C is designed for operation from 0°C to 70°C.



SBP 9818M ... J PACKAGE SBP 9818C ... J OR N PACKAGE

#### PROGRAMMABLE OPTIONS TABLE

| PINS | MEMORY            | (ENABLE           | OUTPUTS            |
|------|-------------------|-------------------|--------------------|
| 18   | S2                | S2                |                    |
| 20   | S1                | S1                |                    |
| 01   | \$3               | \$3               | Strobe Controlled* |
| 21   | No Output Latches | No Output Latches | Output Latches     |

•A TTL high level at pin 21 will make the output flip flops transparent, a low TTL level latches the outputs.

## schematics of inputs and outputs





# functional block diagram



NOTE: ..... Indicates Programmable Options

# recommended operating conditions

| · · · · · · · · · · · · · · · · · · ·          | SBP 9818C<br>MIN NOM MAX I |  | S   | LINUT |     |      |    |
|--|----------------------------|--|-----|-------|-----|------|----|
|  |                            |  | MIN | NOM   | MAX | UNIT |    |
| Supply current, ICC                            | 300                        |  | 500 | 300   |     | 500  | mA |
| Strobe pulse width, tW(G)                      | 100                        |  |     | 100   |     |      | ns |
| Address setup time, t <sub>su(ad)</sub>        | 250↓                       |  |     | 250↓  |     |      | ns |
| Address hold time, th(ad)                      | 50↓                        |  |     | 50↓   |     |      | ns |
| Operating free-air temperature, T <sub>A</sub> | 0                          |  | 70  | -55   |     | 125  | °C |

↓The arrow indicates that the high-to-low transition of the strobe input is used for reference,

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|     | PARAMETER                | TEST CONDITIO   | NS                      | MIN | TYP  | MAX  | UNIT |
|-----|--------------------------|---|-------------------------|-----|------|------|------|
| ⊻ін | High-level input voltage |   |                         | 2   |      |      | V    |
| VIL | Low-level input voltage  |   |                         |     |      | 0.8  | V    |
| VIK | Input clamp voltage      | $I_{CC} = 3 \text{ mA or } V_{CC} = 5 \text{ V},$<br>$I_{I} = -12 \text{ mA}$ |                         |     |      | -1.5 | v    |
|     |                          |   | V <sub>O</sub> = 2.4 V  |     | 100  | 200  |      |
| юн  | Low-level input voltage  | ICC = 300 to 500 mA   | V <sub>O</sub> = 5.5 V  |     | 200  | 400  |      |
|     |                          | V <sub>IH</sub> = 2 V,  | VIL = 0.8 V,            |     | 0.25 | 0.4  |      |
| VOL | Low-level output voltage | I <sub>CC</sub> = 300 mA,   | I <sub>OL</sub> = 16 mA | 1   | 0.25 | 0.4  | 1    |
| 1.  | Input ourroat            | V <sub>1</sub> = 2.4 V  |                         |     | 340  |      |      |
| 1   | input current            | $V_1 = 0.4 V$   |                         |     | 25   |      | 1 #4 |

# switching characterisitics, $T_A = 25^{\circ}C$ , $C_L = 50 \text{ pF}$

|                    | PARAMETER                    | TEST CONDITIONS          | түр    |
|--------------------|------------------------------|--------------------------|--------|
| ta(ad)             | Access time from address     |                          | 250 ns |
| t <sub>a</sub> (S) | Access time from chip select | I <sub>CC</sub> = 300 mA | 150 ns |
| t <sub>a</sub> (G) | Access time from strobe      |                          | 150 ns |



#### FIGURE 1 - TIMING DIAGRAM

NOTE 2: A typical strobe pulse is indicated by the solid waveform. Select inputs may be active high or active low (as indicated by the dashed reference line) and enable or disable the outputs for the duration of their steady active or inactive conditions respectively.

## **ORDERING INSTRUCTIONS**

| TO BE | COMPL | FTFD | BY  | REQUESTOR   |
|-------|-------|------|-----|-------------|
| 100   | 00000 |      | ~ . | 11200201011 |

| COMPANY:ADDRESS:<br>POSTAL ZIP CODE:<br>CONTACT (NAME):<br>PHONE: (Area Code)(NO.)<br>CUSTOMER PURCHASE ORDER NO:<br>CUSTOMER PRINT OR I.D. NO:<br>CUSTOMER PART NO:<br>SYMBOLIZE AS PART NO: | Program<br>memoria<br>80-colur<br>Upon re<br>deck of<br>requeste<br>each of<br>of the in<br>(CAD)<br>program<br>complet<br>Each ca<br>words s<br>those v<br>columns<br>should b | iming i<br>les are s<br>min dat<br>compan<br>cereipt c<br>cards i<br>ed part<br>the wo<br>input da<br>progra<br>data;<br>red pro-<br>ard in<br>pecifier<br>vords.<br>s design<br>pe punc |
|---|---|--|
| ROM MEMORY-ENABLE OPTIONS<br>(Choose one option for each pin):  | Column<br>1-3   | Punc<br>inpu<br>desci  |
| A. PIN 18 H = true enable   | 4   | Punc   |
| (Check one)  □ L = true enable  |   | _  |
| B. PIN 20 $\Box$ H = true enable  | 5-7   | Punc   |
| (Choose one) □ L = true enable  |   | descr  |
| NOTES: 1. L = True enable pins will be logically true if left open.<br>2. All memory enable pins must be true to enable the<br>outputs.   | 8-9<br>10-17  | Blan<br>Punc<br>four,<br>5, D<br>first   |
| ROM LATCH/ENABLE OPTIONS  | 18  | Blan   |
| (Choose one option):  | 19-26   | Punc   |
| <ul> <li>A. □ TRANSPARENT LATCH FOR EACH OUTPUT<br/>(Pin 21 = H for transparency, L for storing)</li> <li>B. □ NO LATCHES (Choose memory enable option for</li> </ul>                         | 27  | Blan   |
| pin 21):  | 28-35   | Punc   |
| B1. PIN 21 (Choose one)<br>L = true enable  | 36  | Blan   |
|   | 37-44   | Punc   |
|   | 45-49   | Blan   |
|   | 50-80   | Same   |
| TO BE COMPLETED BY TI   |   |  |
| SPECIAL DEVICE NO:  |   |  |
| SALES ORDER NO:<br>CONTACT (NAME):  | LOCAT   | ION:<br>EXT:   |

#### **BIT PROGRAMMING INSTRUCTIONS**

instructions for each bit location of these read-only solicited in the form of a sequenced deck of standard a cards providing the information requested below, ied by a properly sequenced listing of these cards. of these items, a computer run will be made from the which will produce a complete function table for the . This function table, showing output conditions for ords, will be forwarded to the purchaser as verification ata as interpreted by the computer-automated design m. This single run also generates mask and test therefore, verification of the function table should be motiv.

the deck prepared by the purchaser identifies the d and describes the levels at the outputs for each of All addresses must have all outputs defined and ated as "blank" must not be punched. The 512 cards ched according to the following data card format:

- ch a right-justified integer representing the binary t address (000-2044) for the first set of outputs ribed on the card.
- ch a ''—'' (Minus sign)
- h a right-justified integer representing the binary t address (003-2047) for the last set of outputs ribed on the card.
- k
- ch "H", "L", or "X" for bits eight, seven, six, five, , three, two, and one (outputs DO 8, DO 7, DO 6, DO 00 4, DO 3, DO 2, and DO 1 in that order) for the set of outputs specified on the card. (See note 1.)
- ık
- ch "H", "L", or "X" for the second set of outputs.
- h "H", "L", or "X" for the third set of outputs.

h "H", "L", or "X" for the fourth set of outputs.

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e as the '187 data card format, page 15.

**TEXAS INSTRUMENTS** INCORPORATED POST OFFICE BOX 225012 • DALLAS, TEXAS 75265

# SBP/TMS 9900 TRANSPORTABLE CROSS-SUPPORT SOFTWARE PRODUCT DESCRIPTION

# • PACKAGING

The SBP/TMS 9900 transportable cross-support package, which is now available for sales and distribution, is composed of three distinct products: 9900 Cross Assembler, Simulator, and ROM Utility. The part number for the package is SYS9900/ 16F.X. The Product Name is TMS 9900 Transportable Cross-Support Software. Initially, the package will be manufactured only on ½ inch, 9 track PE encoded (IBM compatible) magnetic tape recorded at 1600 BPI. The tape will be un-labeled, un-blocked, with 80 ASCII bytes per data record and will contain 131 files. The first file on the tape is a data file which contains:

- a) A one-time descriptor for each file on the tape
- b) A bill of materials (to verify that the complete package has been received), and
- c) An errata list of problems and known solutions for the software version on that tape.

Each file on the tape is terminated by an EOF mark except for the last file which is terminated with a double EOF to indicate end-of-logical tape.

Included in the shipping package is a User Manual for each of the three programs and an Installation Manual covering each of the three programs (4 manuals, total).

# OPERATING ENVIRONMENT

The programs are written to conform to ANSI STANDARD X3.0 (1966) 16-BIT FORTRAN and are designed to execute on any minicomputer with the following minimum characteristics.

- 1) ANSI STANDARD X3.0 (1966) 16-BIT FORTRAN COMPILER
- 2) Two's complement arithmetic
- 3) Disc capacity for up to 7 simultaneously active sequential files.
- 4) A 20K-word user program-memory partition.

To date, the package has been extensively tested on the TI 990/10 under DX10V2.2, DEC PDP11/10 under RSX-11M (FIN IV PLUS), and System 370/160 under MVS.

# • 9900 CROSS ASSEMBLER DESCRIPTION

The SBP/TMS 9900 Assembly Language source is translated by the 9900 Cross Assembler into relocatable linkable SBP/ TMS 9900 Object module format. Both the source input and the object output are fully compatible with the FS 990 Prototype Development System and TMS time-sharing services (GE TERMINET, NCSS, and TYMSHARE).

# • SBP/TMS 9900 SIMULATOR DESCRIPTION

The Simulator is patterned after and affords extensions to the SBP/TMS 9900 Simulator on GE TERMINET, NCSS and TYMSHARE. Object modules generated by the Cross Assembler along with "link-control" statements are input to the first stage of the simulator. The output from this stage, an *absolute*, non-relocatable load module, plus simulation/debug control statements to the second stage of simulation. This stage may be operated in "batchmode" or interactively (e.g., the simulation/debug control stream is entered to the Simulator from a Keyboard/Display device). In this second phase of Simulation the user's program logic is verified and the program's performance characteristics are ascertained. Performance parameterization is supported for considerations such as target system clock speed, memory characteristics, and I/O part descriptions. Debug features include multiple breakpoints, full instruction trace and snapshots, plus the normal inspect/modify for CPU registers. All program references may be made symbolically, using symbols defined in the user's source program.

# • ROM UTILITY DESCRIPTION

When the application program has been satisfactorily verified, the object module may be input to the ROM Utility Program for translation into a format acceptable for production of a gate placement program (preparatory to mass production). Alternatively, the utility may be used to generate a BNPF formatted file which may be input to a PROM Programmer (DATA I/O) to produce a PROM version of the program. In all, there are 12 acceptable input formats and 12 output formats in support of the TMS 1000 and the SBP/TMS 9900 microprocessors.

# AMPL ... A COMPLETE MICROPROCESSOR PROTOTYPING LAB

The AMPL\* Microprocessor Prototyping Lab combines the high performance 990 computer with the low-cost flexibility of the floppy disk to provide a complete microprocessor prototyping lab. The AMPL lab provides in-circuit emulation support, logic-state trace and analysis, read-only memory implementation aids, and SBP 9900A software development support. This microprocessor lab provides the user a dedicated design center where 9900-based systems can be developed in an integrated software-hardware design and debug sequence. Substantial savings in design cost and design time in each phase of new product development is ensured with this system.

The microprocessor lab is structured around the FS9900 system, a fellow member of TI's 990 computer family. The FS990 system includes the Model 911 Video Display Terminal dual floppy-disk drive and TX990/TXDS system software license, all packaged in a self-contained single-bay desk. The Texas Instruments Model 810 Printer option for the FS990 system provides the user a fast throughput for software listings, trace data, and other hard-copy output requirements.

# **In-Circuit Emulation Support**

The SBP 9900A in-circuit emulation feature includes the SBP 9900A emulator, SBP 9900A buffer, and SBP 9900A target connector. This feature allows the SBP 9900A microprocessor-based system design engineer to simulate his target system by utilizing the dedicated 4096 words of emulator memory and the SBP 9900A microprocessor emulator. All functions of the proposed system can be simulated except input/output, and benchmark data can be tabulated.

SBP 9900A emulation is designed to aid the design engineer through each stage of his prototype implementation. Emulation control provided by the FS9900 system allows the design engineer to step through the developed code, setting breakpoints and instruction traces to start/stop tests at desired points within his code.

Two significant advantages included in the emulation feature are the use of dedicated emulator memory and the ability under interactive software control to switch back and forth between target system memory and emulator memory. The dedicated 4096 16-bit words of emulator memory provides a significant speed advantage over systems which utilize host system memory on a cycle-stealing basis. The faster, dedicated emulator is designed so that this dedicated memory can have precedence over target system memory so that even after target system memory is implemented, 9900 code changes can be quickly evaluated and tested before implementing this change in target system ROM/PROM.

## Logic-State Trace

The logic-state trace feature adds a dramatic new dimension to the integration and checkout of the target system.

The FS9900 system trace/emulation features interactive on-line control and analysis to provide fast data reduction and programmable emulation control based on the results of this analysis.

The trace feature can be interconnected with the emulator module or it can utilize the general-purpose Trace Data Probe. When interconnected to the emulator, the design engineer can trace 256 events of both address and 16-bit data. The Trace Data Probe provides 20 individual logic-line trace probes.

These probes can be used by the design engineer to trace any TTL logic lines desired in his target system. The sampling rate can be controlled by a 10-megahertz internal clock or by an external clock up to 10 megahertz. Of the 20 trace probes, 4 have a special glitch latch feature and can detect noise pulses down to 10 nanoseconds in width.

In addition to the 20 trace data probes, 4 general-purpose trace clock qualifier probes are provided to allow the user to prequalify trace conditions based on logic-state conditions within his target system. By using the interactive programming features within the host FS990 system, the design engineer can define procedures and functions to automatically process incoming trace data from these events, perform data reduction looking for defined conditions, display or print only the desired results, or branch into other emulation/trace procedures. Thus, for example the design engineer can set qualifying conditions and start trace and emulation in a continuous cycle while looking for those random troublesome noise glitches. Upon detecting a glitch, the trace/emulation cycle can be programmed to pause momentarily, analyze and print conditions, and then continue the trace/emulation sequence looking for the next glitch. This feature can mean tremendous savings in manpower and design checkout time since the full speed and power of the 990 computer is processing the problem.

## SBP 9900A-BASED

# TM 990/110M MICROCOMPUTER

The TM 990/110M is an assembled, tested microcomputer module utilizing as its CPU the powerful, ruggedized,  $I^2L$  16-bit SBP 9900A microprocessor. With RAM and ROM/EPROM included on board as well as programmable serial and parallel I/O, the TM 990/100M is a powerful single-board microcomputer. Since all address, data, and control lines are brought to the board connectors, the board can be expanded to use the entire capabilities of the SBP 9900A in larger systems. The TM 990/110M is also being reformatted to meet the form factor/ruggedness requirements of the U.S. Navy's standard electronic module (SEM) program.

# Features

- SBP 9900A 16-bit CPU
- 1024 words of 4045 Static RAM
- 1K words of 2708 EPROM, expandable to 4K words using 2716 EPROMs
- SBP 9960/SBP 9961 programmable system interface
- TMS 9902 asynchronous communications controller
- EIA or TTY terminal interface option
- Fully expandable bus structure
- Designed to fit the 990/510 chassis
- TIBUG operating monitor.

## Operation

The TM 990/110M microcomputer is a software compatible member of the SBP 9900A/990 family. The SBP 9900A is used as a CPU to provide 16 bits of processing power with a minicomputer instruction set which includes multiply and divide. The TM 990/110M module is designed for 3-MHz operation, utilizing the full 16 levels of prioritized interrupts and the advanced memory-to-memory architecture of the SBP 9900A. Additionally, the bus structures are set up to take advantage of the full 64K-byte memory-addressing capability of the SBP 9900A and the nonmultiplexed memory, I/O and interrupt buses.

#### Memory

The on-board memory includes both an EPROM/ROM section and a static RAM section. Four sockets are available for TMS 2708, TMS 2716 EPROM or TMS 4700, TMS 4732 ROM operation. Using the available jumper option, all four sockets can be populated with TMS 2716's, providing a maximum on-board EPROM capability of 4K words. The static RAM area consists of 1024 words of memory. Four TMS 4045's are included. The cycle time of this memory is 0.667 microseconds. The minimum area of EPROM/RAM area may not be used for off-board expansion. DMA control lines are also accessible on the bus.

#### Interrupts and Timers

Fifteen maskable interrupts plus the reset and load trap vectors are implemented. The SBP 9961 handles all 15 external interrupts which can be generated from either the bus connector or the SBP 9961 I/O bus. The SBP 9961 enables each level to be individually maskable under program control. Additionally, level 3 can be programmed to use the interval timer in the SBP 9961. Level 4 can be generated from the TMS 9902 as an interval timer or for three other serial interface conditions (see the TMS 9902 Data Manual). Two programmable timers, therefore, are available on board.

# I/O

The serial I/O and the parallel I/O are handled over the dedicated I/O bus of the SBP 9900A, the communications register unit (CRU). The TMS 9902 acts as the controller for this asynchronous serial interface. The character length, baud rate (75 to 38,400), and parity and stop bits are programmable. Three optional types of interface are supported:

- EIA
- 20 mA neutral current loop TTY
- Private wire differential line driver/receiver.

The TM 990/110M board is delivered complete with a 25-pin RS-232 type female connector, and is jumper selectable to support EIA or TTY operation. The differential line driver is normally unpopulated (see *Options*). Also, the TMS 9903 synchronous communications controller can be utilized since the TMS 9902/9903 are socket compatible.

The parallel I/O is handled by the SBP 9900/SBP 9961 pair; 16 parallel lines are all interfaced to the top edge connector which as 40 pins on 0.100 inch centers. Additionally, eight parallel lines are interfaced to the bus connectors. All I/O lines are equipped with pullup resistors.

## TIBUG

The TIBUG monitor TM 990/401-1 is normally supplied preprogrammed in the populated TMS 2708 EPROMs (see *Options*). Its operation is described in the *User's Manual* or the TM 990 Series literature.

#### Options

The TM 990/110M-1 board is equipped with two TMS 2708's preprogrammed with the TIBUG monitor, and the serial I/O is jumper selectable as EIA port or a TTY interface. The TM 990/110M-2 board is populated with two blank EPROMs, and a private wire differential line driver interface is populated instead of the TTY interface. Other software or accessories, such as the line by line assembler and the microterminal, may be ordered under separate part numbers.



Figure F-1. TM 990/110 FUNCTIONAL DIAGRAM

# Specifications

CPU: SBP 9900A

Instruction Set – 69 instructions 8,16, or 32-bit operation 3 MHz System Clock

Interrupts: 16 levels - 15 may be external

Interval Timers: Two (in SBP 9961 and TMS 9902)

|          |            | Maximum    |
|----------|------------|------------|
|          | Resolution | Interval   |
| SBP 9961 | 21.3 µsec  | 349 msec   |
| TMS 9902 | 64 µsec    | 16.32 msec |

Memory: 16-bit word configuration

On-board EPROM/ROM, 1K words, expandable to 4K On-board RAM, 1024 words Off-board expansion to full 32K words

#### I/O

Parallel: 16 lines (expandable to 4K total I/O using CPU)

Serial: Asynchronous Controller TMS 9902 5-8 bit character

Programmable data rate, stop bits, parity

# Baud Rates (bps):

| 75   |   | 2400   |
|------|---|--------|
| 110  | 4 | 4800   |
| 150  |   | 9600   |
| 300  |   | 19,200 |
| 600  |   | 38,400 |
| 1200 |   |        |

# Interfaces

| Bus: Data and Address<br>Control |                     | Three-state TTL compatible buffered output TTL compatible |
|----------------------------------|---------------------|---|
| Parallel                         | I/O and Interrupts: | TTL compatible  |
| Serial I/O:                      |                     | RS-232, 20 mA current loop or differential line driver    |
|                                  |                     |   |

## Software

TIBUG monitor self-contained in EPROM

#### Mating Connectors

| Bus          | 100 pin, 0.125 in. | TI<br>TI | H321150 (wire wrap)<br>H322150 (solder tail) |
|--------------|--------------------|----------|--|
| Parallel I/O | 40 pin, 0.100 in.  | TI<br>3M | H311120 (wire wrap)<br>3464-0001 (no ears)   |

# FIBER-OPTIC COMPONENTS

# TTL MSI

# TYPES SN74LS462, SN74LS463 FIBER-OPTIC DATA-LINK CONTROLLERS

SN74LS462

AUGUST 1979

- Inexpensive, Reliable Alternative to Conventional Copper-Wire Systems
- Single 5-Volt Supply
- Inputs and Outputs Compatible with TTL and Low-Level MOS
- Data Rate of 1 Megabit/Second
- Byte-Oriented Expansion Capability for 16-Bit Applications
- Interfaces With a Wide Range of Optical-Link Components
- Space-Saving 20-Pin 300-Mil Package

|   | J OR N DUAL-IN-LINE PACKAGE<br>(TOP VIEW)   |
|---|---|
| SN74LS462 TRANSMITTER<br>• Drive Current Up To 200 mA<br>• Three Operational Modes:<br>Continuous Data Stream<br>DC Sync (8-Bit or 16-Bit Bursts)<br>AC Sync (8-Bit or 16-Bit Bursts)<br>• Automatic Start-Up | DATA START 1 20 V <sub>CC</sub><br>D7 2 19 DA<br>D6 3 18 E0<br>D5 4 17 E1<br>D4 5 16 CKO<br>D3 6 15 ¢<br>D2 7 14 MODE<br>D1 8 13 AC<br>D0 9 12 E2<br>GND 10 11 SO |
| SN74LS463 RECEIVER  | SN74LS463<br>J OR N DUAL-IN-LINE PACKAGE<br>(TOP VIEW)<br>E0 1 20 VCC<br>E1 2 19 D7   |

- Input Sensitivity of 1 μA
- Error Indication
- 3-State Parallel Data Outputs
- Isolated Comparator Ground For Improved Common-Mode Noise Rejection



#### description

The SN74LS462 transmitter and SN74LS463 receiver are designed for use in optical-wave data-transmission systems. Fabricated with oxide-isolated Integrated Injection Logic (I<sup>2</sup>L) and low-power Schottky<sup>†</sup> TTL technology, these devices are operated from a single 5-volt dc power source and are completely TTL-compatible on all inputs and outputs. The SN74LS462/SN74LS463 transmitter/receiver pair are designed to provide the appropriate encoding, synchronizing, and decoding logic necessary control the transmission of digital data through a wide variety of serial fiber-optic data-link assemblies.

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<sup>†</sup>Integrated Schottky-Barrier diodeclamped transistor is patented by Texas Instruments, U.S. Patent Number 3,463,975,

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# description (continued)

The basic fiber-optic data link shown in Figure 1 consists of five stages; encoding logic, which converts parallel data to be transmitted into a modulated serial data stream; a transducer (source) to convert the electrical serial data stream into optical logic levels (LED on or off); an optical waveguide (fiber) for transmission of the optical data stream; a transducer (detector), which converts the optical levels back into electrical logic levels; and lastly, decoding logic to convert the modulated serial data stream back into parallel output data.



FIGURE 1 – TYPICAL SIMPLEX FIBER-OPTIC DATA LINK

The functions of encoding and decoding are efficiently provided by the SN74LS462 transmitter and SN74LS463 receiver, respectively, by incorporating all of the necessary logic in space-saving, 20-pin, 300-mil packaging. Transducer functions and transmission fibers can be selected from a wide variety of plastic, glass, or silica assemblies now available including Texas Instruments TXE series of low-cost, all plastic, source, detector, and fiber-cable assemblies.

The SN74LS462 transmitter accepts eight-bit parallel data inputs, encodes this data into frequency-shift coding (FSC), and transmits this information in the user-selected operating mode out of the serial output. (For an explanation of frequency-shift coding, see the "Operation" section of this data sheet). The serial output is capable of driving directly an infrared-emitting diode (IRED), which is coupled through a fiber-optic cable to a PIN detector diode. The SN74LS463 receiver then accepts very low-level currents from the PIN detector into an internal transimpedance amplifier, which amplifies this signal to the level required by the logic. The receiver then decodes the serial data stream and reconstructs the eight bits of parallel data originally transmitted. The parallel data word may be expanded to 16-bits through the addition of four standard low-power Schottky components interfaced to the transmitter's and receiver's expand pins. Both transmitter and receiver require either a crystal or TTL-level clock connected to the  $\phi$  input.

More detailed information on the functions of these controllers is included elsewhere in this data sheet in the section entitled "Operation".



#### schematics of inputs and outputs

# TEXAS INSTRUMENTS INCORPORATED

# SN74LS462

| PIN       | SIGNATURE       | FUNCTION   |
|-----------|-----------------|--|
| 1         | DS              | Data start input loads data into the buffer register on the low-to-high-<br>level transition provided that the data acknowledge output is high,  |
| 2         | D7              |  |
| 3         | D6              |  |
| 4         | D5              |  |
| 5         | D4              |  |
| 6         | D3              | > Parallel data inputs.  |
| 7         | D2              |  |
| 8         | D1              |  |
| 9         | D0              |  |
| 10        | GND             | Ground.  |
| <b>11</b> | SO              | Serial output provides a signal capable of driving an infrared-emitting diode (200 mA maximum). SO is connected to the cathode of the diode, and the anode is connected to five volts through a 33-ohm resistor.   |
| 12        | E2              | Expand-2 input accepts inverted data from an external eight-bit shift register for 16-bit operation.   |
| 13        | AC              | AC sync input, which, if mode input is high, selects the AC mode of operation when high and the DC mode when low.  |
| 14 .      | MODE            | Mode input when high allows the AC input to select either AC sync<br>mode or DC sync mode. When low (and AC is low), it selects the con-<br>tinuous mode of operation.   |
| 15        | $\phi$          | Clock input for crystal or TTL clock. (Clock frequency = 8X data rate).  |
| 16        | СКО             | Clock output provides clock frequency to the receiver at the same loca-<br>tion when bidirectional operation is required.  |
| 17        | E1              | Expand-1 output shifts data out of the external shift register for 16-<br>bit operation. For eight-bit operation this is an input and it must be<br>high.  |
| 18        | EO              | Expand-0 output loads external serial shift register for 16-bit operation.   |
| 19        | DA              | Data-acknowledge output provides a signal that, when high, indicates<br>that the buffer register is ready to accept data. It goes low approximately<br>250 ns after a low-to-high-level transition of data start thereby acknow-<br>ledging the input of data. |
| 20        | V <sub>CC</sub> | +5V Supply.  |
|           |                 |  |

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# SN74LS463

| PIN | SIGNATURE       | FUNCTION  |
|-----|-----------------|---|
| 1   | EO .            | Expand-0 output supplies serial data to an external shift register for 16-bit operation.  |
| 2   | E1              | Expand-1 output supplies a clock signal to an external serial shift register for 16-bit operation. For eight-bit operation this is an input and should be shorted to V <sub>CC</sub> .  |
| 3   | E2              | Expand-2 output provides a signal to load data from the external serial register to the external parallel-output buffer register for 16-bit operation.  |
| 4   | $\phi$          | Clock input for crystal or TTL clock. (Clock frequency = 8X data rate).   |
| 5   | AV              | Data-available output goes high when a demodulated word is trans-<br>ferred from the serial shift register to the parallel-output buffer register.<br>This output is self-clearing: it goes inactive (low) typically 800 nano-<br>seconds after going high.   |
| 6   | EF              | Error-flag output goes high if a data bit times out during the trans-<br>mission of 8 or 16 bits of data; that is, if an FSC transition has not<br>occurred in 10 clock periods. It will then remain high (and AV will be<br>inhibited [low]) until 8 bits (or 16 bits for 16-bit operation) have<br>been received without a time-out error occurring on any bit. |
| 7   | GND2            | Comparator ground.  |
| 8   | NONINV          | Noninverting comparator input from the infrared-detecting diode.  |
| 9   | INV             | Inverting comparator input from the infrared-detecting diode.   |
| 10  | GND1            | Digital ground.   |
| 11  | ŌĒ              | Output enable input, which, when low, enables the buffer register out-<br>puts and when high, forces the buffer register outputs into the high-<br>impedance state.   |
| 12  | D0              | )   |
| 13  | D1              |   |
| 14  | D2              |   |
| 15  | D3              |   |
| 16  | D4              | > Buffer register data outputs.   |
| 17  | D5              |   |
| 18  | D6              |   |
| 19  | D7              |   |
| 20  | V <sub>CC</sub> | +5 V Supply.  |

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1)     | 7 V    |
|--|--------|
| Input voltage, any logic input                   | 7 V    |
| Off-state output voltage, SN74LS463 data outputs | 5.5 V  |
| Operating free-air temperature range             | • 70°C |
| Storage temperature range                        | 150°C  |

NOTE 1: Voltage values are with respect to the network ground terminal.

#### recommended operating conditions

|  |                                      | SI   | V74LS4 | 62   | SN74LS463 |     |      |      |
|--|--------------------------------------|------|--------|------|-----------|-----|------|------|
|  |                                      | MIN  | NOM    | MAX  | MIN       | NOM | MAX  | UNIT |
| Supply voltage, V <sub>CC</sub>                |                                      | 4.75 | 5      | 5,25 | 4.75      | 5   | 5.25 | V    |
| Off-state output voltage, SN74LS4              | 63 data outputs                      |      |        |      |           |     | 5.5  | V    |
| High-level output voltage, SO output           | -level output voltage, SO output 5.5 |      |        |      |           | V   |      |      |
| High-level output current, IOH                 |                                      |      |        | -400 |           |     | μA   |      |
|  | SO output                            |      |        | 200  |           |     |      |      |
| Low-level output current, $I_{OL}$             | E1 output                            |      |        |      |           |     | 3    | mA   |
|  | other outputs                        |      |        | 8    |           |     | 8    |      |
| Operating free-air temperature, T <sub>A</sub> |                                      | 0    |        | 70   | 0         |     | 70   | °C   |

# electrical characteristics over recommended operating free-air temperature (unless otherwise noted)

| DADAMETED      |  | TEAT CONDITIONS |                          | S   | SN74LS462 |                  |      | SN74LS463 |      |      |      |
|----------------|--|-----------------|--------------------------|---|-----------|------------------|------|-----------|------|------|------|
|                | PARAMET                                      | ER              | TEST CON                 | DITIONS   | MIN       | TYP <sup>‡</sup> | МАХ  | MIN       | TYP‡ | MAX  | UNIT |
| ∨ін            | High-level logic                             | input voltage   |                          |   | 2         |                  |      | 2         |      |      | V    |
| VIL            | Low-level logic                              | input voltage   |                          |   |           |                  | 0.8  |           |      | 0.8  | V    |
| VIK            | Input clamp vol                              | tage            | V <sub>CC</sub> = MIN,   | l <sub>l</sub> = –18 mA                         |           |                  | -1.5 |           |      | -1.5 | V    |
| ν <sub>τ</sub> | Comparator inp<br>voltage                    | ut threshold    | V <sub>CC</sub> = MAX    |   |           |                  |      |           | 1.2  |      | V    |
|                | Comparator inp                               | ut current      | V <sub>CC</sub> = MAX    |   |           |                  |      | 1         |      | 100  | μA   |
| VOH            | High-level output                            | it voltage      | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V,                          | 2.4       |                  |      | 2.4       |      |      | v    |
|                | (any output except SO)                       |                 | V <sub>IL</sub> = 0.8 V, | OH = 0.4 mA                                     |           |                  |      |           |      |      |      |
|                | Low-level                                    | SOoutput        | $V_{CC} = MIN_{c}$       | V <sub>IH</sub> = 2 V,<br>I <sub>OL</sub> = MAX |           |                  | 0.5  |           |      |      |      |
| VOL            | output voltage                               | E1 output       | VII = 0.8 V.             |   |           | 0.35             | 0.5  |           | 0.35 | 0.5  | V    |
|                |  | other outputs   |                          |   |           | 0.35             | 0.5  |           | 0.35 | 0.5  |      |
|                | High-level output                            | ut current,     | $V_{CC} = MIN,$          | V <sub>IH</sub> = 2 V,                          |           |                  | 4    |           |      |      | mA   |
|                | (SO output)                                  |                 | V <sub>IL</sub> = 0.8 V, | V <sub>OH</sub> = 5.5 V                         |           |                  |      |           |      |      |      |
|                | Off-state output                             | t current,      | Vcc = MAX.               | VIH = 2 V.                                      |           |                  |      |           |      |      |      |
| IOZH           | high-level voltage applied                   |                 | $V_0 = 2.7 V$            |   |           |                  |      |           | 50   | μA   |      |
|                | (D0-D7 outputs                               | (D0-D7 outputs) |                          |   |           |                  |      |           |      |      |      |
|                | Off-state output                             | t current,      | Vcc = MAX,               | Viн = 2 V,                                      |           |                  |      |           |      |      |      |
| IOZL           | low-level voltage applied<br>(D0-D7 outputs) |                 | Vo = 0.4 V               | $V_0 = 0.4 V$                                   |           |                  |      |           |      | -50  | μΑ   |
|                |  |                 | 0                        |   |           |                  |      |           |      |      |      |
| 1.             | Input current at maximum<br>input voltage    |                 | Vcc = MAX.               | Vi = 5.5 V                                      |           |                  |      |           |      | 1    | mA   |
| Ľ'             |  |                 |                          |   |           |                  |      |           |      |      |      |
| Чн             | IIH High-level input current                 |                 | V <sub>CC</sub> = MAX,   | V <sub>I</sub> = 2.4 V                          |           |                  | 20   |           |      | 20   | μΑ   |
| կե             | ILL Low-level input current                  |                 | V <sub>CC</sub> = MAX,   | V <sub>I</sub> = 0.4 V                          |           |                  | -0.4 |           |      | -0.4 | mA   |
| los            | IOS Short-circuit output current §           |                 | V <sub>CC</sub> = MAX    |   | -20       |                  | -100 | -20       |      | -100 | mA   |
| 1cc            | Supply current                               |                 | V <sub>CC</sub> = MAX    |   |           |                  | 100  |           |      | 100  | mA   |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions,

<sup>‡</sup>All typical values are at  $V_{CC}$  = 5 V,  $T_A$  = 25°C.

 $\S$  Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

# timing requirements over recommended ranges of TA and VCC

| PARAMETER          |                                       | SN7   | SN74LS463 |     |     |     |      |
|--------------------|---------------------------------------|-------|-----------|-----|-----|-----|------|
|                    |                                       | MIN N | NOM MAX   | MIN | NOM | MAX | UNIT |
| t <sub>c</sub> (φ) | Clock cycle time                      | 100   |           | 100 |     |     | ns   |
| <sup>t</sup> r(φ)  | Clock rise time                       |       |           |     |     | 18  | ris  |
| t <sub>f</sub> (φ) | Clock fall time                       |       | 9         |     |     | 18  | ns   |
| t <sub>w(φ)</sub>  | Clock pulse width                     | 50    |           | 50  |     |     | ns   |
| t <sub>su</sub>    | Setup time, data in before data start | 15    |           |     |     |     | ns   |
| th                 | Hold time, data in after data start   | 30    |           |     |     |     | ns   |

# switching characteristics over recommended ranges of TA and V<sub>CC</sub>

|    | BARAMETER  | TEST CONDITIONS |                     | S | SN74LS462        |     | SN74LS463 |                  |     |      |
|----|--|-----------------|---------------------|---|------------------|-----|-----------|------------------|-----|------|
|    | PARAMETER  |                 | TEST CONDITIONS     |   | TYP <sup>‡</sup> | MAX | MIN       | TYP <sup>‡</sup> | MAX | UNIT |
| td | Delay time, data start high to<br>data acknowledge low |                 | See Figures 2 and 3 |   | 450              |     |           |                  |     | ns   |
| td | Delay time, data in to serial out                      |                 |                     |   | 250              |     |           |                  |     | ns   |
| td | Delay time, output enable to<br>data out               |                 |                     |   |                  |     | 35        |                  |     | ns   |
| td | Delay time, data in to data<br>available               |                 |                     |   |                  |     |           | 400              |     | ns   |
| td | Delay time, invalid data to<br>error flag              |                 |                     |   |                  |     |           | 300              |     | ns   |
| td | Delay time, clock ( $\phi$ ) input to clock output     |                 |                     |   | 30               |     |           |                  |     | ns   |
| tw | Pulse width, data available high                       |                 |                     |   |                  |     |           | 800              |     | ns   |

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

# PARAMETER MEASUREMENT INFORMATION





Vcc

CL includes probe and jig capacitance

SN74LS462 LOAD CIRCUIT



FIGURE 2 - LOAD CIRCUITS
PARAMETER MEASUREMENT INFORMATION





SN74LS462 VOLTAGE WAVEFORMS



SN74LS463 VOLTAGE WAVEFORMS

FIGURE 3 - SWITCHING CHARACTERISTICS

#### OPERATION

#### serial data coding and synchronization

#### frequency-shift coded (FSC) data

Frequency-shift coding, or FSC, is a term for a data transmission code in which each bit period begins with a transition. A space ('0') has no transition during the bit period, however, a mark ('1') has one transition during the bit period (See Figure 4). FSC formatting provides the advantage that it is self-clocking and therefore precludes the necessity of transmitting a clock signal to the receiving end to define the point in time in which data is valid. The SN74LS462 transmitter and SN74LS463 receiver incorporate FSC data to provide a data rate of one megabit per second.





#### continuous-data-stream mode

Continuous-data-stream mode refers to a mode of serial data transmission in which the word boundaries between consecutive transmissions are not defined by any type of synchronization periods. (See Figure 5A). That is, the next consecutive word is transmitted immediately following the previous word. When no further data is to be transmitted, the serial data line goes to a logic high (LED off) state until a new word is to be transmitted. Continuous data stream offers the advantage of a higher data rate than synchronized transmission schemes.

#### dc-synchronization mode

In the dc-synchronization mode, word boundaries are separated by two bit times at a high logic level (LED off). When no data is to succeed the previous transmission, the serial data line goes to a logic high state until a new word is to be transmitted (See Figure 5B). When new data is to be transmitted after an extended (greater than two bit times) idle period, the current synchronization period will be completed prior to transmission. (i.e., idle periods are always a multiple of two bit time sync periods). Dc synchronization offers the advantage over continuous data stream in that word boundaries are defined by the synchronization period.

#### ac-synchronization mode

Ac synchronization refers to a three-bit time synchronization period wherein the signal is low for one half of the synchronization period (one and a half bit times) and is high for the other half of the synchronization period. The initial state of the synchronization period is dependent upon the status of the serial data line when the synchronization period is entered. If the serial line is low, the first half of the synchronization period is high and the second half is low. Likewise, if the serial line is high, the first half of the synchronization period is low and the second half is high. When no further data is to succeed the previous transmission, the alternating synchronization period is repeated until the next word is to be transmitted. The current synchronization period will be completed prior to data transmission. (See Figure 5C). Ac synchronization provides the advantage that the receiving end remains in constant synchronization with the transmitting end, even during extended idle periods.







#### SN74LS462 transmitter functional description

#### SN74LS462 operational description

When power is first applied to the transmitter, power-up circuitry causes the data acknowledge (DA) output to go active (high) indicating that the buffer register is empty and ready to accept data. (See Figure 6). Parallel loading of the data present on the D0-D7 input pins is accomplished by taking the data start (DS) input high when the data acknowledge is high. Loading will then occur on the rising edge of data start. The parallel data loaded into the buffer register appears at the inputs of the shift register. Approximately 250 nanoseconds after the rising edge of data start, data acknowledge (DA) goes inactive (low). Simultaneously, control logic sends out a pulse to the shift register, and the shift register loads the data from the buffer register is ready to accept new data. The new data now present on the D0-D7 data lines will be entered into the buffer register upon the occurance of the next low-to-high transition of data start. The shift register begins shifting data, one bit at a time, into the modulator where it is encoded into FSC format and output on the serial output (SO) pin. After the eighth bit has been transmitted, further operation depends upon the mode of operation selected by the MODE and ac-sync (AC) inputs. (See Table 1). If the continuous-data-stream mode is selected, the next eight bits are loaded into the shift register from the buffer register and shifting of the data continues without interruption. In the dc-sync mode, the two-bit synchronization period will be inserted between consecutive transmissions. In the

#### OPERATION

ac-sync mode, the three-bit synchronization period will be inserted between consecutive transmissions. (See acsynchronization mode.) In all modes, the output of the modulator is amplified so that the serial output (SO) is capable of directly driving an external infrared-emitting diode (source).

In all modes, if the buffer and shift registers are empty, data acknowledge will be high and the transmitter will enter the wait mode. In the wait mode, if dc-sync or continuous (bit stream) operation is selected, the SO output will remain high (transmit diode off). In the ac-sync mode, the SO output will repeat the three-bit synchronization period. The wait mode is ended by the rising edge of a data start pulse. When exiting an extended wait period, the transmitter will complete the current synchronization period (two bit times for dc-sync, three bit times for ac-sync) prior to beginning serial output from SO.

The transmitter has a clock input ( $\phi$ ) for connection of crystal or TTL-level clock. The bit time is defined as eight cycles of the clock input so that for one-megabit-per-second operation, the clock ( $\phi$ ) frequency must be 8 megahertz. The clock output (CKO) may be used to source the SN74LS463 receiver clock input when full-duplex (bidirectional) systems are configured. The two expander outputs, E0 and E1, and the expander input E2 are used to control external devices when the transmitter is configured for 16-bit operation (see Figure 7). However, for 8-bit operation E1 must be tied directly to V<sub>CC</sub> (+5 volts).

| Γ | INP              | UTS            |                      | ] |
|---|------------------|----------------|----------------------|---|
|   | MODE<br>(PIN 14) | AC<br>(PIN 13) | SYNC SELECTED        |   |
| ſ | L                | L              | Continuous (no sync) | 1 |
|   | L                | н              | Undefined            |   |
|   | н                | L              | DC sync              |   |
|   | н                | н              | AC sync              |   |

#### FUNCTION TABLE

H ≕ high level, L = low level



#### TABLE 1 - MODE-SELECT FUNCTION TABLE

FIGURE 6-SN74LS462 FUNCTIONAL BLOCK DIAGRAM

#### OPERATION

#### SN74LS462 transmitter 16-bit expansion

Sixteen-bit expansion of the transmitter is effected through connection of an SN74LS377 octal D-type flip-flop and an SN74LS165 octal shift register to the expander pins of the transmitter (E0, E1, and E2). (See Figure 7). Addition of these two standard low-power Schottky devices effectively expands the buffer and shift registers of the transmitter to 16 bits. Input E2 is the serial data output of the 'LS165. Outputs E0 and E1 control the shift/load and clock functions, respectively, of the 'LS165. Note that the data start (DS) input is also used to clock data into the 'LS377 external buffer register. Operation in 16-bit mode is identical to 8-bit operation except that the transmitted word length is now 16-bits long.

#### source interface to SN74LS462 transmitter

The serial output (SO) of the transmitter utilizes extremely large output buffer circuitry to provide 200 milliamperes of low-level sink current. This allows the SN74LS462 transmitter to be interfaced to a wide variety of infrared emitting diode (IRED) source assemblies.

The source assembly is connected in the manner illustrated in Figure 8. Note that for a forward diode current of 100 milliamperes, resistor R is shown to be 32 ohms.



#### OPERATION

#### SN74LS463 receiver functional description

#### SN74LS463 operation description

The SN74LS463 receiver receives very-low-level currents generated by the external photodiode detector, amplifies this signal, and decodes it into eight (or optionally 16) parallel data outputs. A block diagram of the SN74LS463 is shown in Figure 9.

The SN74LS463 has amplifier/comparator inputs, NONINV and INV, which receive the signal from the photodetector. The clock input ( $\phi$ ) provides the synchronization for the circuit. The error flag (EF) output indicates a long-bit error has occurred during the transmission of the eight (or 16) bits of data. The data available output (AV) indicates when the data is available at the output buffer register (D0-D7). The AV output will remain active (high) until the occurrence of an appropriate edge is received by the receiver. For the ac-sync mode, AV will clear typically 800 nanoseconds after it becomes active. For the continuous and dc-sync modes, the time at which AV is cleared inactive (low) is dependent upon the state of the input when the last bit of a bit stream is received. If the bit stream is concluded with a high logic level, the next input transition that clears AV will not occur until the first transition of the first bit of the next eight (or 16) bits to be received. However, if the bit stream is concluded with a low logic level, AV will be cleared when the transition to the high logic level of idle is entered. Because the actual point when AV becomes inactive (low) is dependent upon the subsequent data transmitted system designers are urged to utilize the rising edge of AV to set flags, control logic, etc. in their systems. The output enable ( $\overline{OE}$ ) input either enables the eight parallel three-state outputs or forces them into the high-impedance state. The expander outputs, E0, E1, and E2, are used to expander cevier operation to 16 bits. For eight-bit operation, E1 must be connected to V<sub>CC</sub>.

The first stage of the SN74LS463 is a low-noise front-end amplifier optimized for use with a PIN detector diode. When the photodiode detects the infrared signal transmitted through the fiber-optic cable, it produces an output current proportional to the received infrared intensity. This current is converted to a voltage by the comparator transimpedance amplifier and amplified to the levels required for internal logic. The FSC information synchronizes with the timer-counter logic in the demodulator where it is demodulated into non-return-to-zero (NRZ) format and fed to a serial shift register. The internal shift register accepts eight-bit serial data and transfers it in parallel to the buffer register. The data outputs from the buffer register are controlled by the output enable (OE) input; a low at this input enables the outputs, a high forces the outputs to the high-impedance state. If 16-bit operation is selected, serial data will shift out through output E0 to the serial input of an external shift register and data from the external shift register is loaded



FIGURE 9 - SN74LS463 FUNCTIONAL BLOCK DIAGRAM

#### OPERATION

into an external buffer register with a pulse from output E2. A clock signal is supplied to the external shift register through output E1, but for eight-bit operation E1 acts as an input and must be tied to V<sub>CC</sub>.

The receiver counts eight clock pulses for each data bit. If an FSC transition has not occurred within ten clock periods, the bit will time-out. If less than eight bits (or 16 bits for 16-bit operation) have been received when a time-out error occurs, data available will be inhibited (low) and error flag will go high until eight bits (or 16 bits for 16-bit operation) have been received without a time-out error occurring on any bit. After eight bits (or 16 bits for 16-bit operation) have been received without a time-out error, error flag will go low and data available will operate normally. At the end of each eight bits (or 16 bits), a two-bit or longer synchronization pulse (idle period) may occur. This will be recognized as such by the internal circuitry, and error flag will remain low. If synchronization pulses do not occur after eight bits (or 16 bits for 16-bit operation), the continuous bit-stream mode will be assumed.

#### SN74LS463 receiver 16-bit expansion

Sixteen-bit expansion of the receiver is effected through connection of an SN74LS164 8-bit serial shift register and an SN74LS374 octal D-type flip-flop to the expander pins of the receiver (E0, E1, and E2). Figure 10 illustrates the connection of these devices to the receiver.

#### detector interface to the SN74LS463 receiver

The detector assembly is connected to the receiver in the manner illustrated in Figure 11. The PIN detector diode is connected to the NONINV comparator input, and the second diode is a compensating diode connected to the INV comparator input to offset the effects of temperature on the PIN diode characteristics and to establish a PIN "dark" low-level current level.



FIGURE 10 - SN74LS463 16-BIT CONFIGURATION



FIGURE 12 - WIRING DIAGRAM 8-BIT AC SYNC MODE



FIGURE 13 - WIRING DIAGRAM 16-BIT AC SYNC MODE

# Bipolar Memories

#### PROM NUMBERING SYSTEM AND ORDERING INSTRUCTIONS

To complement Texas Instruments continually expanding line of bipolar PROMs, a new numbering system is being implemented. This system provides the user with information regarding the generic programming family, bit density, organization, temperature range, and the size and type of package without the necessity of looking up this information in tables. Below is a guide for use of this new numbering system.

Factory orders for PROMs described in this book should include a type number as explained in the following example.



## USER-PROGRAMMABLE READ-ONLY MEMORY (PROM) LINE SUMMARIES

#### STANDARD PROMS

| NIC141       | 010          |            | DIT CIZE                    | TYPICAL PER  | FORMANCE    | GEE   |  |
|--------------|--------------|------------|-----------------------------|--------------|-------------|-------|--|
|              |              |            | BIT SIZE                    | ADDRESS      | POWER       |       |  |
| I YPE NUMBER | I TPE NOMBER | I.TPE'     | (ORGANIZATION)              | ACCESS TIME  | DISSIPATION | PAGE  |  |
| TBP18SA030   | SN74S188     | <u> </u>   | 256 Bits                    | 25.00        | 400         |       |  |
| TBP18S030    | SN74S288     | $\Box$     | (32W X 8B)                  | 25 115       | 400 11144   | 6.7   |  |
| TBP14S10     | SN74S287     | $\nabla$   |                             | 42           | E00 m14/    | ] 5-7 |  |
| TBP14SA10    | SN74S387     | Q          | 1024 Bits                   | 42 115       | 500 111     |       |  |
| TBP24S10     |              |            | (256W X 4B)                 | 25.00        | 275 mW      | 5-13  |  |
| TBP24SA10    |              | $\diamond$ |                             | 35115        | 37511144    | 0.0   |  |
| TBP18SA22    | SN74S470     | <u> </u>   | 2048 Bits                   | 50 pc        | EEO mW      |       |  |
| TBP18S22     | SN74S471     | $\nabla$   | (256W X 8B)                 | 50 115       | 550 1144    |       |  |
| TBP18S42     | SN74S472     |            |                             |              |             | 5-7   |  |
| TBP18SA42    | SN74S473     | $\Diamond$ |                             | 55.00        | 600 mW      |       |  |
| TBP18S46     | SN74S474     |            | 4096 Bits                   | 55 115       |             |       |  |
| TBP18SA46    | SN74S475     | $\diamond$ | (512W X 8B)                 |              |             |       |  |
| TBP28S42     |              | $\nabla$   |                             | 25.00        | 500 mW      |       |  |
| TBP28S45     |              |            |                             | 30 115       | 500 11177   |       |  |
| TBP24S41     | SN74S476     | $\nabla$   | 4096 Bits                   | 4096 Bits    |             | í     |  |
| TBP24SA41    | SN74S477     | <u> </u>   | (1024W X 4B)                | 40115        | 475 1114    |       |  |
| TBP24S81     | SN74S454     |            | 8192 Bits                   | 45.00        | 625 -14     |       |  |
| TBP24SA81    | SN74S455     | <u>\$</u>  | (2048W X 4B)                | 45 fis       | 625 mw      | E 12  |  |
| TBP28S86     | SN74S478     | $\nabla$   |                             |              |             | 5-13  |  |
| TBP28SA86    | SN74S479     | Q          | 8192 Bits                   | 45 ns        | 625 mW      |       |  |
| TBP28S2708   | SN74S2708    | $\nabla$   | (1024W X 8B)                |              |             |       |  |
| TBP28S85     |              | $\nabla$   |                             | 35 ns        | 550 mW      | ]     |  |
| TBP28S166    |              |            | 16,384 Bits<br>(2048W X 8B) | 35 ns 500 mW |             |       |  |

#### LOW-POWER PROMS

| AIE10/      | 01.0                                     | OUTPUT   | DIT CIZE                              | TYPICAL PER            | SEE.                 |      |  |
|-------------|--|----------|---------------------------------------|------------------------|----------------------|------|--|
| TYPE NUMBER | YPE NUMBER TYPE NUMBER TYPE <sup>†</sup> |          | (ORGANIZATION)                        | ADDRESS<br>ACCESS TIME | POWER<br>DISSIPATION | PAGE |  |
| TBP28L22    |  |          | 2048 Bits<br>(256W X 8B)              | 45 ns                  | 300 mW               |      |  |
| TBP28L42    |  | $\nabla$ | 4096 Bits                             | <u> </u>               | 050                  | 5.13 |  |
| TBP28L45    |  | $\nabla$ | (512W X 8B)                           | 60 ns                  | 250 mvv              |      |  |
| TBP28L86    | SN74LS478                                | $\nabla$ | 8192 Bits                             | 80 ns                  | 350 mW               |      |  |
| TBP28L85    |  | $\nabla$ | (1024W X 8B) 65 ns 275 m <sup>1</sup> |                        | 275 mW               | ]    |  |
| TBP28L166   |  |          | 16,384 Bits                           | 65 ns                  | 250 mW               | ]    |  |
|             |  |          | (2048W X 8B)                          |                        |                      |      |  |

 $^{\dagger} \Delta$  = open collector,  $\nabla$  = three state.

#### POWER-DOWN PROMS

|             |             | OUTPUT            | DIT OUTE                    | TYPICAL PE             | eee                  |      |  |
|-------------|-------------|-------------------|-----------------------------|------------------------|----------------------|------|--|
| TYPE NUMBER | TYPE NUMBER | TYPE <sup>†</sup> | (ORGANIZATION)              | ADDRESS<br>ACCESS TIME | POWER<br>DISSIPATION | PAGE |  |
| TBP28P42    |             | $\nabla$          | 4096 Bits                   | 05                     | FF0/00               |      |  |
| TBP28P45    |             | $\nabla$          | (512W X 8B)                 | 35 ns                  | 550/60 mw            |      |  |
| TBP28P85    |             | $\nabla$          | 8192 Bits<br>(1024W X 8B)   | 35 ns                  | 550/60 mW            | 5-13 |  |
| TBP28P166   |             |                   | 16,384 Bits<br>(2048W X 8B) | 35 ns                  | 550/75 mW            | ]    |  |

### **REGISTERED PROMS**

|           | 01.0        | OUTDUT             | 017 0170                    | TYPICAL PE         | SEE                  |      |  |
|-----------|-------------|--------------------|-----------------------------|--------------------|----------------------|------|--|
|           | TYPE NUMBER | TYPE <sup>†</sup>  | (ORGANIZATION)              | CLOCK<br>TO OUTPUT | POWER<br>DISSIPATION | PAGE |  |
| TBP28R45  |             | $\nabla$           | 4096 Bits<br>(512W X 8B)    |                    | 550 mW               |      |  |
| TBP28R85  |             | $\bigtriangledown$ | 8192 Bits<br>(1024W X 8B)   | 20 ns              | 600 mW               | 5-13 |  |
| TBP28R166 |             | $\bigtriangledown$ | 16,384 Bits<br>(2048W X 8B) |                    | 550 mW               |      |  |

## READ/WRITE MEMORY (RAM) LINE SUMMARY

|                   | BIT SIZE<br>(ORGANIZATION) | OUTBUT        | TYPICAL PE  | RFORMANCE    | OFF  |  |
|-------------------|----------------------------|---------------|-------------|--------------|------|--|
| TYPE NUMBER       |                            | CONFIGURATION | ADDRESS     | POWER        |      |  |
|                   |                            | CONFIGURATION | ACCESS TIME | DISSIPATION  | FAGE |  |
| SN54S189/SN74S189 | 64 Bits                    | $\nabla$      | 25          | 075          | E 20 |  |
| SN54S289/SN74S289 | (16W X 4B)                 | \ \           | 25 hs       | 375 mvv      | 5-29 |  |
| SN74S201          | 256 Bits                   | $\nabla$      | 42 ns       | 500 mW       | 5-33 |  |
| SN74S301          | (256W X 1B)                |               | 42 ns       | 42 ns 500 mW |      |  |

## FIRST-IN/FIRST-OUT (FIFO) MEMORY WITH 3-STATE OUTPUTS

|             | DIT CIZE              |               |               | OFF     |             |       |  |
|-------------|-----------------------|---------------|---------------|---------|-------------|-------|--|
| TYPE NUMBER | BIT SIZE              | DATA          | RATES         | FALL    | POWER       | JEE . |  |
|             | (ORGANIZATION)        | INPUT         | OUTPUT        | THROUGH | DISSIPATION | PAGE  |  |
| SN74S225    | 80 Bits<br>(16W X 5B) | d-c to 10 MHz | d-c to 10 MHz | 190 ns  | 400 mW      | 5-37  |  |

†  $\triangle$  = open collector,  $\nabla$  = three state.



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## PROMS

## SERIES 14 AND 18 **PROGRAMMABLE READ-ONLY MEMORIES**

BULLETIN NO. DL-S 12727, SEPTEMBER 1979

- Titanium-Tungsten (Ti-W) Fuse Link For Reliable Low-Voltage Full Family Compatible Programming
- Full Decoding And Fast Chip Select Simplify System Design
- P-N-P Inputs For Reduced Loading On System **Buffers/Drivers**
- Each PROM Supplied With a High Logic Level • Stored At Each Bit Location
- Applications Include: Microprogramming/Firmware Loaders **Code Converters/Character Generators** Translators/Emulators Address Mapping/Look-Up Tables

| NEW TYPE NUMBER               | OLD TYPE NUMBER | DIT 0175       | OUTDUT                     | TYPICAL PE             | RFORMANCE            |  |
|-------------------------------|-----------------|----------------|----------------------------|------------------------|----------------------|--|
| 0°C to 70°C                   | 0°C to 70°C     | (ORGANIZATION) | CONFIGURATION <sup>†</sup> | ADDRESS<br>ACCESS TIME | POWER<br>DISSIPATION |  |
| TBP18SA030 (J, N)▲            | SN74S188 (J, N) | 256 Bits       | <u>\$</u> .                |                        | 400 111              |  |
| TBP18S030 (J, N) <sup>▲</sup> | SN74S288 (J, N) | (32W X 8B)     | $\nabla$                   | 25 ns                  | 400 mW               |  |
| TBP14S10 (J, N)▲              | SN74S287 (J, N) | 1024 Bits      | $\nabla$                   | 10                     | 500 11               |  |
| TBP14SA10 (J, N)▲             | SN74S387 (J, N) | (256W X 4B)    | Ŷ                          | 42 ns                  | 500 mW               |  |
| TBP18SA22 (J, N)▲             | SN74S470 (J, N) | 2048 Bits      | Ŷ                          | 50                     | 550 W                |  |
| TBP18S22 (J, N)▲              | SN74S471 (J, N) | (256W X 8B)    | $\nabla$                   | 50 ns                  | 550 mW               |  |
| TBP18S42 (J, N)▲              | SN74S472 (J, N) | 4096 Bits      | $\nabla$                   |                        | 220 111              |  |
| TBP18SA42 (J, N)▲             | SN74S473 (J, N) | (512W X 8B)    | Ŷ                          | 55 ns                  | 600 mW               |  |
| TBP18S46 (J, N)▲              | SN74S474 (J, N) | 4096 Bits      | $\nabla$                   |                        | 000 111              |  |
| TBP18SA46 (J, N)▲             | SN74S475 (J, N) | (512W X 8B)    | Q                          | 55 ns                  | 600 mW               |  |

▲ For full temperature parts (-55°C to +125°C) use suffix MJ. For devices with MIL-STD 883B processing (-55°C to +125°C) see page 5-2. †  $\triangle$  = open collector,  $\nabla$  = three state.



Pin assignments for all of these memories are the same for all packages.

#### description

These monolithic TTL programmable read-only memories (PROMs) feature titanium-tungsten (Ti-W) fuse links with each link designed to program in 100 microseconds. The Schottky-clamped versions of these PROMs offer considerable flexibility for upgrading existing designs or improving new designs as they feature full Schottky clamping for improved performance, low-current MOS-compatible p-n-p inputs, choice of bus-driving three-state or open-collector outputs, and improved chip-select access times.

The high-complexity 2048- and 4096-bit PROMs can be used to significantly improve system density for fixed memories as all are offered in the 20-pin dual-in-line package having pin-row spacings of 0.300 inch (7,62 mm).

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TEXAS INSTRUMENTS <sup>†</sup>Integrated Schottky-Barrier diodeclamped transistor is patented by Texas INCORPORATED U.S. Instruments. Patent Number POST OFFICE BOX 225012 • DALLAS, TEXAS 75265 3 463 975.

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## SERIES 14 AND 18 PROGRAMMABLE READ-ONLY MEMORIES

#### description (continued)

Data can be electronically programmed, as desired, at any bit location in accordance with the programming procedure specified. All PROMs, except the TBP14S10 and TBP14SA10 are supplied with a low-logic-level output condition stored at each bit location. The programming procedure open-circuits Ti-W metal links, which reverses the stored logic level at selected locations. The procedure is irreversible; once altered, the output for that bit location is permanently programmed. Outputs that have never been altered may later be programmed to supply the opposite output level. Operation of the unit within the recommended operating conditions will not alter the memory content.

A low level at the chip-select input(s) enables each PROM. The opposite level at any chip-select input causes the outputs to be off.

The three-state output offers the convenience of an open-collector output with the speed of a totem-pole output; it can be bus-connected to other similar outputs yet it retains the fast rise time characteristic of the TTL totem-pole output. The open-collector output offers the capability of direct interface with a data line having a passive pull-up.

#### schematics of inputs and outputs



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage (see Note 1)           |                                       |
|---------------------------------------|---------------------------------------|
| Input voltage                         | 5.5V                                  |
| Off-state output voltage              |                                       |
| Operating free-air temperature range: | Full-temperature-range circuits       |
|                                       | Commercial-temperature-range circuits |
| Storage temperature range             | $-65^{\circ}$ C to $150^{\circ}$ C    |

#### recommended conditions for programming the TBP18S', TBP18SA', TBP14S', and TBP14SA' PROMs

|   |                             | MIN  | NOM              | MAX  | UNIT |  |
|---|-----------------------------|--|------------------|------|------|--|
| Supply voltage Voo (see Note 1)   | Steady state                | 4.75   | 5                | 5.25 |      |  |
|   | Program pulse               | 10   | 10.5             | 11†  | v    |  |
|   | High level, V <sub>IH</sub> | 2.4  |                  | 5    |      |  |
|   | Low level, V <sub>1L</sub>  | 0  |                  | 0.5  | ] `  |  |
|   |                             |  | See load circuit |      |      |  |
| remination of an outputs except the one to be programmed                  |                             | A.75     5     5.25       10     10.5     11 <sup>†</sup> 4.75     5     5.25       10     10.5     11 <sup>†</sup> 4.75     5     5.25       0     0.5     5       See load circuit<br>(Figure 1)     0     0.25       0     0.25     0.3       98     100     1000       25     35     0 |                  |      |      |  |
| Voltage applied to output to be programmed, VO(pr) (see Note 2)           |                             | 0  | 0.25             | 0.3  | V    |  |
| Duration of V <sub>CC</sub> programming pulse X (see Figure 2 and Note 3) |                             | 98   | 100              | 1000 | μs   |  |
| Programming duty cycle for Y pulse  |                             |  | 25               | 35   | %    |  |
| Free-air temperature  |                             | . 0  |                  | 55   | °C   |  |

<sup>†</sup> Absolute maximum ratings.

NOTES: 1. Voltage values are with respect to network ground terminal. The supply voltage rating does not apply during programming.
2. The TBP18S030, TBP18SA030, TBP18SA22, TBP18S22, TBP18S42, TBP18S42, TBP18S46 and TBP18SA46 are supplied with all bit locations containing a low logic level, and programming a bit changes the output of the bit to high logic level. The TBP14S10,

TBP14SA10 are supplied with all bit outputs at a high logic level, and programming a bit changes it to a low logic level.

3. Programming is guaranteed if the pulse applied as 98  $\mu s$  in duration.

step-by-step programming procedure for the TBP18SA030, TBP18S030, TBP14S10, TBP14SA10, TBP18SA22, TBP18SA22, TBP18SA42, TBP18S42, TBP18S46, TBP18SA46

- 1. Apply steady-state supply voltage ( $V_{CC} = 5 V$ ) and address the word to be programmed.
- 2. Verify that the bit location needs to be programmed. If not, proceed to the next bit.
- 3. If the bit requires programming, disable the outputs by applying a high-logic-level voltage to the chip-select input(s).
- 4. Only one bit location is programmed at a time. Connect each output not being programmed to 5 V through 3.9 k $\Omega$  and apply the voltage specified in the table to the output to be programmed. Maximum current into the programmer output is 150 mA.
- 5. Step V<sub>CC</sub> to 10.5 V nominal. Maximum supply current required during programming is 750 mA.
- Apply a low-logic-level voltage to the chip-select input(s). This should occur between 1 μs and 1 ms after V<sub>CC</sub> has reached its 10.5-V level. See programming sequence of Figure 2.
- 7. After the X pulse time is reached, a high logic level is applied to the chip-select inputs to disable the outputs.
- 8. Within the range of 1  $\mu$ s to 1 ms after the chip-select input(s) reach a high logic level, V<sub>CC</sub> should be stepped down to 5 V at which level verification can be accomplished.
- The chip-select input(s) may be taken to a low logic level (to permit program verification) 1 μs or more after V<sub>CC</sub> reaches its steady-state value of 5 V.
- 10. At a Y pulse duty cycle of 35% or less, repeat steps 1 through 8 for each output where it is desired to program a bit.
- 11. Verify accurate programming of every word after all words have been programmed using V<sub>CC</sub> values of 4.5 and 5.5 volts.

NOTE: Only one programming attempt per bit is recommended.

5ν 3.9 kΩ OUTPUT

LOAD CIRCUIT FOR EACH OUTPUT NOT BEING PROGRAMMED OR FOR PROGRAM VERIFICATION

FIGURE 1 - LOAD CIRCUIT



FIGURE 2 - VOLTAGE WAVEFORMS FOR PROGRAMMING



## SERIES 14 AND 18 **PROGRAMMABLE READ-ONLY MEMORIES**

#### recommended operating conditions

| PARAMETER                      |      | TBP14 | TBP14S10, TBP18S22 |      |      | TBP18S030 |      |      | TBP18S42, TBP18S46 |      |      |
|--------------------------------|------|-------|--------------------|------|------|-----------|------|------|--------------------|------|------|
|                                |      | MIN   | NOM                | MAX  | MIN  | NOM       | MAX  | MIN  | NOM                | MAX  | UNIT |
|                                | MJ   | 4.5   | 5                  | 5.5  | 4.5  | 5         | 5.5  | 4.5  | 5                  | 5.5  | v    |
| Supply voltage, VCC            | J, N | 4.75  | 5                  | 5.25 | 4.75 | 5         | 5.25 | 4.75 | 5                  | 5,25 |      |
|                                | MJ   |       |                    | -2   | ۱    |           | -2   |      |                    | 2    |      |
| High-level output current, IOH | J, N |       |                    | -6.5 |      |           | -6.5 |      |                    | -6.5 | mA   |
| Low-level output current, IOL  |      |       |                    | 16   |      |           | 20   |      |                    | 12   | mA   |
|                                | MJ   | -55   |                    | 125♦ | -55  |           | 125  | -55  |                    | 125  | °C   |
|                                | J, N | 0     |                    | 70   | 0    |           | 70   | 0    |                    | 70   |      |

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER       |   | TEST CONDITIONS <sup>†</sup>                       |   |     | ULL TE<br>(MJ)   | MP   | COMM. TEMP<br>(J, N) |                  |      | UNIT |
|-----------------|---|--|---|-----|------------------|------|----------------------|------------------|------|------|
|                 |   |  |   |     | TYP <sup>‡</sup> | MAX  | MIN                  | TYP <sup>‡</sup> | MAX  |      |
| VIH             | High-level input voltage                                |  |   | 2   |                  |      | 2                    |                  |      | V    |
| VIL             | Low-level input voltage                                 |  |   |     |                  | 0.8  |                      |                  | 0.8  | V    |
| VIK             | Input clamp voltage                                     | V <sub>CC</sub> = MIN,                             | I <sub>I</sub> = –18 mA                         |     |                  | -1.2 | -                    |                  | -1.2 | V    |
| ∨он             | High-level output voltage                               | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>I <sub>OH</sub> = MAX | 2.4 | 3.4              |      | 2.4                  | 3,2              |      | v    |
| VOL             | Low-level output voltage                                | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>I <sub>OL</sub> = MAX |     |                  | 0.5  |                      |                  | 0.5  | v    |
| Iozн            | Off-state output current,<br>high-level voltage applied | V <sub>CC</sub> = MAX,<br>V <sub>O</sub> = 2.4 V   | V <sub>IH</sub> = 2 V, .                        |     |                  | 50   |                      |                  | 50   | μA   |
| IOZL            | Off-state output current,<br>low-level voltage applied  | V <sub>CC</sub> = MAX,<br>V <sub>O</sub> = 0.5 V   | V <sub>IH</sub> = 2 V,                          |     |                  | -50  |                      |                  | -50  | μA   |
| ц               | Input current at maximum<br>input voltage               | V <sub>CC</sub> = MAX,                             | V <sub>I</sub> = 5.5 V                          |     | _                | 1    |                      |                  | 1    | mA   |
| Чн              | High-level input current                                | V <sub>CC</sub> = MAX,                             | V <sub>I</sub> = 2.7 V                          |     |                  | 25   |                      |                  | 25   | μA   |
| μL              | Low-level input current                                 | V <sub>CC</sub> = MAX,                             | V <sub>I</sub> = 0.5 V                          |     |                  | -250 |                      |                  | -250 | μA   |
| los             | Short-circuit output current §                          | V <sub>CC</sub> = MAX                              |   | -30 |                  | -100 | -30                  |                  | -100 | mA   |
|                 |   | V <sub>CC</sub> = MAX,                             | TBP14S10  |     | 100              | 135  |                      | 100              | 135  |      |
| 100             | Supply current  | Chip select(s) at 0 V,                             | TBP18S030                                       |     | 80               | 110  |                      | 80               | 110  | mΔ   |
| ' <sup>00</sup> |   | Outputs open,                                      | TBP18S22  |     | 110              | 155  |                      | 110              | 155  |      |
|                 |   | See Note 4   | TBP18S42, TBP18S46                              |     | 120              | 155  |                      | 120              | 155  |      |

#### switching characteristics over recommended ranges of TA and VCC (unless otherwise noted)

| ТҮРЕ                   | TEST CONDITIONS               | t <sub>a(A)</sub> (ns)<br>Access time from<br>address |                        | t <sub>a(S)</sub> (ns)<br>Access time from<br>chip select (enable time) |     |                  | Disa<br>hig | UNIT |                  |      |    |
|------------------------|-------------------------------|---|------------------------|---|-----|------------------|-------------|------|------------------|------|----|
|                        |                               | MIN   | <u>TYP<sup>‡</sup></u> | MAX   | MIN | TYP <sup>‡</sup> | MAX         | MIN  | TYP <sup>‡</sup> | MAX  |    |
| TBP14S10MJ             |                               |   | 42                     | 75  |     | 15               | 40          |      | 12               | 40   | ns |
| TBP14S10               |                               |   | 42                     | 65  |     | 15               | 35          |      | 12               | 35   | ns |
| TBP18S030MJ            |                               |   | 25                     | 50  |     | 12               | 30          |      | 8                | 30   | ns |
| TBP18S030              | $\tau_a(A)$ and $\tau_a(S)$ , |   | 25                     | 40  |     | 12               | 25          |      | 8                | 20   | ns |
| TBP18S22MJ             | B = 200 O                     |   | 50                     | 80  |     | 20               | 40          |      | 15               | 35   | ns |
| TBP18S22               | n [ - 300 sz,                 |   | 50                     | 70  | [   | 20               | 35          |      | 15               | 30   | ns |
| TBP18S42MJ, TBP18S46MJ | See rage 1-14                 |   | 55                     | 85  |     | 20               | 45          |      | 15               | 40   | ns |
| TBP18S42, TBP18S46     | 1.                            |   | 55                     | 75  |     | 20               | 40          |      | 15               | 35 - | ns |

NOTE: MJ designates full-temperature-range circuits (formerly 54 Family), J and N designate commercial-temperature-range circuits (formerly 74 Family).

Torrently 4 Fainly). For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ . Shot more than one output should be shorted at a time and duration of the short circuit should not exceed one second. The military product versions of the '14S10 in the W package operating at free-air temperatures above 108°C requires a heat sink that provides a thermal resistance from case-to-free-air,  $R_{CA}$ , of not more than 42°C/W. NOTE 4: The typical values of  $I_{CC}$  are with all outputs low.

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#### recommended operating conditions

| BADAMETER                           |      | TBP149 | TBP14SA10, TBP18SA22 |         |      | TBP18SA030 |      |      | TBP18SA42, TBP18SA46 |      |    |  |
|-------------------------------------|------|--------|----------------------|---------|------|------------|------|------|----------------------|------|----|--|
| PARAMETER                           |      | MIN NC |                      | NOM MAX | MIN  | NOM        | MAX  | MIN  | NOM                  | MAX  |    |  |
|                                     | MJ   | 4.5    | 5                    | 5.5     | 4.5  | 5          | 5.5  | 4.5  | 5                    | 5.5  |    |  |
| Supply voltage, VCC                 | J, N | 4.75   | 5                    | 5.25    | 4.75 | 5          | 5.25 | 4.75 | 5                    | 5.25 |    |  |
| High-level output voltage, VOH      |      |        |                      | 5.5     |      |            | 5.5  |      |                      | 5.5  | V  |  |
| Low-level output current, IOL       |      |        |                      | 16      |      |            | 20   |      |                      | 16   | mA |  |
|                                     | MJ   | -55    |                      | 125♦    | -55  |            | 125  | -55  |                      | 125  | °. |  |
| Operating free-air temperature, 1 A | J, N | 0      |                      | 70      | 0    |            | 70   | 0    |                      | 70   |    |  |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| [               | PARAMETER                              | TEST CO  | VDITIONS <sup>†</sup>                  | MIN | TYP <sup>‡</sup> | MAX  | UNIT |
|-----------------|--|--|--|-----|------------------|------|------|
| VIH             | High-level input voltage               |  | <u></u>                                | 2   |                  |      | V    |
| VIL             | Low-level input voltage                |  | ······································ |     |                  | 0.8  | V    |
| VIK             | Input clamp voltage                    | V <sub>CC</sub> = MIN,                           | I <sub>I</sub> = –18 mA                |     |                  | -1.2 | V    |
| юн              | High-level output current              | V <sub>CC</sub> = MIN,<br>V <sub>IH</sub> = 2 V, | V <sub>OH</sub> = 2.4 V                |     |                  | 50   | μΑ   |
|                 |  | V <sub>IL</sub> = 0.8 V                          |  |     | -                |      |      |
| Vo.             | Low-level output voltage               | V <sub>CC</sub> = MIN,                           | V <sub>IH</sub> = 2 V,                 |     |                  | 0.5  |      |
| UUL             |  | V <sub>IL</sub> = 0.8 V,                         | I <sub>OL</sub> = MAX                  |     |                  | 0.5  |      |
| 4               | Input current at maximum input voltage | V <sub>CC</sub> = MAX,                           | V <sub>I</sub> = 5.5 V                 |     |                  | 1    | mA   |
| Чн              | High-level input current               | V <sub>CC</sub> = MAX,                           | V1 = 2.7 V                             |     |                  | 25   | μA   |
| 1 <sub>1L</sub> | Low-level input current                | V <sub>CC</sub> = MAX,                           | V <sub>1</sub> = 0.5 V                 | 1   |                  | -250 | μA   |
|                 |  | V <sub>CC</sub> = MAX,                           | TBP18SA030                             |     | 80               | 110  |      |
|                 | Quarter summers                        | Chip select(s) at 0 V,                           | TBP14SA10                              |     | 100              | 135  | ]    |
| lcc             | Supply current                         | Outputs open,                                    | TBP18SA22                              | 1   | 110              | 155  | 1 mA |
|                 |  | See Note 4                                       | TBP18SA42, TBP18SA46                   |     | 120              | 155  | 1    |

#### switching characteristics over recommended ranges of TA and VCC (unless otherwise noted)

| ТҮРЕ                     | TEST<br>CONDITIONS      | <sup>t</sup> a(A)<br>Access time from<br>address |                  | <sup>t</sup> a(S)<br>Access time from<br>chip select<br>(enable time) |     |                  | Propag<br>low-te<br>put f<br>(d | UNIT |                  |     |    |
|--------------------------|-------------------------|--|------------------|---|-----|------------------|---------------------------------|------|------------------|-----|----|
|                          |                         | MIN  | TYP <sup>‡</sup> | MAX   | MIN | TYP <sup>‡</sup> | MAX                             | MIN  | TYP <sup>‡</sup> | MAX | ]  |
| TBP18SA030MJ             |                         |  | 25               | 50  |     | 12               | 30                              |      | 12               | 30  | ns |
| TBP18SA030               | $C_{1} = 20 \text{ pF}$ |  | 25               | 40  |     | 12               | 25                              |      | 12               | 25  | ns |
| TBP14SA10MJ              |                         |  | 42               | 75  |     | 15               | 40                              |      | 15               | 40  | ns |
| TBP14SA10                | $R_{1} = 300.32$        |  | 42               | 65  |     | 15               | 35                              |      | 15               | 35  | ns |
| TBP18SA22MJ              | $R_{2} = 600 s_{2}$     |  | 50               | 80  |     | 20               | 40                              |      | 15               | 35  | ns |
| TBPSA22                  | See Fage 1-14           |  | 50               | 70  |     | 20               | 35                              |      | 15               | 30  | ns |
| TBP18SA42MJ, TBP18SA46MJ |                         |  | 55               | 85  |     | 20               | 45                              |      | 15               | 40  | ns |
| TBP18SA42, TBP18SA46     |                         |  | 55               | 75  |     | 20               | 40                              |      | 15               | 35  | ns |

NOTE: MJ designates full-temperature-range circuits (formerly 54 Family), J and N designate commercial-temperature-range circuits (formerly 74 Family).

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup> All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

• The military product versions of the '14SA10 in the W package operating at free-air temperatures above 108°C requires a beat sink that provides a thermal resistance from case-to-free-air,  $R_{\theta CA}$ , of not more than 42°C/W.

NOTE 4: The typical values of ICC are with all output low.

## PROMS

## SERIES 24 AND 28 STANDARD, LOW-POWER, POWER-DOWN, REGISTERED **PROGRAMMABLE READ-ONLY MEMORIES**

- BULLETIN NO. DL-S 12728, SEPTEMBER 1979
- New, Expanded Family of Standard, Low Power, Power Down, And Registered PROMs
- Titanium-Tungsten (Ti-W) Fuse Links for Reliable Low-Voltage Full-Family-Compatible Programming
- Full Decoding And Fast Chip Select Simplify System Design
- P-N-P Inputs for Reduced Loading On System **Buffers/Drivers**
- Each PROM Supplied With a High Logic Level Stored At Each Bit Location
- Applications Include: Microprogramming/Firm Ware Loaders **Code Converters/Character Generators** Translators/Emulators Address Mapping/Look-Up Tables

| TYPE N                        | UMBER            | OUTPUT                     | BIT SIZE                    | ТҮРІС   | CAL PERFO | RMANCE      |
|-------------------------------|------------------|----------------------------|-----------------------------|---------|-----------|-------------|
|                               |                  | CONFIGURATION <sup>‡</sup> | (ORGANIZATION)              | ACCESS  | TIMES     | POWER       |
| NEW I TPE NUMBER              |                  |                            |                             | ADDRESS | SELECT    | DISSIPATION |
| TBP24S10 (J, N) <sup>†</sup>  |                  | $\nabla$                   | 1024 Bits                   | 25      | 20        | 275         |
| TBP24SA10 (J, N) <sup>†</sup> |                  | $\diamond$                 | (256W X 4B)                 | 35 hs   | 20 hs     | 375 mw      |
| TBP28S42 (J, N) <sup>†</sup>  |                  | $\nabla$                   | 4096 Bits                   | 25      | 15.00     | E00 mW      |
| TBP28S45 (J, N) <sup>†</sup>  |                  | $\nabla$                   | (512W X 8B)                 | 35 m    | 15115     | 500 mw      |
| TBP24S41 (J, N)▲              | SN74S476 (J, N)  | $\nabla$                   | 4096 Bits                   | 10      | 20.00     | 475         |
| TBP24SA41 (J, N)▲             | SN74S477 (J, N)  | $\diamond$                 | (1024W X 4B)                | 40 hs   | 20 hs     | 4/5 111     |
| TBP24S81 (J, N)               | SN74S454 (J, N)  | $\nabla$                   | 8192 Bits                   | 45      | 20        | GOE mW      |
| TBP24SA81 (J, N)              | SN74S455 (J, N)  | $\Diamond$                 | (2048W X 4B)                | 45 ms   | 20 ms     | 02511144    |
| TBP28S86 (J, N)               | SN74S478 (J, N)  | $\bigtriangledown$         |                             | -       |           |             |
| TBP28SA86 (J, N)              | SN74S479 (J, N)  | $\diamond$                 | 8192 Bits                   | 45 ns   | 20 ns     | 625 mW      |
| TBP28S2708 (J, N)             | SN74S2708 (J, N) | $\nabla$                   | (1024W X 8B)                |         |           |             |
| TBP28S85 (J, N) <sup>†</sup>  |                  | $\nabla$                   | 1                           | 35 ns   | 15 ns     | 550 mW      |
| TBP28S166 (J, N) <sup>†</sup> |                  | $\bigtriangledown$         | 16,384 Bits<br>(2048W X 8B) | 35 ns   | 15 ns     | 500 mW      |

## STANDARD PROMS

## LOW POWER PROMS

| TYPE N                       | UMBER            | OUTPUT                     | BIT SIZE       | TYPICAL PERFORMANCE |        |             |  |  |
|------------------------------|------------------|----------------------------|----------------|---------------------|--------|-------------|--|--|
|                              |                  | CONFIGURATION <sup>‡</sup> | (ORGANIZATION) | ACCESS              | TIMES  | POWER       |  |  |
| NEW I YPE NUMBER             | OLD TYPE NUMBER  |                            |                | ADDRESS             | SELECT | DISSIPATION |  |  |
| TRR201 02 / 1 NIT            |                  |                            | 2048 Bits 45   |                     | 25     | 200 -11     |  |  |
| 1 BP28L22 (J, N)             |                  | V                          | (256W X 8B)    | 45 ns               | 35 hs  | 300 mw      |  |  |
| TBP28L42 (J, N) <sup>†</sup> |                  | $\nabla$                   | 4096 Bits      | 60                  | 20     | 050         |  |  |
| TBP28L45 (J, N) <sup>†</sup> |                  | $\nabla$                   | (512W X 8B)    | 60 ns               | 30 ns  | 250 mVV     |  |  |
| TBP28L86 (J, N)*             | SN74LS478 (J, N) | $\nabla$                   | 8192 Bits      | 80 ns               | 35 ns  | 350 mW      |  |  |
| TBP28L85 (J, N) <sup>†</sup> |                  | $\nabla$                   | (1024W X 8B)   | 65 ns               | 30 ns  | 275 mW      |  |  |
| TRR291 166 / 1 NIVT          |                  |                            | 16,384 Bits    | 65                  | 20     | 250         |  |  |
| 1 BF20L 100 (J, N)           |                  | V                          | (2048W X 8B)   | op ns               | 30 hs  | 250 mw      |  |  |

<sup>†</sup> NOTE - Electrical parameters for these devices are design goals only.

ANOTE – These devices available as full-temperature-range and as high-rel processed devices (use suffix MJ or NJ).

 $^{\pm}$   $\bigcirc$  = open collector,  $\bigtriangledown$  = three state.

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## SERIES 24 AND 28 STANDARD, LOW-POWER, POWER-DOWN, REGISTERED PROGRAMMABLE READ-ONLY MEMORIES

#### POWER DOWN PROMS

| TYPE N                       | IUMBER          | OUTPUT        | BIT SIZE       | TYPICAL PERFORMANCE |        |             |  |  |
|------------------------------|-----------------|---------------|----------------|---------------------|--------|-------------|--|--|
|                              |                 | CONFIGURATION | (ORGANIZATION) | ACCESS              | POWER  |             |  |  |
| NEW TYPE NUMBER              | OLD TYPE NUMBER |               |                | ADDRESS             | SELECT | DISSIPATION |  |  |
| TBP28P42 (J, N) <sup>†</sup> |                 | $\nabla$      | 4096 Bits      | 25                  | 25     | E00/60      |  |  |
| TBP28P45 (J, N) <sup>†</sup> |                 | $\nabla$      | (5RW X 8B)     | 35 ns               | 35 115 | 500/60 mw   |  |  |
|                              |                 | ~             | 8291 Bits      | 25                  | 25     | EE0/60 mW   |  |  |
| 1 BP 28P85 (J, N)            |                 |               | (1024W X 8B)   | 35 hs               | 35 115 | 550/60 mw   |  |  |
|                              |                 | ~~~           | 16,384 Bits    | 25.00               | 35.00  | 500/75 mW/  |  |  |
| 18P28P100 (J, N/             |                 |               | (2048W X 8B)   | 35 115              | 35118  | 500/75 mw   |  |  |

#### **REGISTERED PROMS**

| TYPE N                        | IUMBER          | OUTPUT                     | BIT SIZE                    | TYPICAL PERFORMANCE |                        |                      |  |  |  |
|-------------------------------|-----------------|----------------------------|-----------------------------|---------------------|------------------------|----------------------|--|--|--|
| NEW TYPE NUMBER               | OLD TYPE NUMBER | CONFIGURATION <sup>‡</sup> | (ORGANIZATION)              | CLOCK TO<br>OUTPUT  | ADDRESS<br>SET UP TIME | POWER<br>DISSIPATION |  |  |  |
| TBP 28R45 (J, N) <sup>†</sup> |                 | $\nabla$                   | 4096 Bits<br>(512W X 8B)    |                     |                        | 550 mW               |  |  |  |
| TBP28R85 (J, N) <sup>†</sup>  |                 | $\nabla$                   | 8192 Bits<br>(1024W X 8B)   | 20 ns               | 20 ns                  | 600 mW               |  |  |  |
| TBP28R166 (J, N)†             |                 | $\bigtriangledown$         | 16,384 Bits<br>(2048W X 8B) |                     |                        | 550 mW               |  |  |  |

<sup>†</sup> Electrical parameters for these devices are design goals only.

 $^{\dagger}\nabla$  = three state.

#### description

The new 24 and 28 Series of monolithic TTL programmable read-only memories (PROMs) feature an expanded selection of standard, low-power, power-down, and registered PROMs. This expanded PROM family provides the system designer with considerable flexibility in upgrading existing designs or optimizing new designs. Featuring proven titanium-tungsten (Ti-W) fuse links with low-current MOS-compatible p-n-p inputs, all family members utilize a common programming technique designed to program each link with a 100-microsecond pulse.

The new 4096-bit and 8192-bit PROMs are offered in 24-pin 300-mil-wide packages, greatly improving system density for large PROM arrays. For systems requiring even higher levels of complexity and density, the 16,384-bit PROMs provide twice the bit density of the 8192-bit PROMs in 24-pin 600-mil-wide packages. All PROMs are supplied with a logic-high output level stored at each bit location. The programming procedure open-circuits Ti-W metal links, which reverses the stored logic level at selected locations. The procedure is irreversible; once altered, the output for that bit location is permanently programmed. Outputs that have never been altered may later be programmed to supply the opposite output level. Operation of the unit within the recommended operating conditions will not alter the memory content.

Active level(s) at the chip-select input(s) (S or  $\overline{S}$ ) enables all of the outputs. An inactive level at any chip-select input causes all outputs to be off. On power-down PROMs, active level(s) at the chip-enable input(s) (E or  $\overline{E}$ ) power up the device and enables all of the outputs. An inactive level at any chip-enable input causes all the outputs to be off and the PROM to be in a reduced-power standby mode.

The three-state output offers the convenience of an open-collector output with the speed of a totem-pole output; it can be bus connected to other similar outputs, yet it retains the fast rise time characteristics of the TTL totem-pole output. The open-collector output offers the capability of direct interface with a data line having a passive pull-up.

## SERIES 24 AND 28 STANDARD, LOW-POWER, POWER-DOWN, REGISTERED PROGRAMMABLE READ-ONLY MEMORIES

#### **PIN ASSIGNMENTS (TOP VIEWS)**



NC = No internal connection

\* For those pins having dual designations, the designation to the right of the virgule (/) applies only to the type number(s) immediately followed by an asterisk (\*) above the pinout drawing.

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#### standard PROMs

The standard PROM members of Series 24 and 28 offer the highest performance for applications requiring the uncompromised speed of Schottky technology. The fast chip-select access times allow additional decoding delays to occur without degrading speed performance.

#### **Iow-power PROMs**

To upgrade systems utilizing MOS EPROMs or MOS PROMs, the low-power PROM family offers the increased output drive and speed performance of bipolar technology and the reduced power dissipation necessary to implement effective upgrades. Additionally, low-power PROMs offer substantially reduced power dissipation over standard PROMs with minimal speed penalty.

#### power-down PROMs

For power-sensitive systems requiring the speed performance of the standard PROM members as well as reduced system power dissipation, the power-down PROM members allow a 75% or better reduction in power dissipation when disabled while providing standard PROM speed performance when enabled. The power-down and power-up functions are sequenced to occur with the outputs at a high-impedance state. The enable (power-up) function provides adequate performance to allow power-up to occur during the normal read access time precluding any degradation in memory speed performance.

#### registered PROMs

For microprogrammed pipelined systems the Series 24 and 28 registered PROM members offer the system designer reduced package count and improved system performance by incorporating the pipeline register onto the PROM chip. Available in 4096-bit, 8192-bit and 16,384-bit densities, all registered PROMs are provided with synchronous and asynchronous output controls (G and  $\overline{G}$ ) allowing maximum flexibility in data bus control.

When power is first applied, the edge-triggered latch for the synchronous output control is cleared, and the  $\Omega$  outputs are placed in a high-impedance state. To read data, the address is set up, the synchronous output enable, G(SYNC), is taken high, and a low-to-high transition on the clock (C) input causes the selected data to be stored in the registers. That same transition causes the outputs to be enabled if asynchronous output enable  $\overline{G}$  is low. At this time the address may be changed and a new word addressed without affecting the register contents. If the synchronous output enable is low at the time of a low-to-high clock transition, the outputs will be disabled to the high-impedance state. They may be disabled at any time by taking output enable G high.

#### block diagram (positive logic)



## SERIES 24 AND 28 STANDARD, LOW-POWER, POWER-DOWN, REGISTERED PROGRAMMABLE READ-ONLY MEMORIES

#### schematics of inputs and outputs



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage (see Note 1)            |  |
|--|--|
| Input voltage                          |  |
| Chip-select peak input voltage (S, S1, | S2) (see Note 2)                             |
| Off-state output voltage               | 5.5 \  |
| Off-state peak output voltage (see Not | e 2)   |
| Operating free-air temperature range:  | Full-temperature-range circuits (MJ)         |
|  | Commercial-temperature-range circuits (J, N) |
| Storage temperature range              |  |

NOTES: 1. Voltage values are with respect to network ground terminal.

2. These ratings apply only under the conditions described in the programming procedure.

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## SERIES 24 AND 28 STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH OPEN-COLLECTOR OUTPUTS

#### recommended operating conditions

|                                      | PARAMETER |      | TBP28SA86 |      |      | TBP24SA81, TBP24SA41 |      |      | TBP24SA10* |      |     |  |
|--------------------------------------|-----------|------|-----------|------|------|----------------------|------|------|------------|------|-----|--|
| PARAMETER                            |           | MIN  | NOM       | MAX  | MIN  | NOM                  | MAX  | MIN  | NOM        | MAX  |     |  |
|                                      | MJ        | 4.5  | 5         | 5.5  | 4.5  | 5                    | 5.5  | 4.5  | 5          | 5,5  | 1   |  |
| Supply voltage, VCC                  | J, N      | 4.75 | 5         | 5.25 | 4.75 | 5                    | 5.25 | 4.75 | 5          | 5.25 | ٦ř  |  |
| High-level output voltage, VOH       |           |      |           | 5.5  |      |                      | 5.5  |      |            | 5.5  | V   |  |
|                                      | MJ        |      |           | 12   |      |                      | 16   |      |            | 16   |     |  |
| Low-level output current, IOL        | J, N      |      |           | 12   |      |                      | 16   |      |            | 16   |     |  |
|                                      | MJ        | -55  |           | 125  | -55  |                      | 125  | -55  |            | 125  | 0   |  |
| Operating free-air temperature range | J, N      | 0    |           | 70   | 0    |                      | 70   | 0    |            | 70   | 7 5 |  |

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                              |   |  | TBP24SA                | 81                   |       |     |                  |      |     |                  |      |          |
|------------------------------|---|--|------------------------|----------------------|-------|-----|------------------|------|-----|------------------|------|----------|
|                              |   |  | uet                    | TBP28SA              | 86    | ТВ  | P24SA            | 41   | TBF | 24SA             | 10*  |          |
|                              | PARAMETER                                 |  | və.                    | MIN TYP <sup>‡</sup> | MAX   | MIN | TYP <sup>‡</sup> | MAX  | MIN | TYP <sup>‡</sup> | MAX  |          |
| Vін                          | High-level input voltage                  |  |                        | 2                    |       | 2   |                  |      | 2   |                  |      | v        |
| VIL                          | Low-level input voltage                   |  |                        | 0.8                  |       |     | 0.8              |      |     | 0.8              | v    |          |
| VIK                          | Input clamp voltage ·                     | V <sub>CC</sub> = MIN, I <sub>I</sub> =18 mA   |                        | -1.2                 |       |     | 1.2              |      |     | -1.2             | V    |          |
|                              |   | $V_{CC} = MIN, V_{IH} = 2 V,$                  |                        | 50                   |       |     | 50               |      |     | 50               |      |          |
| OH High-level output current |   | V <sub>IL</sub> = 0.8 V                        | V <sub>O</sub> = 5.5 V |                      | 100 1 |     |                  | 100  | 100 |                  |      | μ        |
|                              |   | $V_{CC} = MIN, V_{IH} = 2 V,$                  | MJ                     |                      | 0.5   |     |                  | 0.5  |     |                  | 0.5  | v        |
| <sup>v</sup> o∟              | Low-rever output vortage                  | V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = MAX | J, N                   |                      | 0.5   |     |                  | 0.5  |     |                  | 0.45 | <b>`</b> |
| Ц                            | Input current at maximum<br>input voltage | V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V  |                        |                      | 1     |     |                  | 1    |     |                  | 1    | mA       |
| Чн                           | High-level input current                  | V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V  |                        |                      | 25    |     |                  | 25   | 1   |                  | 25   | μA       |
| 1 <sub>1L</sub>              | Low-level input current                   | V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.5 V  |                        |                      | -250  |     |                  | -250 |     |                  | -250 | μA       |
| 100                          | Supply aurrent                            |  | MJ                     | 125                  |       |     | 95               | 140  |     | 75               |      | mΑ       |
| 1 'CC                        | Supply current                            |  | J, N                   | 125                  | 175   |     | 95               | 140  |     | 75               |      |          |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. <sup>+</sup> All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

#### switching characteristics over recommended ranges of TA and VCC (unless otherwise noted)

| ТҮРЕ       |          | TEST CONDITIONS         | t <sub>a</sub> (A)<br>Access time from<br>address |     |     | t <sub>a</sub> (S)<br>Access time from chip<br>select (enable time) |     |     | Pro<br>time,<br>output | UNIT |     |    |
|------------|----------|-------------------------|---|-----|-----|---|-----|-----|------------------------|------|-----|----|
|            |          |                         | MIN   | ТҮР | MAX | MIN   | ТҮР | MAX | MIN                    | ТҮР  | MAX |    |
| T0040440*  | MJ       |                         |   | 35  |     | ſ   | 20  | 40  |                        | 15   | 40  |    |
| IBP245A10" | J, N     |                         |   | 35  |     |   | 20  | 30  |                        | 15   | 30  | ns |
| TBP24SA81  |          | C <sub>L</sub> = 30 pF, |   | 45  | 70  |   | 20  | 40  |                        | 20   | 40  | ns |
| T00040444  | MJ       | See Page 1-14           |   | 40  | 75  |   | 20  | 40  |                        | 20   | 40  |    |
| 1BP245A41  | J, N     |                         |   | 40  | 60  |   | 20  | 30  |                        | 20   | 30  | ns |
| TBP24SA86  | BP24SA86 |                         |   | 45  | 70  |   | 20  | 40  |                        | 20   | 40  | ns |

\* Electrical parameters for these devices are design goals only.

## SERIES 24 AND 28 STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

#### recommended operating conditions

|                                      |      | T    | TBP24S1 | 0*   | TBP28 | S86, TBP | 28\$2708 | TBP2 | 24S81, TE | 8P24S41 | LINUT |
|--------------------------------------|------|------|---------|------|-------|----------|----------|------|-----------|---------|-------|
| PARAMETER                            |      | MIN  | NOM     | MAX  | MIN   | NOM      | MAX      | MIN  | NOM       | MAX     |       |
|                                      | MJ   | 4.5  | 5       | 5.5  | 4.5   | 5        | 5.5      | 4.5  | 5         | 5.5     |       |
| Supply voltage, VCC                  | J, N | 4.75 | 5       | 5.25 | 4.75  | 5        | 5,25     | 4.75 | 5         | 5.25    | ŢŇ    |
| High-level output current, IOH       | MJ   |      |         | -2   |       |          | -2       |      |           | -2      | mA    |
| High-level output current, IOH       | J, N |      |         | -3.2 |       |          | -3.2     |      |           | -3.2    | 1     |
|                                      | MJ   |      |         | 16   |       |          | 12       |      |           | 16      | -     |
| Low-level output current, IOL        | J, N |      |         | 16   |       |          | 12       |      |           | 16      | 1     |
| Operating free-air temperature range | MJ   | -55  |         | 125  | 55    |          | 125      | -55  |           | 125     | °.    |
|                                      | J, N | 0    |         | 70   | 0     |          | 70       | 0    |           | 70      |       |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|      | PARAMETER   | TEST CONDITIONS   | 5†                    | те         | 3P24S1           | 0*           | T<br>T<br>TB | BP24S<br>BP24S<br>P28S2 | B1,<br>B6,<br>708 | TE         | 3P24S            | 41         | UNIT |
|------|---|---|-----------------------|------------|------------------|--------------|--------------|-------------------------|-------------------|------------|------------------|------------|------|
|      |   |   |                       | MIN        | TYP <sup>‡</sup> | MAX          | MIN          | TYP <sup>‡</sup>        | MAX               | MIN        | TYP <sup>‡</sup> | MAX        |      |
| VIH  | High-level input voltage                                |   |                       | 2          |                  |              | 2            |                         |                   | 2          |                  |            | v    |
| VIL  | Low-level input voltage                                 |   |                       |            |                  | 0.8          |              |                         | 0.8               |            |                  | 0.8        | V    |
| VIK  | Input clamp voltage                                     | $V_{CC} = MIN, I_I = -18 \text{ mA}$                            |                       |            |                  | -1.2         |              |                         | -1.2              |            |                  | -1.2       | V    |
| Vон  | High-level output voltage                               | $V_{CC} = MIN, V_{IH} = 2 V,$<br>$V_{IL} = 0.8 V, I_{OH} = MAX$ |                       | 2.4        | 3.1              |              | 2.4          | 3.1                     |                   | 2.4        | 3.1              |            | v    |
| VOL  | Low-level output voltage                                | $V_{CC} = MIN, V_{1H} = 2 V,$<br>$V_{1L} = 0.8 V, I_{OL} = MAX$ | · · · · · · · · · · · |            |                  | 0.5          |              |                         | 0.5               |            |                  | 0.5        | v    |
| lozн | Off-state output current,<br>high-level voltage applied | V <sub>CC</sub> = MAX, V <sub>IH</sub> = 2 V, V                 | 0 = 2.4 V             |            |                  | 50           |              |                         | 50                |            |                  | 50         | μA   |
| IOZL | Off-state output current,<br>low-level voltage applied  | V <sub>CC</sub> = MAX, V <sub>IH</sub> = 2 V, V                 | o = 0.5 V             |            |                  | 50           |              |                         | -50               |            |                  | 50         | μA   |
| 4    | Input current at maximum<br>input voltage               | V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V                   |                       |            |                  | 1            |              |                         | 1                 |            |                  | 1          | mA   |
| Чн   | High-level input current                                | V <sub>CC</sub> = MAX, V <sub>1</sub> = 2.7 V                   |                       |            |                  | 25           |              |                         | 25                |            |                  | 25         | μA   |
| ΠL   | Low-level input current                                 | V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.5 V                   |                       |            |                  | -250         |              |                         | -250              |            | _                | -250       | μA   |
| los  | Short-circuit<br>output current <sup>§</sup>            | V <sub>CC</sub> = MAX   | J, N                  | -15<br>-20 |                  | -100<br>-100 | -15<br>-20   |                         | -100<br>-100      | -15<br>-20 |                  | 100<br>100 | mA   |
| Icc  | Supply current  | V <sub>CC</sub> = MAX   | MJ<br>J. N            |            | 75               |              |              | 125<br>125              | 175<br>175        |            | 95<br>95         | 140<br>140 | mA   |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions

<sup>‡</sup> All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

 $\S$  Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

#### switching characteristics over recommended ranges of TA and VCC (unless otherwise noted)

| түре       |      | TEST C                  | CONDITIONS        | Ac  | t <sub>a</sub> (A)<br>cess time<br>address | from | Acces | <sup>t</sup> a(S)<br>s time fr<br>ct (enable | om chip<br>e time) |     | <sup>t</sup> PXZ<br>Disable ti | me  | UNIT |
|------------|------|-------------------------|-------------------|-----|--|------|-------|--|--------------------|-----|--------------------------------|-----|------|
|            |      |                         |                   | MIN | TYP  | MAX  | MIN   | ТҮР  | MAX                | MIN | ТҮР                            | MAX |      |
| 700040404  | MJ   |                         |                   |     | 35   |      |       | 20   | 35                 |     | 15                             | 35  | ns   |
| TBP24S10*  | J, N | C <sub>L</sub> = 30 pF  |                   |     | 35   |      |       | 20   | 40                 |     | 15                             | 30  | ns   |
| TBP24S81   |      | for ta(A)               | D = 200 O         |     | 45   | 70   |       | 20   | 40                 |     | 20                             | 40  | ns   |
| T0004044   | MJ   | and t <sub>a(S)</sub> , | $R_{L} = 300 SZ,$ |     | 40   | 75   |       | 20   | 40                 |     | 20                             | 40  | ns   |
| 18724341   | J, N | Cլ=5pF                  | See Page 1-14     |     | 40   | 60   |       | 20   | 30                 |     | 20                             | 30  | ns   |
| TBP28S86   |      | for tpxz                |                   |     | 45   |      |       | 20   | 40                 |     |                                | 40  |      |
| TBP2852708 |      |                         |                   |     | 45   | /0   |       | 20   | 40                 | i   | 20                             | 40  | ns   |

\* Electrical parameters for these devices are design goals only.

NOTE: MJ designates full-temperature-range circuits (formerly 54 Family), J and N designate commercial-temperature-range circuits (formerly 74 Family).

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## SERIES 24 AND 28 STANDARD PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

#### recommended operating conditions

|                                      |      | TBP28 | S42*, TB | P28S45* |      | TBP28S8 | 5*   | Т    | BP28S16 | 6*   |      |
|--------------------------------------|------|-------|----------|---------|------|---------|------|------|---------|------|------|
| PARAMETER                            |      | MIN   | NOM      | MAX     | MIN  | NOM     | MAX  | MIN  | NOM     | MAX  | UNIT |
|                                      | MJ   | 4.5   | 5        | 5.5     | 4.5  | 5       | 5.5  | 4.5  | 5       | 5.5  |      |
| Supply voltage, VCC                  | J, N | 4.75  | 5        | 5.25    | 4.75 | 5       | 5.25 | 4.75 | 5       | 5.25 | ٦ř   |
| High-level output current            | MJ   |       |          | -2      |      |         | -2   |      |         | -2   |      |
| High-level output current, IOH       | J, N |       |          | -3.2    |      |         | -3.2 |      |         | -3.2 |      |
|                                      | MJ   |       |          | 16      |      |         | 16   |      |         | 16   |      |
| _ow-level output current, IOL        | J, N |       |          | 16      |      |         | 16   |      |         | 16   |      |
| Operating free-air temperature range | MJ   | -55   |          | 125     | -55  |         | 125  | -55  |         | 125  | 00   |
|                                      | J, N | 0     |          | 70      | 0    |         | 70   | 0    |         | 70   | 7 ~  |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|      | PARAMETER   | TEST CONDITIONS   | ;†        | ТВ<br>ТВ | P28S4<br>P28S4 | 12*,<br>15* | т   | 3P28S8                  | 35*  | тв  | P28S1            | 66*  | UNIT |
|------|---|---|-----------|----------|----------------|-------------|-----|-------------------------|------|-----|------------------|------|------|
|      |   |   |           | MIN      | TYP‡           | MAX         | MIN | <b>TYP</b> <sup>‡</sup> | MAX  | MIN | TYP <sup>‡</sup> | MAX  |      |
| ∨ін  | High-level input voltage                                |   |           | 2        |                |             | 2   |                         |      | 2   |                  |      | V    |
| VIL  | Low-level input voltage                                 |   |           |          |                | 0.8         |     |                         | 0.8  |     |                  | 0.8  | V    |
| VIK  | Input clamp voltage                                     | V <sub>CC</sub> = MIN, I <sub>I</sub> =18 mA  |           |          |                | -1.2        |     |                         | -1.2 |     |                  | -1.2 | V    |
| Voн  | High-level output voltage                               | $V_{CC} = MIN, V_{IH} = 2 V,$<br>$V_{IL} = 0.8 V, I_{OH} = MAX$                                 |           | 2.4      | 3,1            |             | 2.4 | 3.1                     |      | 2,4 | 3.1              |      | v    |
| VOL  | Low-level output voltage                                | V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V,<br>V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = MAX |           |          |                | 0.5         |     |                         | 0.5  |     | ····             | 0.5  | v    |
| югн  | Off-state output current,<br>high-level voltage applied | V <sub>CC</sub> = MAX, V <sub>IH</sub> = 2 V, V   | o = 2.4 V |          |                | 50          |     |                         | 50   |     |                  | 50   | μA   |
| lozl | Off-state output current,<br>low-level voltage applied  | V <sub>CC</sub> = MAX, V <sub>IH</sub> = 2 V, V   | O = 0.5 V |          |                | -50         |     |                         | -50  |     |                  | -50  | μA   |
| Ц    | Input current at maximum<br>input voltage               | V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V   |           |          |                | 1           |     |                         | 1    |     |                  | 1    | mA   |
| Чн   | High-level input current                                | V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V   |           |          |                | 25          |     |                         | 25   |     |                  | 25   | μA   |
| 412  | Low-level input current                                 | V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.5 V   |           |          |                | -250        |     |                         | -250 |     |                  | -250 | μA   |
| loc  | Short-circuit   | Vcc = MAX   | MJ        | -15      |                | -100        | -15 |                         | -100 | -15 |                  | -100 | mA   |
| 105  | output current §  |   | J, N      | -20      |                | -100        | -20 |                         | 100  | -20 |                  | -100 |      |
| 100  | Supply current  |   | MJ        |          | 105            |             |     | 110                     |      |     | 100              |      | mA   |
| יינכ | Supply current  |   | J, N      |          | 105            |             |     | 110                     |      | 1   | 100              |      | 1    |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>+</sup> All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

§ Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

#### switching characteristics over recommended ranges of TA and VCC (unless otherwise noted)

|                        |  |                         |     | t <sub>a</sub> (A)  |           |                | t <sub>a</sub> (S)     | · ·                |     | tPXZ    |      | T    |
|------------------------|--|-------------------------|-----|---------------------|-----------|----------------|------------------------|--------------------|-----|---------|------|------|
| ТҮРЕ                   | TEST CC  | NDITIONS                | Ac  | cess time<br>addres | from<br>5 | Acces<br>selec | s time fr<br>ct (enabl | om chip<br>e time) |     | Disable | time | UNIT |
|                        |  |                         | MIN | ТҮР                 | MAX       | MIN            | ТҮР                    | MAX                | MIN | ТҮР     | MAX  |      |
| TBP28S42*<br>TBP28S45* | C <sub>L</sub> = 30 pF<br>for t <sub>a</sub> (A) | R <sub>1</sub> = 300 Ω, |     | 35                  |           |                | 15                     |                    |     | 12      |      | ns   |
| TBP28S85*              | and ta(S),                                       | See Page 1-14           |     | 35                  |           |                | 15                     |                    |     | 12      |      | ns   |
| TBP28S166*             | CL = 5 pF<br>FBP28S166* for tPXZ                 |                         | 35  |                     |           | 15             |                        |                    | 12  |         | ns   |      |

\*Electrical parameters for these devices are design goals only.

## SERIES 24 AND 28 LOW-POWER PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

#### recommended operating conditions

| DADAMETER                            |      |      | TBP28L2 | 2*   | TBP28 | L42*, TE | P28L45* |      | TBP28L | 86   |     |
|--------------------------------------|------|------|---------|------|-------|----------|---------|------|--------|------|-----|
| PARAMETER                            |      | MIN  | NOM     | MAX  | MIN   | NOM      | MAX     | MIN  | NOM    | MAX  |     |
| 6 W                                  | MJ   | 4.5  | 5       | 5.5  | 4.5   | 5        | 5.5     | 4.5  | 5      | 5.5  |     |
| Supply voltage, VCC                  | J, N | 4.75 | 5       | 5.25 | 4.75  | 5        | 5.25    | 4.75 | 5      | 5.25 | 1 ° |
| High-level output current, IOH       | MJ   |      |         | -1   |       |          | -1      |      |        | -1   | -   |
| High-level output current, IOH       | J, N |      |         | -1.6 |       |          | -1.6    |      |        | -1.6 |     |
|                                      | MJ   |      |         | 8    |       |          | 8       |      |        | 4    |     |
| Low-level output current, IOL        | J, N |      |         | 8    |       |          | 8       |      |        | 8    |     |
| Operating free-air temperature range | MJ   | -55  |         | 125  | -55   |          | 125     | 55   |        | 125  | °C  |
|                                      | J, N | 0    |         | 70   | 0     |          | 70      | 0    |        | 70   | ן י |

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|      | PARAMETER   | TEST CONDITION  | st                     | тв    | P28L2 | 22*  | ד  <br>ד | 3P28L                   | 12*<br>12* | т   | BP28L            | 86   | UNIT |
|------|---|---|------------------------|-------|-------|------|----------|-------------------------|------------|-----|------------------|------|------|
|      |   |   |                        | MIN . | TYP‡  | MAX  | MIN      | <b>TYP</b> <sup>‡</sup> | MAX        | MIN | TYP <sup>‡</sup> | MAX  | 1    |
| VIH  | High-level input voltage                                |   |                        | 2     |       |      | 2        |                         |            | 2   |                  |      | V    |
| VIL  | Low-level input voltage                                 |   |                        |       |       | 0.8  |          |                         | 0.8        | [   |                  | 0.8  | V    |
| VIK  | Input clamp voltage                                     | $V_{CC} = MIN, I_I = -18 \text{ mA}$  |                        |       |       | -1.2 |          |                         | -1.2       |     |                  | -1.2 | V    |
| ∨он  | High-level output voltage                               | V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V,<br>V <sub>IL</sub> = 0.8 V, I <sub>OH</sub> = MAX |                        | 2.4   | 3.1   |      | 2.4      | 3.1                     |            | 2.4 | 3.1              |      | v    |
| VOL  | Low-level output voltage                                | V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V,<br>V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = MAX |                        |       |       | 0.5  |          |                         | 0.5        |     |                  | 0.5  | v    |
| IOZH | Off-state output current,<br>high-level voltage applied | V <sub>CC</sub> = MAX, V <sub>IH</sub> = 2 V, V   | / <sub>O</sub> = 2.4 V |       |       | 50   |          |                         | 50         |     |                  | 50   | μA   |
| IOZL | Off-state output current,<br>low-level voltage applied  | V <sub>CC</sub> = MAX, V <sub>IH</sub> = 2 V, V   | / <sub>O</sub> = 0.5 V |       |       | -50  |          |                         | -50        |     |                  | -50  | μΑ   |
| 1    | Input current at maximum<br>input voltage               | V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V   |                        |       |       | 1    |          |                         | 1          |     |                  | 1    | mA   |
| Чн   | High-level input current                                | V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V   |                        |       |       | 25   | -        |                         | 25         |     |                  | 25   | μA   |
| ΠL   | Low-level input current                                 | V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.5 V   |                        |       |       | -250 |          |                         | -250       |     |                  | -250 | μA   |
|      | Short-circuit   | $V_{00} = MAX$  | MJ                     | -10   |       | -100 | -10      |                         | -100       | -10 |                  | -100 | mΑ   |
| 105  | output current §  |   | J, N                   | -10   |       | -100 | -10      |                         | -100       | -10 |                  | -100 |      |
| loc  | Supply current  | Vcc = MAX   | MJ                     |       |       |      |          |                         |            |     | 60               | 100  | mA   |
|      | coppi, canon  |   | J, N                   |       | 60    | 85   |          | 50                      |            |     | 60               | 100  |      |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup> All typical values are at V<sub>CC</sub> = 5 V,  $T_A = 25^{\circ}$ C.

 $\S$  Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

#### switching characteristics over recommended ranges of TA and VCC (unless otherwise noted)

| ТҮРЕ                   |      | TEST CON     | IDITIONS                      | Ace | <sup>t</sup> a(A)<br>cess time<br>address | from | Access<br>selec | t <sub>a</sub> (S)<br>s time fro<br>t (enable | om chip<br>time) | D   | <sup>t</sup> PXZ<br>Visable tir | ne  | UNIT |
|------------------------|------|--------------|-------------------------------|-----|---|------|-----------------|---|------------------|-----|---------------------------------|-----|------|
|                        |      |              |                               | MIN | TYP                                       | MAX  | MIN             | ТҮР   | MAX              | MIN | TYP                             | MAX |      |
| TPP201 22* 1           | MJ   | C. = 20 pE   |                               |     | 45  |      |                 | 20  |                  |     | 15                              |     | ns   |
| IDF28L22               | J, N | C[-30 pr     | D                             |     | 45  |      |                 | 20  |                  |     | 15                              |     | ns   |
| TBP28L42*<br>TBP28L45* |      | and $t_a(A)$ | RL = 600 12,<br>See Page 1-15 |     | 60  |      |                 | 30  |                  |     | 25                              |     | ns   |
| 70000000 1             | MJ   | CL - Spr     |                               |     | 85  | 175  |                 | 55  | 135              |     | 50                              | 90  |      |
|                        | J, N | TOP TOXY     |                               |     | 85  | 130  |                 | 55  | 90               |     | 50                              | 75  | ns   |

\* Electrical parameters for these devices are design goals only.

## SERIES 24 AND 28 LOW-POWER PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

#### recommended operating conditions

| BADAMETED                            |      | •    | TBP28L8   | 5*   | Т    | BP28L16 | 6*  |    |
|--------------------------------------|------|------|---|------|------|---------|---|----|
| PARAMETER                            |      | MIN  | NOM   | MAX  | MIN  | NOM     | MAX   |    |
|                                      | MJ   | 4.5  | 5   | 5.5  | 4.5  | 5       | 5.5   |    |
| Supply voltage, VCC                  | J, N | 4.75 | 5   | 5.25 | 4.75 | 5       | 5.25  | ]  |
|                                      | MJ   |      | MIN     NOM     MAX     MI       4.5     5     5.5     4       4.75     5     5.25     4      1    1    1      1.6    1    1      55     125     -       0     70     -70 |      |      | -1      |   |    |
| High-level output current, IOH       | J, N |      |   | -1.6 |      |         | 6*<br>MAX<br>5.5<br>5.25<br>-1<br>-1.2<br>8<br>8<br>125<br>70 | ma |
|                                      | MJ   |      |   | 8    |      |         | 8   |    |
|                                      | J, N |      |   | 8    |      |         | 8   | mA |
| Operating free air temperature renge | MJ   | -55  |   | 125  | -55  |         | 125   | °. |
| Operating nee-an temperature range   | J, N | 0    |   | 70   | 0    |         | MAX<br>5.5<br>5.25<br>-1<br>-1.2<br>8<br>8<br>8<br>125<br>70  |    |

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                 |   |   | uovat    | Т   | BP28L8           | 15*  | TE  | P28L16           | 6*   |      |
|-----------------|---|---|----------|-----|------------------|------|-----|------------------|------|------|
|                 | PARAMETER   | TEST CONDIT   | IONS     | MIN | TYP <sup>‡</sup> | MAX  | MIN | TYP <sup>‡</sup> | MAX  | UNIT |
| VIH             | High-level input voltage                                |   |          | 2   |                  |      | 2   |                  |      | V    |
| VIL             | Low-level input voltage                                 |   |          |     |                  | 0.8  |     |                  | 0.8  | V    |
| VIK             | Input clamp voltage                                     | V <sub>CC</sub> = MIN, I <sub>I</sub> = -18 m   | nA       |     |                  | -1.2 |     |                  | -1.2 | V    |
| v <sub>он</sub> | High-level output voltage                               | V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V<br>V <sub>IL</sub> = 0.8 V, I <sub>OH</sub> = MA | Υ,<br>ΑΧ | 2.4 | 3.1              |      | 2.4 | 3.1              |      | v    |
| VOL             | Low-level output voltage                                | V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V<br>V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = MA | Υ,<br>ΑΧ |     |                  | 0.5  |     |                  | 0.5  | v    |
| lоzн            | Off-state output current,<br>high-level voltage applied | V <sub>CC</sub> = MAX, V <sub>IH</sub> = 2  |          |     | 50               |      |     | 50               | μA   |      |
| lozl            | Off-state output current,<br>low-level voltage applied  | V <sub>CC</sub> = MAX, V <sub>IH</sub> = 2 V  |          |     | -50              |      | -   | 50               | μA   |      |
| Ц               | Input current at maximum<br>input voltage               | V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5   | v        |     |                  | 1    |     |                  | 1    | mA   |
| Чн              | High-level input current                                | $V_{CC} = MAX, V_I = 2.7$   | v        |     |                  | 25   |     |                  | 25   | μA   |
| μL              | Low-level input current                                 | V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.5 V   |          |     |                  | -250 |     |                  | -250 | μA   |
| 105             | Short-circuit   |   | MJ       | 10  |                  | -100 | -10 |                  | -100 | mA   |
| 105             | output current §  |   | J, N     | _10 |                  | -100 | -10 |                  | -100 |      |
| 100             | Supply current  |   | MJ       |     | 55               |      |     | 50               |      | mA   |
| 100             | Supply current  |   | J, N     |     | 55               |      |     | 50               |      |      |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>+</sup> All typical values are at  $V_{CC} = 5 \text{ V}$ ,  $T_A = 25^{\circ} \text{C}$ .

 $\S$  Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

#### switching characteristics over recommended ranges of TA and VCC (unless otherwise noted)

| ТҮРЕ       | TEST CON   | DITIONS                       | Ac  | <sup>t</sup> a(A)<br>cess time<br>address   | from | Acces | <sup>t</sup> a(S)<br>s time fr<br>ct (enab! | om chip<br>e time) | 1 | <sup>t</sup> PXZ<br>Disable ti | me | UNIT |
|------------|--|-------------------------------|-----|---|------|-------|---|--------------------|---|--------------------------------|----|------|
|            |  |                               | MIN | ta(A) ta(S) tPXZ   ess time from<br>address Access time from chip<br>select (enable time) Disable time UNIT   TYP MAX MIN TYP MAX MIN TYP MAX   65 30 25 ns   65 30 25 ns |      |       |   |                    |   |                                |    |      |
| TBP28L85*  | CL = 30 pF for   | D. = 000 O                    |     | 65  |      |       | 30  |                    |   | 25                             |    | ns   |
| TBP28L166* | t <sub>a</sub> (A) and t <sub>a</sub> (S),<br>C <sub>L</sub> = 5 pF for tpχZ | RL = 600 32,<br>See Page 1-15 |     | 65  |      |       | 30  |                    |   | 25                             |    | ns   |

\* Electrical parameters for these devices are design goals only.

#### recommended operating conditions

| PARAMETER                            |      | TBP28P42*, TBP28P45* |     |      |      | TBP28P8 | 5*   | 1    | LINUT |      |    |
|--------------------------------------|------|----------------------|-----|------|------|---------|------|------|-------|------|----|
|                                      |      | MIN                  | NOM | MAX  | MIN  | NOM     | MAX  | MIN  | NOM   | MAX  |    |
| Supply voltage, V <sub>CC</sub>      | MJ   | 4.5                  | 5   | 5.5  | 4.5  | 5       | 5.5  | 4.5  | 5     | 5.5  |    |
|                                      | J, N | 4.75                 | 5   | 5.25 | 4.75 | 5       | 5.25 | 4.75 | 5     | 5.25 |    |
|                                      | MJ   |                      |     | -2   |      |         | -2   |      |       | -2   | mA |
| High-level output current, IOH       | J, N |                      |     | -3.2 |      |         | -3.2 |      |       | -3.2 |    |
|                                      | MJ   |                      |     | 16   |      |         | 16   |      |       | 16   |    |
| Low-level output current, IOL        | J, N |                      |     | 16   |      |         | 16   |      |       | 16   | mA |
|                                      | MJ   | 55                   |     | 125  | -55  |         | 125  | -55  |       | 125  | °0 |
| Operating free-air temperature range | J, N | 0                    |     | 70   | 0    |         | 70   | 0    |       | 70   | C  |

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                | PARAMETER TEST CONDITIONS <sup>†</sup>                  |   | ТВ<br>ТВ  | P28P42*,<br>P28P45* | т                    | 3P28P85* | тв                   | 66* | UNIT             |      |    |
|----------------|---|---|-----------|---------------------|----------------------|----------|----------------------|-----|------------------|------|----|
|                |   |   |           | MIN                 | TYP <sup>‡</sup> MAX | MIN      | TYP <sup>‡</sup> MAX | MIN | TYP <sup>‡</sup> | MAX  | 1  |
| VIH            | High-level input voltage                                |   |           | 2                   |                      | 2        |                      | 2   |                  |      | V  |
| VIL            | Low-level input voltage                                 |   |           |                     | 0.8                  |          | 0.8                  |     |                  | 0.8  | V  |
| VIK            | Input clamp voltage                                     | V <sub>CC</sub> = MIN, I <sub>I</sub> = -18 mA  |           |                     | -1.2                 |          | -1.2                 |     |                  | -1.2 | V  |
| ∨он            | High-level output voltage                               | V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V,<br>V <sub>IL</sub> = 0.8 V, I <sub>OH</sub> = MAX |           | 2.4                 | 3.1                  | 2.4      | 3.1                  | 2.4 | 3.1              |      | v  |
| VOL            | Low-level output voltage                                | V <sub>CC</sub> = MIN, V <sub>IH</sub> = 2 V,<br>V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = MAX |           |                     | 0.5                  |          | 0.5                  |     |                  | 0.5  | v  |
| lоzн           | Off-state output current,<br>high-level voltage applied | V <sub>CC</sub> = MAX, V <sub>IH</sub> = 2 V, V <sub>C</sub>                                    | ) = 2.4 ∨ |                     | 50                   |          | 50                   |     |                  | 50   | μΑ |
| lozl           | Off-state output current,<br>low-level voltage applied  | V <sub>CC</sub> = MAX, V <sub>IH</sub> = 2 V, V <sub>C</sub>                                    | ) = 0.5 V |                     | -50                  |          | -50                  |     |                  | -50  | μΑ |
| 1 <sub>1</sub> | Input current at maximum<br>input voltage               | V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V   |           |                     | 1                    |          | . 1                  |     |                  | 1    | mA |
| Чн             | High-level input current                                | V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V   |           |                     | 25                   | 1        | 25                   |     |                  | 25   | μA |
| կլ             | Low-level input current                                 | V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.5 V   |           |                     | -250                 |          | -250                 | 1   |                  | -250 | μA |
|                | Short-circuit   |   | MJ        | -15                 | -100                 | -15      | 100                  | -15 |                  | -100 |    |
| L'OS           | output current §  |   | J, N      | -20                 | -100                 | -20      | -100                 | -20 |                  | -100 |    |
| 1              | Supply Power Up   |   |           |                     | 100                  |          | 110                  |     | 100              |      |    |
| 221            | current Power Down                                      | VCC = MAX   |           |                     | 12                   |          | 12                   |     | 15               |      |    |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>+</sup> All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

 ${}^{\S}$ Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

#### switching characteristics over recommended ranges of TA and VCC (unless otherwise noted)

|                        | TEST CONDITIONS  |                              | <sup>t</sup> a(A)<br>Access time from<br>address |     |     | <sup>t</sup> a(E)<br>Access time from chip<br>enable (enable time) |     |     | <sup>t</sup> PXZ<br>Disable time |     |     | UNIT |
|------------------------|--|------------------------------|--|-----|-----|--|-----|-----|----------------------------------|-----|-----|------|
| TYPE                   |  |                              |  |     |     |  |     |     |                                  |     |     |      |
|                        |  |                              | MIN  | ТҮР | MAX | MIN  | ТҮР | MAX | MIN                              | ТҮР | MAX |      |
| TBP28P42*<br>TBP28P45* | CL = 30 pF for   | RL = 300 Ω,                  |  | 35  |     |  | 35  |     |                                  | 12  |     | ns   |
| TBP28P85*              | t <sub>a</sub> (A) and t <sub>a</sub> (E),<br>CL = 5 pF for tpXZ | (A) and ta(E), See Page 1-14 |  | 35  |     |  | 35  |     |                                  | 12  |     | ns   |
| TBP28P166*             |  | CL = 5 pr for tPXZ           |  | 35  |     | 35   |     |     | 12                               |     |     | ns   |

\*Electrical parameters for these devices are design goals only.

NOTE: MJ designates full-temperature-range circuits (formerly 54 Family), J and N designate commercial-temperature-range circuits (formerly 74 Family).

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## SERIES 24 AND 28 REGISTERED PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

#### recommended operating conditions

| PARAMETER                                   |      |      | BP28R4 | 5*   | ٦    | BP28R8 | 5*   | Т    |     |      |       |
|---|------|------|--------|------|------|--------|------|------|-----|------|-------|
|   |      | MIN  | NOM    | MAX  | MIN  | NOM    | MAX  | MIN  | NOM | MAX  |       |
| Sumply under a Man                          | MJ   | 4.5  | 5      | 5.5  | 4.5  | 5      | 5.5  | 4.5  | 5   | 5,5  |       |
| Supply voltage, V CC                        | J, N | 4.75 | 5      | 5.25 | 4.75 | 5      | 5.25 | 4.75 | 5   | 5.25 | ] * i |
|   | MJ   |      |        | -2   |      |        | -2   |      |     | -2   |       |
| High-level output current, IOH              | J, N |      |        | -3.2 |      |        | -3.2 |      |     | -3.2 | mA    |
| Low-level output current, IOL               | MJ   |      |        | 16   |      |        | 16   |      |     | 16   |       |
|   | J, N |      |        | 16   |      |        | 16   |      |     | 16   | 1 mA  |
| Clock pulse width high, tw(CH)              |      | 20   |        |      | 20   |        |      | 20   |     |      | ns    |
| Clock pulse width low, tw(CL)               |      | 20   |        |      | 20   |        |      | 20   |     |      | ns    |
| Address setup time, t <sub>su</sub> (A)     |      | 20   |        |      | 20   |        |      | 20   |     |      | ns    |
| Chip select setup time, t <sub>su</sub> (S) |      | 0    |        |      | 0    |        |      | 0    |     |      | ns    |
| Address hold time, t <sub>h</sub> (A)       |      | 0    |        |      | 0    |        |      | 0    |     |      | ns    |
| Chip select hold time, th(S)                |      | 5    |        |      | 5    |        |      | 5    |     |      | ns    |
|   | MJ   | -55  |        | 125  | 55   |        | 125  | -55  |     | 125  | 00    |
| Operating free-air temperature range        | J, N | 0    |        | 70   | 0    |        | 70   | 0    |     | 70   |       |

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER |   | TEST CONDITIONS <sup>†</sup>  |         |     | BP28R            | 45*  | T   | 3P28R                   | 35*  | тв  |                  |      |    |
|-----------|---|---|---------|-----|------------------|------|-----|-------------------------|------|-----|------------------|------|----|
|           |   |   |         |     | TYP <sup>‡</sup> | MAX  | MIN | <b>TYP</b> <sup>‡</sup> | MAX  | MIN | TYP <sup>‡</sup> | MAX  |    |
| VIH       | High-level input voltage                                |   |         | 2   |                  |      | 2   |                         |      | 2   |                  |      | V  |
| VIL       | Low-level input voltage                                 |   |         |     |                  | 0.8  |     |                         | 0.8  |     |                  | 0.8  | V  |
| VIK       | Input clamp voltage                                     | V <sub>CC</sub> = MIN, 1 <sub>I</sub> = -18 mA  |         |     |                  | -1.2 |     |                         | -1.2 |     |                  | -1.2 | V  |
| ∨он       | High-level output voltage                               | V <sub>CC</sub> = MIN, V <sub>1H</sub> = 2 V,<br>V <sub>IL</sub> = 0.8 V, I <sub>OH</sub> = MAX |         | 2.4 | 3.1              |      | 2.4 | 3.1                     |      | 2.4 | 3.1              |      | v  |
| Vai       |   | $V_{CC} = MIN, V_{IH} = 2 V,$   | MJ      |     |                  | 0.5  |     |                         | 0,5  |     |                  | 0.5  |    |
| VOL       | Low-level output voltage                                | V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = MAX  | J, N    |     |                  | 0.5  |     |                         | 0.5  |     |                  | 0,5  | v  |
| lozн      | Off-state output current,<br>high-level voltage applied | V <sub>CC</sub> = MAX, V <sub>IH</sub> = 2 V, V <sub>O</sub> =                                  | = 2.4 V |     |                  | 50   |     |                         | 50   |     |                  | 50   | μA |
| IOZL      | Off-state output current,<br>low-level voltage applied  | V <sub>CC</sub> = MAX, V <sub>IH</sub> = 2 V, V <sub>O</sub> =                                  | = 0.5 V | _   |                  | -50  |     |                         | -50  |     |                  | -50  | μΑ |
| Ч         | Input current at maximum<br>input voltage               | V <sub>CC</sub> = MAX, V <sub>I</sub> = 5.5 V   |         |     |                  | 1    |     |                         | 1    |     |                  | 1    | mA |
| Чн        | High-level input current                                | V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V   |         |     |                  | 25   |     |                         | 25   |     |                  | 25   | μA |
| ЧL        | Low-level input current                                 | V <sub>CC</sub> = MAX, V <sub>1</sub> = 0.5 V   |         |     |                  | -250 |     |                         | -250 |     |                  | -250 | μA |
|           | Short-circuit   |   | MJ      | -15 |                  | -100 | -15 |                         | -100 | -15 |                  | -100 | -  |
| '0s       | output current §  |   | J, N    | -20 |                  | -100 | -20 |                         | -100 | -20 |                  | -100 |    |
| 100       | Supply ourrent  | Vee - MAX   | MJ      |     | 110              |      |     | 120                     |      |     | 110              |      |    |
| 'CC       | Supply current  | VCC = MAX   |         |     | 110              |      |     | 120                     |      |     | 110              |      |    |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup> All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

§ Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

\* Electrical and switching parameters for these devices are design goals only,

## SERIES 24 AND 28 REGISTERED PROGRAMMABLE READ-ONLY MEMORIES WITH 3-STATE OUTPUTS

## switching characteristics over recommended ranges of TA and VCC (unless otherwise noted)

#### types TBP28R45\*, TBP28R85\*, TBP28R166\*

|                     | PARAMETER                      | TEST CONDITIONS         | MIN TYP MAX | UNIT |
|---------------------|--------------------------------|-------------------------|-------------|------|
| t <sub>a</sub> (C)  | Access time from clock         |                         | 20          | ns   |
| tPXZ(C)             | Output disable time from clock | R <sub>L</sub> = 300 Ω, | 20          | ns   |
| tPZX(C)             | Output enable time from clock  | $C_{L} = 30  pF$ ,      | 20          | ns   |
| <sup>t</sup> PXZ(G) | Output disable time from G     | See Figure 1            | 12          | ns   |
| tPZX(G)             | Output enable time from G      |                         | 15          | ns   |

• Electrical and switching parameters for these devices are design goals only.







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## SERIES 24 AND 28 PROGRAMMABLE READ-ONLY MEMORIES

#### recommended conditions for programming

| PARAMETER  | MIN                         | ТҮР   | MAX | UNIT  |     |
|--|-----------------------------|-------|-----|-------|-----|
| Steady-state supply voltage, V <sub>CC</sub>           | 4.5                         | 5     | 5.5 | v     |     |
|  | VIH                         | 2.4   |     | 5     | v   |
|  | VIL                         | 0     |     | 0.5   | • • |
| E3 and E4 input voltage (where appropriate)            | 2.4                         |       | 5   | v     |     |
| Voltage at all outputs except the one to be programmed | 0                           |       | 0.5 | V     |     |
|  | Voltage, VCC(pr)            | 5.75  | 6   | 6.25  | v   |
| Supply voltage programming pulse (see Figure 2)        | Pulse width, tw             | 1000  |     | 2000  | μs  |
|  | Duty cycle                  |       | 25  | 35    | %   |
| Select or enable programming pulse (see Figure 2)      | Voltage, VS(pr)             | 9.75  | 10  | 11    | v   |
|  | VIL                         |       |     |       | v   |
|  | Voltage, Vo(pr)             | 16.75 | 17  | 17.25 | v   |
| Output programming pulse (see Figure 2)                | Rise time, t <sub>r</sub>   | 10    |     | 50    | μs  |
| output programming pulse (see Figure 2)                | Pulse width, t <sub>w</sub> | 98    | 100 | 1000  | μs  |
|  | VIL                         | 0     |     | 0.5   |     |
| Registered PROM verify clock pulse width               | <sup>t</sup> w(CH)          |       | 20  |       | ns  |
| Free-air temperature, T <sub>A</sub>                   |                             | 0     |     | 55    | °C  |

#### step-by-step programming instructions (see Figure 2)

- Address the word to be programmed, apply 5V ± 10% to V<sub>CC</sub> and active levels to all chip select (S and S) or chip enable (E and E) inputs.
- 2. Verify the status of a bit location by checking the output level. For registered PROMs a clock must be applied to the clock pin to verify the output level.
- 3. Increase VCC to VCC(pr) with a minimum current capability of 200 milliamperes.
- 4. Apply  $V_{S(pr)}$  to all the  $\overline{S}$ ,  $\overline{E}$  or  $\overline{G}$  inputs.  $I_{I} \leq 15$  mA.
- 5. Connect all outputs, except the one to be programmed, to a logic low level ( $0 \le V_{IL} \le 0.5 V$ ). Only one bit is programmed at a time.
- Apply the output programming pulse for at least 98 microseconds. Minimum current capability of the programming supply should be 200 milliamperes.
- 7. After terminating the output pulse, disconnect all outputs from VIL conditions.
- 8. Reduce the voltage at  $\overline{S}$ ,  $\overline{E}$  or  $\overline{G}$  inputs to VIL.
- 9. Reduce V<sub>CC</sub> to steady-state voltage and verify output status. Note that for registered PROMs, a clock must be applied to the clock input pin to verify output status.
- 10. Repeat steps 3 through 9 for each bit location that requires programming.
- 11. Verify accurate programming of every word after all words have been programmed using V<sub>CC</sub> values of 4.5 and 5.5 volts. Note that registered PROMs must be clocked to verify the output condition.



FIGURE 2 – TIMING DIAGRAM AND VOLTAGE WAVEFORMS FOR PROGRAMMING SEQUENCE

NOTE: The output to be programmed may be forced to zero volts after the transition to  $V_{O(pr)}$  at the E input has begun.


# SCHOTTKY†TYPES SN54S189A, SN54S289A, SN74S189A, SN74S289A64-BIT HIGH-PERFORMANCETTL MEMORIESBANDOM-ACCESS MEMORIES

SEPTEMBER 1976-REVISED JUNE 1979

#### STATIC RANDOM-ACCESS MEMORIES

- Fully Decoded RAM's Organized as 16 Words of Four Bits Each
- Schottky-Clamped for High Speed: Read Cycle Time . . . 25 ns Typical Write Cycle Time . . . 25 ns Typical
- Choice of Three-State or Open-Collector Outputs
- Compatible with Most TTL and I<sup>2</sup>L Circuits
- Chip-Select Input Simplifies External Decoding

#### description

These 64-bit active-element memories are monolithic Schottky-clamped transistor-transistor logic (TTL) arrays organized as 16 words of four bits each. They are fully decoded and feature a chip-select input to simplify decoding required to achieve expanded



Pin assignments are same for all packages.

system organization. The memories feature p-n-p input transistors that reduce the low-level input current requirement to a maximum of -0.25 milliamperes, only one-eighth that of a Series 54S/74S standard load factor. The chip-select circuitry is implemented with minimal delay times to compensate for added system decoding.

#### write cycle

The information applied at the data input is written into the selected location when the chip-select input and the write-enable input are low. While the write-enable input is low, the 'S189A output is in the high-impedance state and the 'S289A output is off. When a number of outputs are bus-connected, this high-impedance or off state will neither load nor drive the bus line, but it will allow the bus line to be driven by another active output or a passive pull-up.

#### read cycle

The stored information (complement of information applied at the data input during the write cycle) is available at the output when the write-enable input is high and the chip-select input is low. When the chip-select input is high, the 'S189A output will be in the high-impedance state and the 'S289A output will be off.

| EUNICTION | IN          | PUTS         | 'S189A                     | 'S289A                     |
|-----------|-------------|--------------|----------------------------|----------------------------|
| FUNCTION  | CHIP SELECT | WRITE ENABLE | Ουτρυτ                     | OUTPUT                     |
| Write     | L           | L            | High Impedance             | Off                        |
| Read      | L           | н            | Complement of Data Entered | Complement of Data Entered |
| Inhibit   | н           | x            | High Impedance             | Off                        |

FUNCTION TABLE

 $\textbf{H} \equiv \textbf{high level, L} \equiv \textbf{low level, X} \equiv \textbf{irrelevant}$ 

Number 3,463,975.

Texas Instruments. U. S. Patent 5-29

## TYPES SN54S189A, SN54S289A, SN74S189A, SN74S289A 64-BIT HIGH-PERFORMANCE RANDOM-ACCESS MEMORIES

#### functional block diagram



#### schematics of inputs and outputs



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1) |                 | <br>            | <br>7V                               |
|--|-----------------|-----------------|--------------------------------------|
| Input voltage                                |                 | <br>            | <br>5.5 V                            |
| Off-State output voltage                     |                 | <br>            | <br>5.5 V                            |
| Operating free-air temperature range:        | SN54S' Circuits | <br>            | <br>$-55^{\circ}C$ to $125^{\circ}C$ |
|  | SN74S' Circuits | <br>            | <br>. 0°C to 70°C                    |
| Storage temperature range                    |                 | <br>· · · · · . | <br>-65°C to 150°C                   |

NOTE 1: Voltage values are with respect to network ground terminal.

## TYPES SN54S189A, SN54S289A, SN74S189A, SN74S289A 64-BIT HIGH-PERFORMANCE RANDOM-ACCESS MEMORIES

#### recommended operating conditions

|                                    |   | S   | N54S18 | 9A  | s   | N74S18 | 9A  | s    | N74S28   | 89A  | S    | N54S28  | 9A   |    |
|------------------------------------|---|-----|--------|-----|-----|--------|-----|------|----------|------|------|---------|------|----|
|                                    |   | MIN | NOM    | MAX | MIN | NOM    | MAX | MIN  | NOM      | MAX  | MIN  | NOM     | MAX  |    |
| Supply Voltage, V <sub>CC</sub>    |   | 4.5 | 5      | 5.5 | 4.5 | 5      | 5.5 | 4.75 | 5        | 5.25 | 4.75 | 5       | 5,25 | V  |
| High-level output voltage, VOH     |   |     |        |     |     |        | 5.5 |      |          |      |      |         | 5.5  | V  |
| High-I                             | evel output current, IOH                                      |     |        | -2  |     |        |     |      |          | -6.5 |      |         |      | mA |
| Low-I                              | evel output current, IOL                                      |     |        | 16  |     |        | 16  |      |          | 16   |      |         | 16   | mA |
| Width of write pulse (write enable |   | 25  |        |     | 25  |        |     | 25   |          |      | 25   |         |      | ns |
|                                    | Address before write<br>pulse, t <sub>su</sub> (da)           | 01  |        |     | 0†  |        |     | 0†   |          |      | 01   | <u></u> |      |    |
| Setup<br>time                      | Data before end of write<br>pulse, t <sub>su</sub> (da)       | 25† |        |     | 25↑ |        |     | 25↑  |          |      | 25†  |         |      | ns |
|                                    | Chip-select before end of write<br>pulse, t <sub>su</sub> (S) | 25† |        |     | 25↑ |        |     | 25†  | <u> </u> |      | 25↑  |         |      |    |
|                                    | Address after write pulse, th(ad)                             | 31  |        |     | 31  |        |     | 10   |          |      | 01   |         |      |    |
| Hold                               | Data after write pulse, th(da)                                | 01  |        |     | 01  |        |     | 01   |          |      | 10   |         |      | 1  |
| time                               | Chip-select after write<br>pulse, t <sub>h</sub> (S)          | 01  |        |     | 01  |        |     | 01   |          |      | 01   |         |      | ns |
| Opera                              | Operating free-air temperature, TA                            |     |        | 125 | -55 |        | 125 | 0    |          | 70   | 0    |         | 70   | °C |

 $\uparrow$  The arrow indicates the transition of the write-enable input used for reference:  $\uparrow$  for the low-to-high transition,  $\downarrow$  for the high-to-low transition.

#### electrical characteristics over recommended operating free-air temperature range (otherwise noted)

|     | BARAMETER                      | TECT                     | CONDITIONS              | ·+                    |     | 'S189A |       | 'S289A |       |      |      |
|-----|--------------------------------|--------------------------|-------------------------|-----------------------|-----|--------|-------|--------|-------|------|------|
|     | FARAMETER                      | 1651                     | CONDITIONS              | o'                    | MIN | TYP‡   | MAX   | MIN    | TYP ‡ | MAX  | UNIT |
| VIH | High-level input voltage       |                          |                         |                       | 2   |        |       | 2      |       |      | V    |
| VIL | Low-level input voltage        |                          |                         |                       |     |        | 0.8   |        |       | 0.8  | V    |
| VIK | Input clamp voltage            | $V_{CC} = MIN$ ,         | l <sub>l</sub> = –18mA  |                       | ,   |        | -1.2  | ]      |       | -1.2 | V    |
| Vau |                                | V <sub>CC</sub> = MIN,   | VIH = 2 V,              | SN54S'                | 2.4 | 3.4    |       |        |       |      |      |
| ∙он |                                | V <sub>1L</sub> = 0.8 V, | IOH = MAX               | SN74S'                | 2.4 | 3.2    |       |        |       |      | V    |
| 1   | High level output ourrest      | V <sub>CC</sub> = MIN,   | VIH = 2 V,              | V0=2.4 V              |     |        |       |        |       | 40   |      |
| юн  | High-level output current      | V <sub>IL</sub> = 0.8 V  |                         | V <sub>O</sub> =5.5 V |     |        |       |        |       | 100  | μΑ   |
| V   |                                | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V,  | SN54S'                |     | 0.35   | 0.5   |        | 0.35  | 0.5  |      |
| VOL | Low-level output voltage       | V <sub>IL</sub> = 0.8 V, | IOL = 16 mA             | SN74S'                |     | 0.35   | 0.45  |        | 0.35  | 0.45 | v    |
| 1   | Off-state output current,      | V <sub>CC</sub> = MAX,   | VIH = 2 V,              |                       |     |        | 50    |        |       | 1    |      |
| югн | high-level voltage applied     | V <sub>IL</sub> ≃ 0.8 V, | V <sub>OH</sub> = 2.4 V |                       | Į   |        | 50    |        |       |      | μA   |
|     | Off-state output current,      | V <sub>CC</sub> = MAX,   | VIH = 2 V,              |                       |     |        |       |        |       |      |      |
| OZL | low-level voltage applied      | V <sub>IL</sub> = 0.8 V, | V <sub>OL</sub> = 0.4 V |                       |     |        | 50    | }      |       |      | μА   |
| 1.  | Input current at maximum input | Vee - MAX                | V 5 5 V                 |                       |     |        | 1     |        |       | 1    |      |
| 1   | voltage                        |                          | vi = 5.5 v              |                       |     |        | ,<br> |        |       | ·    | mA   |
| Чн  | High-level input current       | V <sub>CC</sub> = MAX,   | V1 = 2.7 V              |                       |     |        | 25    |        |       | 25   | μA   |
| 11L | Low-level input current        | V <sub>CC</sub> = MAX,   | V <sub>I</sub> = 0.5 V  |                       |     |        | -250  |        |       | -250 | μA   |
| los | Short-circuit output current § | V <sub>CC</sub> = MAX    |                         |                       | -30 |        | -100  |        |       |      | mA   |
| 'cc | Supply current                 | V <sub>CC</sub> = MAX,   | See Note 2              |                       |     | 75     | 110   |        | 75    | 105  | mA   |

<sup>1</sup>For conditions shown as MIN or MAX use the appropriate value specified under recommended operating conditions.

 $\ddagger$ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25<sup>o</sup>C.

§ Duration of the short circuit should not exceed one second.

NOTE 2: ICC is measured with the read/write and chip-select inputs grounded. All other inputs at 4.5V, and the outputs open.

## TYPES SN54S189A, SN54S289A, SN74S189A, SN74S289A 64-BIT HIGH-PERFORMANCE RANDOM-ACCESS MEMORIES

# 'S189A switching characteristics over recommended operating ranges of TA and VCC (unless otherwise noted)

|  | PARAMETER                           |                          | TEST CONDITIONS                    | SN545 | SN74 |      |     |      |
|--|-------------------------------------|--------------------------|------------------------------------|-------|------|------|-----|------|
|  |                                     |                          | TEST CONDITIONS                    | TYP‡  | MAX  | ТҮР‡ | MAX | UNIT |
| t <sub>a(ad)</sub> Access time from address<br>Access time from chip select<br>(enable time) |                                     | C <sub>L</sub> = 30 pF,  | 25                                 | 50    | 25   | 35   | ns  |      |
|  |                                     | RL = 300 Ω<br>See Note 3 | 18                                 | 25    | 18   | 22   | ns  |      |
| tSR  | Sense recovery time                 |                          |                                    | 22    | 40   | 22   | 35  | ns   |
| tova   | Dischle time from high or low level | from S                   | $C_L = 5  pF$ ,<br>$B_L = 200  ()$ | 12    | 25   | 12   | 17  |      |
| PAZ  | Disable time from high of fow level | from W                   | See Note 3                         | 12    | 30   | 12   | 25  | ns   |

# 'S289A switching characteristics over recommended operating ranges of TA and VCC (unless otherwise noted)

| DADAMETED |  | TECT CONDITIONS          | SN54            | S289A | SN74S289A |     |      |
|-----------|--|--------------------------|-----------------|-------|-----------|-----|------|
|           | PARAMETER  | TEST CONDITIONS          | түр‡            | MAX   | TYP‡      | MAX | UNIT |
| ta(ad)    | Access time from address                         | $C_L = 30  pF$ ,         | 25 <sup>7</sup> | 50    | 25        | 35  | ns   |
| ta(S)     | Access time from chip select (enable time)       | R <sub>L1</sub> = 300 Ω, | 18              | 25    | 18        | 22  | ns   |
| tSR       | Sense recovery time                              | R <sub>L2</sub> = 600 Ω, | 22              | 40    | 22        | 35  | ns   |
|           | Propagation delay time, low-to-high-level from S | See Note 3               | 12              | 25    | 12        | 17  |      |
| PLH       | output (disable time) from $\overline{W}$        |                          | 12              | 30    | 12        | 25  | TIS  |

<sup>‡</sup>All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> =  $25^{\circ}$ C

NOTE: 3. Load circuit and voltage waveforms are shown on page 1-14.

## 256-BIT HIGH-PERFORMANCE RANDOM-ACCESS MEMORIES

SEPTEMBER 1977-REVISED JUNE 1979

**TYPES SN74S201, SN74S301** 

#### STATIC RANDOM-ACCESS MEMORIES

- Static Fully Decoded RAM's Organized as 256 Words of One Bit Each
- Schottky-Clamped for High Performance

SCHOTTKY†

TTL MEMORIES

- Choice of Three-State or Open-Collector Outputs
- Compatible with Most TTL and I<sup>2</sup>L Circuits
- Chip-Select Inputs Simplify External Decoding



#### description

These 256-bit active-element memories are monolithic transistor-transistor logic (TTL) arrays organized as 256 words of one bit. They are fully decoded and have three chip-select inputs to simplify decoding required to achieve expanded system organizations.

#### write cycle

The information applied at the data input is written into the selected location when the three chip-select inputs and the write-enable input are low. While the write-enable input is low, the 'S201 outputs are in the high-impedance state and the 'S301 outputs are off. When a number of outputs are bus-connected, this high-impedance or off state will neither load nor drive the bus line, but it will allow the bus line to be driven by another active output or a passive pull-up.

#### read cycle

The stored information (complement of information applied at the data input during the write cycle) is available at the output when the write-enable input is high and the three chip-select inputs are low. When any one of the chip-select inputs are high, the 'S201 outputs will be in the high-impedance state and the 'S301 outputs will be off.

#### FUNCTION TABLE

|          | INP                    | UTS |                               |                               |
|----------|------------------------|-----|-------------------------------|-------------------------------|
| FUNCTION | NCTION CHIP SELECT WRI |     | 'S201<br>OUTPUT (DO)          | 'S301<br>OUTPUT (DO)          |
| Write    | L                      | L   | High Impedance                | Off                           |
| Read     | L                      | н   | Complement of<br>Data Entered | Complement of<br>Data Entered |
| Inhibit  | н                      | x   | High Impedance                | Off                           |

 $H \equiv$  high level,  $L \equiv$  low level,  $X \equiv$  irrelevant

<sup>‡</sup>For chip-select: L≡all Si inputs low, H≡one or more Si inputs high

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<sup>†</sup>Integrated Schottky-Barrier diodeclamped transistor is patented by 5-33 Texas Instruments. U. S. Patent Number 3,463,975.



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## TYPES SN74S201, SN74S301 256-BIT HIGH-PERFORMANCE RANDOM-ACCESS MEMORIES

#### schematics of inputs and outputs



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1) | 7 V   |
|--|-------|
| Input voltage                                | 5.5 V |
| Off-State output voltage                     | 5.5 V |
| Operating free-air temperature range         | 70°C  |
| Storage temperature range                    | 150°C |

#### recommended operating conditions

|   |   |     | SN74S20 | 1     |      | SN74S30 | 1    | 115117 |
|---|---|-----|---------|-------|------|---------|------|--------|
|   |   | MIN | NOM     | MAX   | MIN  | NOM     | MAX  |        |
| Supply  | Supply Voltage, V <sub>CC</sub> (see Note 1)                  |     | 5       | 5.25  | 4.75 | 5       | 5.25 | v      |
| High-level output voltage, V <sub>OH</sub>      |   |     |         |       |      |         | 5.5  | v      |
| High-level output current, IOH                  |   |     |         | -10.3 |      |         |      | mA     |
| Low-level output current, IOL                   |   |     |         | 16    |      |         | 16   | mA     |
| Width of write pulse (write enable low), tw(wr) |   | 65  |         |       | 65   |         |      | ns     |
| Satur   | Address before write pulse, tsu(ad)                           | 01  |         |       | 01   |         |      |        |
| time  | Data before end of write pulse, t <sub>su(da)</sub>           | 65† |         | _     | 65†  |         |      | ns     |
| une   | Chip-select before end of write pulse, $t_{su}(\overline{S})$ | 65† |         |       | 65†  |         |      |        |
| Hold  | Address after write pulse, th(ad)                             | 01  |         |       | 0†   |         |      |        |
| time  | Data after write pulse, th(da)                                | 01  |         |       | 01   |         |      | ns     |
| line  | Chip-select after write pulse, $t_h(\overline{S})$            | 01  |         |       | 01   |         |      |        |
| Operat  | Operating free-air temperature, TA                            |     |         | 70    | 0    |         | 70   | °C     |

↑↓ The arrow indicates the transition of the write input used for references: ↑ for the low to high transistion, ↓ for the high to low transistion.

NOTE 1: Voltage values are with respect to network ground terminal.

## TYPES SN74S201, SN74S301 256-BIT HIGH-PERFORMANCE RANDOM-ACCESS MEMORIES

#### electrical characteristics over recommended operating free-air temperature range (otherwise noted)

|        |                                | T                        |  | <u> </u> |       |      |     |       |      | [    |
|--------|--------------------------------|--------------------------|--|----------|-------|------|-----|-------|------|------|
|        | PARAMETER                      | TES                      | T CONDITIONS <sup>†</sup>                    |          | 'S201 |      |     | 'S301 |      | UNIT |
|        |                                |                          |  | MIN      | түр   | MAX  | MIN | ТҮР   | MAX  |      |
| VIH    | High-level input voltage       |                          |  | 2        |       |      | 2   |       |      | V    |
| VIL    | Low-level input voltage        | 1                        |  |          |       | 0.8  |     |       | 0.8  | V    |
| VIK    | Input clamp voltage            | V <sub>CC</sub> = MIN,   | Ij = -18mA                                   |          |       | 1.2  |     |       | -1.2 | V    |
|        | High-level                     | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V,                       | 24       |       |      |     |       |      |      |
| ⊻он    | output voltage                 | V <sub>1L</sub> = 08 V,  | I <sub>OH</sub> = MAX                        | 2.4      |       |      |     |       |      | v    |
| N.     | Low-level                      | V <sub>CC</sub> = MIN,   | V <sub>1H</sub> = 2 V,                       |          |       | 0.45 |     |       | 0.45 |      |
| VOL    | output voltage                 |                          |  | 1        |       | 0.45 |     |       | 0.45 | v    |
|        | High-level                     | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V, V <sub>O</sub> =2.4 V |          |       |      |     |       | 40   |      |
| юн     | output current                 | V <sub>IL</sub> = 0.8 V  | V <sub>O</sub> =5.5 V                        |          |       |      |     |       | 100  | μΑ   |
|        | Off-state output current,      | V <sub>CC</sub> = MAX,   | V <sub>IH</sub> = 2 V,                       |          |       | 40   |     |       |      |      |
| I 'OZH | high-level voltage applied     | VIL = 0.8 V,             | V <sub>OH</sub> = 2.4 V                      |          |       | 40   |     |       |      | μΑ   |
|        | Off-state output current,      | V <sub>CC</sub> = MAX,   | V <sub>1H</sub> = 2 V,                       |          |       | 40   |     |       |      |      |
| 'OZL   | low-level voltage applied      | V <sub>IL</sub> = 0.8 V, | V <sub>OL</sub> = 0.5 V                      |          |       | -40  |     |       |      | μΑ   |
| 1.     | Input current at maximum       |                          |  |          |       |      |     |       | 1    |      |
| 1      | input voltage                  | VCC - WAA,               | v   - 5.5 v                                  |          |       |      |     |       | '    | mA   |
| 111    | High-level input current       | V <sub>CC</sub> = MAX,   | V <sub>1</sub> = 2.7 V                       |          |       | 25   |     |       | 25   | μA   |
| μL     | Low-level input current        | V <sub>CC</sub> = MAX,   | V1 = 0.5 V                                   |          |       | 250  |     |       | -250 | μA   |
| los    | Short-circuit output current § | V <sub>CC</sub> = MAX    |  | -30      |       | -100 |     |       |      | mA   |
| 1cc    | Supply current                 | V <sub>CC</sub> = MAX,   | See Note 2                                   |          | 100   | 140  |     | 100   | 140  | mA   |

<sup>†</sup>For conditions shown as MIN or MAX use the appropriate value specified under recommended operation conditions.

<sup>‡</sup>These typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

 $\ensuremath{\$}$  Duration of the short circuit should not exceed one second.

NOTE: 2. I CC is measured with all chip-select inputs grounded, all other inputs at 4.5 V, and the output open

# 'S201 switching characteristics over recommended operating ranges of ${\rm T}_A$ and ${\rm V}_{CC}$ (unless otherwise noted)

|                  | PARAMETER                              |                      | TEST CONDITIONS                         | MIN | TYP‡ | MAX | UNIT |
|------------------|--|----------------------|---|-----|------|-----|------|
| ta(ad)           | Access time from add                   | ress                 | C <sub>L</sub> = 30 pF,                 |     | 42   | 65  | ns   |
| ta(S)            | Access time from chip                  | select (select time) | R <sub>L</sub> = 300 Ω,                 |     | 13   | 30  | ns   |
| <sup>t</sup> SR  | Sense recovery time                    | <u> </u>             | See Note 3                              |     | 20   | 40  | ns   |
| <sup>t</sup> PXZ | Disable time from<br>high or low level | From S<br>From W     | CL = 5 pF,<br>RL = 300 Ω,<br>See Note 3 |     | 9    | 20  | ns   |

# 'S301 switching characteristics over recommended operating ranges of ${\sf T}_{\sf A}$ and ${\sf V}_{\sf CC}$ (unless otherwise noted)

|                 | PARAMETER   |                         | TEST CONDITIONS          | MIN | TYP‡           | MAX      | UNIT |
|-----------------|---|-------------------------|--------------------------|-----|----------------|----------|------|
| ta(ad)          | Access time from address  | ccess time from address |                          |     | 42             | 65       | ns   |
| ta(S)           | Access time from chip enab  | le (enable time)        | R <sub>L1</sub> = 300 Ω, |     | 13             | 30       | ns   |
| <sup>t</sup> SR | Sense recovery time   |                         | R <sub>L2</sub> = 600 Ω  |     | 20             | 40       | ns   |
| t₽LH            | Propagation delay time,<br>low-to-high-level output<br>(disable time) | From S<br>From W        | See Note 3               |     | <u>8</u><br>15 | 20<br>35 | ns   |

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

NOTE: 3. Load circuit and voltage waveforms are shown on page 1-14.



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## SCHOTTKY† TTL MEMORY

## TYPE SN74S225 16 x 5 ASYNCHRONOUS FIRST-IN/FIRST-OUT MEMORY

SEPTEMBER 1976-REVISED JUNE 1979

- Independent Synchronous Inputs and Outputs
- Organized as 16-Words of 5 Bits
- DC to 10-MHz Data Rate
- 3-State Data Outputs
- 20-Pin, 300-mil, High-Density Package



Pin assignments are same for all packages

#### description

This 80-bit active-element memory is a monolithic Schottky-clamped transistor-transistor logic (STTL) array organized as 16 words of five-bits each. A memory system using the SN74S225 can easily be expanded in multiples of 16 words or of 5 bits as shown in Figure 2. The threestate outputs controlled by a single enable, OE, make bus connection and multiplexing easy.

#### operation

A FIFO is a memory storage device which allows data to be written into and/or read from its array at independent data rates. The 'S225 is a FIFO which will process data at any desired clock rate from DC to 10 MHz. The data is processed in a parallel format, word by word.

Reading or writing is done independently utilizing separate synchronous data clocks. Data may be written into the array on the low-to-high transition of either load clock input. Data may be read out of the array on the low-to-high transition of the unload clock input (normally high). When writing data into the FIFO one of the load clock inputs must be held high while the other strobes in the data. This arrangement allows either load clock to function as an inhibit for the other.

Status of the 'S225 is provided by three outputs. Input ready monitors the status of the last word location and signifies when the memory is full. This output is high whenever the memory is available to accept any data. The unload clock output also monitors the last word location. This output generates a low-logic-level pulse (synchronized to the internal clock pulse) when the location is vacant. The third status output, output ready, is high when the first word location contains valid data and unload clock input is high. When unload clock input is low, output ready will be low. The first word location is defined as the location from which data is provided to the outputs.

The data outputs are noninverted with respect to the data inputs and are three-state with a common control input, output enable. When output enable is low, the data outputs are enabled to function as totem-pole outputs. A high-logic-level forces each data output to a high-impedance state while all other inputs and outputs remain active.

The clear input invalidates all data stored in the memory array by clearing the control logic and setting output ready to a low-logic-level on the high-to-low transition of a low-active pulse. The data outputs do not change as a result of the clear input; however, the output ready at a low-logic-level signifies invalid data.

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Number 3,463,975.

<sup>†</sup>Integrated Schottky-Barrier diodeclamped transistor is patented by 5-37

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## TYPE SN74S225 16 x 5 ASYNCHRONOUS FIRST-IN/FIRST-OUT MEMORY

#### **FUNCTION TABLES**

|         | Table 1 – I | nput Functions     |   |
|---------|-------------|--------------------|---|
| Input   | Pin         | Description        |   |
| СК А    | 1           | Load Clock A       |   |
| DI1-DI5 | 4-8         | Data Inputs        |   |
| ŌĒ      | 9           | Output Enable      |   |
| CK IN   | 16          | Unload Clock Input |   |
| ĊĽŔ     | 18          | Clear              |   |
| СК В    | 19          | Load Clock B       |   |
| GND     | 10          | Ground pin         |   |
| Vcc     | 20          | Supply Voltage     |   |
|         |             |                    | _ |

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#### Table 2 – Output Functions

| Output      | Pin     | Description         |
|-------------|---------|---------------------|
| IR          | 2       | Input Ready         |
| CK OUT      | 3       | Unload Clock Output |
| DO 5 - DO 1 | 11 - 15 | Data Outputs        |
| OR          | 17      | Output Ready        |

#### schematics of inputs and outputs



## TYPE SN74S225 16 x 5 ASYNCHRONOUS FIRST-IN/FIRST-OUT MEMORY

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply Voltage, V <sub>CC</sub> (see Note 1) |    |   |   |   |  |   |   |   |  |   |   |  |   |   |   |         |      |      | 7V   |
|--|----|---|---|---|--|---|---|---|--|---|---|--|---|---|---|---------|------|------|------|
| Input Voltage                                |    |   |   |   |  | - |   |   |  | - |   |  | - |   |   |         |      | . !  | 5.5V |
| Off-State Output Voltage                     |    |   |   |   |  |   |   |   |  |   |   |  |   |   |   | •       |      | . !  | 5.5V |
| Operating Free-Air Temperature Ran           | ge |   |   |   |  |   |   |   |  |   |   |  |   |   |   | (       | )°C  | to 7 | 70°C |
| Storage Temperature Range                    | •  | • | · | • |  |   | · | · |  | • | · |  |   | • | • | <br>65° | C to | 5 15 | 50°C |
|  |    |   |   |   |  |   |   |   |  |   |   |  |   |   |   |         |      |      |      |

NOTE 1: All voltage values are with respect to network ground terminal.

#### recommended operating conditions

|  |  | MIN  | NOM | MAX  | UNIT |
|--|--|------|-----|------|------|
| Supply Voltage, V <sub>CC</sub>          |  | 4.75 | 5   | 5.25 | V    |
|  | All Outputs Except Data                              |      |     | -3.2 |      |
| High-level output current, IOH           | Data Outputs   |      |     | -6.5 |      |
|  | All Outputs Except Data                              |      |     | 8    |      |
| Low-level output current, IOL            | Data Outputs   |      |     | 16   |      |
|  | Load Clock A or B, t <sub>w</sub> (high)             | 25   |     |      |      |
| Pulse Width                              | Unload Clock Input, tw (low)                         | 7    |     |      | ns   |
|  | Clear, t <sub>w</sub> (low)                          | 40   |     |      | I    |
| Satur Time                               | Data to Load Clock, t <sub>su</sub> (Dli) See Note 2 | -201 |     |      |      |
|  | Clear Release to Load Clock, t <sub>su</sub>         | 25†  |     |      |      |
| Hold Time, Data from Load Clock, th(Dli) |  | 701  |     |      | ns   |
| Operating free-air temperature, TA       |  | 0    |     | 70   | °C   |

NOTE 2: Data must be setup within 15 ns after the load clock positive transition.

 $\ensuremath{\dagger}$  = The arrow indicates that the low-to-high transition of the load clock is used for reference.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|            | PARAMETER  | ·····                                | TEST CON  | IDITIONS <sup>†</sup>                            | MIN | TYP‡ | MAX      | UNIT |
|------------|--|--------------------------------------|---|--|-----|------|----------|------|
| ⊻ін        | High-level input voltage                             |                                      |   |  | 2   |      |          | V    |
| VIL        | Low-level input voltage                              |                                      |   |  |     |      | 0.8      | V    |
| VIK        | VIK Input clamp voltage                              |                                      |   | l <sub>l</sub> = -18 mA                          |     |      | -1.2     | V    |
| vон        | High-level output voltage                            |                                      | V <sub>CC</sub> = MIN ,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>I <sub>OH</sub> = MAX  | 2.4 | 2.9  |          | v    |
| VOL        | Low-level output voltage                             |                                      | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V,  | V <sub>IH</sub> = 2 V,<br>I <sub>OL</sub> = MAX  |     | 0.35 | 0.50     | v    |
| югн        | Off-state output current, high-level voltage applied |                                      | V <sub>CC</sub> = MAX,<br>V <sub>IL</sub> = 0.8 V,  | V <sub>IH</sub> = 2 V,<br>V <sub>O</sub> = 2.4 V |     |      | 50       | μA   |
| IOZL       | Off-state output current, low-level voltage applied  |                                      | V <sub>CC</sub> = MAX,<br>V <sub>IL</sub> = 0.8 V,  | V <sub>IH</sub> = 2 V,<br>V <sub>O</sub> = 0.5 V |     |      | -50      | μA   |
| 4          | Input current at maximum input voltage               |                                      | $V_{CC} = MAX,$                                     | VI = 5.5 V                                       |     |      | 1        | mA   |
| Чн         | High-level input current                             | Data In<br>All Inputs Except Data In | V <sub>CC</sub> ≈ MAX,                              | V <sub>I</sub> = 2.7 V                           |     |      | 40<br>25 | μА   |
|            |  | Data In                              |   | N - 0 5 M  |     |      | -1       | mA   |
| <u>''L</u> |  | All Inputs Except Data In            | VCC = MAX,  | vj - 0.5 v                                       |     |      | -250     | μA   |
| los        | IOS Short-circuit output current §                   |                                      |   |  | -30 |      | -100     | mA   |
| 1cc        | Supply Current                                       |                                      | V <sub>CC</sub> = MAX,                              | See Note 3                                       |     | 80   | 120      | mA   |

<sup>†</sup>For conditions shown as MIN or MAX use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at  $V_{CC}$  –5 V,  $T_A$  = 25°C.

§Duration of the short circuit should not exceed one second.

NOTE 3: ICC is measured with all inputs grounded and the output open.

| PARAMETERS       | FROM               | то     | TEST<br>CONDITIONS         | MIN | түр‡ | MAX | υνιτ |
|------------------|--------------------|--------|----------------------------|-----|------|-----|------|
| f <sub>max</sub> | CK A               |        | Ct. = 20 pE                | 10  | 20   |     | MHz  |
| f <sub>max</sub> | СК В               |        | BL = 300 C                 | 10  | 20   |     | MHz  |
| f <sub>max</sub> | CK IN              |        |                            | 10  | 20   |     | MHz  |
| t <sub>w</sub>   | CK OUT             |        |                            | 7   | 14   |     | ns   |
| tPXZ             |                    | DOi    | CL = 5 pF                  |     | 10   | 25  |      |
| <sup>t</sup> PZX | UE                 | DOI    |                            |     | 25   | 40  | ns   |
| tPLH             |                    |        |                            |     | 50   | 75  |      |
| tPHL             |                    | DOI    |                            |     | 50   | 75  | ns   |
| <sup>t</sup> PLH | CK A<br>or<br>CK B | OR     |                            |     | 190  | 300 | ns   |
| tPLH             |                    | 0.0    | ]                          | _   | 40   | 60  |      |
| <b>tPHL</b>      |                    |        |                            |     | 30   | 45  | ns   |
| tPHL             | CLR                | OR     | ]                          |     | 35   | 60  | ns   |
| <sup>t</sup> ₽HL | CK A<br>or<br>CK B | ск оџт | CL = 30 pF,<br>RL = 300 Ω, |     | 25   | 50  | ns   |
| <sup>t</sup> PHL | CK IN              | CK OUT | See Note 4                 |     | 270  | 400 | ns   |
| tpHL             | CK A<br>or<br>CK B | IR     |                            |     | 55   | 75  | ns   |
| <sup>t</sup> PLH | CK IN              | IR     | 1                          |     | 255  | 400 | ns   |
| tPLH             | CLR                | IR     | ]                          |     | 16   | 35  | ns   |
| tPLH             | OR†                | DOi    | ]                          |     | 10   | 20  | ns   |

#### switching characteristics over recommended operating ranges of TA and VCC (unless otherwise noted)

¶ fmax ≡ maximum clock frequency.

t<sub>w</sub>≡pulse width (output)

†↓ == The arrow Indicates that the low-to-high (†) or high-to-low (↓) transition of the output ready (OR) output is used for reference.

 $t_{PLH} \equiv propagation delay time, low-to-high level output.$ 

 $t_{PHL} \equiv propagation delay time, high-to-low-level output.$ 

 $\ddagger$  All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

NOTE 4: Load circuit and voltage waveforms are shown on page 1-14.

TYPE SN74S225 16 x 5 ASYNCHRONOUS FIRST-IN/FIRST-OUT MEMORY



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## TYPE SN74S225 16 x 5 ASYNCHRONOUS FIRST-IN/FIRST-OUT MEMORY



#### **TYPICAL WAVEFORMS FOR A 16-WORD FIFO**





FIGURE 2 - EXPANDING THE 'S225 FIFO (48 WORDS OF 10 BITS SHOWN)

# Support Functions

#### INDEX TO SUPPORT FUNCTIONS

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These high-performance Schottky<sup>†</sup> TTL quadruple bus transceivers employ dual-rank bidirectional four-bit transparent latches and feature three-state outputs designed specifically for driving highly-capacitive or relatively low-impedance loads. The bus-management functions implemented and the high-impedance controls offered provide the designer with a controller/transceiver that interfaces and drives system bus-organized lines directly. They are particularly attractive for implementing:

Bidirectional bus transceivers Data-bus controllers

The bus-management functions, under control of the function-select (S1, S2) inputs, provide complete data integrity for each of the four modes described in the function table. Directional transparency provides for routing data from or to either bus, and the dual store and dual readout capabilities can be used to perform the exchange of data between the two bus lines in the equivalent of a single clock pulse. Storage of data is accomplished by selecting the latch function, setting up the data, and taking the appropriate strobe input low. As long as the strobe is held high, the data is latched for the selected function. Further control is offered through the availability of independent output controls that can be used to enable or disable the outputs as shown in the output-control function table, regardless of the latch function in process. Store operations can be performed with the outputs disabled to a high impedance (Hi-Z). In the Hi-Z state the inputs/outputs neither load nor drive the bus lines significantly. The p-n-p inputs feature typically 400 millivolts of hysteresis to enhance noise rejection.

#### **BUS-MANAGEMENT FUNCTION TABLE**

| MC<br>CONT     | DDE<br>FROLS | STRO    | DBES    | A-T<br>LAT | о-в<br>Ches | B-T         | O-A<br>CHES | OPERATION            |
|----------------|--------------|---------|---------|------------|-------------|-------------|-------------|----------------------|
| S2             | S1           | GAB     | GBA     | 1          | 2           | 1           | · 2         |                      |
|                |              |         | L       | Latek      |             | Trans       | Trans       | Pass B to A          |
| L              |              | _ ^     | н       | Laten      | Trans       | Latch       | Trans       | Read out stored data |
| L              | н            | X       | Χ.      | Latch      | Trans       | Latch Trans |             | Read out stored data |
|                |              | L       | ~       | Trans      | Trans       | Latab       | Trans       | Pass A to B          |
|                | L.           | н       | ^       | Latch      | Trans       | Laten       | Trans       | Read out stored data |
| <b>_</b>       |              | L       | L       | Trans      | Latch       | Trans       | Latch       | Read in both buses   |
|                | -            | н       | н       | Latch      | Latch       | Latch       | Latch       | Store bus data       |
| H = high level |              | L = lov | w level | X = irre   | levant      | Latch =     | latched     | Trans = transparent  |



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<sup>†</sup>Integrated Schottky-Barrier diodeclamped transistor is patented by Texas Instruments. U.S. Patent Number 3,463,975.

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## TYPES SN54S226, SN74S226 4-BIT PARALLEL LATCHED BUS TRANSCEIVERS

logic symbol<sup>†</sup>



<sup>†</sup>This symbol is in accordance with IEEE Std 91/ANSI Y32.14 and current discussions in IEC and IEEE. functional block diagram (positive logic)



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1) |               |         | <br> | 7V             |
|--|---------------|---------|------|----------------|
| Input voltage                                |               |         | <br> | 5.5 V          |
| Off-state output voltage                     |               |         | <br> | 5.5 V          |
| Operating free-air temperature range:        | SN54S226 (see | Note 2) | <br> | –55°C to 125°C |
|  | SN74S226      |         | <br> | . 0°C to 70°C  |
| Storage temperature range                    |               |         | <br> | –65°C to 150°C |

NOTES: 1. Voltage values are with respect to network ground terminal.

2. An SN54S226 in the J package operating at temperatures above 113° C requires a heat-sink that provides a thermal resistance from case to free air,  $R_{\theta CA}$ , of not more than 48° C/W.

## TYPES SN54S226, SN74S226 4-BIT PARALLEL LATCHED BUS TRANSCEIVERS

#### recommended operating conditions

|   | · · · · · · · · · · · | 5   | SN54S22 | 26   | s          | N74S22 | 26    |      |
|---|-----------------------|-----|---------|------|------------|--------|-------|------|
|   |                       | MIN | NOM     | MAX  | MIN        | NOM    | MAX   | UNTI |
| Supply voltage, V <sub>CC</sub>                             |                       | 4.5 | 5       | 5.5  | 4.75       | 5      | 5.25  | Ý    |
| High-level output voltage, V <sub>OH</sub>                  |                       |     |         | 5.5  |            |        | 5.5   | V    |
| High-level output current, IOH                              |                       |     |         | -6.5 |            |        | -10.3 | mA   |
| Width of strobe pulse                                       |                       | 30  |         |      | 20         |        |       | ns   |
| Satur time t  | To Strobe             | 301 |         |      | 201        |        |       |      |
|   | To Select             | 30  |         |      | 20         |        |       | 115  |
| Hold time to  | To Strobe             | 10  |         |      | <b>0</b> † |        |       |      |
|   | To Select             | 0   |         |      | 0          |        |       | 115  |
| Operating free-air temperature, T <sub>A</sub> (see Note 2) |                       | -55 |         | 125  | 0          |        | 70    | °C   |

† The arrow indicates that the low-to-high transition of the strobe input is used for reference.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                                   | PARAMETER                              |                       | TEST CONDITIONS <sup>†</sup>                     | MIN | TYP‡ | MAX   | UNIT         |
|-----------------------------------|--|-----------------------|--|-----|------|-------|--------------|
| VIH                               | High-level input voltage               |                       |  | 2   |      |       | V            |
| VIL                               | Low-level input voltage                |                       |  |     |      | 0.8   | V            |
| VIK                               | Input clamp voltage                    |                       | V <sub>CC</sub> = MIN, I <sub>I</sub> = -18 mA   |     |      | -1.2  | V            |
| Val                               | High level output voltage              | SN54S226              | $V_{CC} = MIN, V_{IH} = 2V,$                     | 2.4 | 3.3  |       | V            |
| ₩ОН                               | Thigh-level output voltage             | SN74S226              | V <sub>IL</sub> = 0.8 V, I <sub>OH</sub> = MAX   | 2.4 | 2.9  |       | ľ            |
| Val                               |  |                       | $V_{CC} = MIN, V_{IH} = 2 V,$                    |     |      | 0.5   |              |
| I VOL                             | Low-level output voltage               |                       | V <sub>IL</sub> = 0.8 V, I <sub>OL</sub> = 15 mA |     |      | 0.5   | ľ            |
| 10711                             | Off-state output current,              |                       | V <sub>CC</sub> = MAX, V <sub>IH</sub> = 2 V,    | 1   |      | 100   |              |
| 102н                              | high-level voltage applied             |                       | V <sub>O</sub> = 2.4 V                           |     |      | 100   | / <u>*</u> ^ |
| 1071                              | Off-state output current,              |                       | V <sub>CC</sub> = MAX, V <sub>IH</sub> = 2 V,    |     |      | _100  |              |
| 102L                              | low-level voltage applied              |                       | V <sub>O</sub> = 0.5 V                           |     |      | -100  | <i>"</i> ^   |
| 4                                 | Input current at maximum input voltage |                       | V <sub>CC</sub> = MAX, V <sub>1</sub> = 5.5 V    |     |      | 1     | mA           |
| ЧΗ                                | High-level input current               |                       | V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V    |     |      | 100   | μA           |
|                                   | Low-level input current                | OCAB, OCBA            |  |     |      | -0.38 |              |
| 11                                |  | All other inputs      |  |     |      | 1.6   | mA           |
| IOS Short-circuit output current§ |  | V <sub>CC</sub> = MAX | -50  |     | -180 | mA    |              |
| ICC                               | Supply current                         |                       | V <sub>CC</sub> = MAX, See Note 3                |     | 125  | 185   | mA           |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. <sup>‡</sup>All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

\$Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.

NOTES: 2. An SN54S226 in the J package operating at temperatures above 113°C requires a heat-sink that provides a thermal resistance from case to free air, R<sub>ØCA</sub>, of not more than 48°C/W.

3.  $I_{CC}$  is measured with all inputs (and outputs) grounded.

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## TYPES SN54S226, SN74S226 4-BIT PARALLEL LATCHED BUS TRANSCEIVERS

#### switching characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = $25^{\circ}$ C

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT) | TEST CO     | NDITIONS    | MIN | түр | MAX | UNIT |
|------------------|-----------------|----------------|-------------|-------------|-----|-----|-----|------|
| <sup>t</sup> PLH | A or P          | P or A         |             |             |     | 20  | 30  |      |
| <sup>t</sup> PHL | AOIB            | BORA           |             |             |     | 15  | 30  | ns   |
| <sup>t</sup> PLH | Colect          | A              |             |             |     | 25  | 37  |      |
| <sup>t</sup> PHL | Select          |                | CL = 50 pF, | RL=280Ω,    |     | 19  | 30  | ns   |
| <sup>t</sup> PLH | Strobe GBA      | A              | See Note 4  |             |     | 25  | 37  |      |
| <sup>t</sup> PHL | or GAB          | Aorb           |             |             |     | 19  | 30  | ns   |
| <sup>t</sup> PZH | Output Control  | A              | 1           |             |     | 12  | 20  | 1    |
| tPZL             | OCBA or OCAB    | A or B         |             |             |     | 12  | 20  | ns   |
| <sup>t</sup> PHZ | Output Control  |                | СL = 5 pF,  | RL = 280 Ω, |     | 10  | 15  |      |
| tpLZ             | OCBA or OCAB    | A or B         | See Note 4  | _           |     | 10  | 15  | ns   |

 $t_{PLH} \equiv propagation delay time, low-to-high-level output$ 

 $t_{PHL} \equiv propagation delay time, low-to-high-level output$ 

 $t_{ZH} \equiv$  output enable time to high level

 $t_{ZL} \equiv output enable time to low level$ 

 $t_{\mbox{HZ}}\equiv \mbox{output}$  disable time from high level

 $t_{LZ} \equiv$  output disable time from low level

NOTE 4: Load circuits and voltage waveforms are shown on page 1-14.

#### applications

The following examples demonstrate four fundamental bus-management functions that can be performed with the 'S226. Exchange of data on the two bus lines can be accomplished with a single high-to-low transition at S2 when S1 is high.



TYPES SN54LS240,SN54LS241,SN54LS244,SN54S240,SN54S241, SN74LS240,SN74LS241,SN74LS244,SN74S240,SN74S241 OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

|         | Typical<br>IOL<br>(Sink | Typical<br>IOH<br>(Source | Typical<br>Dela | Propagation<br>ay Times | Typical<br>Enable/<br>Disable | Typi<br>Dis<br>(En | cal Power<br>sipation<br>abled) |
|---------|-------------------------|---------------------------|-----------------|-------------------------|-------------------------------|--------------------|---------------------------------|
|         | Current)                | Current)                  | Inverting       | Noninverting            | Times                         | Inverting          | Noninverting                    |
| SN54LS' | 12 mA                   | —12 mA                    | 10.5 ns         | 12 ns                   | 18 ns                         | 130 mW             | 135 mW                          |
| SN74LS' | 24 mA                   | —15 mA                    | 10.5 ns         | 12 ns                   | 18 ns                         | 130 mW             | 135 mW                          |
| SN54S'  | 48 mA                   | —12 mA                    | 4.5 ns          | 6 ns                    | 9 ns                          | 450 mW             | 538 mW                          |
| SN74S'  | 64 m A                  | —15 mA                    | 4.5 ns          | 6 ns                    | 9 ns                          | 450 mW             | 538 mW                          |

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- P-N-P Inputs Reduce D-C Loading
- Hysteresis at Inputs Improves
  Noise Margins

#### description

These octal buffers and line drivers are designed specifically to improve both the performance and density of three-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. The designer has a choice of selected combinations of inverting and noninverting outputs, symmetrical  $\overline{G}$  (active-low output control) inputs, and complementary G and  $\overline{G}$  inputs. These devices feature high fan-out, improved fan-in, and 400-mV noise-margin. The SN74LS' and SN74S' can be used to drive terminated lines down to 133 ohms.

#### schematics of inputs and outputs



SN54LS240, SN54S240 ... J SN74LS240, SN74S240 ... J OR N



SN54LS241, SN54S241 ... J SN74LS241, SN74S241 ... J OR N (TOP VIEW)





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### TYPES SN54LS240,SN54LS241,SN54LS244, SN74LS240,SN74LS241,SN74LS244 BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

#### absolute maximum ratings

Same as SN54LS245 and SN74LS245 on page 6-13.

#### recommended operating conditions

|  | SN54LS' |     |     |      |     |      |      |
|--|---------|-----|-----|------|-----|------|------|
| PARAMETER                                    | MIN     | NOM | MAX | MIN  | NOM | MAX  | UNIT |
| Supply voltage, V <sub>CC</sub> (see Note 1) | 4.5     | 5   | 5.5 | 4.75 | 5   | 5.25 | v    |
| High-level output current, IOH               |         |     | -12 |      |     | -15  | mA   |
| Low-level output current, IOL                |         |     | 12  |      |     | 24   | mA   |
| Operating free-air temperature, TA           | -55     |     | 125 | 0    |     | 70   | °C   |

NOTE 1: Voltage values are with respect to network ground terminal.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|          | BADAMETED  |              | TEST CONF   | TIONET  |     | SN54LS' SN74LS' |      |     | •    |                                    |                                      |
|----------|--|--------------|---|---|-----|-----------------|------|-----|------|------------------------------------|--------------------------------------|
|          | CARAMETER  |              | TEST COND   | TIONS   | MIN | TYP‡            | MAX  | MIN | TYP‡ | MAX                                |                                      |
| VIH      | High-level input voltage                               |              |   |   | 2   |                 |      | 2   |      |                                    | V                                    |
| VIL      | Low-level input voltage                                |              |   |   |     |                 | 0.7  |     |      | 0.8                                | V                                    |
| VIK      | Input clamp voltage                                    |              | $V_{CC} = MIN,$   | l <sub>l</sub> = –18 mA                             |     |                 | -1.5 |     |      | -1.5                               | V                                    |
|          | Hysteresis ( $V_{T+} - V_{T-}$ )                       |              | V <sub>CC</sub> = MIN   |   | 0.2 | 0.4             |      | 0.2 | 0.4  |                                    | V                                    |
| Veu      | High level output voltage                              |              | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = V <sub>IL</sub> max | V <sub>IH</sub> = 2 V,<br>, I <sub>OH</sub> = -3 mA | 2.4 | 3.4             |      | 2.4 | 3.4  |                                    |                                      |
| •он      | VOH Thightever output voltage                          |              | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.5 V,              | V <sub>IH</sub> = 2 V,<br>I <sub>OH</sub> = MAX     | 2   |                 |      | 2   |      |                                    | 1                                    |
| Vol      | VOL Low-level output voltage                           |              | $V_{CC} = MIN,$   | I <sub>OL</sub> = 12 mA                             |     |                 | 0.4  |     |      | 0.4                                |                                      |
| .01      |  |              | VIL = VILmax  | I <sub>OL</sub> = 24 mA                             |     |                 |      |     |      | 0.5                                | 1                                    |
| Годн     | Off-state output current,                              |              | Vcc = MAX.  | Vo = 2.7 V  |     |                 | 20   |     |      | 0.4<br>0.5<br>20<br>-20 μ <i>F</i> |                                      |
|          | high-level voltage applied                             |              | VIH = 2 V.  |   |     |                 |      |     |      |                                    | μA                                   |
| IOZL     | Off-state output current,<br>low-level voltage applied |              | VIL = VILmax  | V <sub>O</sub> = 0.4 V                              |     |                 | -20  |     |      | -20                                | , <b>"</b> , ,                       |
| <u> </u> | Input current at maximur                               | n            |   | L   |     |                 |      |     |      |                                    |                                      |
| 1 11     | input voltage  |              | VCC = MAX,  | vi = / v  |     |                 | 0.1  |     |      | 0.1                                | mA                                   |
| Чн       | High-level input current, a                            | any input    | V <sub>CC</sub> = MAX,  | V <sub>I</sub> = 2.7 V                              |     |                 | 20   |     |      | 20                                 | μA                                   |
| 11       | Low-level input current                                |              | V <sub>CC</sub> = MAX,  | VII = 0.4 V   |     |                 | -0.2 |     |      | -0.2                               | mA                                   |
| los      | IOS Short-circuit output current                       |              | V <sub>CC</sub> = MAX   |   | -40 |                 | -225 | -40 |      | -225                               | mA                                   |
|          |  | Outputs high | Ver - MAX   | All   |     | 17              | 27   |     | 17   | 27                                 |                                      |
|          |  | Outputs low  | VCC - MAA   | 'LS240  |     | 26              | 44   |     | 26   | 44                                 | ν<br>ν<br>μΑ<br>μΑ<br>ΜΑ<br>ΜΑ<br>ΜΑ |
| lcc      | Supply current   | Outputs low  | Outputs open  | 'LS241, 'LS244                                      |     | 27              | 46   |     | 27   | 46                                 |                                      |
|          |  | All outputs  | Outputs open /LS  | 'LS240  |     | 29              | 50   |     | 29   | 50                                 | ]                                    |
|          | di   | disabled     |   | 'LS241, 'LS244                                      |     | 32              | 54   |     | 32   | 54                                 |                                      |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

•Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

#### switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

|                  | PARAMETER  |                |             |             | 'LS240 | )  | 'LS |     |     |      |
|------------------|--|----------------|-------------|-------------|--------|----|-----|-----|-----|------|
|                  |  | TESTCON        | DITIONS     | MIN TYP MAX |        |    | MIN | TYP | MAX | UNIT |
| tPLH             | Propagation delay time,<br>low-to-high-level output        |                |             |             | 9      | 14 |     | 12  | 18  | ns   |
| <sup>t</sup> PHL | Propagation delay time,<br>high-to-low-level output See No |                | RL=667Ω,    |             | 12     | 18 |     | 12  | 18  | ns   |
| <sup>t</sup> PZL | Output enable time to low level                            |                |             |             | 20     | 30 |     | 20  | 30  | ns   |
| <sup>t</sup> PZH | Output enable time to high level                           | 1              |             |             | 15     | 23 |     | 15  | 23  | ns   |
| <sup>t</sup> PLZ | Output disable time from low level                         | $C_L = 5 pF$ , | RL = 667 Ω, |             | 15     | 25 |     | 15  | 25  | ns   |
| <sup>t</sup> PHZ | Output disable time from high level                        | See Note 2     |             |             | 10     | 18 |     | 10  | 18  | ns   |

NOTE 2: Load circuit and voltage waveforms are shown on page 1-15.

## TYPES SN54S240, SN54S241, SN74S240, SN74S241 **BUFFERS/LINE DRIVERS/LINE RECEIVERS WITH 3-STATE OUTPUTS**

**REVISED AUGUST 1979** 

#### absolute maximum ratings

Same as the SN54S740 and SN74S740 maximum ratings on page 6-106.

#### recommended operating conditions

| PARAMETER   | L   | SN54S' SN74S' |     |      |     |      |    |
|---|-----|---------------|-----|------|-----|------|----|
|   | MIN | NOM           | MAX | MIN  | NOM | MAX  |    |
| Supply voltage, V <sub>CC</sub> (see Note 1)                        | 4.5 | 5             | 5.5 | 4.75 | 5   | 5.25 | v  |
| High-level output current, IOH                                      |     |               | -12 |      |     | -15  | mA |
| Low-level output current, IOL                                       |     |               | 48  |      |     | 64   | mA |
| External resistance between any input or V <sub>CC</sub> and ground |     |               | 40  |      |     | 40   | kΩ |
| Operating free-air temperature, TA (see Note 3)                     | -55 |               | 125 | 0    |     | 70   | °C |

NOTES: 1. Voltage values are with respect to network ground terminal,

3. An SN54S241J operating at free-air temperature above 116°C requires a heat sink that provides a thermal resistance from case to free-air, R<sub>ØCA</sub>, of not more than 40°C/W.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                 |                             |              |                          |                         | r   | <b>'S240</b>     |      |     | 'S241 |      |  |
|-----------------|-----------------------------|--------------|--------------------------|-------------------------|-----|------------------|------|-----|-------|------|--|
|                 | PARAMETER                   |              | TESTCOM                  | DITIONS                 | MIN | TYP <sup>‡</sup> | MAX  | MIN | TYP‡  | MAX  | UNIT   |
| VIH             | High-level input voltage    |              |                          |                         | 2   |                  |      | 2   |       |      | v  |
| VIL             | Low-level input voltage     |              |                          |                         |     |                  | 0.8  |     |       | 0.8  | V  |
| VIK             | Input clamp voltage         |              | V <sub>CC</sub> = MIN,   | lı = -18 mA             |     |                  | -1.2 |     |       | -1.2 | v  |
|                 | Hysteresis (VT+ VT_)        |              | V <sub>CC</sub> = MIN    |                         | 0.2 | 0.4              |      | 0.2 | 0.4   |      | V P  |
|                 |                             | CN1746/      | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V,  |     |                  |      | 0.7 |       |      |  |
|                 |                             | 511745       | V <sub>IL</sub> = 0.8 V, | I <sub>OH</sub> = -1 mA | 2.1 |                  |      | 2.7 |       |      |  |
|                 |                             | SN54S' and   | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V,  |     | 2.4              |      | -   | 2.4   |      |  |
| ⊻он             | High-level output voltage   | SN74S'       | V <sub>IL</sub> = 0.8 V, | I <sub>OH</sub> = -3 mA | 2.4 | 3.4              |      | 2.4 | 3.4   |      | ľ  |
|                 |                             | SN54S' and   | V <sub>CC</sub> = MIN,   | VIH.= 2 V,              |     |                  |      |     |       |      | ]  |
|                 |                             | SN74S'       | $V_{1L} = 0.5 V$ ,       | IOH = MAX               | 2   |                  |      | 2   |       |      |  |
|                 |                             |              | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V,  |     |                  | 0.55 |     |       | 0.55 |  |
| VOL             |                             |              | VIL = 0.8 V,             | IOL = MAX               |     |                  | 0.55 | Ì   |       | 0.55 | ľ  |
| 1               | Off-state output current,   |              | Vee - MAX                | V = = 74 V              |     |                  | 50   |     |       | 50   |  |
| iozh            | high-level voltage applied  |              | V CC - MAA,              | V0-2.4 V                |     |                  | 50   |     |       |      |  |
| 1071            | Off-state output current,   |              | $V_{H} = 2V,$            | Vo - 0 5 V              |     |                  | 50   |     |       | 50   | <u>"</u> ^                                       |
| JOZL            | low-level voltage applied   |              | v1[ - 0.8 v              | v0 - 0.5 v              |     |                  | 50   |     |       | 50   |  |
| <b>.</b>        | Input current at maximum    | <br>ו        | Vee - MAX                |                         |     |                  | 1    | 1   |       | 1    | <b>m</b> A                                       |
| Ч.<br>          | input voltage               |              | VCC - MAA,               | v   - 5.5 v             |     |                  |      |     |       | ·    |  |
| 1 <sub>IH</sub> | High-level input current, a | ny input     | V <sub>CC</sub> = MAX,   | V <sub>I</sub> = 2.7 V  |     |                  | 50   |     |       | 50   | μА   |
| [ i             |                             | Any A        | Vee - MAX                | $V_{1} = 0.5 V_{1}$     |     |                  | -400 |     |       | -400 | μA   |
| 11              |                             | Any G        | VCC - MAX,               | vi = 0.5 v              |     |                  | 2    |     |       | -2   | mA   |
| los             | Short-circuit output curre  | nt∳          | V <sub>CC</sub> = MAX    |                         | -50 |                  | -225 | -50 |       | -225 | mA   |
|                 |                             | Outputs high |                          | SN54S'                  |     | 80               | 123  |     | 95    | 147  |  |
|                 |                             |              |                          | SN74S'                  | L   | 80               | 135  |     | 95    | 160  | 1  |
| 100             | Supply current              | Outputs low  | V <sub>CC</sub> = MAX,   | SN54S'                  |     | 100              | 145  |     | 120   | 170  | ν<br>ν<br>μΑ<br>μΑ<br>μΑ<br>μΑ<br>πΑ<br>πΑ<br>πΑ |
| 100             | Supply current              |              | Outputs open             | SN74S'                  |     | 100              | 150  |     | 120   | 180  |  |
|                 |                             | Outputs      |                          | SN54S'                  |     | 100              | 145  |     | 120   | 170  |  |
| 1               |                             | disabled     |                          | SN74S'                  |     | 100              | 150  |     | 120   | 180  |  |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. <sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ . <sup>•</sup>Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

#### switching characteristics, VCC = 5 V, TA = 25°C

|                  |   | TEST CON                              |                        |             | 'S240 |     |            |    |     |    |  |
|------------------|---|---------------------------------------|------------------------|-------------|-------|-----|------------|----|-----|----|--|
|                  | PARAMETER   | TEST CON                              | DITIONS                | MIN TYP MAX |       | MAX | MIN TYP MA |    | MAX |    |  |
| <sup>t</sup> PLH | Propagation delay time,<br>low-to-high-level output |                                       |                        |             | 4.5   |     |            | 6  | 9   | ns |  |
| <sup>t</sup> PHL | Propagation delay time,<br>high-to-low-level output | С <sub>L</sub> = 50 pF,<br>See Note 4 | $R_L = 90 \Omega$ ,    |             | 4.5   | 7   |            | 6  | 9   | ns |  |
| TPZL             | Output enable time to low level                     | 1                                     |                        |             | 10    | 15  |            | 10 | 15  | ns |  |
| <sup>t</sup> PZH | Output enable time to high level                    | 1                                     |                        |             | 6.5   | 10  |            | 8  | 12  | ns |  |
| TPLZ             | Output disable time from low level                  | $C_L = 5 pF$ ,                        | R <sub>L</sub> = 90 Ω, |             | 10    | 15  |            | 10 | 15  | ns |  |
| <sup>t</sup> PHZ | Output disable time from high level                 | See Note 4                            |                        |             | 6     | 9   |            | 6  | 9   | ns |  |

NO

## TYPES SN54LS240,SN54LS241, SN54LS244,SN54S240,SN54S241,SN74LS240, SN74LS241,SN74LS244,SN74S240,SN74S241 OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS



## TYPES SN54LS242, SN54LS243, SN74LS242, SN74LS243 QUADRUPLE BUS TRANSCEIVERS

- Two-Way Asynchronous Communication Between Data Buses
- P-N-P Inputs Reduce D-C Loading
- Hysteresis (Typically 400 mV) at Inputs Improves Noise Margin

#### description

These four-data-line transceivers are designed for asynchronous two-way communications between data buses. The SN74LS' can be used to drive terminated lines down to 133 ohms.

#### FUNCTION TABLE (EACH TRANSCEIVER)

| CON | ITROL<br>PUTS | 'LS<br>DATA<br>ST | 242<br>A PORT<br>ATUS | 'LS<br>DATA<br>ST. | 243<br>A PORT<br>ATUS |
|-----|---------------|-------------------|-----------------------|--------------------|-----------------------|
| ĞΑΒ | GBA           | A                 | В                     | А                  | В                     |
| н   | н             | ō                 | I                     | 0                  | Ι                     |
| L   | н             | *                 | *                     | *                  | *                     |
| H L |               | ISOL              | ATED                  | ISOL               | ATED                  |
| L   | L             |                   | ō                     | 1                  | 0                     |

 Possibly destructive oscillation may occur if the transceivers are enabled in both directions at once.

 $I = Input, O = Output, \overline{O} = Inverting Output.$ 

#### schematics of inputs and outputs



SN54LS242 . . . J OR W SN74LS242 . . . J OR N (TOP VIEW)

AUGUST 1979







NC-No internal connection

#### absolute maximum ratings

;79

Same as SN54LS245 and SN74LS245 maximum ratings on page 6-13.

#### recommended operating conditions

|  |     | SN54LS' |     |      | SN74LS' |      |    |  |
|--|-----|---------|-----|------|---------|------|----|--|
|  | MIN | NOM     | MAX | MIN  | NOM     | MAX  |    |  |
| Supply voltage, V <sub>CC</sub> (see Note 1)   | 4.5 | 5       | 5.5 | 4.75 | 5       | 5,25 | V  |  |
| High-level output current, IOH                 |     |         | -12 |      |         | -15  | mA |  |
| Low-level output current, IOL                  |     |         | 12  |      |         | 24   | mA |  |
| Operating free-air temperature, T <sub>A</sub> | -55 |         | 125 | 0    |         | 70   | °C |  |

NOTE 1: Voltage values are with respect to network ground terminal.

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## TYPES SN54LS242, SN54LS243, SN74LS242, SN74LS243 QUADRUPLE BUS TRANSCEIVERS

| [                 |   |                 |  | Dizionist  |     | SN54LS | ;<br>; | []  | SN74LS           | ,    |      |
|-------------------|---|-----------------|--|--|-----|--------|--------|-----|------------------|------|------|
|                   | PARAMETER   |                 | TEST CON   | IDITIONS (   | MIN | TYP‡   | MAX    | MIN | TYP <sup>‡</sup> | MAX  | UNIT |
| VIH               | High-level input voltage                                |                 |  |  | 2   |        |        | 2   |                  |      | V    |
| VIL               | Low-level input voltage                                 |                 |  |  |     |        | 0.7    |     |                  | 0.8  | V    |
| Γ <sup>∨</sup> ικ | Input clamp voltage                                     |                 | V <sub>CC</sub> = MIN,   | lı = –18 mA  |     |        | -1.5   |     |                  | -1.5 | V    |
|                   | Hysteresis (V <sub>T+</sub> – V <sub>T</sub> _)         |                 | V <sub>CC</sub> = MIN  |  | 0.2 | 0.4    |        | 0.2 | 0.4              |      | V    |
| Val               |   |                 | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = V <sub>IL</sub> max, | V <sub>IH</sub> = 2 V,<br>I <sub>OH</sub> = - 3 mA | 2.4 | 3.1    |        | 2.4 | 3.1              |      |      |
| ⊻он               | High-lever output voitage                               |                 | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.5 V,               | V <sub>IH</sub> = 2 V,<br>I <sub>OH</sub> = MAX    | 2   |        |        | 2   |                  |      |      |
| Vei               |   |                 | $V_{CC} = MIN,$  | I <sub>OL</sub> = 12 mA                            |     | 0.25   | 0.4    |     | 0.25             | 0.4  | V    |
| VOL               |   |                 | VIL = VIL max  | I <sub>OL</sub> = 24 mA                            |     |        |        |     | 0,35             | 0.5  |      |
| lоzн              | Off-state output current,<br>high-level voltage applied |                 | V <sub>CC</sub> = MAX,   | V <sub>O</sub> = 2.7 V                             |     |        | 40     |     |                  | 40   | μA   |
| IOZL              | Off-state output current,<br>low-level voltage applied  |                 | VIL = VIL max  | V <sub>O</sub> = 0.4 V                             |     |        | 200    |     |                  | -200 | μA   |
|                   | Input current at maximum                                | A or B          |  | VI = 5.5 V   |     |        | 0.1    |     |                  | 0.1  |      |
| 11                | input voltage   | GAB or GBA      | VCC = MAX,   | V <sub>1</sub> = 7 V                               |     |        | 0.1    |     |                  | 0.1  | m A  |
| Чн                | High-level input current, ar                            | ny input        | V <sub>CC</sub> = MAX,   | V1 = 2.7 V   |     |        | 20     |     |                  | 20   | μA   |
|                   |   | A inputs        | V <sub>CC</sub> = MAX,<br>GAB and GBA a                          | VI = 0.4 V,<br>t VIL max                           |     |        | -0,2   |     |                  | -0.2 |      |
| hι                | input current   | B inputs        | $V_{CC} = MAX,$<br>GAB and GBA a                                 | V <sub>I</sub> = 0.4 V,<br>t 2 V                   |     |        | -0.2   |     |                  | -0.2 | mA   |
|                   |   | GAB or GBA      | V <sub>CC</sub> = MAX,   | V <sub>I</sub> = 0.4 V                             |     |        | -0.2   |     |                  | -0.2 |      |
| los               | Short-circuit output curren                             | it <sup>♠</sup> | V <sub>CC</sub> = MAX  |  | -40 |        | -225   | -40 |                  | -225 | mΑ   |
|                   |   | Outputs high    | Vee = MAX  | 'LS242, 'LS243                                     |     | 22     | 38     |     | 22               | 38   |      |
| 100               | Supply current  | Outputs low     | Outputs open   | 'LS242, 'LS243                                     |     | 29     | 50     |     | 29               | 50   | mΑ   |
|                   |   | All outputs     | See Note 2   | 'LS242   |     | 29     | 50     |     | 29               | 50   |      |
|                   |   | d               | disabled See Note 2  | 'LS243   |     | 32     | 54     |     | 32               | 54   |      |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 $\ddagger$ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25<sup>c</sup>C.

\*Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

NOTE 2: ICC is measured with transceivers enabled in one direction only, or with all transceivers disabled.

#### switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

| [           | DADAMETER   | TEET O                                |                          |             | 'LS242 |    |     | 'LS243 |     |    |
|-------------|---|---------------------------------------|--------------------------|-------------|--------|----|-----|--------|-----|----|
|             | PARAMETER   | TEST CO                               |                          | MIN TYP MAX |        |    | MIN | ТҮР    | MAX |    |
| tPLH        | Propagation delay time,<br>low-to-high-level output |                                       |                          |             | 9      | 14 |     | 12     | 18  | ns |
| tPHL        | Propagation delay time,<br>high-to-low-level output | C <sub>L</sub> = 45 pF,<br>See Note 3 | RL = 667 Ω,              |             | 12     | 18 |     | 12     | 18  | ns |
| <b>tPZL</b> | Output enable time to low level                     | 7                                     |                          |             | 20     | 30 |     | 20     | 30  | ns |
| <b>tPZH</b> | Output enable time to high level                    | 7                                     |                          |             | 15     | 23 |     | 15     | 23  | ns |
| <b>tPLZ</b> | Output disable time from low level                  | CL = 5 pF,                            | $R_{L} = 667 \Omega_{c}$ |             | 15     | 25 |     | 15     | 25  | ns |
| <b>tPHZ</b> | Output disable time from high level                 | See Note 3                            |                          |             | 10     | 18 |     | 10     | 18  | ns |

NOTE 3: Load circuit and waveforms are shown on page 1-15.

## TYPES SN54LS245, SN74LS245 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

BULLETIN NO. DL-S 12471, OCTOBER 1976-REVISED FEBRUARY 1979

- Bi-directional Bus Transceiver in a High-Density 20-Pin Package
- 3-State Outputs Drive Bus Lines Directly
- P-N-P Inputs Reduce D-C Loading on Bus Lines
- Hysteresis at Bus Inputs Improve Noise
  Margins
- Typical Propagation Delay Times, Port-to-Port . . . 8 ns
- Typical Enable/Disable Times . . . 17 ns

|           | IOL      | юн       |
|-----------|----------|----------|
| TYPE      | (SINK    | (SOURCE  |
|           | CURRENT) | CURRENT) |
| SN54LS245 | 12 mA    | —12 mA   |
| SN74LS245 | 24 m A   | –15 mA   |





#### description

ASI

These octal bus transceivers are designed for asynchronous two-way communication between data buses. The control function implementation minimizes external timing requirements.

The device allows data transmission from the A bus to the B bus or from the B bus to the A bus depending upon the logic level at the direction control (DIR) input. The enable input ( $\overline{G}$ ) can be used to disable the device so that the buses are effectively isolated.

The SN54LS245 is characterized for operation over the full military temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C. The SN74LS245 is characterized for operation from 0°C to 70°C.

#### schematics of inputs and outputs



#### FUNCTION TABLE

| ENABLE<br>G | DIRECTION<br>CONTROL<br>DIR | OPERATION       |
|-------------|-----------------------------|-----------------|
| L           | L                           | B data to A bus |
| L           | н                           | A data to B bus |
| н           | х                           | Isolation       |

H = high level, L = low level, X = irrelevant

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note 1)           |     | <br>7 V            |
|--|-----|--------------------|
| Input voltage                              |     | <br>7 V            |
| Off-state output voltage                   |     | <br>5.5 V          |
| Operating free-air temperature range: SN54 | LS' | <br>–55°C to 125°C |
| SN74                                       | LS' | <br>0°C to 70°C    |
| Storage temperature range                  |     | <br>–65°C to 150°C |

NOTE 1: Voltage values are with respect to network ground terminal.

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## TYPES SN54LS245, SN74LS245 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

**REVISED FEBRUARY 1979** 

#### recommended operating conditions

| DADAMETED                          | S   | N54LS2 | 45  | S    | N74LS2 | 45   |      |
|------------------------------------|-----|--------|-----|------|--------|------|------|
|                                    | MIN | NOM    | MAX | MIN  | NOM    | MAX  | UNIT |
| Supply voltage, V <sub>CC</sub>    | 4.5 | 5      | 5.5 | 4.75 | 5      | 5,25 | V    |
| High-level output current, IOH     |     |        | 12  |      |        | 15   | mA   |
| Low-level output current, IOL      |     |        | 12  |      |        | 24   | mA   |
| Operating free-air temperature, TA | -55 |        | 125 | 0    |        | 70   | °C   |

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| [        | DADAM                       | ETED                |              | TEST CON                         | DITIONS                 | S   | N54LS2 | 45   | s        | N74LS2 | 45   | UNIT |
|----------|-----------------------------|---------------------|--------------|----------------------------------|-------------------------|-----|--------|------|----------|--------|------|------|
|          | PARAM                       | EIER                |              | TEST CON                         | DITIONS                 | MIN | TYP‡   | MAX  | MIN      | түр‡   | MAX  | UNIT |
| VIH      | High-level input            | voltage             |              |                                  |                         | 2   |        |      | 2        |        |      | V    |
| VIL      | Low-level input             | voltage             |              |                                  |                         |     |        | 0.7  | [        |        | 0.8  | V    |
| VIK      | Input clamp vol             | tage                |              | $V_{CC} = MIN,$                  | lj =18 mA               |     |        | -1.5 |          |        | -1.5 | V    |
|          | Hysteresis (V <sub>T+</sub> | $-V_{T-}$ )         | A or B input | V <sub>CC</sub> = MIN            |                         | 0.2 | 0.4    |      | 0.2      | 0.4    |      | V    |
| Vou      | Hich-level outpu            |                     |              | $V_{CC} = MIN,$                  | I <sub>OH</sub> = −3 mA | 2.4 | 3.4    |      | 2.4      | 3.4    |      | . v  |
| VOH      |                             | it voitage          |              | VIL = VIL max                    | I <sub>OH</sub> = MAX   | 2   |        |      | 2        |        |      |      |
| Vol      | Low-level output            | t voltane           |              | $V_{CC} = MIN,$<br>$V_{UU} = 2V$ | 1 <sub>0L</sub> = 12 mA |     |        | 0.4  |          |        | 0.4  |      |
| 1 VOL    | Low-level outpu             | it vontage          |              | VIL = VIL max                    | I <sub>OL</sub> = 24 mA |     |        |      |          |        | 0.5  |      |
| Iоzн     | Off-state output            | current,            |              |                                  | V <sub>O</sub> = 2.7 V  |     |        | 20   |          |        | 20   |      |
| <u> </u> | high-level voltag           | e applied           |              | VCC = MAX,                       | ··                      |     |        |      | <u> </u> |        |      | μA   |
| 10ZL     | low-level voltage           | current,<br>applied |              | G at 2 V                         | V <sub>O</sub> = 0.4 V  |     |        | -200 |          |        | -200 |      |
|          | Input current at            |                     | A or B       |                                  | V <sub>1</sub> = 5.5 V  |     |        | 0.1  |          |        | 0.1  |      |
| 11       | maximum input               | voltage             | DIR or G     | VCC = MAX,                       | V <sub>1</sub> = 7 V    |     |        | 0.1  |          |        | 0.1  | mA   |
| Чн       | High-level input            | current             |              | V <sub>CC</sub> = MAX,           | V <sub>IH</sub> = 2.7 V |     |        | 20   | Ţ        |        | 20   | μA   |
| ΠL       | Low-level input             | current             |              | V <sub>CC</sub> = MAX,           | V <sub>IL</sub> = 0.4 V |     |        | -0.2 |          |        | -0.2 | mA   |
| los      | Short-circuit ou            | tput curr           | ent¶         | V <sub>CC</sub> = MAX            |                         | 40  | •      | 225  | -40      |        | 225  | mA   |
|          |                             | Total, o            | utputs high  |                                  |                         |     | 48     | 70   |          | 48     | 70   |      |
| lcc      | Supply current              | Total, o            | utputs low   | V <sub>CC</sub> = MAX,           | Outputs open            |     | 62     | 90   |          | 62     | 90   | mA   |
|          |                             | Outputs             | at Hi-Z      |                                  |                         |     | 64     | 95   |          | 64     | 95   |      |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

### switching characteristics, V\_{CC} = 5 V, T\_A = 25° C

|             | PARAMETER                           |             | TEST CONDITI | ONS        | MIN | ТҮР | MAX | UNIT |
|-------------|-------------------------------------|-------------|--------------|------------|-----|-----|-----|------|
|             | Propagation delay time,             |             | ····         |            |     | 0   | 12  |      |
| UPLH        | low-to-high-level output            |             |              |            |     | 0   | 12  | ns   |
|             | Propagation delay time,             | 0 45 - 5    | D 667 0      | See Mars 2 |     |     | 10  |      |
| PHL         | high-to-low-level output            | CL - 45 pF, | HL - 007 32, | See Note 2 |     | 0   | 12  | ns   |
| <b>tPZL</b> | Output enable time to low level     |             |              | ,          |     | 27  | 40  | ns   |
| <b>tPZH</b> | Output enable time to high level    |             |              |            |     | 25  | 40  | ns   |
| <b>tPLZ</b> | Output disable time from low level  | 0           | D 007.0      | Car Nata 2 |     | 15  | 25  | ns   |
| <b>tPHZ</b> | Output disable time from high level | CL=5pr,     | H = 00/32    | See Note 2 |     | 15  | 25  | ns   |

NOTE 2: Load circuit and waveforms are shown on page 1-15,

## TYPES SN54LS299, SN54S299, SN74LS299, SN74S299 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS

BULLETIN NO. DL-S 12115, MARCH 1974-REVISED FEBRUARY 1979

- Multiplexed Inputs/Outputs Provide Improved Bit Density
- Four Modes of Operation: Hold (Store) Shift Left Shift Right Load Data
- Operates with Outputs Enabled or at High Z
- 3-State Outputs Drive Bus Lines Directly
- Can Be Cascaded for N-Bit Word Lengths
- SN54LS323 and SN74LS323 Are Similar But Have Synchronous Clear
- Applications: Stacked or Push-Down Registers. Buffer Storage, and Accumulator Registers

|        | GUARANTEED    | TYPICAL     |
|--------|---------------|-------------|
| ТҮРЕ   | SHIFT (CLOCK) | POWER       |
|        | FREQUENCY     | DISSIPATION |
| 'LS299 | 35 MHz        | 175 mW      |
| 'S299  | 50 MHz        | 700 mW      |

#### SN54LS299, SN54S299...J PACKAGE SN74LS299, SN74S299...J OR N PACKAGE (TOP VIEW)



#### description

I I L LSI

These Schottky<sup>†</sup> TTL eight-bit universal registers feature multiplexed inputs/outputs to achieve full eight-bit data handling in a single 20-pin package. Two function-select inputs and two output-control inputs can be used to choose the modes of operation listed in the function table.

Synchronous parallel loading is accomplished by taking both function-select lines, S0 and S1, high. This places the three-state outputs in a high-impedance state, which permits data that is applied on the input/output lines to be clocked into the register. Reading out of the register can be accomplished while the outputs are enabled in any mode. A direct overriding input is provided to clear the register whether the outputs are enabled or off.

| <u> </u>                          |  |           |               | INPL | ITS |       |     |      |                 |                  | IN              | PUTS/0          | DUTPU           | TS              |                 |                  | OUTPUTS          |                  |
|-----------------------------------|--|-----------|---------------|------|-----|-------|-----|------|-----------------|------------------|-----------------|-----------------|-----------------|-----------------|-----------------|------------------|------------------|------------------|
| MODE                              | CLEAR  | FUNC      | CTION<br>.ECT |      |     | сгоск | SEF | RIAL | A/QA            | в/Q <sub>В</sub> | c/ac            | D/QD            | e/qe            | F/QF            | G/QG            | н/о <sub>Н</sub> | ۵ <sub>A</sub> , | σ <sub>H</sub> , |
|                                   |  | <u>S1</u> |               | G1'  | G2' |       | SL  | SR   |                 |                  |                 |                 |                 |                 |                 |                  |                  |                  |
| Clear                             | L  | X         | L             | L    | L   | X     | х   | х    | L               | L                | L               | L               | L               | L               | L               | L                | L                | L                |
| Giear                             | L  | L         | X             | L    | Ľ   | X     | х   | х    | L               | Ĺ                | _L              | L               | L               | L               | L               | L                | L                | L                |
| Hold                              | н  | L         | L             | L    | L   | X     | х   | х    | Q <sub>A0</sub> | Q <sub>B0</sub>  | QC0             | Q <sub>D0</sub> | Q <sub>E0</sub> | QFO             | Q <sub>G0</sub> | QH0              | Q <sub>A0</sub>  | QH0              |
| Holu                              | н  | х         | х             | L    | L   | L     | х   | х    | Q <sub>A0</sub> | Q <sub>B0</sub>  | QC0             | Q <sub>D0</sub> | QE0             | Q <sub>F0</sub> | Q <sub>G0</sub> | Q <sub>H0</sub>  | Q <sub>A0</sub>  | QHO              |
| Shift Bight                       | н  | L         | н             | L    | L   | 1     | ×   | н    | н               | Q <sub>An</sub>  | Q <sub>Bn</sub> | QCn             | Q <sub>Dn</sub> | QEn             | QFn             | Q <sub>Gn</sub>  | н                | QGn              |
| Shirt Hight                       | н  | L         | н             | L    | L   | † †   | х   | L    | L               | QAn              | QBn             | QCn             | QDn             | QEn             | QEn             | QGn              | L                | QGn              |
| Shift Laft                        | н  | н         | L             | L    | L   | 1     | н   | х    | QBn             | QCn              | Q <sub>Dn</sub> | QEn             | Q <sub>Fn</sub> | QGn             | Q <sub>Hn</sub> | Н                | QBn              | н                |
| Shirt Left                        | н  | н         | L,            | L    | L,  | 1     | L   | x    | Q <sub>Bn</sub> | QCn              | Q <sub>Dn</sub> | Q <sub>En</sub> | Q <sub>Fn</sub> | Q <sub>Gn</sub> | Q <sub>Hn</sub> | L                | QBn              | L                |
| Load                              | н  | н         | Н             | X    | х   | 1     | х   | Х    | а               | b                | С               | d               | е               | f               | g               | h                | а                | h                |
| <sup>†</sup> When or<br>sequentia | <sup>†</sup> When one or both output controls are high the eight input/output terminals are disabled to the high-impedance state; however, sequential operation or clearing of the register is not affected. |           |               |      |     |       |     |      |                 |                  |                 |                 |                 |                 |                 |                  |                  |                  |

FUNCTION TABLE

a... h = the level of the steady-state input at inputs A through H, respectively. These data are loaded into the flip-flops while the flip-flop outputs are isolated from the input/output terminals. See explanation of function tables on page 1-13,

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TEXAS INSTRUMENTS

## TYPES SN54LS299, SN54S299, SN74LS299, SN74S299 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS

functional block diagram



## TEXAS INSTRUMENTS

POST OFFICE BOX 225012 . DALLAS, TEXAS 75265

## TYPES SN54LS299, SN74LS299 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS

**REVISED FEBRUARY 1979** 

#### schematics of inputs and outputs



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note 1)                |   |   |   |  |   |       |   |   |  |  |  |    |     |      | .7V     |
|---|---|---|---|--|---|-------|---|---|--|--|--|----|-----|------|---------|
| Input voltage                                   |   | • |   |  | • |       |   |   |  |  |  |    |     |      | .7V     |
| Off-state output voltage                        | • |   |   |  |   |       |   |   |  |  |  |    |     |      | 5.5 V   |
| Operating free-air temperature range: SN54LS299 |   |   |   |  |   |       |   |   |  |  |  | -5 | 55° | C to | o 125°C |
| SN74LS299                                       |   |   |   |  |   |       |   |   |  |  |  |    | C   | °C   | to 70°C |
| Storage temperature                             | • | • | • |  | • | <br>• | • | • |  |  |  | -6 | 35° | C to | o 150°C |

NOTE 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

|  |                                      | s   | N54LS2 | 99   | s    | N74LS2 | 99   |     |
|--|--------------------------------------|-----|--------|------|------|--------|------|-----|
|  |                                      | MIN | NOM    | MAX  | MIN  | NOM    | MAX  |     |
| Supply voltage, VCC                            |                                      | 4.5 | 5      | 5.5  | 4.75 | 5      | 5.25 | V   |
| High-level output current lou                  | Q <sub>A</sub> thru Q <sub>H</sub>   |     |        | -1   |      |        | -2.6 | -   |
|  | Q <sub>A</sub> ' or Q <sub>H</sub> ' |     |        | -0.4 |      |        | -0.4 |     |
|  | Q <sub>A</sub> thru Q <sub>H</sub>   |     |        | 12   |      |        | 24   |     |
|  | Q <sub>A</sub> ' or Q <sub>H</sub> ' |     |        | 4    |      |        | 8    |     |
| Clock frequency, fclock                        |                                      | 0   |        | 30   | 0    |        | 30   | MHz |
| Width of clock pulse to the sta                | Clock high                           | 20  |        |      | 20   |        |      |     |
| Width of clock pulse, tw(clock)                | Clock low                            | 20  |        | _    | 20   |        |      | ns  |
| Width of clear pulse, tw(clear)                | Clear low                            | 20  |        |      | 20   |        |      | ns  |
|  | Select                               | 301 |        |      | 301  |        |      | _   |
| Sotup time t                                   | High-level data <sup>♦</sup>         | 201 |        |      | 20†  |        |      |     |
|  | Low-level data <sup>♦</sup>          | 201 |        |      | 20†  |        |      | ns  |
|  | Clear inactive-state                 | 201 |        |      | 20†  |        |      |     |
| Hold time t                                    | Select                               | 10† |        |      | 101  |        |      |     |
|  | Data <sup>◊</sup>                    | 10  |        |      | 10   |        |      | ns  |
| Operating free-air temperature, T <sub>A</sub> |                                      | -55 |        | 125  | 0    |        | 70   | °C  |

 $^{\Diamond}\mathsf{D}\mathsf{a}\mathsf{t}\mathsf{a}$  includes the two serial inputs and the eight input/output data lines.

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## TYPES SN54LS299, SN74LS299 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS

**REVISED FEBRUARY 1979** 

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| r                 |   |                                      |                        |                           |     |        |      |     |        |      |          |
|-------------------|---|--------------------------------------|------------------------|---------------------------|-----|--------|------|-----|--------|------|----------|
|                   | PARAMETER                                 |                                      | TEST CONF              | TIONST                    | SI  | 154LS2 | 99   | SI  | N74LS2 | 99   | LINIT    |
|                   | ANAMETEN                                  |                                      |                        |                           | MIN | TYP‡   | MAX  | MIN | TYP‡   | MAX  | CI.I.I   |
| VIH               | High-level input voltage                  |                                      |                        |                           | 2   |        |      | 2   |        |      | V        |
| VIL               | Low-level input voltage                   |                                      |                        |                           |     |        | 0.7  |     |        | 0.8  | V        |
| VIK               | Input clamp voltage                       |                                      | V <sub>CC</sub> = MIN, | $I_{  } = -18 \text{ mA}$ |     |        | -1.5 |     |        | -1.5 | V        |
|                   |   | Q <sub>A</sub> thru Q <sub>H</sub>   | V <sub>CC</sub> = MIN, | V <sub>IH</sub> = 2 V,    | 2.4 | 3.2    |      | 2.4 | 3,1    |      |          |
| ⊻он               | High-level output voltage                 | Q <sub>A</sub> ' or Q <sub>H</sub> ' | VIL = VILmax,          | 1 <sub>OH</sub> = MAX     | 2.5 | 3.4    |      | 2.7 | 3.4    |      |          |
|                   |   | O a thru Ou                          |                        | <sup>1</sup> OL = 12 mA   |     | 0,25   | 0.4  |     | 0,25   | 0.4  |          |
| Vol               | l ow-level output voltage                 | ag and ag                            | $V_{\rm UU} = 2 V$     | I <sub>OL</sub> = 24 mA   |     |        |      |     | 0.35   | 0.5  |          |
| VOL               | Low-level bulput vortage                  | 0                                    |                        | I <sub>OL</sub> = 4 mA    |     | 0.25   | 0.4  |     | 0,25   | 0.4  | ľ        |
|                   | · · · · · · · · · · · · · · · · · · ·     | ad, or all,                          | AIT = AIT wax          | I <sub>OL</sub> = 8 mA    |     |        |      |     | 0,35   | 0.5  | 1        |
| 1                 | Off-state output current,                 |                                      | V <sub>CC</sub> = MAX, | V <sub>IH</sub> = 2 V,    |     |        | 40   |     |        | 40   |          |
| <sup>i</sup> OZH  | high-level voltage applied                |                                      | V <sub>O</sub> = 2.7 V |                           |     |        | 40   |     |        | 40   | μΑ       |
|                   | Off-state output current,                 |                                      | V <sub>CC</sub> = MAX, | V <sub>IH</sub> = 2 V,    |     |        | 400  |     |        | 400  |          |
| 10ZL              | low-level voltage applied                 | QA thru QH                           | V <sub>O</sub> = 0.4 V |                           |     |        | -400 |     |        | -400 | μΑ       |
|                   |   | S0, S1                               |                        | V1 = 7 V                  |     |        | 200  |     |        | 200  | i i      |
| 4                 | Input current at maximum                  | A thru H                             | V <sub>CC</sub> = MAX  | VI = 5.5 V                |     |        | 100  |     |        | 100  | μA       |
|                   | input voltage                             | Any other                            |                        | V1 = 7 V                  |     |        | 100  |     |        | 100  | l        |
|                   |   | A thru H, SO, S1                     |                        |                           |     |        | 40   |     |        | 40   | · .      |
| ЧН                | High-level input current                  | Any other                            | $V_{CC} = MAX,$        | $v_1 = 2.7 v_1$           |     |        | 20   |     |        | 20   | μΑ       |
|                   |   | S0, S1                               |                        |                           |     |        | -0.8 |     |        | -0.8 | <u> </u> |
| 11                | Low-level input current                   | Any other                            | $V_{CC} = MAX,$        | V <sub>1</sub> = 0.4 V    |     |        | -0.4 |     |        | -0.4 | mA       |
|                   |   | Q <sub>A</sub> thru Q <sub>H</sub>   |                        |                           | -30 |        | -130 | -30 |        | -130 |          |
| l <sup>i</sup> os | Short-circuit output current <sup>9</sup> | Q <sub>A</sub> , or Q <sub>H</sub> , | V <sub>CC</sub> = MAX  |                           | -20 |        | -100 | -20 |        | -100 | mA       |
| <sup>I</sup> CC   | Supply current                            |                                      | V <sub>CC</sub> = MAX  |                           |     | 33     | 53   |     | 33     | 53   | mA       |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. <sup>‡</sup>All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

 ${}^{8}_{8}$ Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.

#### switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

| PARAMETER¶       | FROM<br>(INPUT)   | TO<br>(OUTPUT)                     | TEST CONDITIONS                                     | MIN | түр | MAX | UNIT |
|------------------|---|------------------------------------|---|-----|-----|-----|------|
| fmax             |   |                                    | See Note 2  | 30  | 35  |     | MHz  |
| tPLH             | Clock   | Onlor Our                          | $C_{1} = 15 \text{ pc}$ $B_{1} = 2 \text{ kO}$      |     | 22  | 33  | 07   |
| <sup>t</sup> PHL | CIOCK   |                                    | $O_{L} = 15 \text{ pr}$ , $H_{L} = 2 \text{ Kaz}$ , |     | 26  | 39  | 113  |
| tPHL             | Clear   | QA' or QH'                         | See Note 2  |     | 27  | 40  | ns   |
| tPLH             | Clock   | O a thru Ou                        |   |     | 17  | 25  | 00   |
| tPHL             |   |                                    | $C_{1} = 45 \text{ pc}$ $B_{1} = 665 \Omega$        |     | 26  | 39  | 115  |
| <sup>t</sup> PHL | Clear   | Q <sub>A</sub> thru Q <sub>H</sub> | See Note 2  |     | 26  | 40  | ns   |
| tPZH             | <u><u><u></u><u></u><u></u><u></u><u></u><u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u></u></u></u> | O a thru Ou                        |   |     | 13  | 21  | 00   |
| tPZL             | 01,02   | ad the ad                          |   |     | 19  | 30  | 115  |
| tPHZ             | <u><u><u></u><u></u><u></u><u></u><u></u><u><u></u><u></u><u></u><u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u></u></u></u></u> | O a thru Ou                        | $C_L = 5 pF$ , $R_L = 665 \Omega$ ,                 |     | 10  | 15  | 06   |
| tpLZ             |   |                                    | See Note 2  |     | 10  | 15  | 115  |

 $\P f_{max} \equiv maximum clock frequency$ 

 $t_{PLH} \equiv propagation delay time, low-to-high-level output.$ 

tpHL ≡ propagation delay time, high-to-low-level output

 $t_{PZH} \equiv output enable time to high level$ 

tPZL ≡ output enable time to low level

 $t_{PHZ} \equiv$  output disable time from high level

 $t_{PLZ} \equiv output disable time from low level$ 

NOTE 2: For testing fmax, all outputs are loaded simultaneously, each with CL and RL as specified for the propagation times. See load circuits and waveforms on page 1-15.

## TYPES SN54S299, SN74S299 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS

OUTPUT

#### schematics of inputs and outputs EQUIVALENT OF CLOCK AND EQUIVALENT OF G1 EQUIVALENT OF A THRU H<sup>†</sup>, SO, S1, CLEAR INPUTS AND G2 INPUTS SHIFT RIGHT, AND SHIFT LEFT INPUTS Vcc Vcc Vcc Req 3.5 kΩ 2.8 kΩ NOM NOM INPUT INPUT INPUT Clock: $R_{eq} = 2.8 k\Omega NOM$ Clear: $R_{eq} = 3.5 k\Omega NOM$ <sup>†</sup>When 3-state outputs are disabled. TYPICAL OF OUTPUTS TYPICAL OF OUTPUTS QA THRU QH QA' AND QH' Vcc Vcc 50 Ω NOM 50 Ω NOM

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

OUTPUT

| Supply voltage, VCC (see Note 1)      |                |        |      |    | <br> |   |   | <br> |  | <br>7 V            |
|---------------------------------------|----------------|--------|------|----|------|---|---|------|--|--------------------|
| Input voltage                         |                |        |      |    | <br> |   |   | <br> |  | <br>5.5 V          |
| Off-state output voltage              | <sup>*</sup> . |        |      |    | <br> |   | • | <br> |  | <br>5.5 V          |
| Operating free-air temperature range: | SN54S299       | ) (see | Note | 2) | <br> |   | • | <br> |  | <br>–55°C to 125°C |
|                                       | SN74S299       | ).     |      |    | <br> | · |   | <br> |  | <br>. 0°C to 70°C  |
| Storage temperature                   |                |        |      |    | <br> |   |   | <br> |  | <br>-65°C to 150°C |

NOTES 1: Voltage values are with respect to network ground terminal.

#### recommended operating conditions

|   |                                      |     | SN54S29 | 9    | 5    | N74S29 | 9   |     |  |
|---|--------------------------------------|-----|---------|------|------|--------|---|-----|--|
|   | ·                                    | MIN | NOM     | MAX  | MIN  | NOM    | MAX   |     |  |
| Supply voltage, VCC   |                                      | 4.5 | 5       | 5.5  | 4.75 | 5      | 5.25  | V   |  |
| High-level output current low   | Q <sub>A</sub> thru Q <sub>H</sub>   |     |         | -2   |      |        | -6.5  |     |  |
| rightever output current, IOH   | Q <sub>A</sub> ' or Q <sub>H</sub> ' |     |         | -0.5 |      |        | 9<br>MAX<br>5.25<br>-6.5<br>-0.5<br>20<br>6<br>50<br> |     |  |
|   | Q <sub>A</sub> thru Q <sub>H</sub>   |     |         | 20   |      |        | 20  | m۸  |  |
| Ipply voltage, V <sub>CC</sub><br>gh-level output current, I <sub>OH</sub><br>ow-level output current, I <sub>OL</sub><br>ock frequency, f <sub>clock</sub><br>idth of clock pulse, t <sub>w</sub> (clock)<br>idth of clear pulse, t <sub>w</sub> (clear)<br>itup time, t <sub>su</sub><br>old time, t <sub>h</sub>         | Q <sub>A</sub> ' or Q <sub>H</sub> ' |     |         | 6,   |      |        | 6   |     |  |
| Clock frequency, fclock   |                                      | 0   |         | 50   | 0    | _      | 50  | MHz |  |
| Width of clock pulse to ( )   | Clock high                           | 10  |         |      | 10   |        |   |     |  |
| Width of clock pulse, tw(clock)   | Clock low                            | 10  |         |      | 10   |        |   | 115 |  |
| Width of clear pulse, tw(clear)   | Clear low                            | 10  |         |      | 10   |        |   | ns  |  |
|   | Select                               | 15↑ |         |      | 15†  |        |   |     |  |
| upply voltage, V <sub>CC</sub><br>ligh-level output current, I <sub>OH</sub><br>cow-level output current, I <sub>OL</sub><br>clock frequency, f <sub>clock</sub><br>/idth of clock pulse, t <sub>W</sub> (clock)<br>/idth of clear pulse, t <sub>W</sub> (clear)<br>etup time, t <sub>Su</sub><br>lold time, t <sub>h</sub> | High-level data <sup>♦</sup>         | 7↑  |         |      | 7↑   |        |   |     |  |
| Setup time, Isu   | Low-level data <sup>♦</sup>          | 51  |         |      | 51   |        |   |     |  |
|   | Clear inactive-state                 | 10† |         |      | 10†  |        | MAX    5.25    -6.5    -0.5    20    6    50          | 1   |  |
| Hold time to  | Select                               | 51  |         |      | 51   |        |   |     |  |
|   | Data <sup>♦</sup>                    | 51  |         |      | 51   |        |   | ns  |  |
| Operating free-air temperature, TA  |                                      | -55 |         | 125  | 0    |        | 70  | °C  |  |

 $^{\Diamond}$ Data includes the two serial inputs and the eight input/output data lines.



## TYPES SN54S299, SN74S299 8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|      | PARAMETER                              |                                       | TEST CON                 | DITIONS <sup>†</sup>   | MIN | түр‡ | MAX    | UNIT |
|------|--|---------------------------------------|--------------------------|------------------------|-----|------|--------|------|
| ∨ін  | High-level input voltage               |                                       |                          |                        | 2   |      |        | V    |
| VIL  | Low-level input voltage                |                                       |                          |                        |     |      | 0.8    | V    |
| VIK  | Input clamp voltage                    |                                       | V <sub>CC</sub> = MIN,   | l <sub>l</sub> =18 mA  |     |      | 1.2    | V    |
| VOH  | Q <sub>A</sub> thru Q <sub>H</sub>     |                                       | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V, | 2.4 | 3.2  |        |      |
| ⊻он  | High-level output voltage              | Q <sub>A</sub> ' or Q <sub>H</sub> '  | V <sub>IL</sub> = 0.8 V, | IOH = MAX              | 2.7 | 3.4  |        | ľ    |
|      |  |                                       | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V, |     |      |        |      |
| VOL  | Low-level output voltage               |                                       | V <sub>IL</sub> ≈ 0.8 V, | I <sub>OL</sub> = MAX  |     |      | 0.5    | l v  |
| 1    | Off-state output current,              | 0                                     | VCC = MAX,               | V <sub>IH</sub> = 2 V, |     |      | 100    |      |
| огн  | high-level voltage applied             |                                       | V <sub>O</sub> = 2.4 V   |                        |     |      | 100    | μΑ   |
|      | Off-state output current,              | 0                                     | V <sub>CC</sub> = MAX,   | V <sub>IH</sub> = 2 V, |     |      | -250 µ |      |
| 'OZL | low-level voltage applied              |                                       | V <sub>O</sub> = 0.5 V   |                        |     |      | -250   |      |
| 1    | Input current at maximum input voltage |                                       | V <sub>CC</sub> = MAX,   | V <sub>I</sub> = 5.5 V |     |      | 1      | mA   |
| 1    | High lovel is put everent              | A thru H, SO, S1                      | Ver - MAX                | V. = 27.V              |     |      | 100    |      |
| чн   | rightever input current                | Any other                             | VCC - WAA,               | v] - 2.7 v             |     |      | 50     | μΑ   |
| 1    |  | Clock or clear                        | No MAX                   | N - 0 F N              |     |      | -2     | mA   |
| 1 '1 | Low-level input current                | Any other                             | VCC = WAX,               | vi ≈ 0.5 v             |     |      | -250   | μA   |
|      | Share alian is another second          | Q <sub>A</sub> thru Q <sub>H</sub>    |                          |                        | -40 |      | 100    |      |
| os   | Short-circuit output currents          | Q <sub>A</sub> ' or Q <sub>H</sub> '  | VCC = MAX                |                        | -20 |      | -100   |      |
| 1cc  | Supply current                         | · · · · · · · · · · · · · · · · · · · | V <sub>CC</sub> = MAX    |                        |     | 140  | 225    | mA   |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

§ Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second.

| PARAMETER¶       | FROM<br>(INPUT)  | TO<br>(OUTPUT)                       | TEST CONDITIONS                                | MIN      | түр | MAX | UNIT  |
|------------------|--|--------------------------------------|--|----------|-----|-----|-------|
| f <sub>max</sub> |  |                                      | See Note 2                                     | 50       | 70  |     | MHz   |
| tPLH             | Clock  | 0.4 05 0.4                           | $C_{1} = 15 \text{ ps}$ $B_{1} = 1 \text{ kg}$ |          | 12  | 20  |       |
| <sup>t</sup> PHL |  |                                      | See Note 2                                     | " [      | 13  | 20  |       |
| tPHL.            | Clear  | Q <sub>A</sub> ' or Q <sub>H</sub> ' | See Note 2                                     |          | 14  | 21  | ns    |
| <b>tPLH</b>      | Clock  | O a thru Ou                          |  |          | 15  | 21  |       |
| tPHL             |  |                                      | C - 45 pE B 280                                | <u>م</u> | 15  | 21  | ] ''' |
| <sup>t</sup> PHL | Clear  | Q <sub>A</sub> thru Q <sub>H</sub>   | $C_{L} = 45 \text{ pF}, R_{L} = 28032,$        | \$2,     | 16  | 24  | ns    |
| <sup>t</sup> PZH | <u>Ē1</u> Ē2   | O a thru Ou                          | See Note 2                                     |          | 10  | 18  |       |
| <sup>t</sup> PZL |  |                                      | 1  |          | 12  | 18  |       |
| tPHZ             | <u><u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u></u></u> | O a thru Ou                          | C <sub>L</sub> = 5 pF, R <sub>L</sub> = 280    | Ω,       | 7   | 12  |       |
| <sup>t</sup> PLZ | 01,02  |                                      | See Note 3                                     |          | 7   | 12  |       |

#### switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

¶ f<sub>max</sub> ≡ maximum clock frequency

 $t_{PLH} \equiv$  propagation delay time, low-to-high-level output.

tpHL ≡ propagation delay time, high-to-low-level output

 $t_{PZH} \equiv output$  enable time to high level

 $t_{PZL} \equiv output enable time to low level$ 

 $t_{PHZ} \equiv$  output disable time from high level

 $t_{PLZ} \equiv output disable time from low level$ 

NOTE 3: For testing fmax, all outputs are loaded simultaneously, each with CL and RL as specified for the propagation times. See load circuits and waveforms on page 1-14.



- Operates with Outputs Enabled or at High Z
- 3-State Outputs Drive Bus Lines Directly
- Can Be Cascaded for N-Bit Word Lengths
- Typical Power Dissipation . . . 175 mW
- Guaranteed Shift (Clock) Frequency . . . 30 MHz
- **Applications:** Stacked or Push-Down Registers, Buffer Storage, and **Accumulator Registers**
- SN54LS299 and SN74LS299 Are Similar But Have Direct Overriding Clear



#### description

These Low-Power Schottky<sup>†</sup> eight-bit universal registers feature multiplexed inputs/outputs to achieve full eight-bit data handling in a single 20-pin package. Two function-select inputs and two output-control inputs can be used to choose the modes of operation listed in the function table. Synchronous parallel loading is accomplished by taking both function-select lines, S0 and S1, high. This places the three-state outputs in a high-impedance state, which permits data that is applied on the input/output lines to be clocked into the register. Reading out of the register can be accomplished while the outputs are enabled in any mode. The clear function is synchronous, and a low level at the clear input clears the register on the next low-to-high transition of the clock.

#### FUNCTION TABLE

|                                   |                          |                  |                     | INPL             | ITS                     |                          | _               |              |                  |                 | IN              | PUTS/0          | UTPU            | тs              |                 |                  | OUT             | PUTS            |
|-----------------------------------|--------------------------|------------------|---------------------|------------------|-------------------------|--------------------------|-----------------|--------------|------------------|-----------------|-----------------|-----------------|-----------------|-----------------|-----------------|------------------|-----------------|-----------------|
| MODE                              | CLEAR                    | FUN              | CTION               |                  | TPUT<br>FROL            | CLOCK                    | SEF             | IAL          | A/Q <sub>A</sub> | B/QB            | c/QC            | D/QD            | E/QE            | F/QF            | G/QG            | н/а <sub>н</sub> | ٥٩،             | о <sub>Н'</sub> |
|                                   |                          | S1               | S0                  | G1 <sup>†</sup>  | <b>G</b> 2 <sup>†</sup> |                          | SL              | SR           |                  |                 |                 |                 |                 |                 |                 |                  |                 |                 |
| 0.000                             | L                        | х                | L                   | L                | . L                     | 1                        | х               | Х            | L                | L               | L               | L               | L               | L               | L               | L                | L               | L               |
| Clear                             | L                        | L                | х                   | L                | L                       | t                        | x               | x            | L                | L               | L               | L               | L               | L               | L               | L                | L               | L               |
| Unid                              | н                        | L                | L                   | L                | L                       | x                        | X               | х            | Q <sub>A0</sub>  | Q <sub>B0</sub> | QCO             | Q <sub>D0</sub> | QE0             | Q <sub>F0</sub> | Q <sub>G0</sub> | QH0              | Q <sub>A0</sub> | Q <sub>H0</sub> |
|                                   | н                        | X                | х                   | L                | L                       | L                        | ×               | х            | Q <sub>A0</sub>  | Q <sub>B0</sub> | QC0             | Q <sub>D0</sub> | O <sub>E0</sub> | QFO             | $Q_{G0}$        | α <sub>H0</sub>  | Q <sub>A0</sub> | a <sub>H0</sub> |
| Shift Diaht                       | н                        | L                | н                   | L                | L                       | 1                        | X               | н            | н                | Q <sub>An</sub> | Q <sub>Bn</sub> | QCn             | QDn             | QEn             | Q <sub>Fn</sub> | QGn              | н               | QGn             |
|                                   | н                        | L                | H                   | L                | L                       | 1                        | L X             | L            | L                | Q <sub>An</sub> | Q <sub>Bn</sub> | QCn             | Q <sub>Dn</sub> | Q <sub>En</sub> | Q <sub>Fn</sub> | Q <sub>Gn</sub>  | L               | Q <sub>Gn</sub> |
| Shift Laft                        | н                        | н                | L                   | L                | L                       | <b>↑</b>                 | н               | х            | QBn              | QCn             | QDn             | QEn             | Q <sub>Fn</sub> | QGn             | Q <sub>Hn</sub> | н                | QBn             | н               |
| Shirt Leit                        | н                        | н                | L                   | L                | L                       | 1                        | L               | х            | QBn              | QCn             | Q <sub>Dn</sub> | Q <sub>En</sub> | QFn             | Q <sub>Gn</sub> | Q <sub>Hn</sub> | L                | QBn             | L               |
| Load                              | н                        | н                | Н                   | X                | х                       | 1                        | X               | x            | а                | b               | с               | d               | е               | f               | g               | h                | а               | h               |
| <sup>†</sup> When or<br>sequentia | e or bot<br>al operation | h out<br>on or c | put cor<br>clearing | ntrols<br>of the | are hig<br>registe      | h the eig<br>er is not a | ht in<br>ffecte | put/a<br>ed. | output t         | ermina          | ls are c        | lisabled        | to the          | high-i          | mpedan          | ce state         | e; how          | ever,           |

. h = the level of the steady-state input at inputs A through H, respectively. These data are loaded into the flip-flops while the flip-flop outputs are isolated from the input/output terminals. See explanation of function tables on page 1-19.

schematics of inputs and outputs, absolute maximum ratings, recommended operating conditions, and electrical characteristics

Same as SN54LS299 and SN74LS299, see page 6-17.

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## TYPES SN54LS323, SN74LS323 **8-BIT UNIVERSAL SHIFT/STORAGE REGISTERS**

#### functional block diagram



INPUTS/OUTPUTS NOT SHOWN: (6) C/Q<sub>C</sub> (5) E/Q<sub>E</sub> (14) D/Q<sub>D</sub> (15) F/Q<sub>F</sub>

switching characteristics,  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ 

| PARAMETER¶       | FROM<br>(INPUT)  | TO<br>(OUTPUT) | TEST CONDITIONS                        | MIN | түр | MAX | UNIT |
|------------------|--|----------------|--|-----|-----|-----|------|
| fmax             |  |                | See Note 1                             | 30  | 35  |     | MHz  |
| <sup>t</sup> PĻH | Clask  | 0.4 07 0.4     | $C_L = 15  pF$ , $R_L = 2  k\Omega$ ,  |     | 22  | 33  |      |
| <sup>t</sup> PHL | CIOCK  | ad, or all.    | See Note 1                             |     | 26  | 39  | 115  |
| tPLH             | Clock  | O . thru Ou    |  |     | 17  | 25  |      |
| <sup>t</sup> PHL | CIOCK  |                | $C_1 = 45  pF$ , $R_1 = 665  \Omega$ , |     | 25  | 39  | 115  |
| <sup>t</sup> PZH | <u><u><u></u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u></u> | O a three Out  | See Note 1                             |     | 14  | 21  |      |
| <sup>t</sup> PZL |  |                |  |     | 20  | 30  |      |
| <sup>t</sup> PHZ | <u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u><u></u></u> | O a thru Ou    | $C_L = 5  pF$ , $R_L = 665  \Omega$ ,  |     | 10  | 15  | ne   |
| <sup>t</sup> PLZ |  |                | See Note 1                             |     | 10  | 15  | 113  |

 $f_{max} \equiv maximum$  clock frequency

.

tpLH ≡ propagation delay time, low-to-high-level output

 $t_{PHL}\equiv$  propagation delay time, high-to-low-level output  $t_{PZH}\equiv$  output enable time to high level

 $t_{PZL} \equiv output enable time to low level$ 

 $t_{PHZ} \equiv output disable time from high level$ 

 $f_{PLZ} \equiv$  output disable time from low level NOTE 1: For testing  $f_{max}$ , all outputs are loaded simultaneously, each with  $C_L$  and  $R_L$  as specified for the propagation times. See load circuits and waveforms on page 1-15.
Typical

Propagation

**Delay Times** 

8 ne

9 ns

9 ns

BULLETIN NO. DL-S 12710, JUNE 1979 - REVISED AUGUST 1979

Typical

Disable

Times

11 ns

16 ns

14 ns

Typical

Enable

Times

17 ne

14 ns

14 ns

|                | IOL      | юн       |
|----------------|----------|----------|
|                | Typical  | Typical  |
|                | (Sink    | (Source  |
|                | Current) | Current) |
| <b>'</b> \$340 | 64 mA    | 15 mA    |
| 'S341          | 64 mA    | 15 mA    |
| <b>'</b> S344  | 64 mA    | 15 mA    |

- Pin-for-Pin Compatible With SN74S240 Series
- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- Typical Input and Output Capacitances, <10 pF
- 300 mV Guaranteed Hysteresis at Inputs Improves Noise Margins

## description

TTL

MSI

These octal buffers and line drivers are designed specifically to improve both the performance and density of three-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. The designer has a choice of selected combinations of inverting and noninverting outputs, symmetrical  $\overline{G}$  (active-low output control) inputs, and complementary G and  $\overline{G}$  inputs. These devices feature high fan-out, improved fan-in, 700-mV typical noise margin, and the capability of driving lines with terminations as low as 133 ohms.

| SN74S340 FUNCTION 1 | TABLE |
|---------------------|-------|
|---------------------|-------|

| 1G | 2Ğ | 1Y OUTPUTS             | 2Y OUTPUTS             |
|----|----|------------------------|------------------------|
| н  | н  | Z                      | Z                      |
| н  | L  | z                      | Enabled                |
| L  | н  | Enabled<br>(Inverting) | Z                      |
| L  | L  | Enabled<br>(Inverting) | Enabled<br>(Inverting) |

SN74S341 FUNCTION TABLE

| 1G | 2G | 1Y OUTPUTS | 2Y OUTPUTS |
|----|----|------------|------------|
| Ĥ  | н  | Z          | Enabled    |
| н  | L  | z          | Z          |
| L  | н  | Enabled    | Enabled    |
| L  | L  | Enabled    | z          |

SN74S344 FUNCTION TABLE

| 1G | 2G | 1Y OUTPUTS | 2Y OUTPUTS |
|----|----|------------|------------|
| н  | н  | Z          | Z          |
| н  | L  | z          | Enabled    |
| L  | н  | Enabled    | Z          |
| L  | L  | Enabled    | Enabled    |

Z = high impedance (output off)

SN74S340 ... J OR N PACKAGE (TOP VIEW)



SN74S341 ... J OR N PACKAGE (TOP VIEW)







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## schematics of inputs and outputs



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1) | 7 V    |
|--|--------|
| Input voltage                                | 5.5 V  |
| Off-state output voltage                     | 5.5 V  |
| Operating free-air temperature range         | ა 70°C |
| Storage temperature range $-65^{\circ}$ C to | 150°C  |

## recommended operating conditions

| PARAMETER                                      | MIN  | NOM | MAX  | UNIT |
|--|------|-----|------|------|
| Supply voltage, V <sub>CC</sub> (see Note 1)   | 4.75 | 5   | 5.25 | ν    |
| High-level output current, IOH                 |      |     | -15  | mA   |
| Low-level output current, IOL                  |      |     | 64   | mA   |
| Operating free-air temperature, T <sub>A</sub> | 0    |     | 70   | °C   |

NOTE 1: Voltage values are with respect to network ground terminal.

.

## electrical characteristics over recommended operating conditions (unless otherwise noted)

| <b>[</b>         |   |                          |                         | 5   | SN74S34          | 10      | SN74S |                  |      |            |
|------------------|---|--------------------------|-------------------------|-----|------------------|---------|-------|------------------|------|------------|
|                  | PARAMETER                                       | TEST CON                 | DITIONS                 | MIN | TYP <sup>‡</sup> | MAX     | MIN   | TYP <sup>‡</sup> | MAX  | UNIT       |
| V <sub>T+</sub>  | Positive-going threshold voltage                |                          |                         | 1.3 | 1.5              | 1.9     | 1.3   | 1.5              | 1.9  | v          |
| V <sub>T</sub> _ | Negative-going threshold voltage                |                          |                         | 0.6 | 0.85             | 1.05    | 0.6   | 0.85             | 1.05 | V          |
|                  | Hysteresis (V <sub>T+</sub> - V <sub>T</sub> _) |                          |                         | 0.3 | 0.65             |         | 0.3   | 0.65             |      | V          |
| VIK              | Input clamp voltage                             | V <sub>CC</sub> = MIN,   | l <sub>l</sub> =18 mA   |     |                  | -1.2    |       |                  | -1.2 | v          |
|                  |   | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V,  | 24  |                  |         | 24    |                  |      |            |
|                  |   | V <sub>IL</sub> = 0.5 V, | 1 <sub>OH</sub> = -1 mA | 2.4 |                  |         | 2.4   |                  |      |            |
| Vou              | High-level output voltage                       | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V,  | 24  | 34               |         | 24    | 34               |      |            |
| <sup>v</sup> ∪H  |   | V <sub>IL</sub> = 0.5 V, | I <sub>OH</sub> = −3 mA | 2.7 | 0.4              |         | 2.4   | 0.4              |      | ľ          |
|                  |   | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V,  | 2   |                  |         | 2     |                  |      |            |
|                  |   | V <sub>IL</sub> = 0.5 V, | I <sub>OH</sub> = MAX   | -   |                  |         | -     |                  |      |            |
| Voi              | l ow-level output voltage                       | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V,  |     |                  | 0.55    |       |                  | 0 55 | v          |
| VUL              |   | V <sub>IL</sub> = 0.5 V, | IOL = MAX               |     |                  | 0.55    |       |                  | 0.00 | Ů          |
|                  | Off-state output current,                       | Vcc = MAX                | $V_0 = 24 V$            |     |                  | 50      |       |                  | 50   |            |
| ·02H             | high-level voltage applied                      | $V_{111} = 2V$           | 10 2.41                 |     |                  |         |       |                  |      | uΔ         |
| 1071             | Off-state output current,                       | $V_{\rm H} = 0 V$        | $V_0 = 0.5 V$           |     |                  | -50     |       |                  | 50   | <b>#</b> ^ |
| 1021             | low-level voltage applied                       |                          | 10 0.01                 |     |                  |         |       |                  |      |            |
| і <u>п</u>       | Input current at maximum                        | Vcc = MAX                | Vi = 5.5 V              |     |                  | 1       |       |                  | 1    | mΑ         |
|                  | input voltage                                   |                          |                         |     |                  | · · · · |       |                  | ·    |            |
| Чн               | High-level input current, any input             | V <sub>CC</sub> = MAX,   | V <sub>1</sub> = 2.7 V  |     |                  | 50      |       |                  | 50   | μA         |
| - Iu             | Low-level input current Any A                   | Vcc = MAX                | $V_1 = 0.5 V$           |     |                  | 250     |       |                  | -250 | μA         |
| 16               | AnyGorG   |                          |                         |     |                  | -250    |       |                  | -250 | μA         |
| los              | Short-circuit output current*                   | V <sub>CC</sub> = MAX    |                         | -50 |                  | -225    | -50   |                  | -225 | mA         |
|                  |   | Vcc = MAX                | Outputs high            |     |                  | 75      |       |                  | 135  |            |
| l lcc            | Supply current                                  | Outputs open             | Outputs low             |     |                  | 170     |       |                  | 180  | mA         |
|                  |   | carpats open             | Outputs disabled        |     |                  | 110     |       |                  | 145  |            |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

•Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

## switching characteristics, V<sub>CC</sub> = 5 V, T<sub>A</sub> = $25^{\circ}$ C

| BADAMETED        | TEST CO                 | S                     | N74S3 | 40  | S   | N74S3 | 41  | SI  |     |     |    |    |
|------------------|-------------------------|-----------------------|-------|-----|-----|-------|-----|-----|-----|-----|----|----|
|                  | 1231 001                | MIN                   | TYP   | MAX | MIN | түр   | MAX | MIN | ТҮР | MAX |    |    |
| <sup>t</sup> PLH |                         |                       |       | 7   | 11  |       | 10  | 15  |     | 10  | 15 | ns |
| <sup>t</sup> PHL | С <sub>L</sub> = 50 pF, | $R_{L} = 90 \Omega$ , |       | 8   | 12  |       | 8   | 12  |     | 8   | 12 | ns |
| <sup>t</sup> PZL | See Note 2              |                       |       | 17  | 25  |       | 14  | 21  |     | 14  | 21 | ns |
| <sup>t</sup> PZH |                         |                       |       | 11  | 16  |       | 11  | 17  |     | 11  | 17 | ns |
| tPLZ             | С <sub>L</sub> = 5 pF,  | RL = 90 Ω,            |       | 11  | 17  |       | 16  | 25  |     | 14  | 23 | ns |
| tphz             | See Note 2              |                       |       | 5   | 9   |       | 8   | 13  |     | 5   | 9  | ns |

NOTE 2: Load circuit and voltage waveforms are shown on page 1-14.

 $t_{PLH} \equiv Propagation delay time, low-to-high-level input$ 

 $t_{PHL} \equiv Propagation delay time, high-to-low-level input$ 

 $t_{PZL} \equiv Output enable time to low level$ 

 $t_{PZH} \equiv Output$  enable time to high level

 $t_{PLZ} \equiv Output disable time from low level$  $<math>t_{PHZ} \equiv Output disable time from high level$ 



BULLETIN NO. DL-S 12476, OCTOBER 1976-REVISED FEBRUARY 1979

- Clock Generator/Driver for The TMS 9900 or Other Microprocessors
- High-Level 4-Phase Outputs
- Complementary TTL 4-Phase Outputs
- Self-Contained Oscillator Can be Crystal or Capacitor Controlled
- External Oscillator Can Be Used
- Clocked D-Type Flip-Flop With Schmitt-Trigger Input For Reset Signal Synchronization



## description

TTL MSI

The 'LS362 consists of an oscillator, divide-by-four counter, a second divide-by-four counter with gating to generate four clock phases, high-level (12-volt) output drivers, low-level (5-volt) complementary output drivers, and a D-type flip-flop controlled by an external signal and the  $\phi$ 3 clock. The four high-level clock phases provide clock inputs to a TMS 9900 microprocessor. The four complementary TTL-level clocks can be used to time memory or other logic functions in a TMS 9900 computer system. The D-type flip-flop can be used to provide (for example) a reset signal to a TMS 9900, timed by  $\phi$ 3, on receipt of an input to the FFD input from power turn-on or a manual switch closure. Other applications are possible. A safety feature has been incorporated in the  $\phi$  outputs such that if an open occurs in the V<sub>CC</sub> supply common to 'LS362 and TMS 9900, the  $\phi$  outputs will go low thus protecting the TMS 9900.

The frequency of the internal oscillator can be established by a quartz crystal or capacitor and LC circuit. Either a fundamental or overtone crystal may be used. The LC circuit connected to the tank inputs selects the desired crystal overtone or establishes the internal oscillator frequency when a capacitor is used instead of a crystal. An LC circuit must always be used at the tank inputs when using the internal oscillator. An external oscillator can be used, if desired, see "Applications Information" for details.

CAUTION: Power dissipation at 3 MHz requires the use of a heat sink that provides a thermal resistance from case to free air,  $R_{\theta}C_{A}$ , of not more than 32°C/W.

typical phase relationships of inputs and outputs (OSC is internal)



# TYPE SN74LS362 (TIM9904) Four-phase clock generator/driver

functional block diagram





schematics of inputs and outputs

absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage: V <sub>CC</sub> (see Note 1) |   |   |   |   |   |   |   |  |   |   |   |   |   |   |   |   |  |   |   |        |     |      | . 7 V  |
|--|---|---|---|---|---|---|---|--|---|---|---|---|---|---|---|---|--|---|---|--------|-----|------|--------|
| VDD (see Note 1)                             |   |   |   |   |   |   |   |  |   |   |   |   |   |   |   |   |  |   |   |        |     |      | 13 V   |
| Input voltage: OSCIN                         |   |   |   |   |   |   |   |  |   |   |   |   |   |   |   |   |  |   |   |        |     |      | 5.5 V  |
| FFD  |   |   |   |   |   |   |   |  |   |   |   |   |   |   |   |   |  |   |   | -(     | ).5 | ٧    | to 7 V |
| Operating free-air temperature range         | 9 |   |   |   |   |   |   |  |   |   |   |   |   |   |   |   |  |   |   | 1      | 0°0 | C to | 5 70°C |
| Storage temperature range                    | • | • | • | • | • | • | • |  | • | • | • | • | • | • | • | • |  | • | • | <br>65 | °C  | to   | 150°C  |

NOTE 1: Voltage values are with respect to the network ground terminals connected together.

## recommended operating conditions

|   |                 | MIN  | NOM | MAX  | UNIT |
|---|-----------------|------|-----|------|------|
| Supply voltages   | Vcc             | 4.75 | 5   | 5.25 | V    |
| Supply voltages   | V <sub>DD</sub> | 11.4 | 12  | 12.6 | V    |
|   | φ1, φ2, φ3, φ4  |      |     | -100 | μA   |
|   | All others      |      |     | -400 | μA   |
|   | φ1, φ2, φ3, φ4  |      |     | 4    | mA   |
| Low-level output current, IOL   | All others      |      |     | 8    | mA   |
| Internal oscillator frequency, fosc -   |                 |      | 48  | 54   | MHz  |
| External oscillator pulse width, tw(osc)  |                 | 25   |     |      | ns   |
| Setup time, FFD input (with respect to falling edge of $\phi$ 3), t <sub>su</sub> |                 | 50   |     |      | ns   |
| Hold time, FFD input (with respect to falling edge of $\phi$ 3), t <sub>h</sub>   |                 | 30¶  |     |      | ns   |
| Operating free-air temperature, T <sub>A</sub>                                    |                 | 0    |     | 70   | °C   |

 $\P$ The algebraic convention where the more negative limit is designated minimum is used in this data sheet for time intervals only.

**REVISED FEBRUARY 1979** 

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                   | PARAMETER                |                | TE                          | ST CONDITION              | VS                        | MIN                | түр‡                 | MAX  | UNIT    |
|-------------------|--------------------------|----------------|-----------------------------|---------------------------|---------------------------|--------------------|----------------------|------|---------|
| VIH               | High-level input voltage |                |                             |                           | *                         | 2                  |                      |      | V       |
| N.                | Low-level                | FFD            |                             |                           |                           |                    |                      | 0.5  | V       |
| VIL               | input voltage            | OSCIN          |                             |                           |                           |                    |                      | 0.8  | v       |
| $V_{T+} - V_{T-}$ | Hysteresis               | FFD            |                             |                           |                           | 0.4                | 0.8                  |      | V       |
| VIK               | Input clamp voltage      |                | V <sub>CC</sub> = 4.75 V,   | V <sub>DD</sub> = 11.4 V, | l <sub>l</sub> ≃ –18 mA   |                    |                      | -1.5 | V       |
| Vau               | High-level               | φ1, φ2, φ3, φ4 | V <sub>CC</sub> = 4.75 V,   |                           | 10H = -100 µA             | V <sub>DD</sub> -2 | V <sub>DD</sub> -1.5 | VDD  | v       |
| ⊻он               | output voltage           | Other outputs  | V <sub>DD</sub> = 11.4 V to | 12.6 V                    | l <sub>OH</sub> ≈ –400 µA | 2.7                | 3.4                  |      | Ů Ů     |
| -                 |                          | φ1, φ2, φ3, φ4 |                             |                           | IOL = 4 mA                |                    | 0.25                 | 0.4  |         |
| VOL               |                          | Other outputs  | V <sub>CC</sub> = 4.75 V, 1 | V <sub>DD</sub> = 11.4 V  | IOL = 4 mA                |                    | 0.25                 | 0.4  | mA      |
|                   |                          | Other outputs  |                             |                           | I <sub>OL</sub> = 8 mA    |                    | 0.35                 | 0.5  |         |
| 1.                | Input current at         | FFD            | $V_{00} = 5.25 V$           | Vpp = 126 V               | Vj = 7 V                  |                    |                      | 0.1  | mA      |
| 'I                | maximum input voltage    | OSCIN          | VCC - 5.25 V,               | VDD - 12.0 V              | Vj = 5.5 V                |                    |                      | 0.3  |         |
|                   | High-level               | FFD            | $V_{00} = 5.25 V$           | Vpp = 126 V               | $V_1 = 2.7 V$             |                    |                      | 20   |         |
| 111               | input current            | OSCIN          | VCC 5.25 V,                 | •DD = 12:0 •,             | 1 2.7 0                   |                    |                      | 60   | <u></u> |
|                   | Low-level                | FFD            | Voo = 5.25 V                | Vpp = 126 V               | $V_{1} = 0.4 V$           |                    |                      | -0.4 | mA      |
| '16               | input current            | OSCIN          | VCC - 5.25 V,               | VDD - 12.0 V,             | v] = 0.4 v                |                    |                      | -3.2 |         |
| 100               | Short-circuit            | All except     | $V_{00} = 5.25 V$           |                           |                           | _20                |                      |      | mA      |
| ios               | output current‡          | φ1, φ2, φ3, φ4 | VCC - 5.25 V                |                           |                           | -20                |                      | -100 |         |
| 100               | Supply current from Vo   |                | V <sub>CC</sub> = 5.25 V,   | FFD and OSCIN             | N at GND,                 |                    | 105                  | 175  | mA      |
| -00               | Supply content from vC   | .u             | Outputs open                |                           |                           |                    | 105                  | 175  |         |
| Inn               | Supply current from Ve   |                | V <sub>CC</sub> = 5.25 V,   | V <sub>DD</sub> = 12.6 V, |                           |                    | 12                   | 20   | mΑ      |
| ""                | Suppry content from v    | טו             | FFD and OSCIN               | at GND,                   | Outputs open              |                    | 12                   | 20   |         |

<sup>†</sup>All typical values are at  $V_{CC} = 5 V$ ,  $V_{DD} = 12 V$ ,  $T_A = 25^{\circ}C$ .

<sup>‡</sup>Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second. Outputs  $\phi_1$ ,  $\phi_2$ ,  $\phi_3$ , and  $\phi_4$  do not have short-circuit protection.

## switching characteristics, $T_A = 25^{\circ}$ C, $V_{CC} = 5$ V, $V_{DD} = 12$ V, $f_{osc} = 48$ MHz, see figure 1

|                        | PARAMETER  | TEST CONDITIONS             | MIN¶ | түр | MAX | UNIT |
|------------------------|--|-----------------------------|------|-----|-----|------|
| fout                   | Output frequency, any $\phi$ or $\overline{\phi}$ TTL    |                             |      | 3   |     | MHz  |
| fout                   | Output frequency, OSCOUT                                 |                             |      | 12  |     | MHz  |
| t <sub>c</sub> (φ)     | Cycle time, any $\phi$ output                            |                             | 330  | 333 | 340 | ns   |
| <sup>t</sup> r(φ)      | Rise time, any $\phi$ output                             | 1                           | 5    | 9   | 20  | ns   |
| tf(φ)                  | Fall time, any $\phi$ output                             |                             | 10   | 14  | 20  | ns   |
| t <sub>w</sub> (φ)     | Pulse width, any $\phi$ output high                      |                             | 40   | 55  | 70  | ns   |
| <sup>t</sup> ø1L, ø2H  | Delay time, $\phi$ 1 low to $\phi$ 2 high                |                             | 0    | 5   | 15  | ns   |
| <sup>t</sup> φ2L, φ3H  | Delay time, $\phi 2$ low to $\phi 3$ high                |                             | 0    | 5   | 15  | ns   |
| <sup>t</sup> φ3L, φ4H  | Delay time, $\phi$ 3 low to $\phi$ 4 high                |                             | 0    | 5   | 15  | ns   |
| <sup>t</sup> φ4L, φ1H  | Delay time, $\phi$ 4 low to $\phi$ 1 high                | Output loads:               | 0    | 5   | 15  | ns   |
| <sup>t</sup> ø1H, ø2H  | Delay time, $\phi$ 1 high to $\phi$ 2 high               | φ1, φ3, φ4: 100 pF to GND   | 73   | 83  | 96  | ns   |
| <sup>t</sup> ø2H, ø3H  | Delay time, $\phi$ 2 high to $\phi$ 3 high               | φ2: 200 pF to GND           | 73   | 83  | 96  | ns   |
| <sup>t</sup> ¢3H, ¢4H  | Delay time, $\phi$ 3 high to $\phi$ 4 high               | Others: $R_L = 2 k\Omega$ , | 73   | 83  | 96  | ns   |
| <sup>t</sup> φ4H, φ1H  | Delay time, $\phi$ 4 high to $\phi$ 1 high               | С <sub>L</sub> = 15 рF      | 73   | 83  | 96  | ns   |
| <sup>t</sup> φH, φ TL_ | Delay time, $\phi_n$ high to $\overline{\phi}_n$ TTL low | See Note 2                  | -14  | -4  | 6   | ns   |
| <sup>t</sup> φL, φTH   | Delay time, $\phi_n$ low to $\overline{\phi}_n$ TTL high |                             | -29  | -19 | -9  | ns   |
| <sup>t</sup> ¢3L, QH   | Delay time, $\phi$ 3 low to FFQ output high              |                             | -18  | 8   | 2   | ns   |
| <sup>t</sup> ø3L, QL   | Delay time, $\phi$ 3 low to FFQ output low               |                             | -19  | 9   | 1   | ns   |
| <sup>t</sup> φL, OSOH  | Delay time, $\phi$ low to OSCOUT high                    |                             | -30  | -20 | -10 | ns   |
| <sup>t</sup> ¢H, OSOL  | Delay time, $\phi$ high to OSCOUT low                    |                             | -27  | -17 | -7  | ns   |

NOTE 2: Use load circuit for bi-state totem-pole outputs, page 1-15.

 $\P$  The algebraic convention where the more negative limit is designated minimum is used in this data sheet for time intervals only.

## PARAMETER MEASUREMENT INFORMATION



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## **APPLICATION INFORMATION**

Figure 2 shows the 'LS362 connected to a TMS9900. The oscillator is shown operating with a quartz crystal and an LC circuit connected to the tank terminals.

For operation of the TMS 9900 microprocessor at 3 MHz, the frequency reference will need a resonant frequency of 48 MHz (16 x 3 MHz). A quartz crystal used as a frequency reference should be made for series-mode operation with a resistance in the 20- to 75-ohm range and be capable of a minimum of 2 mW power dissipation. Typical frequency tolerance is  $\pm 0.005\%$ . For 48-MHz operation a third-overtone crystal is used. The inductance L connected across the tank terminals should be 0.47  $\mu$ H  $\pm$  10%, and the capacitance C (including board capacity) should be 22 pF  $\pm$  5%. The LC circuit should be tuned to the third-overtone crystal frequency for best results. A 0.1- $\mu$ F capacitor can be substituted for the quartz crystal. With a capacitor rather than a crystal, the LC tuned circuit establishes the operating frequencies. LC component values for operation at any frequency can be computed from  $f_{OSC} = 1/(2\pi\sqrt{LC})$  where  $f_{OSC}$  is the oscillator frequency, L is the inductance value in henries, and C is the capacitance value in farads.

When the internal oscillator is being used, OSCIN should be connected to  $V_{CC}$  through a resistor (1 k $\Omega$  nominal) and an LC tank circuit must be connected to the tank inputs. An external oscillator can be used by connecting it to OSCIN and disabling the internal oscillator by connecting the crystal terminals to  $V_{CC}$  and leaving the tank inputs open. An external oscillator must have a frequency four times the desired output clock frequency and a 25% duty cycle. See Figure 3.

The first low-level external clock pulse will preset the divide-by-four counter, allowing the external oscillator signal to directly drive the phase generator. Figure 3 is a timing diagram illustrating operation with an external oscillator.

Resistors between  $\phi_1$ ,  $\phi_2$ ,  $\phi_3$ , and  $\phi_4$  outputs of the 'LS362 and the corresponding clock input terminals of the TMS 9900 should be in the 10- to 20-ohm range (See Figure 2). Their purpose is to minimize overshoot and undershoot. The required resistance value is dependent on circuit layout. Clock signal interconnections should be as short as possible.

The D-type flip-flop associated with pins FFD and FFQ can be used to provide a power-on reset and a manual reset to the TMS 9900 as shown in Figure 4. A Schmitt-trigger circuit driving the D input generates a fast-rising waveform when the input voltage rises to a specific value. At power turn-on, voltage across the 0.1  $\mu$ F capacitor in Figure 4 will rise towards V<sub>CC</sub>. This circuit provides a delay that resets the TMS 9900 after V<sub>CC</sub> has stabilized. An optional manual reset switch can be connected to the delay circuit for resetting the TMS 9900 at any time. The TMS 9900 HOLD signal could alternately be actuated by FFD.

The ground terminals GND1 and GND2 should be connected together and to system ground.



FIGURE 2-'LS362 CRYSTAL-CONTROLLED OPERATION



FIGURE 3-EXTERNAL OSCILLATOR TIMING



FIGURE 4-POWER-ON RESET

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# TTL MSI

## TYPES SN54LS373, SN54LS374, SN54S373, SN54S374, SN74LS373, SN74LS374, SN74S373, SN74S374 OCTAL D-TYPE TRANSPARENT LATCHES AND EDGE-TRIGGERED FLIP-FLOPS

BULLETIN NO. DL-S 12350, OCTOBER 1975 - REVISED JUNE 1979

- Choice of 8 Latches or 8 D-Type Flip-Flops In a Single Package
- 3-State Bus-Driving Outputs
- Full Parallel-Access for Loading
- Buffered Control Inputs
- Clock/Enable Input Has Hysteresis to Improve Noise Rejection
- P-N-P Inputs Reduce D-C Loading on Data Lines ('S373 and 'S374)
- SN54LS363 and SN74LS364 Are Similar But Have Higher  $V_{OH}$  For MOS Interface

| OUTPUT | ENABLE |   | OUTPUT     |
|--------|--------|---|------------|
| ENABLE | LATCH  | U | 001901     |
| L      | н      | н | н          |
| L      | н      | L | L          |
| L      | L      | х | <b>Q</b> 0 |
| L L    |        | v | 7          |

### 'LS373, 'S373 FUNCTION TABLE

## 'LS374, 'S374 FUNCTION TABLE

| OUTPUT<br>ENABLE | CLOCK | D | ουτρυτ     |
|------------------|-------|---|------------|
| L                | 1     | н | н          |
| L                | 1     | L | L          |
| L                | L     | х | <b>Q</b> 0 |
| н                | x     | x | Z          |

See explanation of function tables on page 1-13.

#### SN54LS373, SN54S373... J PACKAGE SN74LS373, SN74S373... J OR N PACKAGE (TOP VIEW)



logic: see function table





### description

These 8-bit registers feature totem-pole three-state outputs designed specifically for driving highly-capacitive or relatively low-impedance loads. The high-impedance third state and increased high-logic-level drive provide these registers with the capability of being connected directly to and driving the bus lines in a bus-organized system without need for interface or pull-up components. They are particularly attractive for implementing buffer registers, I/O ports, bidirectional bus drivers, and working registers.

The eight latches of the 'LS373 and 'S373 are transparent D-type latches meaning that while the enable (G) is high the  $\Omega$  outputs will follow the data (D) inputs. When the enable is taken low the output will be latched at the level of the data that was set up.

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## TYPES SN54LS373, SN54LS374, SN54S373, SN54S374, SN74LS373, SN74LS374, SN74S373, SN74S374 OCTAL D-TYPE TRANSPARENT LATCHES AND EDGE-TRIGGERED FLIP-FLOPS

## description (continued)

The eight flip-flops of the 'LS374 and 'S374 are edge-triggered D-type flip-flops. On the positive transition of the clock, the Q outputs will be set to the logic states that were setup at the D inputs.

Schmitt-trigger buffered inputs at the enable/clock lines simplify system design as ac and dc noise rejection is improved by typically 400 mV due to the input hysteresis. A buffered output control input can be used to place the eight outputs in either a normal logic state (high or low logic levels) or a high-impedance state. In the high-impedance state the outputs neither load nor drive the bus lines significantly.

The output control does not affect the internal operation of the latches or flip-flops. That is, the old data can be retained or new data can be entered even while the outputs are off.







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## TYPES SN54LS373, SN54LS374, SN74LS373, SN74LS374 OCTAL D-TYPE TRANSPARENT LATCHES AND EDGE-TRIGGERED FLIP-FLOPS



| input voitage .    |           | •    | •   | •   | •   | • •  | •  | • | • | • | • | • | • | •  | • | • | • | • | • | • | • | • | •   | •     | / V    |
|--------------------|-----------|------|-----|-----|-----|------|----|---|---|---|---|---|---|----|---|---|---|---|---|---|---|---|-----|-------|--------|
| Off-state output v | oltage    |      |     |     |     |      |    |   |   |   |   |   |   |    |   |   |   |   |   |   |   |   | . • |       | 7 V    |
| Operating free-air | tempera   | ture | ran | ge: | SN5 | 54LS | ۰. |   |   |   |   |   |   | ۰. |   |   |   |   |   |   |   |   | ·55 | °C to | 125°C  |
|                    |           |      |     | :   | SN7 | 4LS  | ٠. |   |   |   |   |   |   |    |   |   |   |   |   |   |   |   |     | 0°C 1 | o 70°C |
| Storage temperatu  | ire range |      |     |     |     |      |    |   |   |   |   |   |   |    |   |   |   |   |   |   |   |   | ·65 | °C to | 150°C  |
|                    |           |      |     |     |     |      |    |   |   |   |   |   |   |    |   |   |   |   |   |   |   |   |     |       |        |

NOTE 1: Voltage values are with respect to network ground terminal.

## recommended operating conditions

|                                    |        |     | SN54LS | ,   |      | SN74LS |      |    |
|------------------------------------|--------|-----|--------|-----|------|--------|------|----|
|                                    |        | MIN | NOM    | MAX | MIN  | NOM    | MAX  |    |
| Supply voltage, V <sub>CC</sub>    |        | 4.5 | 5      | 5.5 | 4.75 | 5      | 5.25 | V  |
| High-level output voltage, VOH     |        |     |        | 5.5 |      |        | 5.5  | V  |
| High-level output current, IOH     |        |     |        | - 1 | 1    |        | -2.6 | mA |
| Midth of clock/onchis pulses t     | High   | 15  |        |     | 15   |        |      |    |
| whath of clock/enable pulse, tw    | Low    | 15  |        |     | 15   |        |      | ns |
| Data active time t                 | 'LS373 | 01  |        |     | 01   |        |      |    |
| Data setup time, t <sub>su</sub>   | 'LS374 | 20↑ |        |     | 20↑  | _      |      | ns |
| Data hald time to                  | 'LS373 | 101 |        |     | 10↓  |        |      |    |
|                                    | 'LS374 | 0↑  |        |     | 01   |        |      | ns |
| Operating free-air temperature, TA |        | -55 |        | 125 | 0    |        | 70   | °C |

1 The arrow indicates the transition of the clock/enable input used for reference: 1 for the low-to-high transition, 4 for the high-to-low transition.

## **TYPES SN54LS373, SN54LS374, SN74LS373, SN74LS374** OCTAL D-TYPE TRANSPARENT LATCHES AND **EDGE-TRIGGERED FLIP-FLOPS**

REVISED AUGUST 1977

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                  |   |   |                         |     | SN54LS |                 | [   | SN74LS |      |      |
|------------------|---|---|-------------------------|-----|--------|-----------------|-----|--------|------|------|
|                  |   | TEST CONDITION  | <b>NS</b> '             | MIN | түр‡   | MAX             | MIN | TYP‡   | MAX  | UNIT |
| VIH              | High-level input voltage                  |   |                         | 2   | 2<br>1 |                 | 2   |        |      | v    |
| VIL              | Low-level input voltage                   |   |                         |     |        | 0.7             |     |        | 0.8  | V    |
| VIK              | Input clamp voltage                       | V <sub>CC</sub> = MIN, I <sub>I</sub> = -18 mA                      |                         |     |        | -1.5            |     |        | -1.5 | v    |
| VOH              | High-level output voltage                 | $V_{CC} = MIN, V_{IH} = 2 V,$<br>$V_{IL} = V_{IL}max, I_{OH} = MAX$ |                         | 2.4 | 3.4    | , , ,           | 2.4 | 3.1    |      | v    |
|                  |   | $V_{CC} = MIN, V_{IH} = 2V,$  | IOL = 12 mA             |     | 0.25   | 0.4             |     | 0.25   | 0.4  |      |
| VOL              | Low-level output voltage                  | Vir = Alrwax  | I <sub>OL</sub> = 24 mA |     |        | - <del>71</del> |     | 0.35   | 0.5  | v    |
|                  | Off-state output current,                 | $V_{CC} = MAX, V_{IH} = 2V,$  |                         |     |        |                 |     |        |      |      |
| <sup>i</sup> OZH | high-level voltage applied                | V <sub>O</sub> = 2.7 V  |                         |     |        | 20              |     |        | 20   | μΑ   |
|                  | Off-state output current,                 | $V_{CC} = MAX, V_{IH} = 2 V,$                                       |                         |     |        |                 |     |        |      |      |
| 'OZL             | low-level voltage applied                 | V <sub>O</sub> = 0.4 V  |                         |     |        | -20             |     |        | -20  | μΑ   |
| ų                | Input current at<br>maximum input voltage | V <sub>CC</sub> = MAX, V <sub>I</sub> = 7 V                         |                         |     |        | 0.1             |     |        | 0.1  | mA   |
| ЧΗ               | High-level input current                  | V <sub>CC</sub> = MAX, V <sub>I</sub> = 2.7 V                       |                         |     |        | 20              |     |        | 20   | μA   |
| 4L               | Low-level input current                   | V <sub>CC</sub> = MAX, V <sub>I</sub> = 0.4 V                       |                         |     |        | -0.4            |     |        | 0,4  | mA   |
| los              | Short-circuit output current§             | V <sub>CC</sub> = MAX   |                         | -30 |        | -130            | -30 |        | -130 | mA   |
| 100              | Supply current                            | V <sub>CC</sub> = MAX,  | 'LS373                  |     | 24     | 40              |     | 24     | 40   | -    |
| 100              | Supply current                            | Output control at 4.5 V   | 'LS374                  |     | 27     | 40              |     | 27     | 40   | mA   |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

 $\ddagger$  All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C. §Not more than one output should be shorted at a time and duration of the short circuit should not exceed one second.

| PARAMETER        | FROM     | то       | TEST CONDITIONS                              |     | 'LS37 | 3   |     | 'LS37 | 4   |      |
|------------------|----------|----------|--|-----|-------|-----|-----|-------|-----|------|
|                  | (INPUT)  | (OUTPUT) | TEST CONDITIONS                              | MIN | ТҮР   | MAX | MIN | ТҮР   | MAX | UNIT |
| f <sub>max</sub> |          |          |  |     |       |     | 35  | 50    |     | MHz  |
| tPLH             | Data     | Any 0    |  |     | 12    | 18  |     |       |     |      |
| <sup>t</sup> PHL | Data     | Any d    | C 45 pE . D 667 O                            |     | 12    | 18  |     |       |     | ns   |
| tPLH .           | Clock or | Any 0    | $C_{L} = 45 \text{ pF}, \text{ RL} = 667.52$ |     | 20    | 30  |     | 15    | 28  |      |
| <sup>t</sup> PHL | enable   | Any C    | See Notes 2 and 3                            |     | 18    | 30  |     | 19    | 28  | ns   |
| <sup>t</sup> PZH | Output   | A == 4 0 |  |     | 15    | 28  |     | 20    | 28  |      |
| <sup>t</sup> PZL | Control  | Any G    | 1  |     | 25    | 36  |     | 21    | 28' | ns   |
| <sup>t</sup> PHZ | Output   | A        | $C_L = 5 pF$ , $R_L = 667 \Omega$ ,          |     | 12    | 20  |     | 12    | 20  |      |
| <sup>t</sup> PLZ | Control  | Any u    | See Note 3                                   |     | 15    | 25  |     | 14    | 25  | ns   |

## switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

NOTES: 2. Maximum clock frequency is tested with all outputs loaded.

3. See load circuits and waveforms on page 1-15.

f<sub>max</sub> ≡ maximum clock frequency

 $t_{PLH} \equiv$  propagation delay time, low-to-high-level output

 $t_{PHL} \equiv$  propagation delay time, high-to-low-level output

tPZH ≅ output enable time to high level

tPZL = output enable time to low level

 $t_{PHZ} \equiv output disable time from high level$ 

 $t_{PLZ} \equiv$  output disable time from low level

## TYPES SN54S373, SN54S374, SN74S373, SN74S374 OCTAL D-TYPE TRANSPARENT LATCHES AND EDGE-TRIGGERED FLIP-FLOPS

## schematic of inputs and outputs





## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1) |     |    |     |    |   |  |   | • |  | • |  |  |   |    |         |      | . 7                | ' V |
|--|-----|----|-----|----|---|--|---|---|--|---|--|--|---|----|---------|------|--------------------|-----|
| Input voltage                                |     |    |     |    |   |  |   |   |  |   |  |  |   |    |         |      | 5.5                | i V |
| Off-state output voltage                     |     |    |     |    |   |  |   |   |  |   |  |  |   |    |         |      | 5.5                | v   |
| Operating free-air temperature rang          | je: | SN | 545 | 5′ |   |  |   |   |  |   |  |  |   | •. | <br>55° | C to | o 125              | °C  |
|  |     | SN | 745 | 5' |   |  |   |   |  |   |  |  |   |    | (       | )°C  | to 70 <sup>°</sup> | °C  |
| Storage temperature range                    |     | •  |     | •  | · |  | • | • |  |   |  |  | • | •  | <br>65° | C to | o 150°             | °C  |
| - 4. Materia                                 |     | 1  |     |    |   |  |   |   |  |   |  |  |   |    |         |      |                    |     |

NOTE 1: Voltage values are with respect to network ground terminal.

## recommended operating conditions

|                                    |                |     | SN54S' |     |      | SN74S' |      |                 |
|------------------------------------|----------------|-----|--------|-----|------|--------|------|-----------------|
|                                    |                | MIN | NOM    | MAX | MIN  | NOM    | MAX  |                 |
| Supply voltage, V <sub>CC</sub>    |                | 4.5 | 5      | 5.5 | 4.75 | 5      | 5.25 | V               |
| High-level output voltage, VOH     |                |     |        | 5.5 |      |        | 5.5  | V               |
| High-level output current, IOH     |                |     |        | -2  |      |        | -6.5 | mA              |
| Width of clock/onchio pulse t      | High           | 6   |        |     | 6    |        |      |                 |
| width of clock/enable pulse, tw    | Low            | 7.3 |        |     | 7.3  |        |      | 1 <sup>ns</sup> |
| Data satua tima t                  | ʻ\$373         | 01  |        |     | 01   |        |      |                 |
|                                    | <b>'</b> \$374 | 5†  |        |     | 5†   |        |      | ns              |
| Data hold time, to                 | <b>'</b> \$373 | 10Ļ |        |     | 10↓  |        |      |                 |
|                                    | <b>'</b> \$374 | 2↑  |        |     | 2↑   |        |      | ns              |
| Operating free-air temperature, TA |                | -55 |        | 125 | 0    |        | 70   | °C              |

↑↓ The arrow indicates the transition of the clock/enable input used for reference: ↑ for the low-to-high transition, ↓ for the high-to-low transition, tion,

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## TYPES SN54S373, SN54S374, SN74S373, SN74S374 OCTAL D-TYPE TRANSPARENT LATCHES AND EDGE-TRIGGERED FLIP-FLOPS

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                 | PARAMETER                    |               | TEST C   | ONDITIONST  | MIN | TYPT | MAX  | UNIT |
|-----------------|------------------------------|---------------|--|---|-----|------|------|------|
| ∨ін             | High-level input voltage     |               |  |   | 2   |      |      | V    |
| VIL             | Low-level input voltage      |               |  |   |     |      | 0.8  | V    |
| VIK             | input clamp voltage          |               | V <sub>CC</sub> = MIN,                             | lj =18 mA   |     |      | 1.2  | V    |
|                 |                              | SN54S'        | V <sub>CC</sub> = MIN,                             | V <sub>IH</sub> = 2 V,                            | 2.4 | 3.4  |      |      |
| ⊻он             | High-level output voltage    | SN745'        | V <sub>IL</sub> = 0.8 V,                           | IOH = MAX   | 2.4 | 3.1  |      |      |
| V <sub>OL</sub> | Low-level output voltage     |               | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>I <sub>OL</sub> = 20 mA |     |      | 0.5  | v    |
| 1               | Off-state output current,    |               | V <sub>CC</sub> = MAX,                             | V <sub>IH</sub> = 2 V,                            |     |      |      |      |
| I OZH           | high-level voltage applied   |               | V <sub>O</sub> = 2.4 V                             |   |     |      | 50   | μΑ   |
| 10-1            | Off-state output current,    |               | V <sub>CC</sub> = MAX,                             | V <sub>IH</sub> = 2 V,                            |     |      | 50   |      |
| 'OZL            | low-level voltage applied    |               | V <sub>O</sub> = 0.5 V                             |   | 1   |      | -50  |      |
| 1               | Input current at maximum     | input voltage | V <sub>CC</sub> = MAX,                             | V <sub>1</sub> = 5.5 V                            |     |      | 1    | mA   |
| Чн              | High-level input current     |               | V <sub>CC</sub> = MAX,                             | V1 = 2.7 V  |     |      | 50   | μA   |
| ΊL              | Low-level input current      |               | V <sub>CC</sub> = MAX,                             | V <sub>I</sub> = 0.5 V                            |     |      | 250  | μA   |
| los             | Short-circuit output current | \$            | V <sub>CC</sub> = MAX                              |   | -40 |      | -100 | mA   |
| 1               | Supply current               |               | Vee - MAX  | 'S373   |     | 105  | 160  |      |
| 'cc             |                              |               | VCC - MAA  | 'S374   |     | 90   | 140  |      |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. <sup>†</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C_{\star}$ 

Not more than one output should be shorted at a time and duration of the short circuit should not exceed one second.

# switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

| PARAMETER        | FROM     | то       | TEST CONDITIONS                                 | <b>'</b> \$373 |     |     | 'S374 |     |     |
|------------------|----------|----------|---|----------------|-----|-----|-------|-----|-----|
|                  | (INPUT)  | (OUTPUT) | TEST CONDITIONS                                 | MIN TYP        | MAX | MIN | түр   | MAX |     |
| fmax             |          |          |   |                |     | 75  | 100   |     | MHz |
| <sup>t</sup> PLH | Data     | Any 0    |   | 7              | 12  |     |       |     |     |
| tPHL             | Data     |          | $C_{1} = 15 \text{ pc}$ $R_{1} = 280 \text{ O}$ | 7              | 12  |     |       |     | ns  |
| tPLH             | Clock or | 1-1-1    | C_ 15 pF, N_ 200 32,                            | 7              | 14  |     | 8     | 15  |     |
| <b>tPHL</b>      | enable   | Any C    | See Notes 2 and 4                               | 12             | 18  |     | 11    | 17  | ns  |
| tpzh             | Output   | A=+ 0    |   | 8              | 15  |     | 8     | 15  |     |
| tPZL             | Control  | Any C    |   | 11             | 18  |     | 11    | 18  | ns  |
| <sup>t</sup> PHZ | Output   | Any 0    | $C_L = 5 pF$ , $R_L = 280 \Omega$ ,             | 6              | 9   |     | 5     | 9   |     |
| tpLZ             | Control  |          | See Note 3                                      | 8              | 12  |     | 7     | 12  | 115 |

NOTES: 2. Maximum clock frequency is tested with all outputs loaded.

4. See load circuits and waveforms on page 1-14.

f<sub>max</sub> ≡ maximum clock frequency

tPLH = propagation delay time, low-to-high-level output

tPHL = propagation delay time, high-to-low-level output

 $t_{PZH} \equiv output enable time to high level$ 

tpzL ≡ output enable time to low level

 $t_{PHZ} \equiv output disable time from high level$ 

 $t_{PLZ} \equiv$  output disable time from low level

## TYPES SN54LS374, SN54S374, SN74LS374, SN74S374 OCTAL D-TYPE TRANSPARENT LATCHES AND EDGE-TRIGGERED FLIP-FLOPS

## TYPICAL APPLICATION DATA



6

BULLETIN NO. DL-S 12351, OCTOBER 1975

- P-N-P Inputs and 3-State Outputs Maximize I/O and Data Bus Capabilities
- Data Latch Transparency Permits Asynchronous or Latched Receiver Modes
- Mode and Select Inputs Permit Storing With Outputs Enabled or Disabled
- Strobe-Controlled Flag Flip-Flop Indicates Status or Interrupt
- Asynchronous Clear Sets All Eight Data Lines Low and Initializes Status Flag
- High-Level Output Voltage, Typically 4 V, Drives Most MOS Functions Directly
- Direct Replacement for Intel 3212 or 8212



## description

TTL MSI

This high-performance eight-bit parallel expandable buffer register incorporates package and mode selection inputs and an edge-triggered status flip-flop designed specifically for implementing bus-organized input/output ports. The three-state data outputs can be connected to a common data bus and controlled from the appropriate select inputs to receive or transmit data. An integral status flip-flop provides package busy or request interrupt commands. The outputs, with a 4-volt typical high-level voltage, are compatible for driving low-threshold MOS directly.

### DATA LATCHES

The eight data latches are fully transparent when the internal gate enable, G, input is high and the outputs are enabled (OE = H). Latch transparency is selected by the mode control (M), select ( $\overline{S1}$  and S2), and the strobe (STB) inputs and during transparency each data output ( $DO_i$ ) follows its respective data input ( $DI_i$ ). This mode of operation can be terminated by clearing, de-selecting, or holding the data latches. See data latches function table.

### MODE SELECTION

An input mode or an output mode is selectable from this single input line. In the input mode, MD = L, the eight data latch inputs are enabled when the strobe is high regardless of device selection. If selected during an input mode, the outputs will follow the data inputs. When the strobe input is taken low, the latches will store the most-recently setup data.

In the output mode, M = H, the output buffers are enabled regardless of any other control input. During the output mode the content of the register is under control of the select ( $\overline{S1}$  and S2) inputs. See data latches function table.

### STATUS FLIP-FLOP

The status flip-flop provides a low-level output signal when:

- a. the package is selected
- b. a strobe input is received.

This status signal can be used to indicate that the register is busy or to initiate an interrupt type command.



## schematics of inputs and outputs



1076

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| FUNCTION  | CLEAR | м | <b>s</b> ī1 | S2 | <b>STB</b> | DATA IN | DATA OUT       |
|-----------|-------|---|-------------|----|------------|---------|----------------|
| 0         | L     | н | н           | х  | x          | x       | L              |
| Clear     | L     | L | L           | н  | L          | x       | L              |
| De aulunt | Х     | L | х           | L  | X          | X       | z              |
| De-select | x     | L | н           | x  | ×          | x       | z              |
| للملط     | н     | н | н           | L  | X          | x       | QO             |
| поіа      | н     | L | L           | н  | L          | x       | 0 <sub>0</sub> |
| Data Rus  | н     | н | L           | н  | X          | L       | L              |
| Data Dus  | н     | н | L           | н  | ×          | н       | н              |
| Data Rus  | H     | L | L           | н  | н          | L       | L              |
|           | н     | L | L           | н  | н          | н       | н              |

### DATA LATCHES FUNCTION TABLE

### STATUS FLIP-FLOP FUNCTION TABLE

| CLEAR | sī1 | S2 | STB | INT |
|-------|-----|----|-----|-----|
| L     | н   | X  | X   | н   |
| L     | х   | L  | ×   | н   |
| н     | x   | X  | ↓   | L   |
| н     | L   | н  | х   | L   |

 $H \equiv high \ level \ (steady \ state)$ 

L ≡ low level (steady state)

 $X \equiv irrelevant$  (any input, including transitions)

 $Z \equiv high impedance (off)$ 

 $\downarrow \equiv$  transition from low to high level

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1) . |          |     |   |   |   |   |       | • |   |   |   |   |   |   |    |     |      | . 7 V  |
|--|----------|-----|---|---|---|---|-------|---|---|---|---|---|---|---|----|-----|------|--------|
| Input voltage                                  |          |     |   |   | • |   |       |   |   |   |   | • | • | • |    | •   |      | 5.5 V  |
| Operating free-air temperature range:          | SN54S412 | ! . |   |   |   |   |       |   |   |   |   |   |   |   | -5 | 5°C | C to | 125°C  |
|  | SN74S412 | ! . |   |   |   |   |       |   |   |   |   |   |   |   |    | 0°  | C to | o 70°C |
| Storage temperature range                      |          | •   | • | · | • | • | <br>• | · | • | · | · | • | • | • | -6 | 5°C | C to | 150°C  |

NOTE 1: Voltage values are with respect to network ground terminal.

## recommended operating conditions

| [  | · · · · · · · · · · · · · · · · · · · | SN54S412    | SN74S412      |    |
|--|---------------------------------------|-------------|---------------|----|
|  |                                       | MIN NOM MAX | MIN NOM MAX   |    |
| Supply voltage, V <sub>CC</sub>            |                                       | 4.5 5 5.    | 5 4.75 5 5.25 | V  |
| Pulse width, tw                            | STB or \$1 • S2                       | 25          | 25            |    |
| (see Figures 1, 2, and 4)                  | Clear low                             | 25          | 25            |    |
| Setup time, t <sub>su</sub> (see Figure 3) |                                       | 15↓         | 15↓           | ns |
| Hold time, th (see Figures 1 and           | 13)                                   | 20↓         | 20↓           | ns |
| Operating free-air temperature,            | TA                                    | -55 12      | 5 0 70        | °C |

 $\downarrow$  The arrow indicates that the falling edge of the clock pulse is used for reference.

**REVISED FEBRUARY 1979** 

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                 |                              |  |  |   | s     | N54S41 | 2     | s    | N74S41 | 2     |             |
|-----------------|------------------------------|--|--|---|-------|--------|-------|------|--------|-------|-------------|
|                 | PARAMETER                    |  | TEST CO  | NDITIONS  | MIN   | TYPŦ   | MAX   | MIN  | түрŧ   | MAX   | UNIT        |
| VIH             | High-level input voltage     |  |  |   | 2     |        |       | 2    |        |       | V           |
| VIL             | Low-level input voltage      |  |  |   |       |        | 0.85  |      |        | 0.85  | V           |
| VIK             | Input clamp voltage          |  | V <sub>CC</sub> = MIN;                             | l <sub>l</sub> =18 mA                             |       |        | -1.2  |      |        | -1.2  | V           |
| V <sub>OH</sub> | High-level output voltage    |  | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8 V, | V <sub>IH</sub> = 2 V,<br>I <sub>OH</sub> = –1 mA | 3.4   | 4      |       | 3.65 | 4      |       | v           |
| Ver             |                              |  | $V_{CC} = MIN,$                                    | I <sub>OL</sub> = 15 mA                           |       |        | 0.45  |      |        | 0.45  | V           |
| VOL             |                              |  | VIL = 0.8 V  | 1 <sub>OL</sub> = 20 mA                           |       |        | 0.5   |      |        | 0.5   |             |
| 10711           | Off-state output current,    | DO 1 thru  |  | $V_0 = 24 V$                                      |       |        | 50    |      |        | 50    | <i>μ</i> Δ  |
| 102H            | high-level voltage applied   | DO 8   | *CC min,   | •0 2.4 •  |       |        |       |      |        |       | <i>µn</i>   |
|                 | Off-state output current,    | DO 1 thru  | Vcc = MAX  | $V_{O} = 0.5 V$                                   | ł     |        | -50   |      |        | 50    | uΔ          |
| -OZL            | low-level voltage applied    | DO 8   | •            | •0 •  |       |        |       |      |        |       | <i>µ</i> ,, |
| 1.              | Input current at             |  | Vcc = MAX  | $V_1 = 5.5 V$                                     | }     |        | 1     | }    |        | 1     | mA          |
| <u> </u>        | maximum input voltage        |  | VCC  | •1 5.5 •  |       |        |       |      |        | ·     |             |
| Чн              | High-level input current     |  | V <sub>CC</sub> = MAX,                             | V <sub>I</sub> = 5.25 V                           | 1     |        | 20    |      |        | 10    | μA          |
|                 |                              | <u></u> <u> </u> |  |   |       |        | 1     |      |        | 1     |             |
| ίι∟             | Low-level input current      | м  | V <sub>CC</sub> = MAX,                             | V <sub>1</sub> = 0.4 V                            | 1     |        | -0.75 |      |        | -0.75 |             |
|                 |                              | All others   |  |   | · · · |        | -0.25 |      |        | 0.25  | mA          |
| los             | Short-circuit output current | }  | V <sub>CC</sub> = MAX                              |   | -20   |        | -65   | -20  |        | -65   | mA          |
| 1cc             | Supply current               |  | V <sub>CC</sub> = MAX,                             | see Note 2  |       | 82     |       |      | 82     | 130   | mA          |

<sup>†</sup> For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions,

<sup>†</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

§Not more than one output should be shorted at a time,

NOTE 2: I<sub>CC</sub> is measured with all outputs open, clear input at 4.5 V, and all other inputs grounded.

## switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C

| PARAMETER        | FROM           | то     | FIGURE     | TEST CONDITIONS        | MIN | ТҮР | MAX | UNIT |
|------------------|----------------|--------|------------|------------------------|-----|-----|-----|------|
| tPLH             | STR 51 or S2   | Any    | 1          |                        |     | 18  | 27  |      |
| THL              | 310, 31, 01 32 | DO     | 1          | 0 20 = 5               |     | 15  | 25  | ns   |
| tPHL             | CLR            | Any DO | 2          | CL - SUPF,             |     | 18  | 27  | ns   |
| tPLH             | DI.            | DO.    | 2          | See Note S             |     | 12  | 20  |      |
| TPHL             |                | 001    | <u>з</u> , |                        |     | 10  | 20  | ns   |
| <sup>t</sup> ₽LH | S1 or S2       | INT    | 4          | CL = 30 pF,            |     | 12  | 20  |      |
| TPHL             | STB            | ĪNT    | 4          | See Note 3             |     | 16  | 25  | ] ns |
| <sup>t</sup> PZH | 51 S2 or M     |        | 5          | CL = 30 pF,            |     | 21  | 35  |      |
| <sup>t</sup> PZL | 51, 52, 01 M   |        | 5          | See Note 3             |     | 25  | 40  | ns   |
| <sup>t</sup> PHZ | 51 \$2 or M    | Any DO | 5          | C <sub>L</sub> = 5 pF, |     | 9   | 20  |      |
| <sup>t</sup> PLZ |                |        | 5          | See Note 3             |     | 12  | 20  | l ns |

 $t_{PLH} \equiv$  propagation delay time, low-to-high-level output

 $t_{PHL} \equiv$  propagation delay time, high-to-low-level output

 $t_{PZH} \equiv$  output enable time to high level

 $t_{PZL} \equiv$  output enable time to low level

 $t_{PHZ} \equiv$  output disable time from high level

 $t_{PLZ} \equiv$  output disable time from low level

NOTE 3: Load circuit and voltage waveforms are shown on page 1-14.



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BULLETIN NO. DL-S 12475, OCTOBER 1976-REVISED AUGUST 1977

- Designed to be Interchangeable With Intel 8224
- Single-Chip Clock Driver With Self-Contained Oscillator
- Specifically Designed to Drive All 8080A Microprocessors

## description

TTL MSI

This clock generator is capable of driving 12-volt lines. It contains a crystal-controlled oscillator, a divide-by-nine clock phase generator, two high-level drivers, and auxiliary circuitry.

The internal oscillator is designed to operate with fundamental-mode crystals, or with overtone-mode crystals when using a parallel-tuned circuit connected to the tank terminal, pin 13. The oscillator output appears on pin 12 and drives the divide-by-nine counter. The  $\div$ 9 clock phase generator output consists of phases  $\phi$ 2 for driving MOS inputs and  $\phi$ 2 TTL for driving TTL. Three other TTL outputs, status strobe, reset, and ready, are coupled to the divide-by-nine counter. A sync input from the 8080A is AND'ed with  $\phi$ 1A to produce the status strobe signal through an output NOR gate. The reset input works on a voltage-level basis by use of a Schmitt

## functional block diagram



READY SYNC OUT INPUT

RDYIN

RESET RESIN

ουτ

trigger. A rising voltage waveform is triggered at a particular voltage. A synchronized ready output is obtained by clocking with a  $\phi 2$  signal.

φ2 TTL STSTB

OUT

GND

The SN74LS424 is characterized for operation over the temperature range of  $0^{\circ}$ C to  $70^{\circ}$ C.



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schematics of inputs and outputs



## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note 1) .      |   |   |   |   |   |   |  |  |   |   |   |   |   |   |  |  |  |    |     |      |     | . 7   | v  |
|---|---|---|---|---|---|---|--|--|---|---|---|---|---|---|--|--|--|----|-----|------|-----|-------|----|
| Supply voltage, V <sub>DD</sub>         |   |   |   |   |   |   |  |  |   |   |   |   |   |   |  |  |  |    |     |      |     | 17    | v  |
| Input voltages (sync, reset, ready) .   |   | • |   |   |   |   |  |  |   |   |   |   |   |   |  |  |  |    |     |      |     | . 7   | 'V |
| Operating free-air temperature range, T | A |   |   |   |   |   |  |  |   |   |   |   |   |   |  |  |  |    | C   | )°C  | t t | o 70' | °Ċ |
| Storage temperature range               |   | • | • | • | • | • |  |  | • | • | • | • | • | • |  |  |  | -6 | 35° | °C 1 | to  | 150   | °C |

NOTE 1: Voltage values are with respect to network ground terminal.

## recommended operating conditions

|   | MIN                   | NOM | MAX  | UNIT |
|---|-----------------------|-----|------|------|
| Supply voltage, V <sub>CC</sub>                 | 4.75                  | 5   | 5.25 | V    |
| Supply voltage, V <sub>DD</sub>                 | 11.4                  | 12  | 12.6 | V    |
| Ready input setup time, t <sub>su</sub> (RDYIN) | $50 - \frac{4t_c}{9}$ |     |      | ns   |
| Ready input hold time, th(RDYIN)                | $\frac{4t_c}{9}$      |     |      | ns   |
| Operating free-air temperature range, TA        | 0                     | 25  | 70   | °C   |

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                   | PARAMETER                 |                | r                         | EST CONDITION             | NS                      | MIN  | TYP <sup>‡</sup> | MAX   | UNIT |
|-------------------|---------------------------|----------------|---------------------------|---------------------------|-------------------------|------|------------------|-------|------|
| N                 | High level input voltage  | Reset input    |                           |                           |                         | 2.6  |                  |       | V    |
| ▼IH               | High-level liput voltage  | All others     |                           |                           |                         | 2    |                  |       |      |
| VIL               | Low-level input voltage   |                |                           |                           |                         |      |                  | 0.8   | V    |
| $V_{T+} - V_{T-}$ | Hysteresis                | Reset input    |                           |                           |                         | 0.25 |                  |       | ٠V   |
| Viii              | Input clamp voltage       |                | $V_{00} = 4.75 V_{0}$     | Vpp = 11 4 V              | l <sub>l</sub> = -5 mA  |      |                  | -1    | V    |
| VIK I             | input clamp voltage       |                | VCC - 4.75 V,             | VDD ~ 11.4 V              | li =18 mA               |      |                  | -1.5  |      |
|                   |                           | φ1, φ2         |                           |                           | 100 - 100 -             | 9.4  | 10,4             |       |      |
| V <sub>OH</sub>   | High-level output voltage | Ready, reset   | V <sub>CC</sub> = 4.75 V, | V <sub>DD</sub> = 11.6 V  | 10H100 #A               | 3.6  | 3,9              |       | v    |
| 4                 |                           | Others         |                           |                           | 10H =1 mA               | 2.4  | 3.1              |       |      |
|                   |                           | φ1, φ2, reset, |                           |                           | Lat = 25 mA             |      | 0.2              | 0.45  |      |
| VOL               | Low-level output voltage  | status strobe  | V <sub>CC</sub> = 4.75 V, | V <sub>DD</sub> = 11.4 V  | 10L - 2.5 MA            |      | 0.2              | 0.45  | V    |
|                   |                           | ¢2 TTL, osc    | 1                         |                           | I <sub>OL</sub> = 15 mA |      | 0.25             | 0.45  |      |
| 1.                | Input current at          |                | Vac = 5.25 V              | V== = 12 6 V              | <u> </u>                |      |                  | 100   |      |
| <u>ч</u>          | maximum input voltage     |                | VCC - 5.25 V,             | VDD - 12.0 V,             | v1-7 v                  |      |                  | 100   | μΑ   |
| Чн                | High-level input current  |                | V <sub>CC</sub> = 5.25 V, | VDD = 12.6 V,             | V <sub>1</sub> = 5.25 V |      |                  | 10    | μA   |
| ЧL                | Low-level input current   |                | V <sub>CC</sub> = 5.25 V, | V <sub>DD</sub> = 12.6 V, | VI = 0.4 V              |      |                  | -0.25 | mA   |
| 100               | Short-circuit             | All except     | Vec = 5 V                 | V                         |                         | 10   |                  | 60    | mA   |
| 'OS               | circuit current §         | φ1,φ2          | 1°CC-5°,                  | VDD - 12 V                |                         | -10  |                  | -00   |      |
| Icc               | Supply current from VCC   |                | V <sub>CC</sub> = 5.25 V, | V <sub>DD</sub> = 12 V    |                         |      | 70               | 115   | mA   |
| IDD               | Supply current from VDD   |                | V <sub>DD</sub> = 12.6 V, | $V_{CC} = 5 V_{,}$        | See Note 2              |      | 6                | 12    | mA   |
| <u> </u>          |                           |                | V <sub>CC</sub> = 5 V,    | V <sub>DD</sub> = 12 V,   | V <sub>1</sub> = 2.5 V, |      |                  |       | ~F   |
|                   | input capacitance         |                | f = 1 MHz,                |                           | See Note 2              |      |                  | 8     | P۳   |

<sup>+</sup>All typical values are at  $V_{CC} = 5 V$ ,  $V_{DD} = 12 V$ ,  $T_A = 25^{\circ}C$ .

 Not more than one output should be shorted at a time,  $\phi$ 1 and  $\phi$ 2 do not have short-circuit protection. NOTE 2: I<sub>CC</sub> and I<sub>DD</sub> are measured with outputs disabled and open.

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## switching characteristics, $V_{CC}$ = 5 V, $V_{DD}$ = 12 V, $T_A$ = 25°C, see figure 1

|                      | PARAMETER   | TEST COND                                 | TIONS               | MIN                       | TYP                       | MAX                     | UNIT |
|----------------------|---|---|---------------------|---------------------------|---------------------------|-------------------------|------|
| f <sub>max</sub>     | Maximum oscillator frequency                              |   |                     | 27                        |                           |                         | MHz  |
| t <sub>c(osc)</sub>  | Oscillator cycle time                                     |   |                     | {                         | $\frac{t_c^{\dagger}}{9}$ |                         | ns   |
| <sup>t</sup> w(ø1)   | Pulse width, $\phi$ 1 high                                | φ1 and φ2:                                |                     | $\frac{2t_c}{9} - 20$     |                           | · · · · ·               | ns   |
| <sup>t</sup> w(ø2)   | Pulse width, $\phi 2$ high                                | C <sub>L</sub> = 20 pF to<br>See Figure 2 | 110 pF,             | $\frac{5t_c}{9} - 35$     |                           |                         | ns   |
| <sup>t</sup> w(SS)   | Pulse width, status strobe low                            | φ2 TTL:                                   |                     | <u>t</u> c – 15<br>9      |                           |                         | ns   |
| tr(ø)                | Rise time, clock outputs                                  | C <sub>L</sub> = 30 pF,                   | R1 = 300 $\Omega$ , |                           |                           | 20                      | ns   |
| <sup>t</sup> f(φ)    | Fall time, clock outputs                                  | R2 = 600 Ω,                               | See Figure 3        |                           |                           | 20                      | ns   |
| <sup>t</sup> ø1L,ø2H | Delay time, $\phi 1$ low to $\phi 2$ high                 | Status Strobe:                            |                     | 0                         |                           |                         | ns   |
| <sup>t</sup> φ2L,φ1H | Delay time, $\phi 2$ low to $\phi 1$ high                 | C <sub>L</sub> = 15 pF,                   | R1 = 2 kΩ,          | $\frac{2t_{c}}{9} - 30$   |                           |                         | ns   |
| <sup>t</sup> ø1H,ø2H | Delay time, $\phi$ 1 high to $\phi$ 2 high                | $R2 = 4 k\Omega,$                         | See Figure 3        | $\frac{2t_c}{9}$          |                           | $\frac{2t_{c}}{9} + 20$ | ns   |
|                      |   | OSC, Ready, Rese                          | t:                  |                           |                           | ·····                   |      |
| <sup>t</sup> φ2,φ2T  | Delay time, $\phi 2$ to $\phi 2$ TTL                      | C <sub>L</sub> = 10 pF,                   | $R1 = 2 k\Omega$ ,  | -5                        |                           | 15                      | ns   |
| <sup>t</sup> ø2H,SSL | Delay time, ¢2 high to status strobe low                  | R2 = 4 kΩ,                                | See Figure 3        | $\frac{6t_{\rm C}}{9}-50$ |                           | $\frac{6t_c}{9}$        | ns   |
| <sup>t</sup> RV, φ2L | Delay time, ready or reset<br>output valid to phase 2 low |   |                     | $\frac{4t_c}{9} - 25$     |                           |                         | ns   |

 $t_c \equiv t_c(\phi_1) = t_c(\phi_2)$ 

## EXAMPLE: switching times for $f_{osc} = 20 \text{ MHz} (t_{c(\phi 1)} = t_{c(\phi 2)} = 450 \text{ ns})$

|                      | PARAMETER                                  | TEST CONDITIONS | MIN  | TYP | MAX | UNIT |
|----------------------|--|-----------------|------|-----|-----|------|
| fosc                 | Oscillator frequency                       |                 |      | 20  |     | MHz  |
| tc(osc)              | Oscillator cycle time                      |                 |      | 50  |     | ns   |
| <sup>t</sup> w(φ1)   | Pulse width, ¢1 high                       |                 | . 80 |     |     | ns   |
| <sup>t</sup> w(φ2)   | Pulse width, $\phi 2$ high                 |                 | 215  |     |     | ns   |
| <sup>t</sup> w(SS)   | Pulse width, status strobe                 |                 | 35   |     |     | ns   |
| <sup>t</sup> φ1L,φ2H | Delay time, $\phi 1$ low to $\phi 2$ high  | Same as above   | 0    |     |     | ns   |
| <sup>t</sup> φ2L,φ1H | Delay time, $\phi 2$ low to $\phi 1$ high  |                 | 70   |     |     | ns   |
| <sup>t</sup> ø1H,ø2H | Delay time, $\phi$ 1 high to $\phi$ 2 high |                 | 100  |     | 120 | ns   |
| t                    | Delay time, $\phi^2$ high to               |                 | 250  |     | 200 |      |
| 'φ2H,SSL             | status strobe low                          |                 | 250  |     | 300 | 115  |
| tov (c)              | Delay time, ready or reset                 |                 | 175  |     |     | -    |
| ۲ν,φ2L               | output valid to $\phi$ 2 low               |                 | 1/5  |     |     |      |



NOTE: Transistion times, pulse widths, and interpulse relationships are distorted in this diagram in order to define various intervals, See Figure 5 for correct relative relationships,

## VOLTAGE WAVEFORMS

**FIGURE 1** 



6

## TYPICAL APPLICATION DATA

The 'LS424 is a single-chip clock generator/driver for 8080A CPU's, furnishing three clocks ( $\phi$ 1,  $\phi$ 2 and  $\phi$ 2 TTL), status strobe, reset, and ready signals. The 'LS424 contains a crystal-controlled oscillator, a divide-by-nine counter, two high-level drivers, and several auxiliary logic functions. Figure 4 is a functional block diagram of the SN74LS424. Figure 5 shows the relationship between  $\phi$ 1,  $\phi$ 2, and the oscillator frequency period.

### oscillator

A high order of clock frequency stability is provided by use of an external quartz crystal to set the oscillator frequency which is nine times the operating frequency of the 8080A. The quartz crystal is operated in a series-resonant mode. A fundamental-mode crystal requires no auxiliary circuitry, but an overtone-mode crystal requires an ac-coupled parallel-resonant circuit to be connected to the tank connection (pin 13). The parallel-resonant circuit, tuned to the oscillator frequency, compensates for the lower Q of the overtone-mode crystal. The required size of the circuit components can be calculated from  $f = 1/2\pi\sqrt{LC}$  where f is the oscillator frequency, L is inductance value, and C is capacitance value. Figure 6 shows an ac-coupled parallel-tuned circuit used with the SN74LS424.

### clock phase generator

The divide-by-nine clock phase generator contains a divide-by-nine counter, logic required to shape the clock pulses as shown under parameter measurement information, gates and flip-flops to generate auxiliary signals, and output drivers. The divide-by-nine counter waveforms are combined with gates to form a  $\phi$ 1 pulse with a width of two periods of the oscillator frequency, repeating at intervals of nine oscillator periods. Similarly, the  $\phi$ 2 pulse, having a width of five oscillator frequency periods, is formed lagging the  $\phi$ 1 pulse by two oscillator periods.

 $\phi$ 1 and  $\phi$ 2 outputs are provided by high-level drivers for direct connection to the 8080A CPU.  $\phi$ 2 TTL is derived in a manner similar to  $\phi$ 1 and  $\phi$ 2, but the output driver output is at TTL voltage levels. The  $\phi$ 2 TTL pulse width is the same as  $\phi$ 2. A  $\phi$ 2 TTL application is clocking in direct memory access activities. Figure shows the 'LS424 connected to an 8080A, quartz crystal, and LC circuits.

### status strobe

The 8080A CPU puts status information on its data bus at the beginning of each machine cycle that defines the nature of the machine operation for that cycle. A sync signal from the 8080A is gated by an internal timing signal ( $\phi$ 1A) and becomes a status strobe to notify system components that the status data is present on 8080A status output lines. The status strobe signal connects directly to the 'S428 system controller.

The status strobe signal is alternatively generated by the reset input. An external RC series network connected to V<sub>CC</sub> and the reset input will provide a rising voltage waveform when V<sub>CC</sub> is turned on. An internal Schmitt trigger circuit generates a sharp, fast-rising waveform when the reset input reaches a particular voltage value. The Schmitt trigger is connected to the D input of a flip-flop clocked by  $\phi$ 2D. When power is turned on, the combination of internal and external circuitry will produce a status strobe signal. A manual reset switch can be connected as in figure 6 to the RC network to produce reset and status strobe signals for the 8080A.

The ready signal indicates to the 8080A that an external device has completed transfer of data to or from the data bus. A ready signal input to the 'LS424 drives the D input of a flip-flop clocked by an internal  $\phi$ 2D signal. Timing requirements of the 8080A machine cycle are met by the synchronization with the system clocks provided by the flip-flop. This implementation saves about 200 ns of system time during memory cycles (as contrasted with generating a "wait request" within the 8080A's MOS logic) since the bipolar logic of the 'LS424 has much less delay.

## TYPICAL APPLICATION DATA



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# TYPES SN74S428(TIM8228), SN74S438(TIM8238) CONTROLLER AND BUS DRIVER FOR 8080A SYSTEMS

BULLETIN NO. DL-S 12468, OCTOBER 1976

 Designed to Be Interchangeable with Intel 8228 and 8238

| DESIGNATION         PIN NOS.         FUNCTION           D0 thru D7         15, 17, 12, 10, BIDIRECTIONAL DATA PORT<br>6, 19, 21, 8         (TO TMS 8080A)           D80 thru D87         13, 16, 11, 9, BIDIRECTIONAL DATA PORT<br>5, 18, 20, 7         (TO SYSTEM BUS)           I/OR         25         READ OUTPUT TO 1/O<br>(ACTIVE LOW)           IO/W         27         WRITE OUTPUT TO 1/O<br>(ACTIVE LOW)           MEMR         24         READ OUTPUT TO MEMORY<br>(ACTIVE LOW)           MEMW         26         WRITE OUTPUT TO MEMORY<br>(ACTIVE LOW)           MEMW         26         WRITE OUTPUT TO MEMORY<br>(ACTIVE LOW)           MEMW         26         INPUT TO INDICATE<br>TMS 8080A IS IN INPUT<br>MODE (ACTIVE HIGH)           INTA         23         INTERRUPT ACKNOWLEDGE<br>OUTPUT (ACTIVE HIGH)           HLDA         2         INPUT TO INDICATE<br>TMS 8080A IS IN WRITE           WR         3         SYSTEM DATA PORT           WR         2         INPUT TO INDICATE           MEM         2         SYSTEM DATA PORT           BUSEN         22         ENABLE INPUT (ACTIVE<br>LOW)           STSTB         1         STNOBE INPUT FROM<br>SN74LS424 (TIM8224)           VCC         28         SUPLY VOLTAGE (5 V)           GND         14         GROUND  |             | PIN DESIG       | SNATIONS                |   |
|--|-------------|-----------------|-------------------------|---|
| D0 thru D7         15, 17, 12, 10, BIDIRECTIONAL DATA PORT           6, 19, 21, 8         (TO TMS 8080A)           DB0 thru DB7         13, 16, 11, 9, BIDIRECTIONAL DATA PORT           5, 18, 20, 7         (TO SYSTEM BUS)           I/OR         25           READ OUTPUT TO 1/O<br>(ACTIVE LOW)           IO/W         27           WRITE OUTPUT TO I/O<br>(ACTIVE LOW)           MEMR         24           READ OUTPUT TO MEMORY<br>(ACTIVE LOW)           MEMW         26           WRITE OUTPUT TO MEMORY<br>(ACTIVE LOW)           MEMW         26           INPUT TO INDICATE           DBIN         4           TMS 8080A IS IN INPUT<br>MODE (ACTIVE HIGH)           INTA         2           INPUT TO INDICATE           INPUT TO INDICATE           INPUT TO INDICATE           WR         3           INPUT TO INDICATE           MODE (ACT   | DESIGNATION | PIN NOS.        | FUNCTION                |   |
| DU HRU D/         6, 19, 21, 8         (TO TMS 8080A)           DB0 thru DB7         13, 16, 11, 9,<br>5, 18, 20, 7         BIDIRECTIONAL DATA PORT<br>5, 18, 20, 7           I/OR         25         READ OUTPUT TO 1/O<br>(ACTIVE LOW)           IO/W         27         WRITE OUTPUT TO 1/O<br>(ACTIVE LOW)           MEMR         24         READ OUTPUT TO MEMORY<br>(ACTIVE LOW)           MEMW         26         WRITE OUTPUT TO MEMORY<br>(ACTIVE LOW)           MEMW         26         UNPUT TO INDICATE<br>TMS 8080A IS IN INPUT<br>MODE (ACTIVE HIGH)           INTA         23         INTERRUPT ACKNOWLEDGE<br>OUTPUT (ACTIVE LOW)           HLDA         2         INPUT TO INDICATE<br>TMS 8080A         INPUT TO INDICATE           WR         3         TMS 8080A IS IN WRITE<br>MODE (ACTIVE LOW)         SYSTEM DATA PORT           BUSEN         22         ENABLE INPUT (ACTIVE<br>LOW)         SYNCHRONIZING STATUS           STSTB         1         STNOBE INPUT FROM<br>SN74LS424 (TIM8224)           VCC         28         SUPLY VOLTAGE (5 V)           GND         14         GROUND <td>D0 .t. D7</td> <td>15, 17, 12, 10,</td> <td>BIDIRECTIONAL DATA PORT</td> <td></td>  | D0 .t. D7   | 15, 17, 12, 10, | BIDIRECTIONAL DATA PORT |   |
| DB0 thru DB713, 16, 11, 9,<br>5, 18, 20, 7BIDIRECTIONAL DATA PORT<br>(TO SYSTEM BUS)1/OR25READ OUTPUT TO 1/O<br>(ACTIVE LOW)10/W27WRITE OUTPUT TO 1/O<br>(ACTIVE LOW)MEMR24READ OUTPUT TO MEMORY<br>(ACTIVE LOW)MEMW26WRITE OUTPUT TO MEMORY<br>(ACTIVE LOW)DBIN4INPUT TO INDICATE<br>TMS 8080A IS IN INPUT<br>MODE (ACTIVE HIGH)INTA23INTERRUPT ACKNOWLEDGE<br>OUTPUT (ACTIVE HIGH)INTA23INPUT TO INDICATE<br>TMS 8080AWR2INPUT TO INDICATE<br>OUTPUT (ACTIVE HIGH)WR2SYSTEM DATA PORT<br>ENABLE INPUT (ACTIVE LOW)WR3SYSTEM DATA PORT<br>ENABLE INPUT (ACTIVE LOW)VCC28SUPPLY VOLTAGE (5 V)GND14GROUND   |             | 6, 19, 21, 8    | (TO TMS 8080A)          |   |
| DB0 (III DB)5, 18, 20, 7(TO SYSTEM BUS) $\overline{I/OR}$ 25READ OUTPUT TO I/O<br>(ACTIVE LOW) $\overline{IO/W}$ 27WRITE OUTPUT TO I/O<br>(ACTIVE LOW) $\overline{MEMR}$ 24READ OUTPUT TO MEMORY<br>(ACTIVE LOW) $\overline{MEMW}$ 26WRITE OUTPUT TO MEMORY<br>(ACTIVE LOW) $\overline{MEMW}$ 26WRITE OUTPUT TO MEMORY<br>(ACTIVE LOW) $\overline{MEMW}$ 26UNPUT TO INDICATE<br>TO INDICATEDBIN4TMS 8080A IS IN INPUT<br>MODE (ACTIVE HIGH)INTA23INTERRUPT ACKNOWLEDGE<br>OUTPUT (ACTIVE HIGH)<br>FROM TMS 8080AHLDA2INPUT TO INDICATE<br>TMS 8080AWR3TMS 8080A IS IN WRITE<br>MODE (ACTIVE LOW)WR22SYSTEM DATA PORT<br>ENABLE INPUT (ACTIVE<br>LOW)STSTB1STROBE INPUT FROM<br>SN74LS424 (TIM8224)VCC28SUPLY VOLTAGE (5 V)GND14GROUND  |             | 13, 16, 11, 9,  | BIDIRECTIONAL DATA PORT |   |
| I/OR25READ OUTPUT TO I/O<br>(ACTIVE LOW)IO/W27WRITE OUTPUT TO I/O<br>(ACTIVE LOW)MEMR24READ OUTPUT TO MEMORY<br>(ACTIVE LOW)MEMW26WRITE OUTPUT TO MEMORY<br>(ACTIVE LOW)DBIN4INPUT TO INDICATE<br>TMS 8080A IS IN INPUT<br>MODE (ACTIVE HIGH)INTA23INTERRUPT ACKNOWLEDGE<br>OUTPUT (ACTIVE LOW)HLDA2INPUT TO INDICATE<br>TMS 8080AWR3SYSTEM DATA PORT<br>ENABLE INPUT (ACTIVE LOW)WR3SYNCHRONIZING STATUS<br>STSTB1STROBE INPUT FROM<br>SN74LS424 (TIM8224)VCC28SUPLY VOLTAGE (5 V)GND14GROUND   |             | 5, 18, 20, 7    | (TO SYSTEM BUS)         |   |
| IOIN       23       (ACTIVE LOW)         IO/W       27       WRITE OUTPUT TO I/O<br>(ACTIVE LOW)         MEMR       24       READ OUTPUT TO MEMORY<br>(ACTIVE LOW)         MEMW       26       WRITE OUTPUT TO MEMORY<br>(ACTIVE LOW)         DBIN       4       INPUT TO INDICATE<br>TMS 8080A IS IN INPUT<br>MODE (ACTIVE HIGH)         INTA       23       INTERRUPT ACKNOWLEDGE<br>OUTPUT (ACTIVE LOW)         HLDA       2       INPUT TO INDICATE<br>TMS 8080A         WR       3       TMS 8080A         WR       3       SSSEA         WR       3       SYSTEM DATA PORT         BUSEN       22       ENABLE INPUT (ACTIVE<br>LOW)         STSTB       1       STROBE INPUT FROM<br>SN74LS424 (TIM8224)         VCC       28       SUPPLY VOLTAGE (5 V)         GND       14       GROUND  | I/OB        | 25              | READ OUTPUT TO I/O      |   |
| IO/W27WRITE OUTPUT TO I/O<br>(ACTIVE LOW)MEMR24READ OUTPUT TO MEMORY<br>(ACTIVE LOW)MEMW26WRITE OUTPUT TO MEMORY<br>(ACTIVE LOW)DBIN4INPUT TO INDICATE<br>TMS 8080A IS IN INPUT<br>MODE (ACTIVE HIGH)INTA23INTERRUPT ACKNOWLEDGE<br>OUTPUT (ACTIVE LOW)HLDA2INPUT TO INDICATE<br>TMS 8080AWR3TMS 8080A IS IN WRITE<br>HOLD ACKNOWLEDGEWR2INPUT TO INDICATE<br>TMS 8080AWR3SYSTEM DATA PORT<br>ENABLE INPUT (ACTIVE LOW)WR22ENABLE INPUT (ACTIVE<br>DODE (ACTIVE LOW)WR3SYSTEM DATA PORT<br>SYSTEM DATA PORTBUSEN22ENABLE INPUT (ACTIVE<br>LOW)STSTB1STROBE INPUT FROM<br>SN74LS424 (TIM8224)VCC28SUPPLY VOLTAGE (5 V)GND14GROUND   |             |                 | (ACTIVE LOW)            | ļ |
| Image: State of the state | 10/W        | 27              | WRITE OUTPUT TO I/O     |   |
| MEMR24READ OUTPUT TO MEMORY<br>(ACTIVE LOW)MEMW26WRITE OUTPUT TO MEMORY<br>(ACTIVE LOW)DBIN4INPUT TO INDICATE<br>TMS 8080A IS IN INPUT<br>MODE (ACTIVE HIGH)INTA23INTERRUPT ACKNOWLEDGE<br>OUTPUT (ACTIVE LOW)HLDA2INPUT TO INDICATE<br>HOLD ACKNOWLEDGE<br>OUTPUT (ACTIVE HIGH)WR3TMS 8080AWR3SYSTEM DATA PORTBUSEN22ENABLE INPUT (ACTIVE<br>LOW)STSTB1STROBE INPUT FROM<br>SN74LS424 (TIM8224)VCC28SUPLY VOLTAGE (5 V)GND14GROUND  |             |                 | (ACTIVE LOW)            | ł |
| MEMIN     LT     (ACTIVE LOW)       MEMW     26     WRITE OUTPUT TO MEMORY<br>(ACTIVE LOW)       INPUT     INPUT TO INDICATE       DBIN     4     TMS 8080A IS IN INPUT<br>MODE (ACTIVE HIGH)       INTA     23     INTERRUPT ACKNOWLEDGE<br>OUTPUT (ACTIVE LOW)       HLDA     2     INPUT YACKNOWLEDGE       WR     3     TMS 8080A       WR     3     INPUT YACKNOWLEDGE       WR     3     INPUT YACKNOWLEDGE       WR     3     SYSTEM DACKNOWLEDGE       WR     3     SYSTEM DATA PORT       BUSEN     22     ENABLE INPUT (ACTIVE<br>LOW)       STSTB     1     STROBE INPUT FROM<br>SN74LS424 (TIM8224)       VCC     28     SUPPLY VOLTAGE (5 V)       GND     14     GROUND  | MEMB        | 24              | READ OUTPUT TO MEMORY   | 1 |
| MEMW26WRITE OUTPUT TO MEMORY<br>(ACTIVE LOW)DBIN4INPUT TO INDICATEDBIN4TMS 8080A IS IN INPUT<br>MODE (ACTIVE HIGH)INTA23INTERRUPT ACKNOWLEDGE<br>OUTPUT (ACTIVE LOW)HLDA2HOLD ACKNOWLEDGE<br>INPUT (ACTIVE HIGH)<br>FROM TMS 8080AWR3INPUT TO INDICATE<br>FROM TMS 8080A IS IN WRITE<br>MODE (ACTIVE LOW)BUSEN22ENABLE INPUT (ACTIVE LOW)STSTB1SYNCHRONIZING STATUS<br>STROBE INPUT FROM<br>SN74LS424 (TIM8224)VCC28SUPPLY VOLTAGE (5 V)GND14GROUND  |             | 27              | (ACTIVE LOW)            |   |
| INDICATION     INPUT       DBIN     4     INPUT TO INDICATE       TMS 8080A IS IN INPUT     MODE (ACTIVE HIGH)       INTA     23     INTERRUPT ACKNOWLEDGE       UIPUT (ACTIVE LOW)     HOLD ACKNOWLEDGE       HLDA     2     INPUT (ACTIVE HIGH)       FROM TMS 8080A     INPUT TO INDICATE       WR     3     TMS 8080A       BUSEN     22     ENABLE INPUT (ACTIVE LOW)       BUSEN     22     ENABLE INPUT (ACTIVE LOW)       STSTB     1     STNOBE INPUT FROM<br>SN74LS424 (TIM8224)       VCC     28     SUPPLY VOLTAGE (5 V)       GND     14     GROUND   |             | 26              | WRITE OUTPUT TO MEMORY  |   |
| DBIN       4       INPUT TO INDICATE         TMS 8080A IS IN INPUT       MODE (ACTIVE HIGH)         INTA       23       INTERRUPT ACKNOWLEDGE         OUTPUT (ACTIVE LOW)       HOLD ACKNOWLEDGE       HOLD ACKNOWLEDGE         HLDA       2       INPUT (ACTIVE HIGH)         FROM TMS 8080A       INPUT TO INDICATE       FROM TMS 8080A         WR       3       TMS 8080A IS IN WRITE         MODE (ACTIVE LOW)       SYSTEM DATA PORT         BUSEN       22       ENABLE INPUT (ACTIVE LOW)         STSTB       1       STNOBE INPUT FROM         SN74LS424 (TIM8224)       VCC       28         VCC       28       SUPPLY VOLTAGE (5 V)         GND       14       GROUND   |             | 20              | (ACTIVE LOW)            |   |
| DBIN     4     TMS 8080A IS IN INPUT<br>MODE (ACTIVE HIGH)       INTA     23     INTERRUPT ACKNOWLEDGE<br>OUTPUT (ACTIVE LOW)       HLDA     2     HOLD ACKNOWLEDGE<br>INPUT (ACTIVE HIGH)       FROM TMS 8080A     INPUT TO INDICATE       WR     3     TMS 8080A IS IN WRITE<br>MODE (ACTIVE LOW)       BUSEN     22     ENABLE INPUT (ACTIVE LOW)       STSTB     1     STNOBE INPUT FROM<br>SN74LS424 (TIM8224)       VCC     28     SUPLY VOLTAGE (5 V)       GND     14     GROUND   |             |                 | INPUT TO INDICATE       |   |
| MODE (ACTIVE HIGH)       INTA     23       INTERRUPT ACKNOWLEDGE<br>OUTPUT (ACTIVE LOW)       HLDA     2       INPUT (ACTIVE HIGH)<br>FROM TMS 8080A       INPUT TO INDICATE       WR     3       TMS 8080A IS IN WRITE<br>MODE (ACTIVE LOW)       SYSTEM DATA PORT       BUSEN     22       ENABLE INPUT FROM<br>SYNCHRONIZING STATUS       STSTB     1       STSTB     1       VCC     28       SUPLY VOLTAGE (5 V)       GND     14   | DBIN        | 4               | TMS 8080A IS IN INPUT   |   |
| INTA     23     INTERRUPT ACKNOWLEDGE<br>OUTPUT (ACTIVE LOW)       HLDA     2     HOLD ACKNOWLEDGE     0       HLDA     2     INPUT (ACTIVE HIGH)<br>FROM TMS 8080A     1       WR     3     TMS 8080A IS IN WRITE<br>MODE (ACTIVE LOW)       BUSEN     22     SYSTEM DATA PORT<br>ENABLE INPUT (ACTIVE<br>LOW)       STSTB     1     STROBE INPUT FROM<br>SN74LS424 (TIM8224)       VCC     28     SUPLY VOLTAGE (5 V)       GND     14     GROUND  |             |                 | MODE (ACTIVE HIGH)      |   |
| INTR     23     OUTPUT (ACTIVE LOW)       HLDA     2     HOLD ACKNOWLEDGE     1       INPUT (ACTIVE HIGH)     FROM TMS 8080A     1       WR     3     INPUT TO INDICATE       WR     3     TMS 8080A IS IN WRITE       MODE (ACTIVE LOW)     SYSTEM DATA PORT       BUSEN     22     ENABLE INPUT (ACTIVE LOW)       STSTB     1     STROBE INPUT FROM<br>SN74LS424 (TIM8224)       VCC     28     SUPPLY VOLTAGE (5 V)       GND     14     GROUND  | INITA       | 22              | INTERRUPT ACKNOWLEDGE   |   |
| HLDA     2     HOLD ACKNOWLEDGE     1       HLDA     2     INPUT (ACTIVE HIGH)<br>FROM TMS 8080A     1       WR     3     INPUT TO INDICATE<br>MODE (ACTIVE LOW)       BUSEN     22     ENABLE INPUT (ACTIVE<br>LOW)       STSTB     1     SYNCHRONIZING STATUS<br>STROBE INPUT FROM<br>SN74LS424 (TIM8224)       VCC     28     SUPPLY VOLTAGE (5 V)       GND     14     GROUND  |             | 23              | OUTPUT (ACTIVE LOW)     |   |
| HLDA     2     INPUT (ACTIVE HIGH)<br>FROM TMS 8080A       WR     3     INPUT TO INDICATE<br>TMS 8080A IS IN WRITE<br>MODE (ACTIVE LOW)       BUSEN     22     ENABLE INPUT (ACTIVE<br>LOW)       STSTB     1     SYNCHRONIZING STATUS<br>STROBE INPUT FROM<br>SN74LS424 (TIM8224)       VCC     28     SUPPLY VOLTAGE (5 V)       GND     14     GROUND   |             |                 | HOLD ACKNOWLEDGE        | C |
| Image: FROM TMS 8080A       Image: FROM TMS 8080A       Image: FROM TMS 8080A       Image: FROM TMS 8080A is in write       3     TMS 8080A is in write       MODE (ACTIVE LOW)       SYSTEM DATA PORT       ENABLE INPUT (ACTIVE       LOW)       STSTB       1     SYNCHRONIZING STATUS       STROBE INPUT FROM       SN74LS424 (TIM8224)       VCC     28       SUPPLY VOLTAGE (5 V)       GND     14   | HLDA        | 2               | INPUT (ACTIVE HIGH)     |   |
| WR     3     INPUT TO INDICATE       3     TMS 8080A IS IN WRITE<br>MODE (ACTIVE LOW)       BUSEN     22     SYSTEM DATA PORT<br>ENABLE INPUT (ACTIVE<br>LOW)       STSTB     1     SYNCHRONIZING STATUS<br>STROBE INPUT FROM<br>SN74LS424 (TIM8224)       VCC     28     SUPPLY VOLTAGE (5 V)       GND     14     GROUND   |             |                 | FROM TMS 8080A          |   |
| WR     3     TMS 8080A IS IN WRITE<br>MODE (ACTIVE LOW)       BUSEN     22     SYSTEM DATA PORT<br>ENABLE INPUT (ACTIVE<br>LOW)       STSTB     1     SYNCHRONIZING STATUS<br>STROBE INPUT FROM<br>SN74LS424 (TIM8224)       VCC     28     SUPPLY VOLTAGE (5 V)       GND     14     GROUND   |             |                 | INPUT TO INDICATE       |   |
| MODE (ACTIVE LOW)       BUSEN     22       SYSTEM DATA PORT       LOW)       STSTB     1       STROBE INPUT FROM<br>SN74LS424 (TIM8224)       VCC     28       SUPPLY VOLTAGE (5 V)       GND     14   | WR          | 3 <sup>.</sup>  | TMS 8080A IS IN WRITE   |   |
| BUSEN     22     SYSTEM DATA PORT       22     ENABLE INPUT (ACTIVE<br>LOW)       STSTB     1     SYNCHRONIZING STATUS<br>STROBE INPUT FROM<br>SN74LS424 (TIM8224)       VCC     28     SUPPLY VOLTAGE (5 V)       GND     14     GROUND   |             |                 | MODE (ACTIVE LOW)       |   |
| BUSEN     22     ENABLE INPUT (ACTIVE<br>LOW)       STSTB     1     SYNCHRONIZING STATUS<br>STROBE INPUT FROM<br>SN74LS424 (TIM8224)       VCC     28     SUPPLY VOLTAGE (5 V)       GND     14     GROUND   |             |                 | SYSTEM DATA PORT        |   |
| LOW)       STSTB     1       STROBE INPUT FROM<br>SN74LS424 (TIM8224)       VCC     28       SUPPLY VOLTAGE (5 V)       GND     14   | BUSEN       | 22              | ENABLE INPUT (ACTIVE    |   |
| STSTB         SYNCHRONIZING STATUS           STSTB         1         STROBE INPUT FROM           SN74LS424 (TIM8224)         VCC         28           VCC         28         SUPPLY VOLTAGE (5 V)           GND         14         GROUND  |             |                 | LOW)                    |   |
| STSTB         1         STROBE INPUT FROM<br>SN74LS424 (TIM8224)           VCC         28         SUPPLY VOLTAGE (5 V)           GND         14         GROUND   |             |                 | SYNCHRONIZING STATUS    |   |
| SN74LS424 (TIM8224)           VCC         28         SUPPLY VOLTAGE (5 V)           GND         14         GROUND  | STSTB       | 1               | STROBE INPUT FROM       |   |
| VCC         28         SUPPLY VOLTAGE (5 V)           GND         14         GROUND  |             |                 | SN74LS424 (TIM8224)     |   |
| GND 14 GROUND  | Vcc         | 28              | SUPPLY VOLTAGE (5 V)    |   |
| •  | GND         | 14              | GROUND                  |   |



## functional block diagram



## description

TTL LSI

These monolithic Schottky-clamped <sup>†</sup>TTL system controllers are designed specifically to provide bus-driving and peripheral-control capabilities for interfacing memory and I/O devices with the 8080A in small to medium-large micro-computer systems.

A bidirectional eight-bit parallel bus driver is provided that isolates the 8080A bus from the memory and I/O data bus allowing the system designed to utilize cost-effective memory and peripheral devices while obtaining the maximum efficiency from the microprocessor. The TTL system drivers also provide increased fan-out with a lower impedance that enhances noise margins on the system bus.

Implementation of the status latches and control decoding array of the SN74S428/SN74S438 provides for using either a single-level interrupt vector RST7 for small systems, or multiple-byte call instructions for systems needing unlimited interrupt levels.

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<sup>†</sup>Integrated Schottky-Barrier diodeclamped transistor is patented by Texas Instruments. U.S. Patent Number 3,463,975.

## description (continued)

With respect to the system clocks, the SN74S438 is configured to generate an advanced response for I/O or memory write output signals to further simplify peripheral control implementation of complex systems. See Figure 3.

### 8-bit parallel bus transceiver

The 8-bit parallel bus transceiver buffers the 8080A data bus from the memory and I/O system bus by providing one port (DO through D7) to interface with the 8080A and another port (DBO through DB7) to interface with the system devices. The 8080A side of the transceiver is designed specifically to interface with the microprocessor data bus ensuring not only that the processor output drive capabilities are adequate, but also that the inputs are driven with enhanced noise margins. The system bus side features high fan-out buffers designed to drive a number of system devices simultaneously and directly. The system port is rated to sink ten milliamperes of current and to source one milliampere of current at standard low-threshold voltage levels.

Status lines from the 8080A instruction-status decoder and the system bus enable input (BUSEN) provide complete transceiver directional and enable control to ensure integrity of both the processor data and the system bus data.

### status latches

During the beginning of each machine cycle, the six status latches receive status information from the 8080A data bus indicating the type of operation that will be performed. When the STSTB input goes low, the latches store the status data and generate the signals needed to enable and sequence the memory and I/O control outputs. The status words and types of machine cycles are enumerated in Table A.

| STATUS |          |           |       | 808    | 0A   |       |     |      | TYPE OF                       | 'S428/'S438                           |
|--------|----------|-----------|-------|--------|------|-------|-----|------|-------------------------------|---------------------------------------|
| WORD   |          |           | ST    | ATUS   | OUTP | JT    |     |      |                               | COMMAND                               |
| WOND   | D0       | D1        | D2    | D3     | D4   | D5    | D6  | D7   | MACHINE CYCLE                 | GENERATED                             |
| 1      | L        | н         | L     | L      | L    | н     | L   | н    | Instruction fetch             | MEMR                                  |
| 2      | <u> </u> | н         | L     | L      | L    | L     | L   | н    | Memory read                   | MEMR                                  |
| 3      | L        | L         | L     | L      | L    | L     | L   | L    | Memory write                  | MEMW                                  |
| 4      | . L      | н         | н     | L      | L    | L     | L   | н    | Stack read                    | MEMR                                  |
| 5      | L        | L         | н     | L      | L    | L     | L   | L    | Stack write                   | MEMW                                  |
| 6      | L        | н         | L     | L      | L    | L     | н   | L    | Input read                    | I/OR                                  |
| 7      | L        | L         | L     | L      | н    | L     | L   | L.   | Output write                  | I/OW                                  |
| 8      | н        | н         | L     | L      | L    | н     | L   | L    | Interrupt acknowledge         | INTA                                  |
| 9      | L        | н         | L     | н      | L    | L     | L   | н    | Halt acknowledge              | NONE                                  |
| 10     | н        | н         | L     | н      | L    | н     | L   | L    | Interrupt acknowledge at halt | INTĂ                                  |
|        | INTA     | <u>ow</u> | STACK | нгта   | OUT  | M     | INP | MEMR |                               | · · · · · · · · · · · · · · · · · · · |
|        |          | 5         | στατι | JS INF | ORM  | ATION | I . |      |                               |                                       |

#### TABLE A - STATUS WORDS

### decoding array

The decoding array receives enabling commands from the status latches and sequencing commands from the 8080A and generates memory and I/O read/write commands and an interrupt acknowledgement.

# TYPES SN74S428(TIM8228), SN74S438(TIM8238) CONTROLLER AND BUS DRIVER FOR 8080A SYSTEMS

## description (continued)

The read commands ( $\overline{\text{MEMR}}$ ,  $\overline{I/OR}$ ) and the interrupt acknowledgement ( $\overline{\text{INTA}}$ ) are derived from the status bit(s) and the data bus input mode (DBIN) signal. The write commands ( $\overline{\text{MEMW}}$ ,  $\overline{I/OW}$ ) are derived from the status bit(s) and the write mode ( $\overline{\text{WR}}$ ) signal. (See Table A.) All control commands are active low to simplify interfacing with memory and I/O controllers.

The interrupt acknowledgement (INTA) command output is actually a dual function pin. As an output, its function is to provide the INTA command to the memory and I/O peripherals as decoded from the status inputs and latches. When CALL is used as an interrupt instruction, the SN74S428/SN74S428 generates the proper sequence of control signals. Additionally, the terminal includes high-threshold decoding logic that permits it to be biased through a one-kilohm series resistor to the 12-volt supply to implement an interrupt structure that automatically inserts an RST7 instruction on the bus when the DBIN input is active and an interrupt is acknowledged. This capability provides a single-level interrupt vector with minimal hardware.

The asynchronous bus enable (BUSEN) input to the decoding array is a control signal that protects the system bus. The system bus can be accessed and driven from the SN74S428/SN74S428 controller only when the BUSEN input is at a low voltage level.

## absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note 1) .   | • |   | • ' | • | • |  | • | • |   |   |   |   | • |   |   | • | • |  |  |    |     |     |      | . 7 | ۷  |
|--------------------------------------|---|---|-----|---|---|--|---|---|---|---|---|---|---|---|---|---|---|--|--|----|-----|-----|------|-----|----|
| Input voltage                        |   |   |     |   |   |  |   |   |   |   |   |   |   |   |   |   |   |  |  |    |     |     |      | 7   | v  |
| Operating free-air temperature range |   | • |     |   |   |  |   |   |   | • |   |   |   |   |   |   |   |  |  |    | C   | ٥°C | to   | 70° | ,С |
| Storage temperature range            |   |   | •   | • | • |  |   |   | • | • | • | • | • | • | • |   |   |  |  | -6 | 35° | C t | :o 1 | 50° | °C |

NOTE 1: Voltage values are with respect to network ground terminal.

### recommended operating conditions

|  |                           | MIN  | NOM | MAX  | UNIT |
|--|---------------------------|------|-----|------|------|
| Supply voltage, VCC                                  |                           | 4.75 | 5   | 5,25 | v    |
| High level output surrent low                        | D0 thru D7                |      |     | -10  | μA   |
|  | All others                |      |     | -1   | mA   |
|  | D0 thru D7                |      |     | 2    |      |
| Low-level output current, IOL                        | All others                |      |     | 10   |      |
| Status strobe pulse width, tw(STSTB) (see Figure 3)  |                           | 22   |     |      | ns   |
| Satura time to (use Silver O) Status inputs D0 three |                           | 8    |     |      |      |
| Setup time, t <sub>su</sub> (see Figure 3)           | System bus inputs to HLDA | 10   |     |      | ns   |
| Hold time to (see Figure 2)                          | Status inputs D0 thru D7  | 5    |     |      |      |
| Hold time, th (see Figure 3)                         | System bus inputs to HLDA | 20   |     |      | ns   |
| Operating free-air temperature, T <sub>A</sub>       |                           | 0    |     | 70   | °C   |

# TYPES SN74S428(TIM8228), SN74S438(TIM8238) Controller and bus driver for 8080A systems

|                 | PARAMETER                     | TEST CON          | DITIONS                  | MIN                          | TYP‡ | MAX  | UNIT |    |
|-----------------|-------------------------------|-------------------|--------------------------|------------------------------|------|------|------|----|
| VIH             | High-level input voltage      |                   |                          | 2                            |      |      | v    |    |
| VIL             | Low-level input voltage       |                   |                          |                              |      |      | 0.8  | V  |
| VIK             | Input clamp voltage           |                   | $V_{CC} = MIN,$          | l j ≃ –5 mA                  |      |      | -1   | V  |
| Val             | High level output voltage     | D0 thru D7        | $V_{CC} = MIN,$          | V <sub>IH</sub> = 2 V,       | 3.6  | 4    |      | V  |
| •он             | rightevel output voltage      | All other outputs | V <sub>IL</sub> = 0.8 V, | I <sub>OH</sub> ≈ MAX        | 2.4  |      |      | ľ  |
| Vai             |                               |                   | V <sub>CC</sub> = MIN,   | $V_{CC} = MIN, V_{IH} = 2V,$ |      |      | 0.45 | v  |
| VOL             | Low-level output voltage      |                   | V <sub>IL</sub> = 0.8 V, | IOL = MAX                    |      |      | 0.45 | Ľ. |
| 1               | Off-state output current,     |                   | Vaa - MAX                |                              |      |      | 100  |    |
| <sup>VOZH</sup> | high-level voltage applied    | VCC - MAA,        | v0 - 5.25 v              |                              |      | 100  | μ-   |    |
|                 | Off-state output current,     |                   | VMAX                     |                              |      |      | 100  |    |
| 'OZL            | low-level voltage applied     | VCC - WAA,        | VO - 0.45 V              |                              |      | -100 | μΑ   |    |
|                 | High-level input current      | INTÁ              | V <sub>CC</sub> = MIN,   | See Figure 1                 |      |      | 5    | mA |
| Чн              |                               | DO thru D7        |                          | V E 2E V                     |      |      | 20   |    |
|                 |                               | All other inputs  |                          | vi - 5.25 v                  |      |      | 100  |    |
|                 | Low-level input current       | D2 or D6          | V <sub>CC</sub> = MAX,   |                              |      |      | -750 |    |
| hL.             |                               | STSTB             |                          | V <sub>1</sub> = 0.45 V      |      |      | -500 | μA |
|                 |                               | All other inputs  | 1                        |                              |      |      | -250 | 1  |
| los             | Short-circuit output current§ | -                 | V <sub>CC</sub> = MAX    |                              | -15  |      | 90   | mA |
| 1cc             | Supply current                |                   | V <sub>CC</sub> = MAX    |                              |      | 140  | 190  | mA |

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

\$Not more than one output should be shorted at a time.

| PARAMETER        | FROM<br>(INPUT) | TO<br>(OUTPUT)                  | TEST CON                 | DITIONS      | MIN | түр | МАХ | UNIT |
|------------------|-----------------|---------------------------------|--------------------------|--------------|-----|-----|-----|------|
| <sup>t</sup> PD  | D0 thru D7      | DB0 thru DB7                    | C <sub>L</sub> = 100 pF, | See Figure 2 | 5   |     | 40  | ns   |
| tPD.             | DB0 thru DB7    | D0 thru D7                      | CL = 25 pF,              | See Figure 2 |     |     | 30  | ns   |
| <sup>t</sup> ₽HL | STSTB           | INTA, I/OR, MEMR,<br>I/OW, MEMW |                          |              | 20  |     | 60  | ns   |
| <sup>t</sup> PD  | WR              | I/OW, MEMW                      | C <sub>L</sub> = 100 pF, | See Figure 2 | 5   |     | 45  | ns   |
| tPLH             | DBIN            | INTA, I/OR, MEMR                |                          |              |     |     | 30  | ns   |
| tPLH             | HLDA            | INTA, I/OR, MEMR                | 1                        |              |     |     | 25  | ns   |
| <sup>t</sup> PZX | DBIN            | D0 thru D7                      | $C_{1} = 25 \text{ ps}$  | Saa Eiguna 2 |     |     | 45  | ns   |
| tPXZ             | DBIN            | D0 thru D7                      | - CL - 25 pF,            | See Figure 2 |     |     | 45  | ns   |
| tPZX             | STSTB, BUSEN    | DB0 thru DB7                    | C. = 100 = 5             | See Eleven 2 | 1   |     | 30  | ns   |
| tPXZ             | BUSEN           | DB0 thru DB7                    | ουρε,                    | See Figure 2 |     |     | 30  | ns   |

## switching characteristics, $V_{CC}$ = 5 V, $T_A$ = 25°C, see figure 3

 $f_{tpD} \equiv propagation delay time$ 

 $t_{\mathsf{PHL}} \equiv \mathsf{propagation}$  delay time, high-to-low-level output

 $t_{PLH} \equiv propagation delay time, low-to-high-level output$ 

 $t_{PZX} \equiv$  output enable time from high-impedance state

 $t_{PXZ} \equiv$  output disable time to high-impedance state
## TYPES SN74S428(TIM8228), SN74S438(TIM8238) CONTROLLER AND BUS DRIVER FOR 8080A SYSTEMS

### PARAMETER MEASUREMENT INFORMATION



NOTE A: Advanced response of I/OW or MEMW for the SN74S438 is indicated by the dashed line.

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FIGURE 3-VOLTAGE WAVEFORMS

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## TYPES SN74S428(TIM8228), SN74S438(TIM8238) CONTROLLER AND BUS DRIVER FOR 8080A SYSTEMS

TYPICAL APPLICATION DATA



FIGURE 4-SYSTEM INTERFACING WITH CENTRAL PROCESSING UNIT

## TTL MSI

## TYPES SN54LS440 THRU SN54LS444, SN54LS448, SN74LS440 THRU SN74LS444, SN74LS448 QUADRUPLE TRIDIRECTIONAL BUS TRANSCEIVERS

BULLETIN NO. DL-S 12709, AUGUST 1979

- 3-Way Asynchronous Communication
- On-Chip Bus Selection Decoding
- Input Hysteresis Improves Noise Margin
- Choice of Open-Collector or 3-State Outputs

#### description

These bus transceivers are designed for asynchronous three-way communication between four-line data buses. They give the designer a choice of selecting inverting, noninverting, or a combination of inverting and noninverting data paths with either 3-state or open-collector outputs.

The S0 and S1 inputs select the bus from which data are to be transferred. The  $\overline{G}$  inputs enable the bus or buses to which data are to be transferred. The port for any bus selected for input and any other bus not enabled for output will be at high impedance including those of the open-collector devices.

The SN54LS440 through SN54LS444 and SN54LS448 are characterized for operation over the full military temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C. The SN74LS440 through SN74LS444 and SN74LS448 are characterized for operation from 0°C to 70°C.



SN54LS' ..... J PACKAGE SN74LS' ..... J OR N PACKAGE

| DEVICE | OUTPUT         | LOGIC          |
|--------|----------------|----------------|
| 'LS440 | Open-Collector | True           |
| 'LS441 | Open-Collector | Inverting      |
| 'LS442 | 3-State        | True           |
| 'LS443 | 3-State        | Inverting      |
| 'LS444 | 3-State        | True/Inverting |
| 'LS448 | Open-Collector | True/Inverting |

#### FUNCTION TABLE

|    |    | INF | UTS | ;  | _  | TRANSF       | ERS BETWE    | EN BUSES     |
|----|----|-----|-----|----|----|--------------|--------------|--------------|
| -  |    |     |     |    | -  | 'LS440       | 'LS441       | 'LS444       |
| cs | 51 | SO  | GA  | GB | GC | 'LS442       | 'LS443       | 'LS448       |
| н  | X  | х   | X   | х  | X  | None         | None         |              |
| ×  | н  | н   | ×   | х  | х  | None         | None         | None         |
| ×  | X  | х   | н   | н  | н  | None         | None         | None         |
| X  | L  | L   | X   | н  | н  | None         | None         | None         |
| X  | L  | н   | н   | х  | н  | None         | None         | None         |
| X  | ļн | L   | н   | н  | х  | None         | None         | None         |
| L  | L  | L   | X   | L  | L  | A → B, A → C | à → B, Ā → C | Ā ≁ B, Ā → C |
| L  | L  | н   | L   | х  | L  | B → C, B → A | B → C, B → A | B → C, B → A |
| L  | н  | L   | L   | L  | х  | C → A, C → B | C → A,C → B  | C → A, C → B |
| L  | L  | L   | X   | L  | н  | A → B        | Ä → B        |              |
| L  | L  | н   | н   | х  | L  | B≁C          | B→C          | B≁C          |
| L  | н  | L   | L   | Н  | х  | C→A          | Ē≁A          | Č≁A          |
| L  | L  | L   | X   | н  | L  | A → C Ā → C  |              | Ā→C          |
| L  | L  | н   | L   | х  | н  | B→A          | B→A          |              |
| L  | н  | L   | н   | L  | x  | C≁B          | Ū → B        | C→B          |

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## TYPES SN54LS440 THRU SN54LS444, SN54LS448, SN74LS440 THRU SN74LS444, SN74LS448 QUADRUPLE TRIDIRECTIONAL BUS TRANSCEIVERS

logic symbols<sup>†</sup>



(\*LS440 is open-collector version)





<sup>†</sup>These symbols are in accordance with IEEE Std 91/ANSI Y32.14 and current discussions in IEC and IEEE.

## TYPES SN54LS440 THRU SN54LS444, SN54LS448, SN74LS440 THRU SN74LS444, SN74LS448 QUADRUPLE TRIDIRECTIONAL BUS TRANSCEIVERS

functional block diagram (composite showing one of four transceivers from each type, positive logic)



absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note 1)              |                |
|---|----------------|
| Input voltage                                 | 7 V            |
| Off-state output voltage                      | 5.5 V          |
| Operating free-air temperature range: SN54LS' | –55°C to 125°C |
| SN74LS'                                       | 0°C to 70°C    |
| Storage temperature range                     | –65°C to 150°C |

NOTE 1: Voltage values are with respect to network ground terminal.

## TYPES SN54LS440, SN54LS441, SN54LS448, SN74LS440, SN74LS441, SN74LS448 QUAD TRIDIRECTIONAL BUS TRANSCEIVERS WITH OPEN-COLLECTOR OUTPUTS

#### recommended operating conditions

|  | SI<br>SI<br>SI | N54LS4<br>N54LS4<br>N54LS4 | 140<br>141<br>148 | S<br>S<br>S | N74LS4<br>N74LS4<br>N74LS4 | 140<br>141<br>148 | UNIT |
|--|----------------|----------------------------|-------------------|-------------|----------------------------|-------------------|------|
|  | MIN            | NOM                        | MAX               | MIN         | NOM                        | MAX               |      |
| Supply voltage, V <sub>CC</sub> (see Note 1) | 4.5            | 5                          | 5.5               | 4.75        | 5                          | 5.25              | v    |
| High-level output voltage, VOH               |                |                            | 5.5               |             |                            | 5.5               | V    |
| Low-level output current, IOL                |                |                            | 12                |             |                            | 24                | mA   |
| Operating free-air temperature, TA           | -55            |                            | 125               | 0           |                            | 70                | С    |

NOTE 1: Voltage values are with respect to the network ground terminal.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|       |                               |                           |                        | TFOT OON               | numeria                  |      | SN54L | S'   |      | SN74LS | •    |      |
|-------|-------------------------------|---------------------------|------------------------|------------------------|--------------------------|------|-------|------|------|--------|------|------|
| ĺ     | PARAMETER                     | {                         |                        | TESTCON                | DITIONS                  | MIN  | TYP‡  | MAX  | MIN  | TYP‡   | MAX  | UNIT |
| VIH   | High-level input vol          | tage                      |                        |                        |                          | 2    |       |      | 2    |        |      | v    |
| VIL   | Low-level input vol           | tage                      |                        |                        |                          |      |       | 0.5  |      |        | 0.6  | V    |
| VIK   | Input clamp voltage           | ;                         |                        | $V_{CC} = MIN,$        | 1 <sub>1</sub> =18 mA    |      |       | -1.5 | _    |        | -1.5 | V    |
|       | Hysteresis (V <sub>T+</sub> – | VT_)                      | A,B,C input            | V <sub>CC</sub> = MIN  |                          | 0.1  | 0.4   |      | 0.2  | 0.4    |      | V    |
|       |                               | High-level output current |                        | V <sub>CC</sub> = MIN, | V <sub>OH</sub> = 5.5 V, |      |       | 100  |      |        | 100  |      |
| ноч ( | IOH High-level output current |                           | V <sub>IH</sub> = 2 V, | VIL= VILmax            |                          |      | 100   |      |      | 100    | μΑ   |      |
|       |                               |                           | V <sub>CC</sub> = MIN, | lou = 12 mA            |                          | 0.25 | 0.4   |      | 0.25 | 0.4    | v    |      |
| VOL   | Low-level output vo           | oltage                    |                        | V <sub>IH</sub> = 2 V, |                          |      |       |      |      |        |      |      |
|       |                               |                           |                        | VIL = VILmax           | I <sub>OL</sub> = 24 mA  |      |       |      |      | 0.35   | 0.5  | v    |
|       | Input current at              |                           | A,B,C input            | Vee - MAX              | V <sub>1</sub> = 5.5 V   |      |       | 0.1  |      |        | 0.1  |      |
| 4.    | maximum input vo              | tage                      | All others             | VCC - MAA              | V1 = 7 V                 |      |       | 0.1  |      |        | 0.1  |      |
| Чн    | IIH High-level input current  |                           |                        | V <sub>CC</sub> = MAX, | VI = 2.7 V               |      |       | 20   |      |        | 20   | μA   |
| hL.   | Low-level input cur           | rent                      |                        | V <sub>CC</sub> = MAX, | V1=0.4 V                 |      |       | -0.4 |      |        | -0.4 | mA   |
| 100   | Supply ourrant                | Out                       | outs low               |                        | Outputs open             |      | 62    | 90   |      | 62     | 90   | m۸   |
| l icc | Supply current                | Out                       | outs disabled          |                        | Outputs open             |      | 64    | 95   |      | 64     | 95   |      |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. <sup>‡</sup>All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

## switching characteristics at V<sub>CC</sub> = 5 V, R<sub>L</sub> = 667 $\Omega$ , C<sub>L</sub> = 45 pF, T<sub>A</sub> = 25°C (see Note 2)

|                | BADANETED         | INDUT  | OUTPUT  |     | 'LS44 | 0   |     | 'LS44 | 1   |     | 'LS448 | 3   | LINUT |
|----------------|-------------------|--------|---------|-----|-------|-----|-----|-------|-----|-----|--------|-----|-------|
|                | PARAMETER         | INPUT  | 001901  | MIN | TYP   | MAX | MIN | ТҮР   | MAX | MIN | түр    | MAX | UNIT  |
|                |                   | A      | В       |     | 24    | 35  |     | 21    | 30  |     | 21     | 30  |       |
|                | <b>.</b>          | A      | С       |     | 24    | 35  |     | 21    | 30  |     | 21     | 30  |       |
| <b>t</b> D1 11 | Propagation delay | В      | A       |     | 24    | 35  |     | 21    | 30  |     | 21     | 30  |       |
| PLH            | time, low-to-high | В      | С       |     | 24    | 35  |     | 21    | 30  |     | 24     | 35  | '''   |
|                | level output      | С      | A       |     | 24    | 35  |     | 21    | 30  |     | 21     | 30  |       |
|                |                   | C      | В       | _   | 24    | 35  |     | 21    | 30  |     | 24     | 35  |       |
|                |                   | A      | В       |     | 20    | 30  |     | 9     | 15  |     | 9      | 15  |       |
|                | Proposition dolou | A      | С       |     | 20    | 30  |     | 9     | 15  |     | 9      | 15  |       |
| toui           | time high to low  | В      | A       |     | 20    | 30  |     | 9     | 15  |     | 9      | 15  |       |
| 415            | lime, nigh-to-tow | В      | С       |     | 20    | 30  |     | 9     | 15  |     | 20     | 30  | '''   |
|                |                   | С      | A       |     | 20    | 30  |     | 9     | 15  |     | 9      | 15  |       |
|                |                   | С      | В       |     | 20    | 30  |     | 9     | 15  |     | 20     | 30  |       |
|                | Propagation delay | any G  | A, B, C |     | 29    | 45  |     | 23    | 35  |     | 25     | 40  |       |
| <b>tPLH</b>    | time, low-to-high | S0, S1 | A, B, C |     | 33    | 50  |     | 27    | 40  |     | 26     | 40  | ns    |
|                | level output      | CS     | A, B, C |     | 31    | 45  |     | 26    | 40  |     | 25     | 40  |       |
|                | Propagation delay | any G  | A, B, C |     | 27    | 40  |     | 20    | 30  |     | 22     | 35  |       |
| <b>tPHL</b>    | time, high-to-low | S0, S1 | A, B, C |     | 32    | 50  |     | 26    | 40  |     | 27     | 40  | ns    |
|                | level output      | CS     | A, B, C |     | 28    | 45  |     | 21    | 30  |     | 22     | 35  | L     |

NOTE 2: Load circuits and voltage waveforms are shown on page 1-15.

## TYPES SN54LS442, SN54LS443, SN54LS444, SN74LS442, SN74LS443, SN74LS444 QUAD TRIDIRECTIONAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

### recommended operating conditions

|  | SN54LS442   SN54LS443   SN54LS444   MIN NOM   4.5 5   5.5 | s<br>s<br>s                           | UNIT |      |     |      |    |
|--|---|---------------------------------------|------|------|-----|------|----|
|  | MIN   | SN54LS444<br>MIN NOM MAX<br>4.5 5 5.5 |      | MIN  | NOM | MAX  |    |
| Supply voltage, V <sub>CC</sub> (see Note 1)   | 4.5   | 5                                     | 5.5  | 4.75 | 5   | 5.25 | V  |
| High-level output current, IOH                 |   |                                       | -12  |      |     | -15  | mA |
| Low-level output current, IOL                  |   | 12                                    |      |      | _   | 24   | mA |
| Operating free-air temperature, T <sub>A</sub> | -55   | -55 12                                |      |      |     | 70   | °C |

NOTE 1: Voltage values are with respect to the network ground terminal.

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|      |                                     |            |             |                        | DITIONS <sup>†</sup>    |     | SN54L | S'   |     | SN74L | s'   | LINUT |
|------|-------------------------------------|------------|-------------|------------------------|-------------------------|-----|-------|------|-----|-------|------|-------|
|      | PARAMETE                            | R          |             | TEST CON               | DITIONS                 | MIN | түр‡  | MAX  | MIN | түр‡  | MAX  | UNIT  |
| VIH  | High-level input                    | voltage    |             |                        |                         | 2   |       |      |     |       |      | V     |
| VIL  | Low-level input                     | voltage    |             |                        |                         |     |       | 0.5  |     |       | 0.6  | V     |
| VIK  | Input clamp vol                     | tage       |             | V <sub>CC</sub> = MIN, | l <sub>l</sub> = –18 mA |     |       | 1.5  |     |       | -1.5 | V     |
| -    | Hysteresis (V <sub>T+</sub>         | - VT_)     | A,B,C input | V <sub>CC</sub> = MIN  |                         | 0.1 | 0.4   |      | 0.2 | 0.4   |      | v     |
| Vou  | High lovel outpu                    | ut voltage |             | $V_{CC} = MIN,$        | 1 <sub>OH</sub> = -3 mA | 2.4 | 3.4   |      | 2.4 | 3.4   |      | v     |
| VOH  |                                     | it vortage |             | VIL = VILmax           | IOH = MAX               | 2   |       |      | 2   |       |      |       |
| Vai  | Low-level output voltage            |            |             | $V_{CC} = MIN,$        | l <sub>OL</sub> = 12 mA |     | 0.25  | 0.4  |     | 0.25  | 0.4  | V     |
| VOL  |                                     | it vortage |             | $V_{IL} = V_{IL}max$   | I <sub>OL</sub> = 24 mA |     |       |      |     | 0.35  | 0.5  |       |
| югн  | Off-state output<br>voltage applied | t current, | high-level  | V <sub>CC</sub> = MAX, | V <sub>O</sub> = 2.7 V  |     |       | 20   |     |       | 20   | _     |
| IOZL | Off-state output<br>voltage applied | t current, | low-level   | CS at 2 V              | V <sub>O</sub> = 0.4 V  |     |       | -400 |     |       | -400 | μΑ    |
|      | Input current at                    | :          | A,B,&C      |                        | V <sub>I</sub> = 5.5 V  |     |       | 0.1  |     |       | 0.1  |       |
| 11   | maximum input                       | voltage    | Others      |                        | V <sub>1</sub> = 7 V    |     |       | 0.1  |     |       | 0.1  | mA    |
| Чн   | High-level input current            |            |             | V <sub>CC</sub> = MAX, | V <sub>I</sub> = 2.7 V  |     |       | 20   |     |       | 20   | μA    |
| ΠL   | Low-level input current             |            |             | V <sub>CC</sub> = MAX, | VI = 0.4 V              |     |       | -0.4 |     |       | -0.4 | mA    |
| los  | OS Short circuit output current ¶   |            |             | V <sub>CC</sub> = MAX  |                         | -40 |       | -225 | -40 |       | -225 | mA    |
| 100  | Total outputs low                   |            |             | Outputs open           |                         | 62  | 90    |      | 62  | 90    | mΑ   |       |
| 'CC  | Suppry current                      | Output     | s at Hi-Z   |                        |                         |     | 64    | 95   |     | 64    | 95   |       |

 $\dagger$  For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.  $\ddagger$ All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

 $\P$  Not more than one output should be shorted at a time, and duration of the short circuit should not exceed one second.

## TYPES SN54LS442, SN54LS443, SN54LS444, SN74LS442, SN74LS443, SN74LS444 QUAD TRIDIRECTIONAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

|                  |   |             | 0.170.17 | TEST                                    |     | 'LS44 | 2   |     | 'LS443 |     |     | 'LS444 |     |      |
|------------------|---|-------------|----------|---|-----|-------|-----|-----|--------|-----|-----|--------|-----|------|
|                  | RAMETER                                   |             | 001201   | CONDITIONS                              | MIN | ТҮР   | MAX | MIN | ТҮР    | MAX | MIN | TYP    | MAX | UNIT |
|                  |   | A           | В        | ]                                       |     | 10    | 14  |     | 9      | 14  |     | 9      | 14  |      |
| ł                | Propagation                               | A           | С        |   |     | 10    | 14  |     | 9      | 14  |     | 9      | 14  |      |
| +n               | delay time,                               | В           | А        |   |     | 10    | 14  |     | 9      | 14  |     | 9      | 14  | 115  |
| PLH              | low-to-high                               | В           | С        |   |     | 10    | 14  |     | 9      | 14  |     | 10     | 14  |      |
|                  | level output                              | С           | А        |   |     | 10    | 14  |     | 9      | 14  |     | 9      | 14  |      |
|                  |   | С           | В        |   |     | 10    | 14  |     | 9      | 14  |     | 10     | 14  |      |
|                  |   | A           | В        |   |     | 13    | 20  |     | 7      | 13  |     | 7      | 13  |      |
|                  | Propagation                               | Α           | С        |   |     | 13    | 20  |     | 7      | 13  |     | 7      | 13  |      |
| ****             | delay time,                               | В           | А        |   |     | 13    | 20  |     | 7      | 13  |     | 7      | 13  | ns   |
| PHL              | high-to-low                               | В           | С        | CL = 45 pF,                             |     | 13    | 20  |     | 7      | 13  |     | 13     | 20  |      |
|                  | level output                              | С           | А        | - R <sub>L</sub> = 667 Ω<br>-<br>-<br>- |     | 13    | 20  |     | 7      | 13  |     | 7      | 13  |      |
|                  |   | С           | В        |   |     | 13    | 20  |     | 7      | 13  |     | 13     | 20  |      |
|                  | Output enable                             | Any G       | A, B, C  |   |     | 22    | 33  |     | 22     | 33  |     | 22     | 33  |      |
| <b>tPZL</b>      | time to low                               | SO or S1    | A, B, C  |   |     | 28    | 42  |     | 28     | 42  | ł   | 28     | 42  | ns   |
|                  | level                                     | CS          | A, B, C  |   |     | 23    | 36  |     | 24     | 36  |     | 23     | 36  |      |
| <sup>t</sup> PZH | Output enable<br>time to high<br>level    | G, s,<br>Cs | A, B, C  |   |     | 21    | 32  |     | 20     | 32  |     | 24     | 32  | ns   |
| tplz             | Output disable<br>time from low<br>level  | G, s,<br>GS | A, B, C  | С <sub>L</sub> = 5 рF,                  |     | 14    | 25  |     | 15     | 25  |     | 14     | 25  | ns   |
| tPHZ             | Output disable<br>time from high<br>level | G, s,<br>Cs | A, B, C  | R <sub>L</sub> = 667 Ω                  |     | 14    | 25  |     | 15     | 25  |     | 14     | 25  | ns   |

### switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$ (see Note 2)

NOTE 2: Load circuits and voltage waveforms are shown on page 1-15.

### schematics of inputs and outputs



### TEXAS INSTRUMENTS INCORPORATED POST OFFICE BOX 225012 • DALLAS, TEXAS 75265

BULLETIN NO. DL-S 12700, JUNE 1979

### SN54S484, SN74S484 BCD-TO-BINARY CONVERTERS SN54S485, SN74S485 BINARY-TO-BCD CONVERTERS

- Significant Savings in Package Count Compared with SN54184, SN54185A, SN74184, or SN74185A (Over Half in Many Applications)
- **Three-State Outputs**

#### description

TTL LSI

These monolithic converters are derived from the SN54S371/SN74S371 custom-programmed read-only memories. Both of these converters comprehend that the least-significant bits (LSB) of the binary and BCD are logically equal, and in each case the LSB bypasses the converter as shown in the typical applications. This means that a nine-bit converter is produced in each case. The devices are cascadable to N bits.

The three-state outputs offer the convenience of open-collector outputs with the speed of totempole outputs: they can be bus-connected to other similar outputs yet they retain the fast rise-time characteristic of totem-pole outputs. A high logic level at either enable  $(\overline{G})$  input causes the outputs to be in a high-impedance state.

These converters, by including three more bits of conversion than their SN54184/SN74184 or SN54185/SN74185 counterparts, result in а reduction in package count by more than half in most applications, and a significant savings in power consumption in many applications as shown in the tables at right.

#### SN54S484/SN74S484 vs SN54184/SN74184

|         |       |             | MAX       |      | TYP                | CAL              |  |  |
|---------|-------|-------------|-----------|------|--------------------|------------------|--|--|
| DECADES | COL   | JNT         | CUR       | RENT | @ T <sub>A</sub> = | S 11ME<br>= 25°C |  |  |
|         |       |             | 0         | A)   | (ns)               |                  |  |  |
|         | 'S484 | <b>'184</b> | 'S484     | '184 | <b>'</b> S484      | '184             |  |  |
| 3       | 3     | 6           | 0.41      | 0.59 | 117                | 135              |  |  |
| 4       | 5     | 11          | 0.72      | 1.09 | 180                | 189              |  |  |
| 5       | 8     | 18          | 1.18      | 1.78 | 270                | 270              |  |  |
| 6       | 12    | 27          | 1.75      | 2.67 | 342                | 351              |  |  |
| 7       | 16    | 38          | 2.37 3.76 |      | 405                | 405              |  |  |
| 8       | 21    | 49          | 3.14      | 4.85 | 495                | 485              |  |  |
| 9       | 27    | 62          | 4.02      | 6.14 | 567                | 540              |  |  |



logic symbols<sup>†</sup>





<sup>†</sup>These symbols are in accordance with IEEE Std 91/ANSI Y32.14 and current discussions in IEC and IEEE.

с

D

E

F

G

н

#### SN54S485/SN74S485 vs SN54185/SN74185

| BINARY<br>BITS | PACK  | AGE<br>JNT | MAXI<br>SUPI<br>CURF<br>(A | MUM<br>PLY<br>RENT | TYPI<br>ACCES<br>@ T <sub>A</sub> =<br>(n | CAL<br>S TIME<br>= 25°C<br>s) |  |  |  |
|----------------|-------|------------|----------------------------|--------------------|---|-------------------------------|--|--|--|
|                | 'S485 | '185       | 'S485                      | '185               | 'S485                                     | '185                          |  |  |  |
| 8              | 2     | 3          | 0.35                       | 0.30               | 72  | 81                            |  |  |  |
| 16             | 8     | 16         | 1.44                       | 1.58               | 252                                       | 216                           |  |  |  |
| 24             | 19    | 40         | 3.44                       | 3.96               | 459                                       | 351                           |  |  |  |
| 32             | 33    | 74         | 4.78                       | 5.45               | 612 486                                   |                               |  |  |  |

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|                  | SN54S484, SN74S484<br>BCD-TO-BINARY CONVERTER |          |            |              |                |            |             |                         |                |                      |                          |                  |                  |                |                |          |          |          |      | SN       | 54S             | 485                  | , SN   | 74S4       | 485       |            |            |           |            |    |        |
|------------------|---|----------|------------|--------------|----------------|------------|-------------|-------------------------|----------------|----------------------|--------------------------|------------------|------------------|----------------|----------------|----------|----------|----------|------|----------|-----------------|----------------------|--------|------------|-----------|------------|------------|-----------|------------|----|--------|
|                  |   |          |            | BCI          | ът             | о∙в        | INA         | ARY                     | CON            | /ER1                 | ER                       |                  |                  |                |                |          |          |          | E    | BINA     | RY              | -тс                  | )-В(   | D C        | ٥N        | /ER        | TEF        | 3         |            |    |        |
| ·                |   |          |            |              | ١              | FUI        | ICT         | ION                     | TABL           | .E                   |                          |                  |                  |                |                | <u></u>  |          |          |      |          | FL              | JNC                  | ті     | ד אכ       | ABI       | LE         |            |           |            |    |        |
|                  |   | 1        | NPU        | тs           |                |            |             |                         |                | c                    | OUTF                     | UTS              |                  |                |                |          |          | IN       | IPUT | S        |                 |                      |        |            |           | о          | UTF        | ידטי      | s          |    | •      |
| н                | G   | F        | Е          | D            | С              | в          | Α           | ¥8                      | ¥7             | ¥6                   | ¥5                       | ¥4               | Y3               | Y2             | Y1             | н        | G        | F        | E    | D        | с               | в                    | Α      | Y8         | ¥7        | Y6         | Y5         | ¥4        | Y3         | Y2 | Y1     |
| 160              | 80  | 40       | 20         | 10           | 8              | 4          | 2           | 256                     | 128            | 64                   | 32                       | 16               | 8                | 4              | 2              | 256      | 128      | 64       | 32   | 16       | 8               | 4                    | 2      | 160        | 80        | 40         | 20         | 10        | 8          | 4  | 2      |
| L                | L   | L        | L          | L            | L              | L          | L           | L                       | L              | L                    | L                        | L                | L                | L              | L              | L        | L        | L        | L    | L        | L               | L                    | L      | L          | Ľ         | L          | L          | L         | L          | L  | L      |
| L                | L   | L        | L          | L            | L              | L          | н           | L                       | L              | L                    | L                        | L                | L                | L              | н              |          | L        | L        | L    | L        | L               | L                    | H      | L          | L         | L          | L          | L         | L          | L  | н      |
|                  | L   | L        | L          | L            | L              | н          | L           |                         | L              | L                    | L.                       | L                | L                | н              | 니              |          | L        | L        | L    | L        | L<br>1          | н                    | -      | L          | L         | L          | L.         | L.        | L .        | н  | ь<br>ц |
|                  | L.  | L        | L          | L            | L              | н          | н           |                         | L              | L                    | L.                       | L                | L                | н              | , H            | <u> </u> | <u> </u> | <u> </u> |      | <u> </u> | <u>_</u>        | н<br>1               |        |            | 1         | <u> </u>   | <u> </u>   | 1         | _ <u>_</u> |    | н<br>  |
|                  | <u> </u>                                      | <u> </u> | - <u>-</u> | <u>-</u>     | <u>н</u>       | - <u>-</u> | ÷.          | 1                       | $\overline{m}$ | $\overline{m}$       | $\overline{\mathcal{T}}$ | $\overline{m}$   | $\overline{\pi}$ | $\overline{n}$ | $\overline{m}$ |          | 1        | L.       | 1    | 1        | н               | L                    | н      | 1          | L         | L          | L          | н         | L          | L  | L      |
|                  | L   | L        | L          | L            | н              | н          | L           | V//                     |                | Invali               | d BC                     | D co             | de               |                |                |          | L        | L        | L    | Ľ        | н               | н                    | L      | L          | L         | L          | L          | н         | L          | L  | н      |
| L                | L   | L        | L          | L            | н              | н          | н           | V//                     | ///            |                      | tputs                    | are              | high)<br>///     |                | $//\lambda$    | L        | L        | L        | L    | L        | н               | н                    | н      | L          | L         | L          | L          | н         | L          | н  | L      |
| L                | L   | L        | L          | н            | L.             | L,         | L           | L                       | L              | L                    | L                        | L                | H                | L              | H              | L        | L        | Ĺ        | L    | н        | L               | L                    | L      | L          | L         | L          | L          | н         | L          | н  | н      |
| L                | L   | L        | L          | н            | L              | L          | н           | L                       | L              | L                    | L                        | L                | н                | н              | L              | L        | L        | L        | L    | н        | L               | L                    | н      | L          | Ľ         | L          | L          | н         | н          | L  | L      |
| LL               | L   | L        | L          | н            | L              | н          | L,          | LL                      | L              | L                    | L                        | L                | н                | н              | н              | LL       | L        | L        | L    | н        | L               | н                    | L      | L          | L         | L          | н          | L         | L          | L  | L _    |
|                  |   |          |            |              |                |            |             |                         |                |                      |                          |                  |                  |                |                |          |          |          |      |          |                 |                      |        |            |           |            |            |           |            |    |        |
| Τн               | н   | н        | н          | L            | L              | н          | Ľ           | ۲н                      | L              | L                    | н                        | н                | L                | L              | n              | Тн       | L        | L        | L    | н        | н               | н                    | ſ      | Гн         | н         | н          | L          | L         | L          | н  | ۲ ۱    |
| н                | н   | н        | н          | L            | L              | н          | н           | н                       | L              | L                    | н                        | н                | L                | L              | н              | н        | L        | L        | L    | н        | н               | н                    | н      | н          | н         | н          | L          | L         | L          | н  | н      |
| н                | н   | н        | н          | L            | н              | L          | L           | н                       | L              | L                    | н                        | н                | Ł                | н              | L              | н        | L        | L        | Н    | L        | L               | L                    | L      | н          | н         | Н          | L          | L         | Н          | L  | L      |
| н                | н   | Н        | н          | L            | Н              | L          | н           | $\mathbb{V}$            | $\square$      | $\square$            | ///                      | ///              | //               | //             | $\square$      | н        | L        | L        | н    | L        | L               | L                    | н      | н          | н         | н          | L          | н         | L          | L  | L      |
| н                | н   | н        | н          | L            | н              | н          | L           | V//                     |                |                      |                          |                  |                  |                |                | н        | L        | L        | н    | L        | L               | н                    | L      | н          | н         | н          | L          | н         | L          | L  | н      |
| _ н              | н   | . н      | <u>н</u>   | L            | н              | Н          | н           | ¥77                     |                |                      |                          |                  |                  |                |                | н        | L        |          | Н    | L        | <u>_</u>        | н                    | Н      | н          | н         | н          | L          | н         |            | н  | L      |
| н                | н   | н        | н          | н            | L              | L          | L           | Н                       | L              | L                    | н                        | н                | L                | н              | н              | Н        | L        | L        | н    | L        | н               | L                    | L      | н          | н         | н          | L          | н         | L          | н  | н      |
| I H              | н   | н        | н          | н            | L              | L          | н           | I H                     | L              | L                    | н                        | н                | н                | L              | L              | Н        | L        | L        | н    | L        | н               | ц<br>                | н      | [ Н        | н         | н          | с <u>Г</u> | н         | н          |    | L      |
| Н                | н   | н        | н          | н            | L              | н          | L           | н                       | L              | L .                  | н                        | н                | н                | L<br>U         | н              |          | L<br>1   |          | н    | L<br>1   | н               | н                    | L<br>L | н          | п         | н          | н          | . Ц.<br>Т | 1          | -  | ь<br>н |
|                  | н   | н        | н          | н            | ᄂ              | н          | н           |                         | ւ<br>ւ         | ь<br>1               | п                        | п                | н                | п              | ч              |          | <u> </u> |          |      | <u>н</u> | $\frac{\pi}{1}$ | 1                    | -<br>  | н          | - <u></u> | - <u>H</u> | <u></u>    | -         |            | н  |        |
| $-\frac{\pi}{4}$ | <u>- п</u><br>н                               | н        | н          | н            | H              | <u> </u>   | <u>-</u> н  | 77                      |                |                      | $\overline{\pi}$         | $\overline{\pi}$ | 777              | 777            |                | Нн       | L        | L        | н    | н        | L               | L                    | н      | н          | н         | н          | н          | Ľ         | Ľ          | L  | н      |
| Н                | н   | н        | н          | н            | н              | н          | L           | V//                     |                |                      |                          |                  |                  |                |                | н        | Ľ        | L        | н    | н        | L               | н                    | L      | н          | н         | н          | н          | L         | н          | L  | L      |
| н                | н   | н        | н          | н            | н              | н          | н           | $\mathbb{V}/\mathbb{I}$ |                |                      |                          |                  |                  |                |                | н        | L        | L        | н    | н        | L               | н                    | н      | н          | н         | н          | н          | н         | L          | L  | L      |
| X                | х   | x        | х          | х            | н              | х          | н           | H                       | Н              | Н                    | Н                        | Н                | Н                | Н              | Н              | н        | L        | L        | н    | н        | н               | L                    | L      | н          | н         | н          | н          | Н         | L          | L  | н      |
| ×                | ×   | х        | х          | х            | н              | н          | х           | н                       | н              | Н                    | н                        | н                | н                | н              | н              | н        | L        | L        | н    | н        | Н               | L                    | н      | н          | н         | н          | н          | н         | L          | н  | L      |
| L                |   |          |            |              |                |            |             |                         |                |                      | _                        |                  |                  |                |                | Ή        | L        | L        | н    | н        | Н               | н                    | L      | н          | н         | н          | н          | н         | L          | н  | н      |
| H =              | hig   | n levi   | el         |              | L              | = lo       | ow l        | evel                    |                | Х                    | = irre                   | levar            | nt               |                |                | н        | L        | L        | н    | Н        | н               | Н                    | н      | н          | <u>H</u>  | н          | н          | Н         | н          | L  | L      |
|                  |   |          |            |              |                |            |             |                         |                |                      |                          |                  |                  |                |                | н        | L        | н        | L    | L        | L               | L                    | L      |            |           |            |            |           |            |    |        |
|                  |   |          |            |              |                |            | В           |                         | VPUT           | -                    |                          |                  |                  |                |                |          |          |          | thru |          |                 |                      |        | н          | н         | н          | н          | н         | н          | н  | н      |
|                  |   |          |            |              |                |            |             |                         |                | Lş                   | D                        |                  |                  |                |                | ЦН       | н        | н        | н    | Н        | н               | Н                    | н      |            |           |            |            |           |            |    |        |
|                  |   | м        | sd /       |              |                | ~-         |             |                         |                | /                    |                          | -                |                  |                |                |          |          |          |      |          |                 |                      |        |            |           |            |            |           |            |    |        |
|                  |   | 1        | 50 i       | во           | 40             | :          | 20          | 10                      | 8              | 4                    | 2                        | 1                |                  |                |                |          |          |          |      |          | ві              | NA                   | RY     | INP        | υт        |            |            |           |            |    |        |
|                  |   |          |            |              |                |            |             |                         |                |                      |                          |                  |                  |                |                | 25       | 6 12     | 28 6     | 54   | 32       | 1               | 6                    | 8      | 4          | 2         | 1          |            |           |            |    |        |
|                  | HGFEDCBA                                      |          |            |              |                |            |             |                         |                |                      |                          |                  |                  |                |                | لے       |          | <u> </u> | Ļ.   | Ť        |                 |                      | Ľ      | <u> </u>   | Ļ         | - I        |            |           |            |    |        |
|                  |   |          |            |              |                |            |             |                         |                |                      |                          |                  |                  |                |                |          |          |          | 1 (  | ذ        | F               | E                    |        | J          | C         | в          | А          |           |            |    |        |
|                  |   |          |            |              | SN             | 54S        | 484         | /SN7                    | 4548           | 4                    |                          |                  |                  |                |                |          |          |          |      | SN       | 154             | S48                  | 5/S    | N74        | S489      | 5          |            |           |            |    |        |
|                  |   |          |            |              |                |            |             |                         |                |                      |                          |                  |                  |                |                |          |          |          |      |          |                 |                      |        |            |           |            |            |           |            |    |        |
|                  |   | Ľ        | 8          | $\mathbf{T}$ | <u>¥6</u><br>T |            | 15          | <u>Y4</u>               | <u>Y3</u>      | $\frac{\gamma_2}{T}$ | ¥1-                      | 1                |                  |                |                |          |          | Ľ        | 8 Y  |          | <u>б</u>        | $\frac{\gamma 5}{T}$ | Y      | 4          | 13<br>T   | Y2<br>T    | <u>11</u>  | ┙╽        |            |    |        |
|                  |   |          |            |              |                |            | 1           |                         |                | I                    |                          |                  |                  |                |                |          |          | 16       | 0 (8 | 0        | 40              | 20                   | 1      | ۰ <u>،</u> | 8         | 4          | 2          | 1         | ,          |    |        |
|                  | 256 128 64 32 16 8 4 2 1                      |          |            |              |                |            |             |                         |                |                      |                          |                  |                  | M              | SD 🔪           |          |          |          |      |          |                 |                      | SD.    |            | -         |            |            |           |            |    |        |
|                  |   | M        | SB         |              |                | BIN        | <b>I</b> AF |                         | JTPU           | т                    |                          | LSB              |                  |                |                |          |          |          |      |          | в               | CD                   | οι     | ΤΡΙ        | т         | -          | .0         |           |            |    |        |

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#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note 1) .    |          |            | <br> |                     |
|---------------------------------------|----------|------------|------|---------------------|
| Input voltage                         |          |            | <br> | 5.5V                |
| Off-state output voltage              |          |            | <br> | 5.5V                |
| Operating free-air temperature range: | SN54S484 | , SN54S485 | <br> | -55°C to 125°C      |
|                                       | SN74S484 | , SN74S485 | <br> | $\dots$ 0°C to 70°C |
| Storage temperature range             |          |            | <br> | —65°C to 150°C      |

#### recommended operating conditions

|                                 |     | SN54S'        |     |      | SN74S' |      |      |
|---------------------------------|-----|---------------|-----|------|--------|------|------|
|                                 | MIN | MIN NOM MAX M |     | MIN  | NOM    | MAX  | UNIT |
| Supply voltage, V <sub>CC</sub> | 4.5 | 5             | 5.5 | 4.75 | 5      | 5,25 | V    |
| Off-state output voltage        |     |               | 5,5 |      |        | 5,5  | V    |
| High-level output current, IOH  |     |               | -2  |      |        | -6.5 | mA   |
| Low-level output current, IOL   |     |               | 16  |      |        | 16   | mA   |
| Operating free-air temperature  | -55 |               | 125 | 0    |        | 70   | °C   |

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|      | PARAMETER   | т   | EST CONDITION           | IS <sup>†</sup>          | MIN TYP <sup>‡</sup> | MAX   | UNIT |
|------|---|---|-------------------------|--------------------------|----------------------|-------|------|
| VIH  | High-level input voltage                                |   |                         |                          | 2                    |       | V V  |
| VIL  | Low-level input voltage                                 |   |                         |                          |                      | 0,8   | V    |
| VIK  | Input clamp voltage                                     | V <sub>CC</sub> = MIN,                          | l <sub>l</sub> = -18 mA |                          |                      | -1.2  | V    |
| ∨он  | High-level output voltage                               | V <sub>CC</sub> = MIN,<br>I <sub>OH</sub> = MAX | V <sub>IH</sub> = 2 V,  | V <sub>IL</sub> = 0.8 V, | 2.4                  |       | v    |
| VOL  | Low-level output voltage                                | V <sub>CC</sub> = MIN,<br>I <sub>OL</sub> = MAX | V <sub>IH</sub> = 2 V,  | V <sub>IL</sub> = 0.8 V, |                      | 0,5   | v    |
| lozн | Off-state output current,<br>high-level voltage applied | V <sub>CC</sub> = MAX,                          | V <sub>IH</sub> = 2 V,  | V <sub>O</sub> = 2.7 V   |                      | 50    | μA   |
| IOZL | Off-state output current<br>low-level voltage applied   | V <sub>CC</sub> = MAX,                          | V <sub>IH</sub> = 2 V,  | V <sub>O</sub> = 0.4 V   |                      | -50   | μA   |
| 11   | Input current at maximum input voltage                  | V <sub>CC</sub> = MAX,                          | V <sub>1</sub> = 5.5 V  |                          |                      | 1     | mA   |
| Чн   | High-level input current                                | V <sub>CC</sub> = MAX,                          | V <sub>1</sub> = 2.7 V  |                          |                      | 25    | μA   |
| կլ   | Low-level input current                                 | V <sub>CC</sub> = MAX,                          | VI = 0.5 V              |                          |                      | -0.25 | mA   |
| los  | Short-circuit output current §                          | V <sub>CC</sub> = MAX,                          |                         |                          | -30                  | -100  | mA   |
| Icc  | Supply current  | V <sub>CC</sub> = MAX,                          | See Note 2              |                          | 105                  | 155   | mA   |
| CO   | Off-state output capacitance                            | V <sub>CC</sub> = 5 V,                          | V <sub>O</sub> = 5 V,   | f = 1 MHz                | 6.5                  |       | pF   |

### switching characteristics over recommended ranges of TA and VCC (unless otherwise noted)

| PARAMETER        |                          | TEST<br>CONDITIONS     |              |  | SN54S'           |     | SN745                |     |      |
|------------------|--------------------------|------------------------|--------------|--|------------------|-----|----------------------|-----|------|
|                  |                          |                        |              |  | TYP <sup>‡</sup> | MAX | MIN TYP <sup>‡</sup> | MAX | UNIT |
| ta(ad)           | Access time from address | C. = 20 oF             | Cao Elaura 1 |  | 45               | 95  | 45                   | 70  | ns   |
| <sup>t</sup> PZX | Output enable time       | C[-30pr,               | See Figure 1 |  | 15               | 45  | 15                   | 30  | ns   |
| tpxz             | Output disable time      | C <sub>L</sub> = 5 pF, | See Figure 1 |  | 10               | 40  | 10                   | 25  | ns   |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

§Not more than one output should be shorted at a time and duration of the short-circuit should not exceed one second,

NOTES: 1. Voltage values are with respect to network ground terminal.

With outputs open and enable (G) inputs grounded, I<sub>CC</sub> is measured first by selecting a word that contains the maximum number of high-level outputs, then be selecting a word that contains the maximum number of low-level inputs.



### PARAMETER MEASUREMENT INFORMATION

NOTES: A. CL includes probe and capacitance.

B. All diodes are IN916 or IN3064.

C. Waveform 1 is for an output with internal conditions such that the output is low except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high except when disabled by the output control.

**FIGURE 1** 

### schematics of inputs and outputs





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### TYPICAL APPLICATION DATA SN54S485/SN74S485



20-BIT-BINARY-TO-BCD CONVERTER



21-BIT-BINARY-TO-BCD CONVERTER



22-BIT-BINARY-TO-BCD CONVERTER



 $\begin{array}{l} \textbf{24-BIT-BINARY-TO-BCD CONVERTER} \\ \text{*SN54185/SN74185 can be used.} \\ \text{K} = 10^3, \, \text{M} = 10^6 \end{array}$ 



23-BIT-BINARY-TO-BCD CONVERTER



25-BIT-BINARY-TO-BCD CONVERTER



6-75



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## TTL SSI

## TYPES SN54LS540, SN54LS541, SN74LS540, SN74LS541 Octal Buffers and Line Drivers With 3-state Outputs

BULLETIN NO. DL-S 12722, AUGUST 1979

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- P-N-P Inputs Reduce D-C Loading
- Hysteresis at Inputs Improves Noise Margins
- Data Flow-thru Pinout (All Inputs on Opposite Side from Outputs)

### description

These octal buffers and line drivers are designed to have the performance of the popular SN54LS240/ SN74LS240 series and, at the same time, offer a pinout having the inputs and outputs on opposite sides of the package. This arrangement greatly enhances printed circuit board layout.

The three-state control gate is a 2-input NOR such that if either  $\overline{G1}$  or  $\overline{G2}$  are high, all eight outputs are in the high-impedance state.

The 'LS540 offers inverting data and the 'LS541 offers true data at the outputs.

The SN54LS540 and SN54LS541 are characterized for operation over the full military temperature range of  $-55^{\circ}$ C to  $125^{\circ}$ C. The SN74LS540 and SN74LS541 are characterized for operation from 0°C to 70°C.



SN54LS' ... J PACKAGE

SN74LS' ... J OR N PACKAGE

|         | Rated    | Rated    | Typical Power |              |  |
|---------|----------|----------|---------------|--------------|--|
|         | IOL      | юн       | Dissipation   |              |  |
|         | (Sink    | (Source  | (Enabled)     |              |  |
|         | Current) | Current) | Inverting     | Noninverting |  |
| SN54LS' | 12 mA    | —12 mA   | 92.5 mW       | 117.5 mW     |  |
| SN74LS' | 24 mA    | —15 mA   | 92.5 mW       | 117.5 mW     |  |

### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, V <sub>CC</sub> (see Note 1) 7             | ' V<br>/ V |
|--|------------|
| Operating free-air temperature range: SN54LS540, SN54LS541 | ာ°င<br>၁°۲ |
| Storage temperature range                                  | °C         |

NOTE 1: Voltage values are with respect to the network ground terminal.

#### schematics of inputs and outputs



ADVANCE INFORMATION

This document contains information on

a new product. Specifications are subject

to change without notice.



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## TYPES SN54LS540, SN54LS541, SN74LS540, SN74LS541 OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS



<sup>†</sup>These symbols are in accordance with IEEE Std 91/ANSI Y32.14 and current discussions in IEC and IEEE.



#### 'LS540





## TYPES SN54LS540, SN54LS541, SN74LS540, SN74LS541 OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

### recommended operating conditions

|  | SN54LS' |     |     |      |     | SN74LS' |    |  |
|--|---------|-----|-----|------|-----|---------|----|--|
|  | MIN     | NOM | MAX | MIN  | NOM | MAX     |    |  |
| Supply voltage, V <sub>CC</sub> (see Note 1)   | 4.5     | 5   | 5.5 | 4.75 | 5   | 5.25    | V  |  |
| High-level output current, IOH                 |         |     | -12 |      |     | -15     | mA |  |
| Low-level output current, IOL                  |         |     | 12  |      |     | 24      | mA |  |
| Operating free-air temperature, T <sub>A</sub> | -55     |     | 125 | 0    |     | 70      | °C |  |

NOTE 1: Voltage values are with respect to network ground terminal.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                    |                                |              |   | TEST CONDITIONS!                                  |     | SN54LS |      |     | SN74LS | ·    |       |  |
|--------------------|--------------------------------|--------------|---|---|-----|--------|------|-----|--------|------|-------|--|
|                    | PARAMETER                      |              | TESTCOND  | DITIONS   | MIN | TYP‡   | MAX  | MIN | TYP‡   | MAX  | וואטן |  |
| VIH                | High-level input voltage       |              |   | - <u> </u>  | 2   |        |      | 2   |        |      | V     |  |
| VIL                | Low-level input voltage        |              |   |   |     |        | 0.7  |     |        | 0.8  | V     |  |
| VIK                | Input clamp voltage            |              | $V_{CC} = MIN,$   | lj = –18 mA                                       |     |        | -1.5 |     |        | -1.5 | V     |  |
|                    | Hysteresis $(V_{T+} - V_{T-})$ |              | V <sub>CC</sub> = MIN   |   | 0.2 | 0.4    |      | 0.2 | 0.4    |      | V     |  |
| Vou                | High-level output voltage      |              | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = V <sub>IL</sub> max | V <sub>IH</sub> = 2 V,<br>, I <sub>OH</sub> =3 mA | 2.4 | 3.4    |      | 2.4 | 3.4    |      |       |  |
| VOH                | Thigh force output vortage     |              | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.5 V,              | V <sub>IH</sub> = 2 V,<br>I <sub>OH</sub> = MAX   | 2   |        |      | 2   |        |      |       |  |
| Voi                | Low-level output voltage       |              | $V_{CC} = MIN,$   | IOL = 12 mA                                       |     | 0.25   | 0.4  |     | 0.25   | 0.4  | V     |  |
|                    |                                |              | $V_{IL} = V_{IL} max$   | I <sub>OL</sub> = 24 mA                           |     |        |      |     | 0.35   | 0.5  | ľ     |  |
| Iozн               | Off-state output current,      |              | V <sub>CC</sub> = MAX,  | V <sub>O</sub> = 2.7 V                            |     |        | 20   |     |        | 20   |       |  |
|                    | Off-state output current       |              | V <sub>IH</sub> = 2 V,  | ·   | ┼   |        |      |     |        |      | μA    |  |
| OZL                | low-level voltage applied      |              | VIL = VILmax  | V <sub>O</sub> = 0.4 V                            |     |        | -20  |     | 20     |      |       |  |
| ц                  | Input current at maximum       | m            | V <sub>CC</sub> = MAX,  | V <sub>I</sub> = 7 V                              |     |        | 0.1  |     |        | 0.1  | mA    |  |
| <u></u>            | High-level input current,      | any input    | Vcc = MAX,  | VI = 2.7 V  |     |        | 20   |     |        | 20   | μA    |  |
|                    | Low-level input current        |              | Vcc = MAX.  | V1 = 0.4 V  |     |        | -0.2 |     |        | -0.2 | mA    |  |
| 105                | Short-circuit output curre     | ent♦         | V <sub>CC</sub> = MAX   |   | -40 |        | -225 | -40 |        | -225 | mA    |  |
| <u> </u>           |                                | Outputs high |   | 'LS540  |     | 13     |      |     | 13     |      |       |  |
| Į                  |                                | Outputs high | 5   | 'LS541  |     | 18     |      |     | 18     |      |       |  |
| · · ·              | Supply summert                 |              |   | 'LS540  |     | 24     |      |     | 24     |      |       |  |
| I <sub>CC</sub> Su | Supply current                 |              | Outputs open  | 'LS541  |     | 29     |      |     | 29     |      |       |  |
|                    |                                | All outputs  | ]   | 'LS540  | 30  |        |      | 30  |        |      |       |  |
|                    |                                | disabled     |   | 'LS541  |     | 31     |      |     | 31     |      |       |  |

| | b

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

\*Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

### switching characteristics, VCC = 5 V, TA = $25^{\circ}$ C

| PARAMETER        |   | TEST CONDITIONS           |                      | 'LS540 |     |     | 'LS541 |     |  |    |
|------------------|---|---------------------------|----------------------|--------|-----|-----|--------|-----|--|----|
|                  |   | TEST CON                  | MIN                  | TYP    | MAX | MIN | TYP    | MAX |  |    |
| <sup>t</sup> PLH | Propagation delay time,<br>low-to-high-level output |                           |                      |        | 9   |     |        | 12  |  | ns |
| <sup>t</sup> PHL | Propagation delay time,<br>high-to-low-level output | CL ≈ 45 pF,<br>See Note 2 | $R_L = 667 \Omega$ , |        | 12  |     |        | 12  |  | ns |
| <sup>t</sup> PZL | Output enable time to low level                     | ]                         |                      |        | 20  |     |        | 20  |  | ns |
| <sup>t</sup> PZH | Output enable time to high level                    | 1                         |                      |        | 15  |     |        | 25  |  | ns |
| <sup>t</sup> PLZ | Output disable time from low level                  | CL = 5 pF,                | $R_L = 667 \Omega$ , |        | 15  |     |        | 15  |  | ns |
| <sup>t</sup> PHZ | Output disable time from high level                 | See Note 2                |                      |        | 10  |     |        | 10  |  | ns |

NOTE 2: Load circuit and voltage waveforms are shown on page 1-15.

## TYPES SN54LS600 THRU SN54LS603, SN74LS600 THRU SN74LS603 MEMORY REFRESH CONTROLLERS



#### SELECTION TABLE

| DEVICE |                    | MEMORY CIZE | PIN ASSIGNMENTS |        |                |  |  |  |
|--------|--------------------|-------------|-----------------|--------|----------------|--|--|--|
| DEVICE | NEFRESH WODES      | MEMORY SIZE | PIN 9           | PIN 17 | PIN 18         |  |  |  |
| 'LS600 | Transparent, Burst | 4K or 16K   | 4K/16K          | NC     | NC             |  |  |  |
| 'LS601 | Transparent, Burst | 64K         | A7              | NC     | NC             |  |  |  |
| 'LS602 | Cycle Steal, Burst | 4K or 16K   | 4K/16K          | READY  | RC CYCLE STEAL |  |  |  |
| 'LS603 | Cycle Steal, Burst | 64K         | A7              | READY  | RC CYCLE STEAL |  |  |  |

NC = No internal connection.

#### description

TTL

LSI

The 'LS600 thru 'LS603 memory refresh controllers contain one 8-bit synchronous counter, nine 3-state buffer drivers, four RC-controlled multivibrators, and other control circuitry on a monolithic chip. They are intended for use with RAS-only-refresh dynamic RAMs. These controllers have 3-state RAS and address outputs that are in the high-impedance state when no refresh is in progress. They become active approximately 30 nanoseconds after the REF REQ pins are taken high and remain active until about 30 nanoseconds after the refresh is complete.

#### operating modes

In the transparent refresh mode, row refresh cycles occur during inactive CPU-memory times so that, in most cases, the entire memory refresh sequence can be done "transparently" (without interrupting CPU operations). When the REF REQ pins are taken high to indicate an idle CPU/memory period, as many rows as possible are refreshed. A low level on BUSY signals the CPU to wait until the end of the current row refresh cycle before reinstating operations. When the RC time constant programmed at RC BURST indicates that the safe refresh time of the memory has been exceeded, the memory refresh controller will automatically signal the CPU for an emergency burst-mode refresh by taking HOLD low. The CPU must then take the REF REQ pins high and keep them at the level until HOLD goes high after all rows have been refreshed. The automatic burst refresh will be initiated by the refresh controller even when transparent or cycle-steal refresh operations are already in progress.

PRODUCT PREVIEW

6-80 This document contains information on a product under development. Texas Instruments reserves the right to change or discontinue this product without notice. TEXAS INSTRUMENTS INCORPORATED POST OFFICE BOX 225012 • DALLAS, TEXAS 75265

## TYPES SN54LS600 THRU SN54LS603, SN74LS600 THRU SN74LS603 MEMORY REFRESH CONTROLLERS

Cycle-steal refresh is implemented by dividing the safe refresh time into equal segments and refreshing one row in each of those segments. The safe refresh time is programmed by the time constant at RC BURST and the segment time by the time constant at RC CYCLE STEAL. A low level at READY on the 'LS602 and 'LS603 indicates to the CPU to suspend operations for one memory cycle for a row refresh. In effect it "steals" one memory cycle from the CPU.

In all operating modes, the latch on the automatic burst mode circuit is reset at the end of every complete memory refresh cycle.

| PIN    | PIN NAME              | FUNCTIONAL DESCRIPTION   |  |  |  |
|--------|-----------------------|--|--|--|--|
| 1      | BUSY                  | Active output indicates to the CPU that a refresh cycle is in progress.                          |  |  |  |
| 16     | HOLD                  | Active output should be a priority interrupt to the CPU for emergency burst refresh.             |  |  |  |
| 15     | RAS                   | 3 state output row address strobe.   |  |  |  |
| 11     | RC RAS HI             | Timing node for high-level portion of RAS. See Note 1.   |  |  |  |
| 12     | RC RAS LO             | Timing node for low-level portion of RAS. See Note 1.  |  |  |  |
| 2-8    | A0 thru A6            | 3 state output row address lines.  |  |  |  |
| 9      | A7                    | MSB row address line for 'LS600 and 'LS603 (64K-bit memory controllers).                         |  |  |  |
|        |                       | A high input level disables the A6 row address line for 'LS600 and 'LS602. (The high level input |  |  |  |
| 9      | 40/100                | makes the count chain 6 bits long while the low level makes the count chain 5 bits long.)        |  |  |  |
|        | 25.201                | Interrupt to CPU for cycle steal refresh ('LS602 and 'LS603).                                    |  |  |  |
| 1/     | READY                 | No internal connection on 'LS600 and 'LS601.   |  |  |  |
| 18     | RC CYCLE STEAL        | Timing node that controls the READY output. See Note 1.  |  |  |  |
| 19     | RC BURST              | Timing node for burst refresh. See Note 1.   |  |  |  |
| 40.44  | REF REQ1,             |  |  |  |  |
| 13,14  | REF REQ2              | High level on both pins starts and continues row retresh. Low on either pin inhibits retresh.    |  |  |  |
| 20, 10 | V <sub>CC</sub> , GND | 5-V power supply and network ground pins.  |  |  |  |

NOTE 1: All timing nodes require a resistor to V<sub>CC</sub> and a capacitor to GND. Programmed time is approximately equal to 0.24 RC.



### TYPES SN54LS604 THRU SN54LS607, SN74LS604 THRU SN74LS607 **OCTAL 2-INPUT MULTIPLEXED LATCHES** BULLETIN NO. DI-S 12699, JULY 19

### (TIM99604 THRU TIM99607)

- Choice of Outputs: Three-State ('LS604, 'LS606) Open-Collector ('LS605, 'LS607)
- 16 D-Type Registers, One for each Data Input
- Multiplexer Selects Stored Data from Either A Bus or B Bus
- Application Oriented: Maximum Speed ('LS604, 'LS605) Giltch-Free Operation ('LS606, 'LS607)

### description

TTL

LSI

The 'LS604 through 'LS607 multiplexed latches are ideal for storing data from two input buses, A and B, and providing the output bus with stored data from either the A or B register.

The clock loads data on the positive-going (low-level to high-level) transition. The clock pin also controls the active and high-impedance states of the outputs. When the clock pin is low, the outputs are in the high-impedance or off state. When the clock pin is high, the outputs are enabled.

The 'LS604 and 'LS605 are optimized for high-speed operation. The 'LS606 and 'LS607 are especially designed to eliminate decoding voltage spikes.

These functions are ideal for interface from a 16-bit microprocessor to a 64K RAM board. The row and column addresses can be loaded as one word from the microprocessor and then multiplexed sequentially to the RAM during the time that RAS and CAS are active.

The SN54LS604 through SN54LS607 are characterized for operation over the full military temperature range of -55°C to 125°C; the SN74LS604 through SN74LS607 are characterized for operation from 0°C to 70°C.

|        |        | OUTPUTS    |       |                        |
|--------|--------|------------|-------|------------------------|
| A1-A8  | B1-B8  | SELECT A/B | CLOCK | Y1-Y8                  |
| A data | B data | L          | t t   | B data                 |
| A data | B data | н          | t     | A data                 |
| х      | x      | х          | ι L   | Z or Off               |
| х      | ×      | L          | н     | B register stored data |
| х      | x      | н          | Н     | A register stored data |

### FUNCTION TABLE

H = high level (steady state)

X = irrelevant

L = low level (steady state)

Z = high-impedance state

Off = H if pull-up resistor is connected to open-collector output

1 = transistion from low to high level

SN54LS604 thru SN54LS607 ... J PACKAGE SN74LS604 thru SN74LS607 ... J OR N PACKAGE (TOP VIEW)



## TYPES SN54LS604 THRU SN54LS607, SN74LS604 THRU SN74LS607 Octal 2-input multiplexed latches

logic symbols<sup>†</sup>







functional block diagram (positive logic)



<sup>†</sup>These symbols are in accordance with IEEE Std 91/ANSI Y32.14 and current discussions in IEC and IEEE.

#### schematics of inputs and outputs



## TEXAS INSTRUMENTS

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## TYPES SN54LS604, SN54LS606, SN74LS604, SN74LS606 OCTAL 2-INPUT MULTIPLEXED LATCHES WITH 3-STATE OUTPUTS

### recommended operating conditions

|  | SN54LS604<br>SN54LS606 |     |     | SN74LS604<br>SN74LS606 |     |      | UNIT |  |
|--|------------------------|-----|-----|------------------------|-----|------|------|--|
|  | MIN                    | NOM | MAX | MIN                    | NOM | MAX  | 0    |  |
| Supply voltage, V <sub>CC</sub> (see Note 1) | 4.5                    | 5   | 5.5 | 4,75                   | 5   | 5.25 | V    |  |
| High-level output current, IOH               |                        | _   | _1  |                        |     | -2.6 | mA   |  |
| Low-level output current, IOL                |                        |     | 12  |                        |     | 24   | mA   |  |
| Width of clock pulse, tw                     | 20                     |     |     | 20                     |     |      | ns   |  |
| Setup time, t <sub>su</sub>                  | 201                    |     |     | 201                    |     |      | ns   |  |
| Hold time, t <sub>h</sub> !                  | 10                     |     |     | 10                     |     |      | ns   |  |
| Operating free-air temperature, TA           | -55                    |     | 125 | 0                      |     | 70   | °C   |  |

NOTE 1: Voltage values are with respect to network ground terminal.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|          | PARAMETER TEST CONDITION         | st   | SN54LS604<br>SN54LS606                          |                         |     | 5    | 04<br>506 | UNIT |      |      |                |
|----------|----------------------------------|--|---|-------------------------|-----|------|-----------|------|------|------|----------------|
|          |                                  |  |   |                         | MIN | TYP‡ | MAX       | MIN  | ТҮР‡ | MAX  |                |
| VIH      | High-level input voltage         |  |   |                         | 2   | _    |           | 2    |      |      | V              |
| VIL      | Low-level input voltage          |  |   |                         |     | _    | 0.7       |      |      | 0.8  | V              |
| VIK      | Input clamp voltage              | $V_{CC} = MIN,$  | lı =18 mA                                       |                         |     |      | 1.5       |      |      | -1.5 | V              |
| ∨он      | High-level output voltage        | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = V <sub>IL</sub> max, | V <sub>IH</sub> ≈ 2 V,<br>I <sub>OH</sub> = MAX |                         | 2.4 | 3.1  |           | 2.4  | 3.1  |      | v              |
| Voi      | Low-level output voltage         | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V,                          | I <sub>OL</sub> ≈ 12 mA |     | 0,25 | 0.4       |      | 0.25 | 0.4  | V              |
| VOL      | Low-level output voltage         | VIL = VIL max,   |   | IOL = 24 mA             |     |      |           |      | 0.35 | 0.5  | Ň              |
| 10711    | Off-state output current,        | $V_{CC} = MAX,$  | V <sub>IH</sub> = 2 V,                          |                         | 1   |      | 20        |      |      | 20   |                |
| 'OZH     | high-level voltage applied       | VIL = VIL max,   | V <sub>O</sub> = 2.7 V                          |                         |     |      | 20        |      |      | 20   | μΑ             |
| 1071     | Off-state output current,        | V <sub>CC</sub> = MAX,   | V <sub>IH</sub> = 2 V,                          |                         | }   |      | 20        |      |      | _ 20 |                |
| 102L     | low-level voltage applied        | VIL = VIL max,   | V <sub>O</sub> = 0.4                            |                         |     |      | -20       |      |      | -20  | <b>#^</b>      |
| 1.       | Input current at                 | Vec = MAX  | $V_{1} = 7 V$                                   | А, В                    |     |      | 0.1       |      |      | 0.1  | mA             |
| l 'l     | maximum input voltage            | VCC 1112A,   | vi = , v  | CLK, SELECT             |     |      | 0.1       |      |      | 0.1  |                |
| <b>—</b> | High-level input current         |  | $V_{1} = 2.7 V$                                 | А, В                    |     |      | 20        |      |      | 20   |                |
|          |                                  | VCC MAA,   | vi - 2.7 v                                      | CLK, SELECT             |     |      | 20        |      |      | 20   | <u><u></u></u> |
| 1        | Low-level input current          | $V_{00} = MAX$   | $V_{1} \approx 0.4 V$                           | А, В                    |     |      | 0.4       |      |      | -0.4 | mA             |
|          |                                  | VCC - MAA,   | V  = 0.4 V                                      | CLK, SELECT             |     |      | -0.2      |      |      | -0.2 | IIIA           |
| IOS      | Short-circuit<br>output current§ | V <sub>CC</sub> = MAX  |   |                         | 30  |      | -130      | -30  |      | -130 | mA             |
| 1CC      | Supply current                   | V <sub>CC</sub> = MAX,   | See Note 2                                      |                         |     | 55   | 70        |      | 55   | 70   | mA             |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

 $\S$  Note more than one output should be shorted at a time.

NOTE 2: ICC is tested with all inputs grounded and all outputs open.

### switching characteristics, VCC = 5 V, TA = 25°C

| PARAMETER         | FROM                 | TEST        |                      | 'LS604 |     |     | 'LS606 |     |     |      |    |
|-------------------|----------------------|-------------|----------------------|--------|-----|-----|--------|-----|-----|------|----|
| CANAMETER         | (INPUT)              | 1201 0      |                      | MIN    | TYP | MAX | MIN    | TYP | MAX | UNIT |    |
| tPLH              | Select A/B           |             |                      |        | 15  | 25  |        | 36  | 50  |      |    |
| <sup>t</sup> PHL  | (Data: A = H, B = L) |             |                      |        | 23  | 35  |        | 16  | 30  | ns   |    |
| tPLH              | Select A/B           | CL = 45 pF, | RL = 667 Ω,          |        | 31  | 45  |        | 22  | 35  |      |    |
| <sup>t</sup> PHL  | (Data: A = L, B = H) | See Note 3  | See Note 3           |        |     | 19  | 30     |     | 22  | 35   | ns |
| <sup>t</sup> PZH  | Clock                |             |                      |        | 19  | 30  |        | 27  | 40  |      |    |
| <sup>t</sup> PZL  | CIUCK                |             |                      | _      | 28  | 40  |        | 35  | 50  | 115  |    |
| tPHZ              | Clock                | CL = 5 pF,  | $R_L = 667 \Omega$ , |        | 20  | 30  |        | 20  | 30  | -    |    |
| <sup>t</sup> PLZ_ | CIUCK                | See Note 3  |                      |        | 15  | 25  |        | 15  | 25  | 115  |    |

 $t_{PLH} \equiv propagation delay time, low-to-high-level output$ 

 $t_{PHL} \equiv propagation delay time, low-to-high-level output$ 

 $t_{ZH} \equiv$  output enable time to high level

 $t_{ZL} \equiv output enable time to low level$ 

 $t_{HZ} \equiv$  output disable time from high level

 $t_{LZ} \equiv$  output disable time from low level

NOTE 3: Load circuits and voltage waveforms are shown on page 1-14.

## TYPES SN54LS605, SN54LS607, SN74LS605, SN74LS607 OCTAL 2-INPUT MULTIPLEXED LATCHES WITH OPEN-COLLECTOR OUTPUTS

### recommended operating conditions

|  | SN54LS605<br>SN54LS607 |     |     | SN74LS605<br>SN74LS607 |     |      | UNIT |
|--|------------------------|-----|-----|------------------------|-----|------|------|
|  | MIN                    | NOM | MAX | MIN                    | NOM | MAX  |      |
| Supply voltage, V <sub>CC</sub> (see Note 1)   | 4.5                    | 5   | 5.5 | 4.75                   | 5   | 5.25 | v    |
| High-level output voltage, VOH                 |                        |     | 5.5 |                        |     | 5.5  | V    |
| Low-level output current, IOL                  |                        |     | 12  |                        |     | 24   | mA   |
| Width of clock pulse, t <sub>w</sub>           | 20                     |     |     | 20                     |     |      | ns – |
| Setup time, t <sub>su</sub>                    | 201                    |     |     | 20†                    |     |      | ns   |
| Hold time, t <sub>h</sub>                      | 10                     |     |     | 10                     |     |      | ns   |
| Operating free-air temperature, T <sub>A</sub> | -55                    |     | 125 | 0                      |     | 70   | °C   |

NOTE 1: Voltage values are with respect to network ground terminal.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|     | PARAMETER                                 | TES  | TEST CONDITIONS <sup>†</sup>                      |                         |     | SN54LS605<br>SN54LS607 |             |     | SN74LS605<br>SN74LS607 |            |    |
|-----|---|--|---|-------------------------|-----|------------------------|-------------|-----|------------------------|------------|----|
|     |   |  |   |                         | MIN | түр‡                   | МАХ         | MIN | түр‡                   | MAX        |    |
| VIH | High-level input voltage                  |  |   |                         | 2   |                        |             | 2   |                        |            | V  |
| VIL | Low-level input voltage                   |  |   |                         |     |                        | 0.7         |     |                        | 0.8        | v  |
| VIК | Input clamp voltage                       | V <sub>CC</sub> = MIN,   | l <sub>I</sub> ≂ –18 mA                           |                         |     |                        | -1.5        |     |                        | -1.5       | V  |
| юн  | High-level output current                 | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = V <sub>IL</sub> max, | V <sub>IH</sub> = 2 V,<br>V <sub>OH</sub> = 5.5 V |                         |     |                        | 250         |     |                        | 250        | μA |
| VOL | Low-level output voltage                  | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = V <sub>IL</sub> max  | V <sub>IH</sub> = 2 V,                            | I <sub>OL</sub> = 12 mA |     | 0,25                   | 0.4         |     | 0.25<br>0.35           | 0.4<br>0.5 | v  |
| 11  | Input current at<br>maximum input voltage | V <sub>CC</sub> = MAX,   | V <sub>1</sub> = 7 V                              | A, B<br>CLK, SELECT     |     |                        | 0.1<br>0.1  |     |                        | 0.1<br>0.1 | mA |
| ίн  | High-level input current                  | V <sub>CC</sub> = MAX,   | V <sub>I</sub> = 2.7 V                            | A, B<br>CLK, SELECT     |     |                        | 20<br>20    |     |                        | 20<br>20   | μA |
| կլ  | Low-level input current                   | V <sub>CC</sub> = MAX,   | V <sub>1</sub> = 0.4 V                            | A, B<br>CLK, SELECT     |     |                        | -0.4<br>0.2 |     |                        | 0.4<br>0.2 | mA |
| Icc | Supply current                            | V <sub>CC</sub> = MAX,   | See Note 2  |                         |     | 40                     | 60          |     | 40                     | 60         | mA |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. <sup>‡</sup>All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

NOTE 2: ICC is tested with all inputs grounded and all outputs open.

### switching characteristics, $V_{CC} = 5 V$ , $T_A = 25^{\circ}C$

| PARAMETER        | FROM                 | TEST CONDITIONS |                        |     | 'LS605 |     |     | 'LS607 |      |     |
|------------------|----------------------|-----------------|------------------------|-----|--------|-----|-----|--------|------|-----|
| TANAMETER        | (INPUT)              | 1201            | MIN                    | түр | MAX    | MIN | түр | MAX    | UNIT |     |
| <b>tPLH</b>      | Select A/B           |                 |                        |     | 28     | 40  |     | 51     | 70   |     |
| <sup>t</sup> PHL | (Data: A = H, B = L) |                 |                        |     | 28     | 40  |     | 21     | 30   | ns  |
| <sup>t</sup> PLH | Select A/B           | CL=45pF,        | $R_{L} = 667 \Omega$ , |     | 39     | 60  |     | 28     | 40   |     |
| <sup>t</sup> PHL | (Data: A = L, B = H) | See Note 3      |                        |     | 25     | 40  |     | 28     | 40   | 115 |
| <sup>t</sup> PLH | Clock                |                 |                        |     | 27     | 40  |     | 30     | 45   |     |
| tPHL.            |                      |                 |                        |     | 25     | 40  |     | 32     | 45   | 115 |

 $t_{PLH} \equiv propagation delay time, low-to-high-level output$ 

 $t_{\text{PHL}} \equiv \text{propagation}$  delay time, low-to-high-level output

NOTE 3: Load circuits and voltage waveforms are shown on page 1-14.

## TYPES SN54LS608, SN74LS608 Memory cycle controllers

AUGUST 1979



#### description

MSI

The 'LS608 memory cycle controller is designed to interface between a microprocessor and dynamic RAM memories. It contains six RS latches, five D-type flip-flops, and more than 50 miscellaneous gates on a single chip. The 'LS608 combines maximum flexibility and ease of programming via RC nodes to allow optimum memory cycle performance.

The 'LS608 can operate as a stand-alone interface but is also designed to be part of a three-chip memory controller set. The user must select one of the 'LS600 thru 'LS603 refresh controllers and one of the 'LS604 thru 'LS607 multiplexers to use along with the 'LS608 memory cycle controller for complete dynamic RAM control.

After the user has selected and attached RC networks to pins 1, 12, and 15, the 'LS608 will deliver proper RAS, CAS, and READ/WRITE output signals to execute one memory cycle as the start input is switched from low to high. The actual cycle executed will depend upon steady-state input conditions of the 'LS608 as indicated in the table below.

|                   |         | INPUT CONDITIONS |     |     |        |      |              |         |  |  |  |
|-------------------|---------|------------------|-----|-----|--------|------|--------------|---------|--|--|--|
|                   | MODE    | P/Ñ              | R/W | RMW | RAS    | CAS  | START        | REFRESH |  |  |  |
| MEMORI CICLE      | MODE    | IN               | IN  | IN  | ENABLE | HOLD | IN           | IN      |  |  |  |
|                   |         |                  |     |     | IN     | ÍN   |              |         |  |  |  |
| READ              |         | н                | н   | н   | L      | н    | <b>↑</b> ' ' | L       |  |  |  |
| WRITE             | PAGE    | н                | L   | н   | L      | н    | †            | L       |  |  |  |
| READ-MODIFY-WRITE |         | н                | н   | L   | L      | н    | 1            | L       |  |  |  |
| READ              |         | L                | н   | н   | L      | н    | 1            | L       |  |  |  |
| WRITE             | NORMAL  | L                | L   | н   | L .    | н    | †            | L       |  |  |  |
| READ-MODIFY-WRITE |         | L                | н   | L   | L      | н    | 1 1          | L       |  |  |  |
| REFRESH           | DECRESU | ×                | ×   | ×   | L      | н    | †            | н       |  |  |  |
| EXTERNAL REFRESH  | nernean | x                | ×   | ×   | н      | н    | x            | L       |  |  |  |

H = High, L= Low, x = irrelevant,  $\uparrow$  = low-to-high transition

#### PRODUCT PREVIEW

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## TYPES SN54LS608, SN74LS608 MEMORY CYCLE CONTROLLERS

#### PIN FUNCTION TABLE

| PIN | PIN NAME                  | FUNCTIONAL DESCRIPTION  |
|-----|---------------------------|---|
| 1   | RC PRECHARGE              | User-programmable timing node* for precharge (CAS high and RAS high).   |
| 2   | ₽/Ñ IN                    | When high, enables page mode; when low, enables normal mode. The page mode read or write cycle holds RAS continuously low while CAS and column addresses are sequenced.   |
| 3   | R/₩ IN                    | When high, initiates a read cycle (holds R/ $\overline{W}$ OUT high). When low, initiates a write cycle (holds R/ $\overline{W}$ OUT low). Pin 4 must be high.  |
| 4   | RMW IN                    | When low, enables read-modify-write cycle. $R/\overline{W}$ IN must be high at the start of the RMW cycle.  |
| 5   | ₽/₩ OUT                   | When high, indicates a read cycle is in progress. When low, indicates a write cycle is in progress. Normally ties to a $\overline{W}$ memory input in a system.   |
| 6   | RAS ENABLE IN             | When low, enables $\overline{RAS}$ output. When high, $\overline{RAS}$ is in the high-impedance or third state.   |
| 7   | RAS OUT                   | 3-state row-address-strobe output controlled by RAS ENABLE IN. In the three-chip controller set, the RAS output of the 'LS608 ties to the RAS output of the refresh controller ('LS600 thru 'LS603).  |
| 8   | GND                       | Device and substrate ground.  |
| 9   | CAS OUT                   | Column-address-strobe output.   |
| 10  | CAS HOLD IN               | When low, allows $\overline{\text{CAS}}$ to latch in low state. When high, latch is removed. Can be used to improve data retrieval during read cycle.   |
| 11  | MEMBSY and ROW/COLUMN OUT | In a system where the 'LS608 is a stand-alone controller, this output indicates<br>a memory busy condition to the microprocessor. When the 'LS608 is used as a<br>part of a three-chip controller set, this pin ties to the SELECT A/B input of<br>the multiplexer ('LS604 thru 'LS607) in addition to indicating a memory<br>busy condition to the microprocessor. |
| 12  | RCRAH                     | User-programmable timing node* for row address hold time. (high level at MEMBSY and ROW/COLUMN OUT).  |
| 13  | START IN                  | When changed from low to high, initiates a memory cycle.  |
| 14  | REFRESH IN                | When high, enables RAS-only refresh cycle,  |
| 15  | RC CAS LO                 | User-programmable timing node* for column-address-strobe low time.  |
| 16  | Vcc                       | 5-volt power supply terminal.   |

\*All timing nodes require a resistor to V<sub>CC</sub> and a capacitor to ground. Programmed time is approximately 0.24 RC.

### TYPES SN54LS610 THRU SN54LS613, SN74LS610 THRU SN74LS613 MEMORY MAPPERS AUGUST 1979

- (TIM99610 THRU TIM99613)
- Expands 4 Address Lines to 12 Address Lines
- Designed for Paged Memory Mapping
- Output Latches Provided on 'LS610 and 'LS611
- Choice of 3-State or Open-Collector Map Outputs
- Compatible with TMS 9900 and Other Microprocessors

|        | OUTPUTS | MAP            |
|--------|---------|----------------|
| DEVICE | LATCHED | OUTPUT TYPE    |
| 'LS610 | Yes     | 3-State        |
| 'LS611 | Yes     | Open-Collector |
| 'LS612 | No      | 3-State        |
| 'LS613 | No      | Open-Collector |

#### description

LSI

These memory-mapper integrated circuits contain a 4-line to 16-line decoder, a 16-word by 12-bit RAM, 16 channels of 2-line to 1-line multiplexers, and other miscellaneous circuitry on a monolithic chip. The 'LS610 and 'LS611 also contain 12 latches with an enable control.



\*NOTE: Pin 28 has no internal connection on 'LS612 and 'LS613

The memory mappers are designed to expand a microprocessor's memory address capability by eight bits. The four mostsignificant bits of the memory address bus (see Figure 1) can be used to select one of 16 map registers that contain 12 bits each. These 12 bits are presented to the system memory address bus through the map output buffers along with the unused memory address bits from the CPU. However, addressable memory space without reloading the map registers is the same as would be available with the memory mapper left out. The addressable memory space is increased only by periodically reloading the map registers from the data bus.

This configuration lends itself to memory utilization of 16 pages of  $2^{(n-4)}$  registers each without reloading (n = number of address bits available from CPU).

These devices have four modes of operation (read, write, map, and pass). Data may be read from or loaded into the map register selected by the register select inputs (RS0 thru RS3) under control of  $R/\overline{W}$  whenever chip select ( $\overline{CS}$ ) is low. The data I/O takes place on the data bus D0 thru D7. The map operation will output the contents of the map register selected by the map address inputs (MA0 thru MA3) when  $\overline{CS}$  is high and  $\overline{MM}$  (map mode control) is low. The 'LS612 and 'LS613 output stages are transparent in this mode, while the 'LS610 and 'LS611 outputs may be transparent or latched. When  $\overline{CS}$  and  $\overline{MM}$  are both high (pass mode), the address bits on MA0 thru MA3 appear as the most significant bits at the map outputs (assuming appropriate latch enable ) with low levels in the other bit positions.



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## TYPES SN54LS610 THRU SN54LS613, SN74LS610 THRU SN74LS613 MEMORY MAPPERS

functional block diagram (positive logic)



#### PIN FUNCTION TABLE

| PIN           | PIN NAME              | FUNCTIONAL DESCRIPTION   |
|---------------|-----------------------|--|
| 7-12,         | D0 thru D11           | I/O connections to data and control bus used for reading from and writing to the map register          |
| 2934          |                       | selected by RS0-RS3 when CS is low. Mode controlled by R/W.  |
| 36, 38, 1, 3  | RS0 thru RS3          | Register select inputs for I/O operations.   |
| 6             | R/₩                   | Read or write control used in I/O operations to select the condition of the data bus. When high, the   |
|               |                       | data bus outputs are active for reading the map register. When low, the data bus is used to write into |
|               |                       | the register.  |
| 5             | STROBE                | Strobe input used to enter data into the selected map register during I/O operations.                  |
| 4             | CS                    | Chip select input. A low input level selects the memory mapper (assuming more than one used) for       |
|               |                       | an I/O operation.  |
| 35, 37, 39, 2 | MA0 thru MA3          | Map address inputs to select one of 16 map registers when in map mode (MM low and CS high).            |
| 14—19,        | MO0 thru MO11         | Map outputs. Present the map register contents to the system memory address bus in the map mode.       |
| 2227          |                       | In the pass mode, these outputs provide the map address data on MO8-MO11 and low levels on             |
|               |                       | M00–M07.   |
| 13            | MM                    | Map mode input. When low, 12 bits of data are transferred from the selected map register to the map    |
|               |                       | outputs. When high (pass mode), the 4 bits present on the map address inputs are passed to the map     |
| -             |                       | outputs.   |
| 21            | ME                    | Map enable for the map outputs. A low level allows the outputs to be active while a high input level   |
|               |                       | puts the outputs at high impedance.  |
| 28            | С                     | Latch enable input for the 'LS610 and 'LS611 (no internal connection for 'LS612 and 'LS613). A         |
|               |                       | high level will transparently pass data to the map outputs. A low level will latch the outputs.        |
| 40, 20        | V <sub>CC</sub> , GND | 5-V power supply and network ground (substrate) pins.  |

## TTL MSI

- Bidirectional Bus Transceivers in High-Density 20-Pin Packages
- Local Bus-Latch Capability
- Hysteresis at Bus Inputs Improves Noise Margins
- Choice of True or Inverting Logic
- Choice of 3-State or Open-Collector Outputs

| DEVICE | OUTPUT         | LOGIC     |
|--------|----------------|-----------|
| 'LS620 | 3-State        | Inverting |
| 'LS621 | Open-Collector | True      |
| 'LS622 | Open-Collector | Inverting |
| 'LS623 | 3-State        | True      |

### description

These octal bus transceivers are designed for asynchronous two-way communication between data buses. The control function implementation allows for maximum flexibility in timing.

These devices allow data transmission from the A bus to the B bus or from the B bus to the A bus depending upon the logic levels at the enable inputs ( $\overline{GBA}$  and GAB).

The enable inputs can be used to disable the device so that the buses are effectively isolated.

The dual-enable configuration gives the 'LS620 thru 'LS623 the capability to store data by simultaneous enabling of  $\overline{G}BA$  and GAB. Each output reinforces its input in this transceiver configuration. Thus, when both control inputs are enabled and all other data sources to the two sets of bus lines are at high impedance, both sets of bus lines (16 in all) will remain at their last states. The 8-bit codes appearing on the two sets of buses will be identical for the 'LS621 and 'LS623 devices or complementary for the 'LS620 and 'LS622.



#### FUNCTION TABLE

| ENABLE | INPUTS | OPERATION        |                  |  |  |
|--------|--------|------------------|------------------|--|--|
| Ğва    | GAB    | 'LS620, 'LS622   | 'LS621, 'LS623   |  |  |
| L      | L      | B data to A bus  | B data to A bus  |  |  |
| н      | Н      | A data to B bus  | A data to B bus  |  |  |
| н      | L      | Isolation        | Isolation        |  |  |
|        |        | B data to A bus, | B data to A bus, |  |  |
| , L    | н      | Ā data to B bus  | A data to B bus  |  |  |

H = high level, L = low level, X = irrelevant

#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note 1) .    |         | <br> | <br>7 V                 |
|---------------------------------------|---------|------|-------------------------|
| Input voltage                         |         | <br> | <br>7 V                 |
| Off-state output voltage              |         | <br> | <br>5.5 V               |
| Operating free-air temperature range: | SN54LS' | <br> | <br>–55°C to 125°C      |
|                                       | SN74LS' | <br> | <br>$\dots$ 0°C to 70°C |
| Storage temperature range             |         | <br> | <br>–65°C to 150°C      |

NOTE 1: Voltage values are with respect to network ground terminal.

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## TYPES SN54LS620 THRU SN54LS623, SN74LS620 THRU SN74LS623 OCTAL BUS TRANSCEIVERS

### logic symbols<sup>†</sup>



<sup>†</sup>These symbols are in accordance with IEEE Std 91/ANSI Y32.14 and current discussions in IEC and IEEE.

### functional block diagrams (positive logic)

¼ 'LS620, ¼ 'LS622



¼ 'LS621, ¼ 'LS623



### schematics of inputs and outputs



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## TYPES SN54LS620, SN54LS623, SN74LS620, SN74LS623 OCTAL BUS TRANSCEIVERS WITH 3-STATE OUTPUTS

#### recommended operating conditions

| PARAMETER                                    | SI<br>SI | N54LS6<br>N54LS6 | 20<br>23 | SI<br>SI | UNIT |      |    |
|--|----------|------------------|----------|----------|------|------|----|
|  | MIN      | NOM              | MAX      | MIN      | NOM  | MAX  |    |
| Supply voltage, V <sub>CC</sub> (see Note 1) | 4.5      | 5                | 5.5      | 4.75     | 5    | 5.25 | V  |
| High-level output current, IOH               |          |                  | 12       |          |      | -15  | mA |
| Low-level output current, IOL                |          |                  | 12       |          |      | 24   | mA |
| Operating free-air temperature, TA           | -55      |                  | 125      | 0        |      | 70   | °Ĉ |

NOTE 1: Voltage values are with respect to network ground terminal.

#### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER |                                       |                               | TEST CON               | TEST CONDITIONS <sup>†</sup> |      |      | SN54LS620<br>SN54LS623 |      |      | SN74LS620<br>SN74LS623 |    |  |  |
|-----------|---------------------------------------|-------------------------------|------------------------|------------------------------|------|------|------------------------|------|------|------------------------|----|--|--|
|           |                                       |                               |                        | MIN                          | TYP‡ | MAX  | MIN                    | TYP‡ | MAX  |                        |    |  |  |
| VIH       | High-level input voltage              |                               |                        |                              | 2    |      |                        | 2    |      |                        | V  |  |  |
| VIL       | Low-level input voltage               |                               |                        |                              |      |      | 0.5                    |      |      | 0.6                    | V  |  |  |
| VIK       | Input clamp voltage                   |                               | $V_{CC} = MIN,$        | $I_1 = -18 \text{ mA}$       |      |      | -1.5                   |      |      | -1.5                   | V  |  |  |
|           | Hysteresis ( $V_{T+} - V_{T-}$ ) A or | B input                       | V <sub>CC</sub> = MIN  |                              | 0.1  | 0.4  |                        | 0.2  | 0.4  |                        | V  |  |  |
| Vou       | High-lovel output voltage             |                               | $V_{CC} = MIN,$        | l <sub>OH</sub> =3 mA        | 2.4  | 3.4  | _                      | 2.4  | 3.4  |                        | v  |  |  |
| ⊻он       |                                       |                               | $V_{1L} = V_{1L} max$  | I <sub>OH</sub> = MAX        | 2    |      |                        | 2    |      |                        | ľ  |  |  |
| Vei       | Low-level output voltage              |                               | $V_{CC} = MIN,$        | I <sub>OL</sub> = 12 mA      |      | 0.25 | 0.4                    |      | 0.25 | 0.4                    | v  |  |  |
| VOL       |                                       |                               | $V_{IL} = V_{IL} max$  | I <sub>OL</sub> = 24 mA      |      |      |                        |      | 0.35 | 0.5                    |    |  |  |
| 107H      | Off-state output current,             |                               | V <sub>CC</sub> = MAX, | G at 2 V,                    |      |      | 20                     |      |      | 20                     | μA |  |  |
|           | high-level voltage applied            |                               | $V_0 = 2.7 V$          |                              |      |      |                        |      |      | ·····-                 | ļ  |  |  |
| 1071      | Off-state output current,             |                               | V <sub>CC</sub> = MAX, | Gat2V,                       |      |      | -400                   |      |      | -400                   | μA |  |  |
|           | low-level voltage applied             |                               | V <sub>O</sub> = 0.4 V |                              |      |      |                        |      |      |                        | ļ  |  |  |
| 1 .       | Input current at                      | A or B                        | Vcc = MAX              | V <sub>1</sub> = 5.5 V       |      |      | 0.1                    |      |      | 0.1                    | mA |  |  |
|           | maximum input voltage                 | GBA or GAB                    |                        | $V_1 = 7V_{$                 |      |      | 0.1                    |      |      | 0.1                    |    |  |  |
| Чн        | High-level input current              |                               | V <sub>CC</sub> = MAX, | V <sub>I</sub> = 2.7 V       |      |      | 20                     |      |      | 20                     | μA |  |  |
| 11L       | Low-level input current               |                               | V <sub>CC</sub> = MAX, | V <sub>I</sub> = 0.4 V       |      |      | -400                   |      |      | -400                   | μA |  |  |
| los       | Short-circuit output current¶         |                               | V <sub>CC</sub> = MAX  |                              | -40  |      | -225                   | -40  |      | -225                   | mA |  |  |
|           |                                       | Outputs high                  |                        |                              |      | 48   | 70                     |      | 48   | 70                     |    |  |  |
| 1cc       | Total supply current                  | oly current Outputs low VCC = | V <sub>CC</sub> = MAX, | Outputs open                 |      | 62   | 90                     |      | 62   | 90                     | mA |  |  |
|           |                                       | Outputs at Hi-Z               |                        |                              |      | 64   | 95                     |      | 64   | 95                     |    |  |  |

<sup>†</sup>For conditions shown as MIN or MAX use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

 $\P$  Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second.

### switching characteristics at V<sub>CC</sub> = 5 V, $T_A = 25^{\circ}C$

| PARAMETER |                                     | FROM    | TO       | TEST CONDITIONS | 'LS620 |     |     | 'LS623 |     |     | UNIT  |
|-----------|-------------------------------------|---------|----------|-----------------|--------|-----|-----|--------|-----|-----|-------|
|           |                                     | (INPUT) | (OUIFOI) |                 | MIN    | ТҮР | MAX | MIN    | TYP | MAX |       |
|           | Propagation delay time,             | A       | В        |                 |        | 6   | 10  |        | 8   | 15  |       |
| ΨLH       | low-to-high-level output            | В       | A        | 0 45 - 5        |        | 6   | 10  |        | 8   | 15  | 115   |
|           | Propagation delay time,             | A       | В        | CL=45 pr,       |        | 8   | 15  |        | 11  | 15  |       |
| PHL       | high-to-low-level output            | В       | A        | <b>D</b> 007.0  |        | 8   | 15  |        | 11  | 15  | ris - |
|           | Output enable time to low level     | ĞВА     | A        | HL=00/32,       |        | 31  | 40  |        | 31  | 40  |       |
| ΨZL       |                                     | GAB     | B        | Cas Nata O      |        | 31  | 40  |        | 31  | 40  | ns    |
|           | <b>A A A A A A A A A A</b>          | ĞВА     | A        | See Note 2      |        | 23  | 40  |        | 26  | 40  |       |
| ΨZH       | Output enable time to high level    | GAB     | В        |                 |        | 23  | 40  |        | 26  | 40  | ns    |
|           | Quantum disable time from low lovel | ĞвА     | A        | 0 5 - 5         |        | 15  | 25  |        | 15  | 25  |       |
| ΨLZ       | Output disable time from low level  | GAB     | В        |                 |        | 15  | 25  |        | 15  | 25  | ns    |
|           | Output disable time from high level | ĞВА     | А        | n L - 007 12,   |        | 15  | 25  |        | 15  | 25  |       |
| TPHZ      |                                     | GAB     | В        | See Note 2      |        | 15  | 25  |        | 15  | 25  | ns    |

NOTE 2: For load circuits and voltage waveforms, see page 1-15.

## TYPES SN54LS621, SN54LS622, SN74LS621, SN74LS622 Octal bus transceivers with open-collector outputs

### recommended operating conditions

| PARAMETER                                      | SN54LS621<br>SN54LS622 |     |     |      |     | SN74LS621<br>SN74LS622 |    |  |  |
|--|------------------------|-----|-----|------|-----|------------------------|----|--|--|
|  | MIN                    | NOM | MAX | MIN  | NOM | MAX                    |    |  |  |
| Supply voltage, V <sub>CC</sub> (see Note 1)   | 4.5                    | 5   | 5.5 | 4.75 | 5   | 5.25                   | V  |  |  |
| High-level output voltage, V <sub>OH</sub>     |                        |     | 5.5 |      |     | 5.5                    | v  |  |  |
| Low-level output current, IOL                  |                        |     | 12  |      |     | 24                     | mA |  |  |
| Operating free-air temperature, T <sub>A</sub> | -55                    |     | 125 | 0    |     | 70                     | °C |  |  |

NOTE 1: Voltage values are with respect to network ground terminal.

### electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER |                            |              |                        | SN54LS621                    |      |      | SN74LS621 |           |      |      |      |
|-----------|----------------------------|--------------|------------------------|------------------------------|------|------|-----------|-----------|------|------|------|
|           |                            |              | TEST CON               | TEST CONDITIONS <sup>†</sup> |      |      | 22        | SN74LS622 |      |      | UNIT |
|           |                            |              |                        |                              | MIN  | түр‡ | MAX       | MIN       | τγρ‡ | MAX  |      |
| VIH       | High-level input voltage   |              |                        |                              | 2    |      |           | 2         |      |      | v    |
| VIL       | Low-level input voltage    |              |                        |                              |      |      | 0.5       |           | _    | 0.6  | V    |
| VIK       | Input clamp voltage        |              | $V_{CC} = MIN,$        | lı = —18 mA                  |      |      | -1.5      |           |      | -1.5 | v    |
| -         | Hysteresis (VT+ - VT_) A o | r B input    | V <sub>CC</sub> = MIN  |                              | 0.1  | 0.4  |           | 0.2       | 0.4  |      | v    |
|           | High-level output current  |              | V <sub>CC</sub> = MIN, | V <sub>IH</sub> = 2 V,       |      | 100  |           |           | 400  |      |      |
| юн        |                            |              | VIL = VIL max,         | V <sub>OH</sub> = 5.5 V      |      |      | 100       |           |      | 100  | μΑ   |
|           | Low-level output voltage   |              | V <sub>CC</sub> = MIN, | loi = 12  mA                 |      | 0.25 | 0.4       |           | 0.25 | 0.4  |      |
| VOL       |                            |              | VIH ≈ 2 V,             | -= 2 V,                      | 0.20 |      |           |           |      | l v  |      |
|           |                            |              | VIL = VIL max          | I <sub>OL</sub> = 24 mA      | 4    |      |           |           | 0.35 | 0.5  |      |
|           | Input current at           |              |                        |                              |      |      |           |           |      |      |      |
| 11        | maximum input voltage      |              | $V_{CC} = MAX,$        | V <sub>1</sub> = 7 V         |      |      | 0.1       |           |      | 0.1  | mA   |
| Чн        | High-level input current   |              | V <sub>CC</sub> = MAX, | V <sub>1</sub> = 2.7 V       |      |      | 20        |           |      | 20   | μA   |
| ΊL        | Low-level input current    |              | V <sub>CC</sub> = MAX, | V <sub>1</sub> = 0.4 V       |      |      | -400      |           |      | -400 | μA   |
| lee       | Total supply current       | Outputs high | V <sub>CC</sub> = MAX, | Outputs open                 |      | 48   | 70        |           | 48   | 70   |      |
| 'CC       |                            | Outputs low  |                        |                              |      | 62   | 90        |           | 62   | 90   | mA   |

<sup>†</sup>For conditions shown as MIN or MAX use the appropriate value specified under recommended operating conditions. <sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

### switching characteristics at V<sub>CC</sub> = 5 V, $T_A = 25^{\circ}C$

| PARAMETER        |                          | FROM    | TO       | TEST CONDITIONS         | 'LS621 |     |     |     | UNIT |     |    |
|------------------|--------------------------|---------|----------|-------------------------|--------|-----|-----|-----|------|-----|----|
|                  |                          | (INPUT) | (001901) |                         | MIN    | ТҮР | MAX | MIN | түр  | MAX | 1  |
| <sup>t</sup> PLH | Propagation delay time,  | A       | В        |                         |        | 17  | 25  |     | 19   | 25  |    |
|                  | low-to-high-level output | В       | A        | С <sub>L</sub> = 45 рF, |        | 17  | 25  |     | 19   | 25  | ns |
|                  | Propagation delay time,  | A       | В        |                         |        | 16  | 25  |     | 14   | 25  |    |
| PHL              | high-to-low-level output | В       | A        |                         |        | 16  | 25  |     | 14   | 25  | ns |
|                  | Output disable time      | ĞВА     | A        | HL=00732,               |        | 23  | 40  |     | 26   | 40  |    |
| ͲLΗ              | from low level           | GAB     | В        |                         |        | 25  | 40  |     | 28   | 40  |    |
| tPHL             | Output disable time      | GBA     | A        | See Note 2              |        | 34  | 50  |     | 43   | 60  |    |
|                  | from high level          | GAB     | В        | ]                       |        | 37  | 50  |     | 39   | 60  | ns |

NOTE 2: For load circuits and voltage waveforms, see page 1-15.


Single-bit errors in the 16-bit data word are flagged and corrected.

errors have occurred in memory.

Single-bit errors in the 6-bit checkword are flagged, and the CPU sends the EDAC through the correction cycle even though the 16-bit word is not in error. The correction cycle will simply pass along the original 16-bit word in this case and produce error syndrome bits to pinpoint the error-generating location.

Dual-bit errors are flagged but not corrected. These dual errors may occur in any two bits of the 22-bit word from memory (two errors in the 16-bit data word, two errors in the 6-bit checkword, or one error in each word).

The gross-error condition of all lows or all highs from memory will be detected. Otherwise, errors in three or more bits of the 22-bit word are beyond the capabilities of these devices to detect.

| Memory Control |    | ntrol |   | Data 1/0              | Charlessond 1/O      | Error Flags |      |  |
|----------------|----|-------|---|-----------------------|----------------------|-------------|------|--|
| Cycle          | S1 | S0    | EDAC FUnction                                 | Data 1/0              | Checkword I/O        | SEF         | DEF  |  |
| WRITE          | L  | L     | Generate Checkword                            | Input Data            | Output Checkword     | L           | L    |  |
| READ           | L  | н     | Read Data & Checkword                         | Input Data            | Input Checkword      | L           | L    |  |
| READ           | н  | н     | Latch & Flag Errors                           | Latch Data            | Latch Checkword      | Ena         | bled |  |
| READ           | н  | L     | Correct Data Word &<br>Generate Syndrome Bits | Output Corrected Data | Output Syndrome Bits | Ena         | bled |  |

#### CONTROL FUNCTION TABLE

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PRODUCT PREVIEW

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# TYPES SN54LS630,SN54LS631,SN74LS630,SN74LS631 16-BIT PARALLEL ERROR DETECTION AND CORRECTION CIRCUITS

functional block diagram



#### ERROR FUNCTION TABLE

| Total N     | umber of Errors | Erro | r Flags    | Data Correction |  |  |  |
|-------------|-----------------|------|------------|-----------------|--|--|--|
| 16-Bit Data | 6-Bit Checkword | SEF  | DEF        | Data Correction |  |  |  |
| 0           | 0               | L    | L          | Not Applicable  |  |  |  |
| 1           | 0               | н    | L L        | Correction      |  |  |  |
| 0           | 1               | н    | L          | Correction      |  |  |  |
| 1           | 1               | н    | н          | Interrupt       |  |  |  |
| 2           | 0               | н    | н          | Interrupt       |  |  |  |
| 0           | 2               | н    | <u>  н</u> | Interrupt       |  |  |  |

In order to be able to determine whether the data from the memory is acceptable to use as presented to the bus, the EDAC must be strobed to enable the error flags and the flags will have to be tested for the zero condition.

The first case in the error function table represents the normal, no-error condition. The CPU sees lows on both flags. The next two cases of single-bit errors require data correction. Although the EDAC can discern the single checkbit error and ignore it, the error flags are identical to the single error in the 16-bit data word. The CPU will ask for data correction in both cases. An interrupt condition to the CPU results in each of the last three cases, where dual errors occur.

#### error detection and correction details

During a memory write cycle, six check bits (CB0-CB5) are generated by eight-input parity generators using the data bits as defined below. During a memory read cycle, the 6-bit checkword is retrieved along with the actual data.

## TYPES SN54LS630,SN54LS631,SN74LS630,SN74LS631 16-BIT PARALLEL ERROR DETECTION AND CORRECTION CIRCUITS

| CHECKWORD |   | 16-BIT DATA WORD |   |   |   |   |   |   |   |   |    |    |    |    |    |    |
|-----------|---|------------------|---|---|---|---|---|---|---|---|----|----|----|----|----|----|
| BIT       | 0 | 1                | 2 | 3 | 4 | 5 | 6 | 7 | 8 | 9 | 10 | 11 | 12 | 13 | 14 | 15 |
| СВО       | × | ×                |   | × | × |   |   |   | × | x | x  |    |    | x  |    |    |
| CB1       | × |                  | x | × |   | × | × |   | × |   |    | x  |    |    | ×  |    |
| CB2       |   | ×                | × |   | × | × |   | x |   | × |    |    | x  |    |    | x  |
| СВЗ       | × | ×                | × |   |   |   | × | × |   |   | x  | ×  | ×  |    |    |    |
| CB4       |   |                  |   | × | × | × | x | × |   |   |    |    |    | х  | ×  | ×  |
| CB5       |   |                  |   |   |   |   |   |   | x | х | ×  | x  | x  | ×  | x  | ×  |

The six check bits are parity bits derived from the matrix of data bits as indicated by "x" for each bit.

Error detection is accomplished as the 6-bit checkword and the 16-bit data word from memory are applied to internal parity generators/checkers. If the parity of all six groupings of data and check bits are correct, it is assumed that no error has occurred and both error flags will be low. (It should be noted that the sense of two of the check bits, bits CBO and CB1, is inverted to ensure that the gross-error condition of all lows and all highs is detected.)

If the parity of one or more of the check groups is incorrect, an error has occurred and the proper error flag or flags will be set high. Any single error in the 16-bit data word will change the sense of exactly three bits of the 6-bit checkword. Any single error in the 6-bit checkword changes the sense of only that one bit. In either case, the single error flag will be set high while the dual error flag will remain low.

Any two-bit error will change the sense of an even number of check bits. The two-bit error is not correctable since the parity tree can only identify single-bit errors. Both error flags are set high when any two-bit error is detected.

Three or more simultaneous bit errors can fool the EDAC into believing that no error, a correctable error, or an uncorrectable error has occurred and produce erroneous results in all three cases.

Error correction is accomplished by identifying the bad bit and inverting it. Identification of the erroneous bit is achieved by comparing the 16-bit data word and 6-bit checkword from memory with the new checkword with one (checkword error) or three (data word error) inverted bits.

As the corrected word is made available on the data word I/O port, the checkword I/O port presents a 6-bit syndrome error code. This syndrome code can be used to identify the bad memory chip.

|                |     | s   | YNDROME | ERROR    | ODE      |     |
|----------------|-----|-----|---------|----------|----------|-----|
| ERROR LOCATION | СВО | CB1 | CB2     | CB3      | CB4      | CB5 |
| DB0            | L   | L   | н       | L        | н        | н   |
| DB1            | L   | н   | L       | L        | н        | н   |
| DB2            | н   | L   | L       | L        | н        | н   |
| DB3            | L L | L   | н       | н        | L        | н   |
| DB4            | L   | н   | L       | н        | L        | н   |
| DB5            | н   | L   | L       | н        | L        | н   |
| DB6            | н   | L   | н       | L        | L        | н   |
| DB7            | н   | н   | L       | L        | L        | н   |
| DB8            | L   | L   | н       | н        | н        | L   |
| DB9            | L L | н   | L       | н        | н        | L   |
| DB10           | L   | н   | н       | L        | н        | L   |
| DB11           | ) н | L   | н       | L        | н        | L   |
| DB12           | н   | н   | L       | Ł        | н        | L   |
| DB13           | L   | н   | н       | н        | L        | L   |
| DB14           | н   | L   | н       | н        | L        | L   |
| DB15           | н   | н   | L       | н        | L        | L   |
| CBO            | L   | н   | н       | н        | н        | н   |
| CB1            | н   | L   | н       | н        | н        | н   |
| CB2            | н   | н   | L       | н        | н        | н   |
| CB3            | н   | н   | н       | L        | н        | н   |
| CB4            | н   | н   | н       | н        | L        | н   |
| CB5            | н   | н   | н       | н        | н        | L   |
| NO ERROR       | н   | н   | н       | <u>н</u> | <u>н</u> | н   |

#### ERROR SYNDROME TABLE

## TYPES SN54LS630,SN54LS631,SN74LS630,SN74LS631 16-BIT PARALLEL ERROR DETECTION AND CORRECTION CIRCUITS

#### applications

It is possible to design the error detection and correction function using a single EDAC. Even though most semiconductor memories have separate inputs and outputs, the EDAC's data and checkbit pins are I/O combinations. But wired AND logic becomes mandatory, and a fairly complex system timing is required for both bus logic and controlling the EDAC. This scheme becomes difficult to implement both in terms of board layout and timing. System performance is also adversely affected. See Figure 1.



FIGURE 1-ERROR DETECTION AND CORRECTION USING A SINGLE EDAC UNIT

Optimized systems can be implemented using two EDACs in parallel. One of the units is used strictly as an encoder during the memory write cycle. Both controls S0 and S1 are grounded. This encoder chip will generate the 6-bit checkword for memory storage along with the 16-bit data.

The second of the two EDACs will be used as a decoder during the memory read cycle. This decoder chip does require timing pulses for proper operation. Control S0 is set low and S1 high as the memory read cycle begins. After the memory output data is valid, the control S0 input is moved from the low to a high. This low-to-high transition latches the 22-bit word from memory into internal registers of this second EDAC and enables the two error flags. If no error occurs, the CPU can accept the 16-bit word directly from memory. If a single error has occurred, the CPU must move the control S1 input from the high to a low to output corrected data and the error syndrome bits. Any dual error should be an interrupt condition.

In most applications, status registers will be used to keep tabs on error flags and error syndrome bits. If repeated patterns of error flags and syndrome bits occur, the CPU will be able to recognize these symptoms as a "hard" error. The syndrome bits can be used to pinpoint the faulty memory chip. See Figure 2.



FIGURE 2-ERROR DETECTION AND CORRECTION USING TWO EDAC UNITS



- Bi-directional Bus Transceivers in High-Density 20-Pin Packages
- Hysteresis at Bus Inputs Improves Noise Margins
- Choice of True or Inverting Logic
- Choice of 3-State or Open-Collector Outputs

#### description

TTL

MS

These octal bus transceivers are designed for asynchronous two-way communication between data buses. The devices transmit data from the A bus to the B bus or from the B bus to the A bus depending upon the level at the direction control (DIR) input. The enable input  $(\overline{G})$  can be used to disable the device so that the buses are effectively isolated.

#### SN54LS640, SN54LS642...J PACKAGE SN74LS640, SN74LS642...J OR N PACKAGE (TOP VIEW)

SN74LS640 THRU SN74LS6

OCTAL BUS TRANSCEIVERS BULLETIN NO. DL-S 12674, APRIL 1979

TYPES SN54LS640 THRU SN54LS645,



#### SN54LS641, SN54LS645...J PACKAGE SN74LS641, SN74LS645...J OR N PACKAGE (TOP VIEW)



FUNCTION TABLE

| CO | NTROL | OPERATION       |                 |                 |  |  |  |  |  |  |  |  |  |
|----|-------|-----------------|-----------------|-----------------|--|--|--|--|--|--|--|--|--|
| IN | PUTS  | 'LS640          | 'LS641          | 'LS643          |  |  |  |  |  |  |  |  |  |
| G  | DIR   | 'LS642          | 'LS645          | 'LS644          |  |  |  |  |  |  |  |  |  |
| L  | L     | B data to A bus | B data to A bus | B data to A bus |  |  |  |  |  |  |  |  |  |
| L  | н     | A data to B bus | A data to B bus | Ā data to B bus |  |  |  |  |  |  |  |  |  |
| н  | X     | Isolation       | Isolation       | Isolation       |  |  |  |  |  |  |  |  |  |

H = high level, L= low level, X = irrelevant

#### absolute maximum ratings

Same as SN54LS245 and SN74LS245 maximum ratings on page 6-13.

#### SN54LS643, SN54LS644...J PACKAGE SN74LS643, SN74LS644...J OR N PACKAGE (TOP VIEW)



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#### recommended operating conditions

|  |      |         |     |      |         |      |             |     | _    |    |
|--|------|---------|-----|------|---------|------|-------------|-----|------|----|
|  | SN   | 54LS64  | 0   | S    | N74LS64 | 40   | SN          | 0-1 |      |    |
|  | SN   | 154LS64 | 3   | S    | N74LS64 | 43   | SN          | 3–1 |      |    |
| PARAMETER                                    | · SN | 154LS64 | 5   | S    | N74LS6  | 45   | SN74LS645-1 |     |      |    |
|  | MIN  | NOM     | MAX | MIN  | NOM     | MAX  | MIN         | NOM | MAX  |    |
| Supply voltage, V <sub>CC</sub> (see Note 1) | 4.5  | 5       | 5.5 | 4.75 | 5       | 5.25 | 4.75        | 5   | 5.25 | v  |
| High-level output current, IOH               |      |         | -12 |      |         | -15  |             |     | -15  | mA |
| Low-level output current, IOL                |      |         | 12  |      |         | 24   |             |     | 48   | mΑ |
| Operating free-air temperature, TA           | -55  |         | 125 | 0    |         | 70   | 0           |     | 70   | °C |

NOTE 1: Voltage values are with respect to the network ground terminal.

electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|      | PARAMETER                              |                 | TEST CONDITIONS <sup>†</sup>         |                         | sr<br>sr<br>sr | N54LS64<br>N54LS64<br>N54LS64 | 0<br>3<br>5 | S<br>S<br>S | N74LS6<br>N74LS6<br>N74LS6 | 40<br>43<br>45 | SN74LS640-1<br>SN74LS643-1<br>SN74LS645-1 |      |      | UNIT      |
|------|--|-----------------|--------------------------------------|-------------------------|----------------|-------------------------------|-------------|-------------|----------------------------|----------------|---|------|------|-----------|
|      |  |                 |                                      |                         | MIN            | TYP‡                          | MAX         | MIN         | TYP <sup>‡</sup>           | MAX            | MIN                                       | TYP‡ | MAX  |           |
| ∨ін  | High-level input voltage               |                 |                                      |                         | 2              |                               |             | 2           |                            |                | 2   |      |      | v         |
| VIL  | Low-level input voltage                |                 |                                      |                         |                |                               | 0.5         |             |                            | 0,6            |   |      | 0.6  | V         |
| VIK  | Input clamp voltage                    |                 | V <sub>CC</sub> = MIN,               | I <sub>I</sub> = -18 mA |                |                               | -1.5        |             |                            | -1.5           |   |      | -1.5 | v         |
|      | Hysteresis ( $V_{T+} - V_{T-}$ ) A or  | B input         | V <sub>CC</sub> = MIN                |                         | 0.1            | 0.4                           |             | 0.2         | 0.4                        |                | 0.2                                       | 0.4  |      | V         |
| Vóн  | High-level output voltage              |                 | V <sub>CC</sub> ≈ M1N,<br>V1H = 2 V, | l <sub>OH</sub> =3 mA   | 2.4            | 3.4                           |             | 2.4         | 3.4                        |                | 2.4                                       | 3.4  |      | v         |
|      |  |                 | VIL = VIL max                        | I <sub>OH</sub> = MAX   | 2              |                               |             | 2           | -                          |                | 2   |      |      |           |
|      | ······································ |                 | V <sub>CC</sub> = MIN,               | I <sub>OL</sub> = 12 mA |                | 0.25                          | 0.4         |             | 0.25                       | 0.4            |   | 0.25 | 0.4  |           |
| VOL  | Low-level output voltage               |                 | VIH = 2 V,                           | IOL = 24 mA             |                |                               |             |             | 0.35                       | 0.5            |   | 0.35 | 0.5  | v         |
|      |  |                 | VIL = VIL max                        | IOL = 48 mA             |                |                               |             |             |                            |                |   | 0.4  | 0.5  | 1         |
|      | Off-state output current,              |                 | V <sub>CC</sub> = MAX,               | Gat 2 V,                |                |                               |             |             |                            |                |   |      |      |           |
| 'OZH | high-level voltage applied             |                 | V <sub>O</sub> = 2.7 V               |                         |                |                               | 20          |             |                            | 20             |   |      | 20   | μΑ        |
| 1    | Off-state output current,              |                 | V <sub>CC</sub> = MAX,               | Gat 2 V,                |                |                               | 400         |             |                            | 400            |   |      | 400  |           |
| 'OZL | low-level voltage applied              |                 | V <sub>O</sub> = 0.4 V               |                         |                |                               | -400        | 1           |                            | -400           |   |      | -400 | <i>~~</i> |
| 1.   | Input current at                       | A or B          |                                      | V <sub>I</sub> = 5.5 V  |                |                               | 0.1         |             |                            | 0.1            |   |      | 0.1  | mA        |
| ''   | maximum input voltage                  | DIR or G        |                                      | V  = 7 V                |                |                               | 0.1         |             |                            | 0.1            |   |      | 0.1  | 1 "''     |
| ЧΗ   | High-level input current               |                 | V <sub>CC</sub> = MAX,               | V <sub>IH</sub> = 2.7 V |                |                               | 20          |             |                            | 20             |   |      | 20   | μA        |
| 11L  | Low-level input current                |                 | V <sub>CC</sub> = MAX,               | VIL = 0.4 V             |                |                               | -400        |             |                            | -400           |   |      | -400 | μA        |
| los  | Short-circuit output current           |                 | V <sub>CC</sub> = MAX                |                         | -40            |                               | -225        | -40         |                            | -225           | -40                                       |      | -225 | mA        |
|      |  | Outputs high    |                                      |                         |                | 48                            | 70          |             | 48                         | 70             |   | 48   | 70   |           |
| Icc  | Total supply current                   | Outputs low     | V <sub>CC</sub> = MAX,               | Outputs open            |                | 62                            | 90          |             | 62                         | 90             |   | 62   | 90   | mA        |
|      |  | Outputs at Hi-Z | 1                                    |                         |                | 64                            | 95          |             | 64                         | 95             |   | 64   | 95   | 1         |
|      |  |                 |                                      |                         |                |                               |             |             |                            |                |   |      |      |           |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions. <sup>‡</sup>All typical values are at V<sub>CC</sub> = 5 V, T<sub>A</sub> = 25°C.

¶Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second,

## switching characteristics at V<sub>CC</sub> = 5 V, $T_A$ = 25°C

|  | PARAMETER                               |         | то           | TECT CONDITIONS | 'LS64 | 10, 'LS | 640-1 | 'LS64 | 3, 'LS6 | 43–1 | 'LS6 | 45, 'LS | 645-1 |     |
|--|---|---------|--------------|-----------------|-------|---------|-------|-------|---------|------|------|---------|-------|-----|
|  | FARAMETER                               | (INPUT) | (OUTPUT)     | TEST CONDITIONS | MIN   | түр     | MAX   | MIN   | ТҮР     | MAX  | MIN  | түр     | MAX   |     |
|  | Propagation delay time,                 | A       | В            |                 |       | 6       | 10    |       | 6       | 10   |      | 8       | 15    |     |
| ΨLH  | low-to-high-level output                | В       | A            | C. = 45 oF      |       | 6       | 10    |       | 8       | 15   |      | 8       | 15    | ns  |
|  | Propagation delay time,                 | A       | В            | CL - 45 PF,     |       | 8       | 15    |       | 9       | 15   |      | 11      | 15    |     |
| <sup>v</sup> PHL   | high-to-low-level output                | В       | A            | D 007.0         |       | 8       | 15    |       | 11      | 15   |      | 11      | 15    | ns  |
|  |   | G, DIR  | A            | HL - 007 32,    |       | 31      | 40    |       | 32      | 45   |      | 31      | 40    |     |
| ۳ZL  |   | G, DIR  | В            | 0 11 0          |       | 31      | 40    |       | 32      | 45   |      | 31      | 40    | ns  |
|  | Over the start of the birth lovel       | Ĝ, DIR  | А            | See Note 2      |       | 23      | 40    |       | 27      | 40   |      | 26      | 40    |     |
| чРZН   | Output enable time to high level        | Ğ, DIR  | В            |                 |       | 23      | 40    |       | 23      | 40   |      | 26      | 40    | ns  |
|  |   | Ĝ, DIR  | Α            | 0               |       | 15      | 25    |       | 15      | 25   |      | 15      | 25    |     |
| ΨLZ  | tpLZ Output disable time from low level | Ĝ, DIR  | В            | CL = 5 pF,      |       | 15      | 25    |       | 15      | 25   |      | 15      | 25    | ns  |
|  | Ġ, DIR                                  | А       | HL - 667 52, |                 | 15    | 25      |       | 15    | 25      |      | 15   | 25      |       |     |
| tpHZ Output disable time from high levents of the term of term | Output disable time from high level     | G, DIR  | В            | See Note 2      |       | 15      | 25    |       | 15      | 25   |      | 15      | 25    | n\$ |

NOTE 2: For load circuits and voltage waveforms, see page 1-15.

## schematics of inputs and outputs



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# OCTAL BUS TYPES TRANSC SN54LS640 m JÜ 0 SN54 4LS643 Ś 64 Þ **SN54LS645** N74LS645 OUTPUTS

# TYPES SN54LS640, SN54LS643, SN54LS645, SN74LS640, SN74LS643, SN74LS645 Octal bus transceivers with 3-state outputs

#### **TYPICAL CHARACTERISTICS**







**FIGURE 2** 



**FIGURE 4** 

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# recommended operating conditions

| PARAMETER                                      | SI<br>SI<br>SI | N54LS6<br>N54LS6<br>N54LS6 | 41<br>42<br>44 | s<br>s<br>s | N74LS6<br>N74LS6<br>N74LS6 | 41<br>42<br>44 | SN74LS641–1<br>SN74LS642–1<br>SN74LS644–1 |     |      | UNIT |
|--|----------------|----------------------------|----------------|-------------|----------------------------|----------------|---|-----|------|------|
|  | MIN            | NOM                        | MAX            | MIN         | NOM                        | MAX            | MIN                                       | NOM | MAX  |      |
| Supply voltage, V <sub>CC</sub> (see Note 1)   | 4.5            | 5                          | 5.5            | 4.75        | 5                          | 5.25           | 4.75                                      | 5   | 5.25 | V    |
| High-level output voltage, VOH                 |                |                            | 5.5            |             |                            | 5.5            |   |     | 5.5  | V    |
| Low-level output current, IOL                  |                |                            | 12             |             |                            | 24             |   |     | 48   | mA   |
| Operating free-air temperature, T <sub>A</sub> | -55            |                            | 125            | 0           |                            | 70             | 0   |     | 70   | °C   |

NOTE 1 : Voltage values are with respect to network ground terminal.

## electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

|                 | PARAMETER                                 |                 | TEST CONDITIONS <sup>†</sup>                                     |   |     | SN54LS641<br>SN54LS642<br>SN54LS644<br>MIN TYP <sup>‡</sup> MAX |      |     | SN74LS641<br>SN74LS642<br>SN74LS644<br>MIN TYP <sup>‡</sup> MAX |      |     | SN74LS641–1<br>SN74LS642–1<br>SN74LS644–1<br>MIN TYP <sup>‡</sup> MAX |      |    |  |
|-----------------|---|-----------------|--|---|-----|---|------|-----|---|------|-----|---|------|----|--|
| VIH             | High-level input voltage                  |                 |  |   | 2   |   |      | 2   |   |      | 2   |   |      | V  |  |
| VIL             | Low-level input voltage                   |                 |  |   | [   |   | 0.5  |     |   | 0.6  |     |   | 0.6  | V  |  |
| VIK             | Input clamp voltage                       |                 | V <sub>CC</sub> = MIN,   | I <sub>L</sub> = -18 mA                           |     |   | -1.5 |     |   | -1.5 |     |   | 1.5  | V  |  |
|                 | Hysteresis $(V_{T+} - V_{T-})$            | A or B input    | V <sub>CC</sub> = MIN  |   | 0.1 | 0.4   |      | 0.2 | 0.4   |      | 0.2 | 0.4   |      | V  |  |
| юн              | High-level output curren                  | t               | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = V <sub>IL</sub> max, | V <sub>IH</sub> = 2 V,<br>V <sub>OH</sub> = 5.5 V |     |   | 100  |     |   | 100  |     |   | 100  | μA |  |
|                 |   |                 | V <sub>CC</sub> = MIN,   | IOL = 12 mA                                       |     | 0.25  | 0.4  |     | 0.25  | 0.4  |     | 0.25  | 0.4  |    |  |
| VOL             | Low-level output voltage                  |                 | V <sub>IH</sub> = 2 V,   | I <sub>OL</sub> = 24 mA                           |     |   |      |     | 0.35  | 0.5  |     | 0.35  | 0.5  | v  |  |
|                 |   |                 | VIL = VIL max  | 1 <sub>OL</sub> = 48 mA                           |     |   |      |     |   |      |     | 0.4   | 0.5  |    |  |
| ų               | Input current at<br>maximum input voltage |                 | V <sub>CC</sub> = MAX,   | VI = 7 V  |     |   | 0.1  |     |   | 0.1  |     |   | 0.1  | mA |  |
| Чн              | High-level input current                  |                 | V <sub>CC</sub> = MAX,   | Vi = 2.7 V  |     |   | 20   |     |   | 20   |     |   | 20   | μA |  |
| ΙL              | Low-level input current                   |                 | V <sub>CC</sub> = MAX,   | V <sub>1</sub> = 0.4 V                            |     |   | -400 |     |   | -400 |     |   | -400 | μA |  |
|                 |   | Outputs high    |  |   |     | 48  | 70   |     | 48  | 70   |     | 48  | 70   |    |  |
| <sup>I</sup> cc | Total Supply Current                      | Outputs low     | V <sub>CC</sub> = MAX,   | Outputs open                                      |     | 62  | 90   |     | 62  | 90   |     | 62  | 90   | mA |  |
|                 |   | Outputs at Hi-Z |  |   |     | 64  | 95   |     | 64  | 95   |     | 64  | 95   |    |  |

<sup>†</sup>For conditions shown as MIN or MAX use the appropriate value specified under recommended operating conditions. <sup>‡</sup>All Typical values are at  $V_{CC}$  = 5 V, T<sub>A</sub> = 25°C.

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INSTRUMENTS

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## switching characteristics at VCC = 5 V, $T_A = 25^{\circ}C$

|       | PARAMETER                | FROM    | то       | TEST CONDITIONS                       | 'LS6 | 'LS641, 'LS641-1 |     |     | 'LS642, 'LS642-1 |     |     | 'LS644, 'LS644-1 |                   |      |
|-------|--------------------------|---------|----------|---------------------------------------|------|------------------|-----|-----|------------------|-----|-----|------------------|-------------------|------|
|       | PARAMETER                | (INPUT) | (OUTPUT) | TEST CONDITIONS                       | MIN  | TYP              | MAX | MIN | түр              | MAX | MIN | түр              | MAX               | UNIT |
|       | Propagation delay time,  | A       | В        |                                       |      | 17               | 25  |     | 19               | 25  |     | 17               | 25                |      |
| լ սեր | low-to-high-level output | В       | A        | C. = 45 pF                            |      | 17               | 25  |     | 19               | 25  |     | 19               | 25                | 115  |
|       | Propagation delay time,  | A       | В        | υ <u>μ</u> - 45 μι,                   |      | 16               | 25  |     | 14               | 25  |     | 14               | 25                |      |
| PHL   | high-to-low-level output | В       | A        | B 667 0                               |      | 16               | 25  |     | 14               | 25  |     | 16               | 25                |      |
|       | Output disable time      | Ĝ, DIR  | A        | n[-00/32,                             |      | 23               | 40  |     | 26               | 40  |     | 26               | 40                |      |
| ΨLH   | from low level           | Ğ, DIR  | В        | Con Note 2                            |      | 25               | 40  |     | 28               | 40  |     | 25               | 40                | 115  |
|       | Output disable time      | G, DIR  | A        | See Note 2                            |      | 34               | 50  |     | 43               | 60  |     | 43               | 60                |      |
| PHL   | from high level          | G, DIR  | В        | · · · · · · · · · · · · · · · · · · · |      | 37               | 50  |     | 39               | 60  |     | 37               | 7 50 <sup>n</sup> | 115  |

841, BUS

SN74LS641

SN54LS642, S642 SN74LS SCEIVERS WI

9, SN54LS644, 5644

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**OPEN-COLLECTOR OUTPUTS** 

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NOTE 2: For load circuits and voltage waveforms, see page 1-15.

#### schematics of inputs and outputs



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# TTL TYPES SN54S740, SN54S741, SN54S744, SN74S740, SN74S741, SN74S744 MSI OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

BULLETIN NO. DL-S 12711, JUNE 1979 - REVISED AUGUST 1979

Typical

Propagation

**Delay Times** 

4 ns

6 ns

|        | юн       | IOL      |                |
|--------|----------|----------|----------------|
|        | Typical  | Typical  |                |
|        | (Source  | (Sink    |                |
|        | Current) | Current) |                |
| SN54S' | -12 mA   | 48 mA    | <b>'</b> S740  |
|        |          |          | <i>'</i> S741  |
| SN74S' | 15 mA    | 64 mA    | <b>*</b> \$744 |
|        |          |          |                |

- 3-State Outputs Drive Bus Lines or Buffer Memory Address Registers
- P-N-P Inputs Reduce D-C Loading
- Typical Input and Output Capacitances < 10 pF
  </li>

#### description

These octal buffers and line drivers are designed specifically to improve both the performance and density of three-state memory address drivers, clock drivers, and bus-oriented receivers and transmitters. The designer has a choice of selected combinations of inverting and noninverting outputs, symmetrical  $\overline{G}$  (active-low output control) inputs, and complementary G and  $\overline{G}$  inputs. These devices feature high fan-out, improved fan-in, and less than 10-picofarad capacitance at inputs and outputs.

**'S740 FUNCTION TABLE** 

| 1G | 2G | 1Y OUTPUTS             | 2Y OUTPUTS             |
|----|----|------------------------|------------------------|
| н  | н  | Z                      | Z                      |
| н  | L  | Z                      | Enabled<br>(Inverting) |
| L  | н  | Enabled<br>(Inverting) | z                      |
|    |    | Enabled                | Enabled                |
| L. |    | (Inverting)            | (Inverting)            |

| <b>'</b> S7 | 41 | FUN | ICTI | ON T | ABL | .E |   |
|-------------|----|-----|------|------|-----|----|---|
|             |    |     |      |      |     |    | _ |

| 1G | 2G | 1Y OUTPUTS | 2Y OUTPUTS |
|----|----|------------|------------|
| н  | н  | Z          | Enabled    |
| н  | L  | Z          | Z          |
| L  | н  | Enabled    | Enabled    |
| L  | L  | Enabled    | Z          |

|    | S744 FUNCTION TABLE |            |            |  |  |  |  |  |  |
|----|---------------------|------------|------------|--|--|--|--|--|--|
| 1G | 2G                  | 1Y OUTPUTS | 2Y OUTPUTS |  |  |  |  |  |  |
| н  | н                   | Z          | . Z        |  |  |  |  |  |  |
| н  | L                   | Z          | Enabled    |  |  |  |  |  |  |
| L  | н                   | Enabled    | Z          |  |  |  |  |  |  |
| L  | L                   | Enabled    | Enabled    |  |  |  |  |  |  |

 $Z \equiv$  high impedance (output off)

6 ns 10 ns 10 ns SN54S740 ... J PACKAGE SN74S740 ... J OR N PACKAGE

Typical

Enable

Times

10 ns

10 ns

Typical

Disable

Times

6 ne

11 ns









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## TYPES SN54S740, SN54S741, SN54S744, SN74S740, SN74S741, SN74S744 OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

## schematics of inputs and outputs



#### absolute maximum ratings over operating free-air temperature range (unless otherwise noted)

| Supply voltage, VCC (see Note 1) .    |         |   |       | <br>7 V                 |
|---------------------------------------|---------|---|-------|-------------------------|
| Input voltage                         |         |   |       | <br>5.5 V               |
| Off-state output voltage              |         |   |       | <br>5.5 V               |
| Operating free-air temperature range: | SN54LS' | · |       | <br>–55°C to 125°C      |
|                                       | SN74LS' |   |       | <br>$\dots$ 0°C to 70°C |
| Storage temperature range             |         |   | ••••• | <br>–65°C to 150°C      |

#### recommended operating conditions

| DADAMETER                                      |     | SN54S | ·   | SN74S' |     |      | LINUT |
|--|-----|-------|-----|--------|-----|------|-------|
|  | MIN | NOM   | MAX | MIN    | NOM | МАХ  | UNIT  |
| Supply voltage, V <sub>CC</sub> (see Note 1)   | 4.5 | 5     | 5.5 | 4.75   | 5   | 5.25 | v     |
| High-level output current, IOH                 |     |       | -12 |        |     | -15  | mA    |
| Low-level output current, IOL                  |     |       | 48  |        |     | 64   | mA    |
| Operating free-air temperature, T <sub>A</sub> | 55  |       | 125 | 0      |     | 70   | °C    |

NOTE 1: Voltage values are with respect to network ground terminal.

# TYPES SN54S740, SN54S741, SN54S744, SN74S740, SN74S741, SN74S744 OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

| electrical characteristics over re | ecommended operating | free-air temperature rang | e (unless otherwise noted) |
|------------------------------------|----------------------|---------------------------|----------------------------|
|                                    |                      |                           |                            |

|           |                              |              |                          |                        |     | 'S740            |      | 'S  | 741, 'S7         | 44   |            |
|-----------|------------------------------|--------------|--------------------------|------------------------|-----|------------------|------|-----|------------------|------|------------|
|           | PARAMETER                    |              | TEST CONDITIONS'         |                        | MIN | TYP <sup>‡</sup> | MAX  | MIN | TYP <sup>‡</sup> | MAX  | UNIT       |
| VIH       | High-level input voltage     |              |                          |                        | 2   |                  |      | 2   |                  |      | v          |
| VIL       | Low-level input voltage      |              |                          |                        |     |                  | 0.8  |     |                  | 0.8  | V          |
| VIK       | Input clamp voltage          |              | V <sub>CC</sub> = MIN,   | lı = -18 mA            |     |                  | -1.2 |     |                  | -1.2 | V          |
|           |                              |              | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V, | 24  |                  |      | 24  |                  |      |            |
|           |                              |              | V <sub>IL</sub> = 0.8 V, | IOH = -1 mA            | 2.7 |                  | -    | 2.4 |                  |      |            |
| Vou       | High-level output voltage    |              | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V, | 24  | 34               |      | 24  | 34               | 1    |            |
| VOH       | Thigh-level output voltage   |              | V <sub>IL</sub> = 0.8 V, | IOH = -3 mA            | £.7 | 0.4              |      | 2.4 |                  |      |            |
| ļ         |                              |              | $V_{CC} = MIN,$          | V <sub>IH</sub> = 2 V, | 24  |                  |      | 24  |                  |      |            |
|           |                              |              | V <sub>IL</sub> = 0.8 V, | IOH = MAX              |     |                  |      |     |                  |      |            |
| Voi       | Low-level output voltage     |              | V <sub>CC</sub> = MIN,   | V <sub>IH</sub> = 2 V, |     |                  | 0.55 |     |                  | 0.55 | v          |
| -02       |                              |              | V <sub>IL</sub> = 0.8 V, | IOL = MAX              |     |                  |      |     |                  |      |            |
|           | Off-state output current,    |              | Vcc = MAX                | $V_0 = 24 V$           |     |                  | 50   |     |                  | 50   |            |
| -0211     | H high-level voltage applied |              | $V_{11} = 2V$            |                        |     |                  |      |     |                  |      | <i>μ</i> Δ |
|           | Off-state output current,    |              | $V_{\rm H} = 0.8 V$      | $V_0 = 0.5 V$          |     |                  | 50   |     |                  | -50  |            |
| .02L      | low-level voltage applied    |              |                          | 10 0.01                |     |                  |      |     |                  |      |            |
| 1         | Input current at maximur     | n            | Vcc = MAX                | Vi = 5.5 V             |     |                  | 1    |     |                  | 1    | mA         |
|           | input voltage                |              |                          |                        |     |                  |      |     |                  |      |            |
| <u>Чн</u> | High-level input current,    | any input    | V <sub>CC</sub> = MAX,   | V <sub>1</sub> = 2.7 V |     |                  | 50   |     |                  | 50   | μA         |
| l Iu      | Low-level input current      | Any A        | Vcc = MAX.               | Vi = 0.5 V             |     |                  | -250 |     |                  | -250 | μA         |
|           |                              | Any G or G   |                          |                        |     |                  | -250 |     |                  | -250 | μA         |
| los       | Short-circuit output curre   | ent•         | V <sub>CC</sub> = MAX    | •                      | -50 |                  | -225 | -50 |                  | -225 | mA         |
|           |                              | Outputs high |                          | SN54S'                 |     | 25               | 60   | [   | 60               | 90   | ĺ          |
| )         |                              |              |                          | SN74S'                 |     | 23               | 60   |     | 55               | 90   |            |
| lcc       | Supply current               | Outputs low  | V <sub>CC</sub> = MAX,   | SN54S'                 |     | 100              | 145  |     | 118              | 160  | mA         |
|           |                              |              | Outputs open             | SN74S'                 |     | 97               | 140  |     | 111              | 155  |            |
|           |                              | Outputs      |                          | SN54S'                 |     | 69               | 110  |     | 72               | 110  | ļ          |
|           |                              | disabled     | \                        | SN74S'                 |     | 64               | 100  |     | 68               | 100  |            |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions.

<sup>‡</sup>All typical values are at  $V_{CC} = 5 V$ ,  $T_A = 25^{\circ}C$ .

Not more than one output should be shorted at a time, and duration of the short-circuit should not exceed one second,

## switching characterisitics, $V_{CC}$ = 5 V, $T_A$ = 25°C

|                  |             |                        |     | 'S740 |     |     | 'S741 |     |     | 'S744 |     |      |
|------------------|-------------|------------------------|-----|-------|-----|-----|-------|-----|-----|-------|-----|------|
| PARAMETER        | TEST CO     | NDITIONS               | MIN | түр   | MAX | MIN | түр   | MAX | MIN | түр   | MAX | UNIT |
| tPLH             |             |                        |     | 4     | 7   |     | 6     | 9   |     | 6     | 9   | ns   |
| <sup>t</sup> PHL | CL = 50 pF, | $R_{L} = 90 \Omega$ ,  |     | 4     | 7   |     | 5     | 8   |     | 5     | 8   | ns   |
| <sup>t</sup> PZL | See Note 2  |                        | 1   | 10    | 15  |     | 10    | 16  |     | 10    | 15  | ns   |
| <sup>t</sup> PZH |             |                        | -   | 7     | 11  |     | 8     | 13  |     | 7     | 11  | ns   |
| <sup>t</sup> PLZ | CL = 5 pF,  | R <sub>L</sub> = 90 Ω, |     | 6     | 11  |     | 11    | 18  |     | 10    | 1,6 | ns   |
| <sup>t</sup> PHZ | See Note 2  |                        |     | 3     | 6   |     | 5     | 9   |     | 3     | 6   | ns   |

NOTE 2: Load circuit and voltage waveforms are shown on page 1-14.

tPLH ≡ Propagation delay time, low-to-high-level input

 $t_{PHL} \equiv Propagation delay time, high-to-low-level input$ 

tpzL = Output enable time to low level

 $t_{PZH} \equiv 0$  utput enable time to high level

 $t_{PLZ} \equiv Output disable time from low level$ 

 $t_{PHZ} \equiv Output disable time from high level$ 

## TYPES SN54S740, SN54S741, SN54S744, SN74S740, SN74S741, SN74S744 OCTAL BUFFERS AND LINE DRIVERS WITH 3-STATE OUTPUTS

#### TYPICAL APPLICATION DATA



# SBP 9708 Parallel-Byte Multiplier

### FEATURES

- Signed or Unsigned 8-Bit Multiplier Produces 16-Bit Product
- On-Chip Latches Simplify System Design
- Transparent or Latched (Pipelined) Operating Modes
- Bus Compatible With Popular 8-Bit Microprocessors
- Supports Systems With Bus Data Rates Up to 4 MHz
- Standard 16-Pin Packaging Maximizes Boards Density
- Compatible With TTL and Low-Threshold MOS
- Choice of Ambient Temperature Performance Ranges:

SBP 9708M ...  $-55^{\circ}$ C to 125°C SBP 9708E ...  $-40^{\circ}$ C to 85°C SBP 9708C ...  $0^{\circ}$ C to 70°C

#### DESCRIPTION

This 8-bit by 8-bit I<sup>2</sup>L parallel multiplier provides a 16-bit signed or unsigned product resulting from two signed 2's complement or unsigned 8-bit bytes. Designed specifically to achieve the cost-effectiveness needed for microprocessor based systems, the SBP 9708 combines the static logic of I<sup>2</sup>L with a pin-efficient organization to make available a low-cost byte-oriented peripheral multiplier that can improve CPU throughput rates and reduce software overhead significantly over iterative algorithms.

Sequential byte-parallel operations can be performed in either a transparent or latched (pipelined) multiply mode. In the transparent mode, the multiplier/multiplicand latches accept the two operators, the 16-bit product bypasses the output latches and is available in two of the multiplier array bytes directly from the 8-bit 4-to-1 multiplexer. This mode is best-suited when the need is for fast, isolated multiply occurrences. In the latched mode, during the first write cycle, the multiplier latch accepts new data and the previous array result is strobed into the two product latches. On the next write cycle, the multiplicand is latched. In this mode, designed for multiply-intensive systems, pipelining allows sequential multiplication operations carried out at a rate 50% faster than in the transparent mode.

In addition to single line controls for operating mode (MODE) and sign-bit handling (S/ $\overline{U}$ ), active-low chip-select (CS) and read-write (R/ $\overline{W}$ ) inputs are configured to make the multiplier addressable from hardware and software as either a memory-mapped, or an I/O-mapped peripheral. Sequential parallel byte loading (write) and result output (reading) are steered to or from the storage latches by a single most-significant byte/least-significant byte (M/ $\overline{L}$ ) control input.

All versions are TTL and low-threshold MOS compatible. Output pullup resistors are provided on chip to minimize external components.

## CONTROL FUNCTION TABLE

| MODE                |   | 11  |     |      | C INCTION  |
|---------------------|---|-----|-----|------|--|
| MODE                | ଞ | R/W | M/L | MODE | FUNCTION   |
|                     | н | х   | х   | x    | I/O Disabled   |
|                     | L | L   | L   | н    | Load Multiplier Latch  |
| Transparent         | L | L   | н   | н    | Load Multiplicand Latch  |
| Manapiy             | L | н   | L   | н    | Read LSB Product From Adder Array  |
|                     | L | н   | н   | н    | Read MSB Product From Adder Array  |
|                     | L | L   | L   | L    | Load Multiplier, Latch, Strobe<br>Adder Array Data into Product<br>Latches |
| Latched<br>Multiply | L | L   | н   | L    | Load Multiplicand Latch  |
|                     | L | н   | L   | L    | Read LSB Product Latch   |
|                     | L | н   | н   | Ļι   | Read MSB Product Latch   |

#### SIGN-BIT SELECTION FUNCTION TABLE

| s/Ū | I/O SIGNIFICANCE       |
|-----|------------------------|
| L   | Unsigned Byte Multiply |
| н   | Signed Byte Multiply   |





#### PIN DESCRIPTION

| SIGNATURE       | PIN                | DESCRIPTION  |
|-----------------|--------------------|--|
| v <sub>cc</sub> | 16                 | Provides +5 V connection to resistive pullups on outputs and voltage dividers on inputs.   |
| GND             | 8                  | Ground   |
| INJ *           | 5                  | Injector current input   |
| D0-D7           | 7,<br>9 thru<br>15 | Data input∕output port   |
| ĊŠ, R/₩         | 2,4                | Chip select low causes product latch data to be transferred onto the external data bus if read-write is high or causes multiplier/multiplicand data to be input to one of the input latches from the external bus if $R/\overline{W}$ is low. Chip select high causes D0-D7 to be at a logic high level.                 |
| M/T             | 3                  | Most/Least byte select determines which multiplier latch is loaded on input, which byte of the product is read on output. Byte 1 latch and LSB product latch are accessed on M/L low.  |
| MODE            | 6                  | MODE high causes adder array outputs to be passed directly to the 2 to 1 multiplexer. MODE low causes adder array outputs to be strobed into the product latches as the multiplier latch is loaded. Previous product data is then available after new multipliers are loaded. The multiplier latch must be loaded first. |
| s∕Ū             | 1                  | Signed multiply when high, unsigned multiply when low.   |

\*Nominal current may be supplied by connection of a 24  $\Omega\pm5\%$  (2 watt) resistor from V<sub>CC</sub> to INJ input.

#### SBP 9708

## recommended operating conditions

| PARAMETER                                       |                               |           |     |  | MAX | UNIT |
|---|-------------------------------|-----------|-----|--|-----|------|
| Supply voltage, V <sub>CC</sub>                 |                               |           |     |  | 5.5 | v    |
| Injector current, I <sub>INJ</sub>              |                               |           |     |  | 175 | mA   |
| High-level output voltage, V <sub>OH</sub>      |                               |           |     |  | 5.5 | V    |
| Low-level output current, IOL (SBP 9708C only*) |                               |           |     |  | 8   | mA   |
| Width of load pulse (chip select low), tw(CS)   |                               |           |     |  |     | ns   |
|   | M/L before load pulse         | 35↓       |     |  |     |      |
| Setup time                                      | Data before end of loa        | 60t       |     |  | ns  |      |
|   | R/W before load puls          | 40‡       |     |  |     |      |
| Hold time                                       | M/L after load pulse,         | 10        |     |  |     |      |
|   | Data after load pulse,        | 10†       |     |  | ns  |      |
|   | R/W after chip select,        | 01        |     |  | }   |      |
|   |                               | SBP 9708M | -55 |  | 125 |      |
| Operating free-air                              | r temperature, T <sub>A</sub> | SBP 9708E | -40 |  | 85  | °C   |
|   |                               | SBP 9708C | 0   |  | 70  |      |

• Values for SBP 9708M and SBP 9708E will be announced at a later date.

# electrical characteristics over recommended operating free-air temperature range (unless otherwise noted)

| [   | PARAMETER                                 | TEST CONDITIONS <sup>†</sup>                      |  |                            |      | TYP ‡ | MAX  | UNIT |
|-----|---|---|--|----------------------------|------|-------|------|------|
| VIH | High-level input voltage                  |   |  |                            | 2    |       |      | V    |
| VIL | Low-level input voltage                   |   |  |                            |      |       | 0.8  | V    |
| VIK | Input clamp voltage                       | V <sub>CC</sub> = MIN,                            | l <sub>l</sub> = –12 mA                          |                            |      |       | -1.5 | V    |
| Vон | High-level output voltage                 | V <sub>CC</sub> = MIN,                            | V <sub>IH</sub> = 2.4 V,<br>No Load              | V <sub>IL</sub> = 0.8V,    | 2.5  | 3.5   |      | v    |
| VOL | Low-level output voltage                  | V <sub>CC</sub> = MIN,<br>V <sub>IL</sub> = 0.8V, | V <sub>IH</sub> = 2 V,<br>I <sub>OL</sub> = 8 mA | I <sub>INJ</sub> = 130 mA, |      |       | 0.5  | v    |
| los | Short-circuit output current              | V <sub>CC</sub> = 5.5V                            |  |                            | -0.3 | -0.8  | -1.2 | mA   |
| 11  | Input current at maximum<br>input voltage | V <sub>CC</sub> = MAX,                            | V <sub>I</sub> = 5.5 V                           |                            |      | 0.4   | 1    | mA   |
| Чн  | High-level input current                  | V <sub>CC</sub> = MAX,                            | V <sub>1</sub> = 2.4 V                           |                            | 1    | -0.3  | -0.7 | mA   |
| 11  | Low-level input current                   | V <sub>CC</sub> = MAX,                            | V <sub>1</sub> = 0.5 V                           |                            |      | -0.7  | -1.1 | mA   |
| ICC | Supply current                            | V <sub>CC</sub> = MAX                             |  |                            |      | 8     | 15   | mA   |

# switching characteristics over recommended operating free-air temperature range, $V_{CC} = 5V$ , $I_{INJ} = 165 \text{ mA}$

| PARAMETER | FROM | то               | TEST CONDITIONS            | NO EXTERNAL<br>PULLUP |       |     | SEE LOAD<br>CIRCUIT |                  |     | UNIT |
|-----------|------|------------------|----------------------------|-----------------------|-------|-----|---------------------|------------------|-----|------|
| -         |      |                  |                            | MIN                   | TYP ‡ | MAX | MIN                 | TYP <sup>‡</sup> | MAX |      |
| tPD(CS)   | CS   | OUTPUT (D7-D0)   |                            |                       | 240   |     |                     | 150              | 200 | ns   |
| tPD(S/U)  | S/U  | OUTPUT (D7-D0)   | CL = 80 pF                 |                       | 340   |     |                     | 250              | 325 | ns   |
| tPD(M/L)  | M/L  | OUTPUT (D7-D0)   |                            |                       | 250   |     |                     | 160              | 200 | ns   |
| tPD(MPY)  | CS ↑ | PROD OUT (D7-D0) | CL = 80 pF, VI(mode) = 2 V |                       | 365   |     |                     | 275              | 400 | ns   |

<sup>†</sup>For conditions shown as MIN or MAX, use the appropriate value specified under recommended operating conditions for the applicable type, <sup>‡</sup> All typical values are at V<sub>CC</sub> = 5V, T<sub>A</sub> = 25°C.

↓ ↑ The arrow indicates the transition of the chip-select input used for reference: ↑ for the low-to-high transition, ↓ for the high-to-low transition.



 $\mathbf{C}_{\mathsf{L}}$  includes probe and jig capacitance.

#### LOAD CIRCUIT

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TIMING DIAGRAM-TYPICAL PIPELINED MODE SEQUENCE OF MULTIPLIES



TIMING DIAGRAM-TYPICAL TRANSPARENT MODE CYCLE



SBP 9708 TYPICAL MEMORY-MAPPED APPLICATION (8080A SYSTEM)

SBP 9708



8080A SYSTEM MULTIPLIER LOAD CYCLE USING SN74LS245 (MEMORY-MAPPED)



8080A SYSTEM PRODUCT READ CYCLE (MEMORY-MAPPED)

SBP 9708



\*DECODER OUTPUT GOES ACTIVE (HIGH) ON A UNIQUE DECODE OF ADDRESS LINES A3-A15



8080A SYSTEM MULTIPLIER LOAD CYCLE USING SN74S428 OR SN74S438



8080A SYSTEM MULTIPLIER READ CYCLE USING SN74S428 OR SN74S438

# MECHANICAL DATA

### ORDERING INSTRUCTIONS

Orders for devices from this book should include the package outline letter(s) at the end of the type number.

#### Examples: SN54S482J, SN74S740N

It is necessary to use only the first letter of the package type (J or N) unless the device is available in more than one type of J (dual-in-line ceramic) package, or in more than one type of N (dual-in-line plastic) package.

Special ordering instructions for programmable read-only memories (PROMs) are found on page 5-2.

## J ceramic packages (including JT and JW dual-in-line and JQ quad-in-line packages)

These hermetically sealed dual-in-line packages consist of a ceramic base, ceramic cap, and a 16-, 18-, 20-, 24-, 28-, or 48lead frame. Hermetic sealing is accomplished with glass. The JT packages are intended for insertion in mounting-hole rows on 0.300 (7,62) centers, JW packages for mounting-hole rows on 0.600 (15,24) centers, and the JQ quad-in-line package for mounting-hole rows on 0.600 (15,24) and 0.800 (20,32) centers. Once the leads are compressed and inserted sufficient tension is provided to secure the package in the board during soldering. Tin-plated ("bright-dipped") leads require no additional cleaning or processing when used in soldered assembly.

NOTE: For the 16-, 28-, and 20-pin packages, the letter J is used by itself since these packages are available only in the 0.300 (7,62) row spacing. For the 24-pin packages, if no second letter nor row spacing is specified, the package is assumed to have 0.600 (15,24) row spacing.



NOTES: a. All dimensions are shown in inches (and parenthetically in millimeters for reference only). Inch dimensions govern.



NOTES: a. All dimensions are shown in inches (and parenthetically in millimeters for reference only). Inch dimensions govern,

b. Each pin centerline is located within 0.010 (0,26) of its true longitudinal position.

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NOTES: a. All dimensions are shown in inches (and parenthetically in millimeters for reference only). Inch dimensions govern. b. Each pin centerline is located within 0.010 (0,26) of its true longitudinal position.



NOTES: a. All dimensions are shown in inches (and parenthetically in millimeters for reference only). Inch dimensions govern.

b. Each pin centerline is located within 0.010 (0,26) of its true longitudinal position.



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NOTES: a. All dimensions are shown in inches (and parenthetically in millimeters for reference only). Inch dimensions govern.

b. Each pin centerline is located within 0.010 (0,26) of its true longitudinal position.


NOTES: a. All dimensions are shown in inches (and parenthetically in millimeters for reference only). Inch dimensions govern. b. Each pin centerline is located within 0.010 (0,26) of its true longitudinal position.

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MECHANICAL DATA

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#### N plastic packages (including NT and NW dual-in-line packages)

These dual-in-line packages consist of a circuit mounted on a 16-, 18-, 20-, 24-, or 28-pin lead frame and encapsulated within an electrically nonconductive plastic compound. The compound will withstand soldering temperature with no deformation and circuit performance characteristics remain stable when operated in high-humidity conditions. The packages are intended for insertion in mounting-hole rows on 0.300 (7,62) centers for the NT packages and on 0.600 (15,24) centers for the NW packages. Once the leads are compressed and inserted, sufficient tension is provided to secure the package in the board during soldering. Leads require no additional cleaning or processing when used in soldered assembly.

NOTE: For the 16-, 18-, 20-, and 28-pin packages, the letter N is used by itself since these packages are available in only one row-spacing width – 0.300 (7,62) for the 16-, 18-, and 20-pin packages and 0.600 (15,24) for the 28-pin package. For the 24-pin package, if no second letter nor row spacing is specified, the package is assumed to have 0.600 (15,24) row spacing.



NOTES: a. All dimensions are shown in inches (and parenthetically in millimeters for reference only). Inch dimensions govern. b. Each pin centerline is located within 0.010 (0,26) of its true longitudinal position.





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z plastic packages (continued) 24-PIN NT PLASTIC, 0.300 (7,62) ROW SPACING 1.250 (31,8) MAX 13 24 23 14 0.093 (2,36) R NOM- $0.310 \pm 0.010$ 0.160 (4,06) NOM (7.87 ± 0.26) (12 0.275 (6,99) MAX 8 (10 3 5 6 9 11 0.015 (0,38) MIN 0.080 (2,03) NOM 0.070 (1,78) 0.033 (0,83) 24 PLACES 0.010 (0,25) NOM 0.200 (5,08) MAX SEATING PLANE <u>105°</u> 90° 24 PLACES 0.033 (0,83) MIN 24 PLACES 0.125 (3,17) MIN 0.018 ± 0.003 (0,457 ± 0,076) 24 PLACES - 0.011 ± 0.003 (0,279 ± 0,076) 24 PLACES 0.085 (2,16) MAX-PIN SPACING 0.100 (2,54) T.P. 4 PLACES (See Note b)

MECHANICAL DATA

NOTES: a. All dimensions are shown in inches (and parenthetically in millimeters for reference only). Inch dimensions govern.

b. Each pin centerline is located within 0.010 (0,26) of its true longitudinal position.

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b. Each pin centerline is located within 0.010 (0,26) of its true longitudinal position.

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**MECHANICAL DATA** 

NOTES: a. All dimensions are shown in inches (and parenthetically in millimeters for reference only). Inch dimensions govern.

b. Each pin centerline is located within 0.010 (0,26) of its true longitudinal position.

### W ceramic flat package

These hermetically sealed flat packages consist of an electrically nonconductive ceramic base and cap, and a 16- or 24-lead frame. Hermetic sealing is accomplished with glass. Tin-plated ("bright-dipped") leads (-00) require no additional cleaning or processing when used in soldered assembly.



NOTES: a. All dimensions are shown in inches (and parenthetically in millimeters for reference only). Inch dimensions govern.

- b. Index point is provided on cap for terminal identification only.
- c. Leads are within 0.005 (0,13) radius of true position (T.P.) at maximum material condition.
- d. This dimension determines a zone within which all body and lead irregularities lie.
- e. Not applicable for solder-dipped leads.
- f. When solder-dipped leads are specified, dipped area extends from lead tip to within 0.050 (1,27) of package body.

## **MECHANICAL DATA**

W ceramic flat package (continued)



- NOTES: a. All dimensions are shown in inches (and parenthetically in millimeters for reference only). Inch dimensions govern.
  - b. Index point is provided on cap for terminal identification only.
  - c. Leads are within 0.005 (0,13) radius of true position (T.P.) at maximum material condition.
  - d. This dimension determines a zone within which all body and lead irregularities lie.
  - e. Not applicable for solder-dipped leads.
  - f. When solder-dipped leads are specified, dipped area extends from lead tip to within 0.050 (1,27) of package body.
  - g. End configuration of 24-pin package is at the option of T1.

# ERRATA

This page and the one that follows correct pages 5-7 and 5-15. In addition to showing pins 18 and 19 of TBP28S85, TBP28L85, and TBP28P85 to be active high (E, not  $\vec{E}$ ), the rank numbers of all A, E, G, and Q pins have been changed to correspond with the numbering in the standard pin-outs currently under consideration by the JEDEC Committee on Bipolar Memories, JC42.1. For the same reason, S pins (chip select) have been redesignated G (output enable), these functions being interchangeable in unregistered PROMs. With the exception of the E to  $\vec{E}$  corrections, these changes strictly involve nomenclature, not functional changes.

### SERIES 14 AND 18 PROGRAMMABLE READ-ONLY MEMORIES

| TBP18SA030, TBP18S030  | <sup>,</sup> TBP14S10, TBP14SA10  | TBP18SA22, TBP18S22   | TBP18S42, TBP18SA22   | TBP18S46, TBP18SA46  |
|--|---|---|---|--|
| 256 BITS   | 1024 BITS   | 2048 BITS   | 4096 BITS   | 4096 BITS  |
| (32 WORDS BY 8 BITS)   | (256 WORDS BY 4 BITS)   | (256 WORDS BY 8 BITS)   | (512 WORDS BY 8 BITS)   | (512 WORDS BY 8 BITS)  |
| (TOP VIEW)   | (TOP VIEW)  | (TOP VIEW)  | (TOP VIEW)  | (TOP VIEW)   |
| 00 1 6 Vcc<br>012 5 6<br>02 3 4 A4<br>03 4 7 A3<br>04 5 7 A2<br>05 6 11 A1<br>06 7 10 A0<br>GND 8 0 07 | A6 16 VCC   A5 15 A7   A4 16 12   A3 13 13   A0 12 00   A1 11 01   A2 10 02   GND 03 03 | A0 1 20 VCC<br>A1 2 30 A7<br>A2 3 30 A6<br>A3 4 17 A5<br>A4 5 16 G2<br>Q0 6 16 G1<br>Q1 7 10 C7<br>Q2 8 17 Q6<br>Q3 9 17 Q5<br>GND 10 11 Q4 | A0 1 20 Vcc   A1 19 A8   A2 19 A7   A3 17 A6   A4 16 A5   Q0 19 B7   Q1 11 A6   Q2 13 Q6   Q3 12 Q5   GND 11 Q4 | A7 1 28 VCC<br>A6 2 23 A8<br>A5 3 22 NC<br>A4 2 21 G4<br>A3 5 20 G1<br>A2 5 29 G3<br>A1 7 19 G3<br>A1 7 19 G2<br>A0 8 17 Q7<br>Q0 9 19 Q6<br>Q1 20 19 Q4 |

Pin assignments for all of these memories are the same for all packages.

13 03

GND 12

## ERRATA

### SERIES 24 AND 28 PROGRAMMABLE READ-ONLY MEMORIES



• For those pins having dual designations, the designation to the right of the virgule (/) applies only to the type number(s) immediately followed by an asterisk (\*) above the pinout drawing.

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